S29GLxxxM MirrorBit™ Flash Family
S29GL256M, S29GLI28M, S29GL064M, S29GL032M
256 Megabit, I28 Megabit, 64 Megabit, and 32Megabit, 3.0 Volt-only Page Mode Flash Memory featuring 0.23 um MirrorBit process technology

Datasheet

DATASHEET

Distinctive Characteristics

Architectural Advantages

- **Single power supply operation**
  - 3 volt read, erase, and program operations
- **Manufactured on 0.23 um MirrorBit process technology**
- **SecSi™ (Secured Silicon) Sector region**
  - 128-word/256-byte sector for permanent, secure identification through an 8-word/16-byte random Electronic Serial Number, accessible through a command sequence
  - May be programmed and locked at the factory or by the customer
- **Flexible sector architecture**
  - 256Mb: 512 32 Kword (64 Kbyte) sectors
  - 128Mb: 256 32 Kword (64 Kbyte) sectors
  - 64Mb (uniform sector models): 128 32 Kword (64 Kbyte) sectors or 128 32 Kword sectors
  - 64Mb (boot sector models): 127 32 Kword (64 Kbyte) sectors + 8 4Kword (8Kbyte) boot sectors
  - 32Mb (uniform sector models): 64 32Kword (64 Kbyte) sectors of 64 32Kword sectors
  - 32Mb (boot sector models): 63 32Kword (64 Kbyte) sectors + 8 4Kword (8Kbyte) boot sectors
- **Compatibility with JEDEC standards**
  - Provides pinout and software compatibility for single-power supply flash, and superior inadvertent write protection
- **100,000 erase cycles typical per sector**
- **20-year data retention typical**

Performance Characteristics

- **High performance**
  - 90 ns access time (128Mb, 64Mb, 32Mb), 100 ns access time (256Mb)
  - 4-word/8-byte page read buffer
  - 25 ns page read times (128Mb, 64Mb, 32Mb)
  - 30 ns page read times (256Mb)
  - 16-word/32-byte write buffer
  - 16-word/32-byte write buffer reduces overall programming time for multiple-word updates
- **Low power consumption (typical values at 3.0 V, 5 MHz)**
  - 18 mA typical active read current (64 Mb, 32 Mb)
  - 25 mA typical active read current (256 Mb, 128 Mb)
  - 50 mA typical erase/program current
  - 1 µA typical standby mode current
- **Package options**
  - 40-pin TSOP
  - 48-pin TSOP
  - 56-pin TSOP
  - 64-ball Fortified BGA
  - 48-ball fine-pitch BGA
  - 63-ball fine-pitch BGA

Software & Hardware Features

- **Software features**
  - Program Suspend & Resume: read other sectors before programming operation is completed
  - Erase Suspend & Resume: read/program other sectors before an erase operation is completed
  - Data# polling & toggle bits provide status
  - CFI (Common Flash Interface) compliant: allows host system to identify and accommodate multiple flash devices
  - Unlock Bypass Program command reduces overall multiple-word programming time
- **Hardware features**
  - Sector Group Protection: hardware-level method of preventing write operations within a sector group
  - Temporary Sector Unprotect: V_{ID}-level method of charging code in locked sectors
  - WP#/ACC input accelerates programming time (when high voltage is applied) for greater throughput during system production. Protects first or last sector regardless of sector protection settings on uniform sector models
  - Hardware reset input (RESET#) resets device
  - Ready/Busy# output (RY/BY#) detects program or erase cycle completion

General Description

The S29GL256/128/064/032M family of devices are 3.0 V single power Flash memory manufactured using 0.23 um MirrorBit technology. The S29GL256M is a 256 Mbit, organized as 16,777,216 words or 33,554,432 bytes. The S29GL128M is a 128 Mbit, organized as 8,388,608 words or 16,777,216 bytes. The S29GL064M is a 64 Mbit, organized as 4,194,304 words or 8,388,608 bytes. The S29GL032M is a 32 Mbit, organized as 2,097,152 words or 4,194,304 bytes. Depending on the model number, the devices have an 8-bit wide data bus only, 16-bit wide data bus only, or a 16-bit wide data bus that can also function as an 8-bit wide data bus by using the BYTE# input. The devices can be programmed either in the host system or in standard EPROM programmers.

Access times as fast as 90 ns (S29GL128M, S29GL064M, S29GL032M) or 100 ns (S29GL256M) are available. Note that each access time has a specific operating voltage range (V_{CC}) as specified in the Product Selector Guide and the Ordering Information sections. Package offerings include 40-pin TSOP, 48-pin TSOP, 56-pin TSOP, 48-ball fine-pitch BGA, 63-ball fine-pitch BGA and 64-ball Fortified BGA, depending on model number. Each device has separate chip enable (CE#), write enable (WE#) and output enable (OE#) controls.

Each device requires only a **single 3.0 volt power supply** for both read and write functions. In addition to a V_{CC} input, a high-voltage **accelerated program (ACC)** feature provides shorter programming times through increased current on the WP#/ACC input. This feature is intended to facilitate factory throughput during system production, but may also be used in the field if desired.

The device is entirely command set compatible with the **JEDEC single-power-supply Flash standard**. Commands are written to the device using standard microprocessor write timing. Write cycles also internally latch addresses and data needed for the programming and erase operations.

The **sector erase architecture** allows memory sectors to be erased and reprogrammed without affecting the data contents of other sectors. The device is fully erased when shipped from the factory.

Device programming and erasure are initiated through command sequences. Once a program or erase operation has begun, the host system need only poll the DQ7 (Data# Polling) or DQ6 (toggle) **status bits** or monitor the **Ready/Busy# (RY/BY#)** output to determine whether the operation is complete. To facilitate programming, an **Unlock Bypass** mode reduces command sequence overhead by requiring only two write cycles to program data instead of four.

Hardware data protection measures include a low V_{CC} detector that automatically inhibits write operations during power transitions. The hardware sector protection feature disables both program and erase operations in any combination of sectors of memory. This can be achieved in-system or via programming equipment.

The **Erase Suspend/Erase Resume** feature allows the host system to pause an erase operation in a given sector to read or program any other sector and then complete the erase operation. The **Program Suspend/Program Resume** feature enables the host system to pause a program operation in a given sector to read any other sector and then complete the program operation.

The **hardware RESET# pin** terminates any operation in progress and resets the device, after which it is then ready for a new operation. The RESET# pin may be tied to the system reset circuitry. A system reset would thus also reset the device, enabling the host system to read boot-up firmware from the Flash memory device.

The device reduces power consumption in the **standby mode** when it detects specific voltage levels on CE# and RESET#, or when addresses have been stable for a specified period of time.

The **Write Protect (WP#)** feature protects the first or last sector by asserting a logic low on the WP#/ACC pin or WP# pin, depending on model number. The protected sector will still be protected even during accelerated programming.

The **SecSi™ (Secured Silicon) Sector** provides a 128-word/256-byte area for code or data that can be permanently protected. Once this sector is protected, no further changes within the sector can occur.

Spansion MirrorBit flash technology combines years of Flash memory manufacturing experience to produce the highest levels of quality, reliability and cost effectiveness. The device electrically erases all bits within a sector simultaneously via hot-hole assisted erase. The data is programmed using hot electron injection.

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Product Selector Guide

S29GL256M

Part Number	S29GL256M	
Speed Option	10	11
Max. Access Time (ns)	100	110
Max. CE# Access Time (ns)	100	110
Max. Page Access Time (ns)	30	30
Max. OE# Access Time (ns)	30	30

S29GLI28M

Part Number	S29GL128M	
Speed Option	90	10
Max. Access Time (ns)	90	100
Max. CE# Access Time (ns)	90	100
Max. Page Access Time (ns)	25	30
Max. OE# Access Time (ns)	25	30

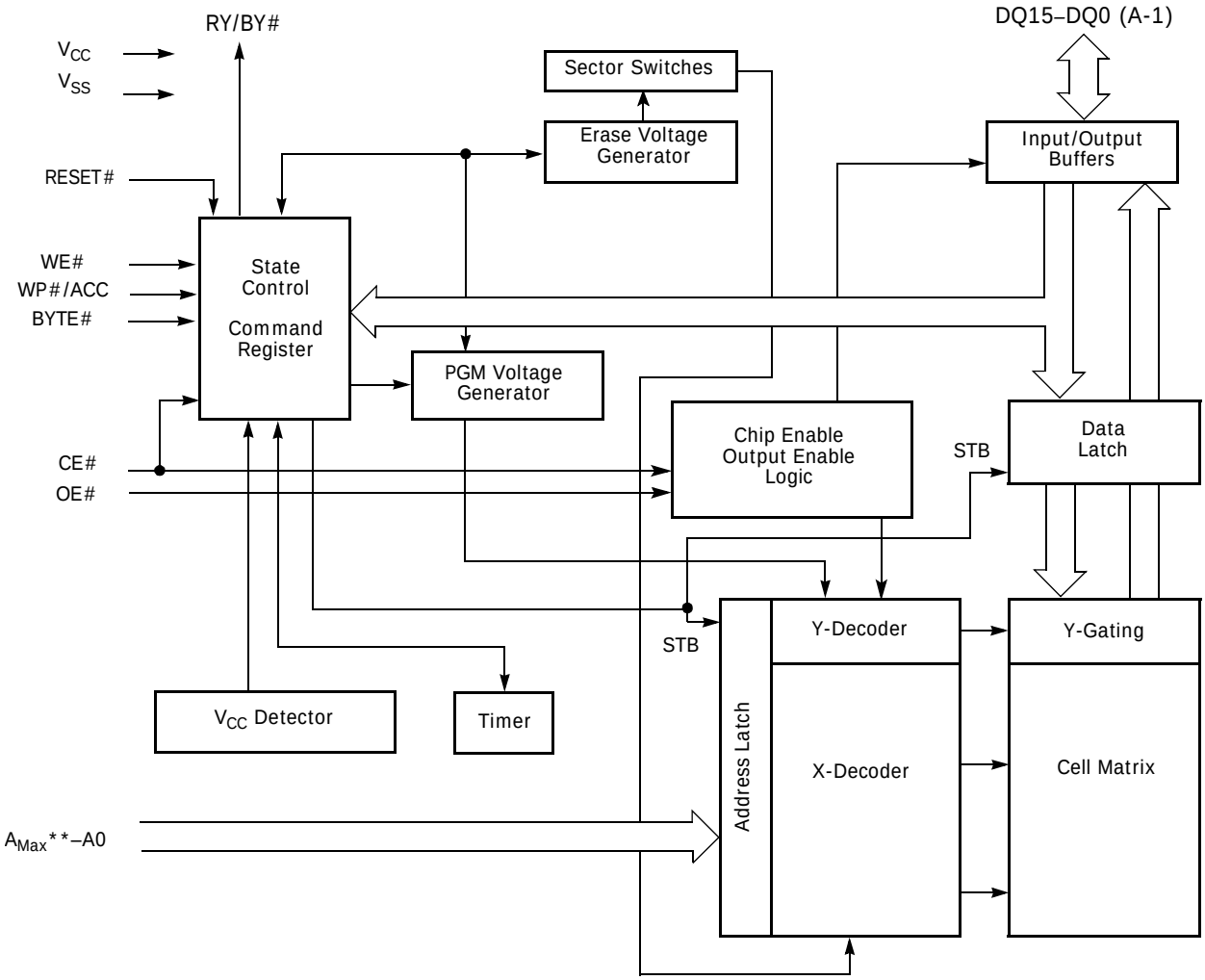
S29GL064M

Part Number	S29GL064M		
Speed Option	90	10	11
Max. Access Time (ns)	90	100	110
Max. CE# Access Time (ns)	90	100	110
Max. Page Access Time (ns)	25	30	30
Max. OE# Access Time (ns)	25	30	30

S29GL032M

Part Number	S29GL032M		
Speed Option	90	10	11
Max. Access Time (ns)	90	100	110
Max. CE# Access Time (ns)	90	100	110
Max. Page Access Time (ns)	25	30	30
Max. OE# Access Time (ns)	25	30	30

Block Diagram



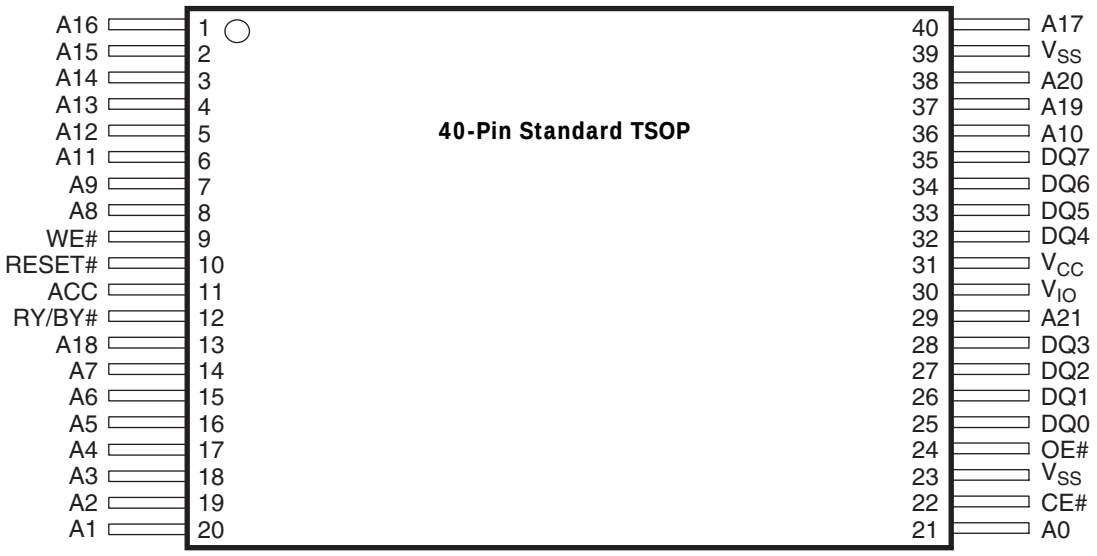
*** A_{Max} GL256M = A23*

A_{Max} GL128M = A22

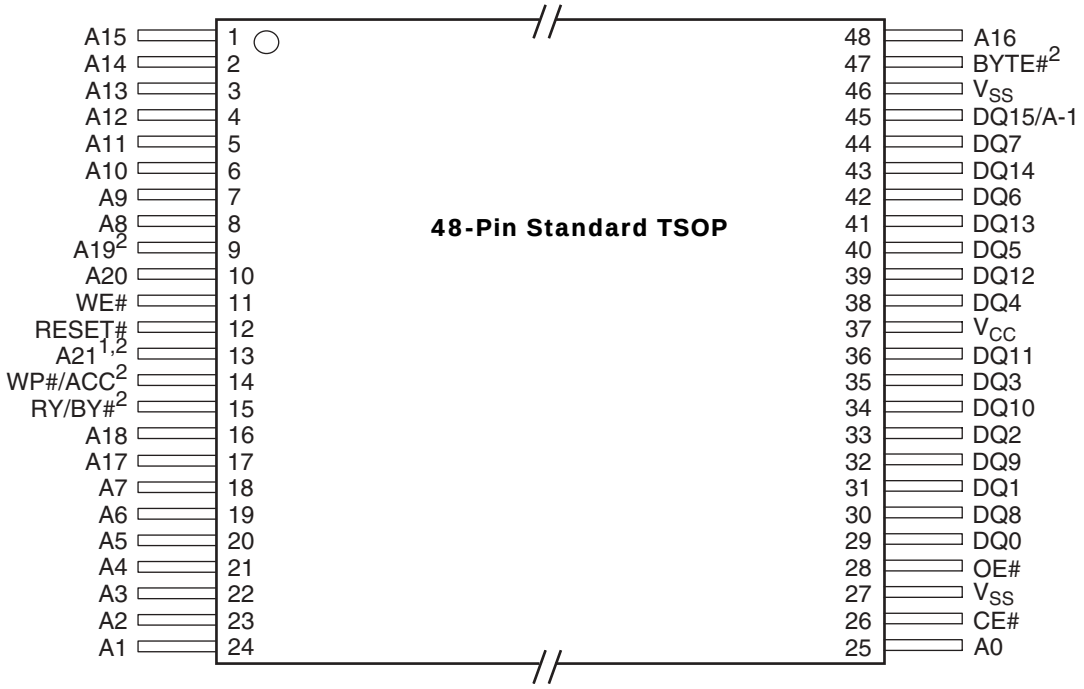
A_{Max} GL064M = A21 (A_{Max} GL064M-00 = A22)

A_{Max} GL032M = A20 (A_{Max} GL032M-00 = A21)

Connection Diagrams



Connection Diagrams

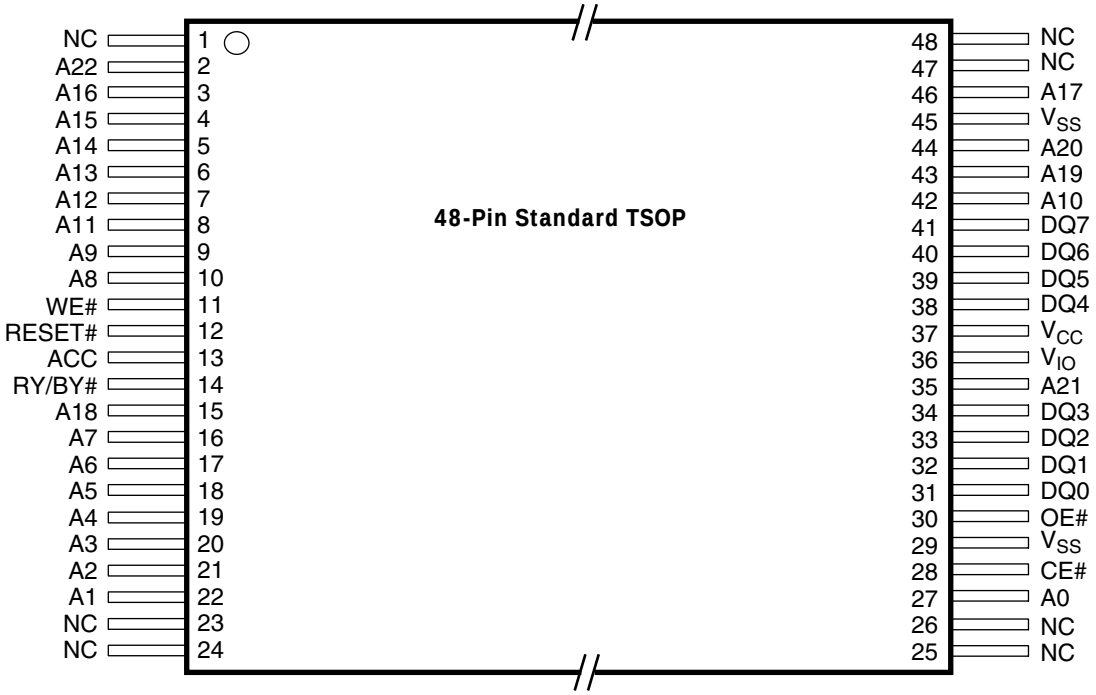


Notes:

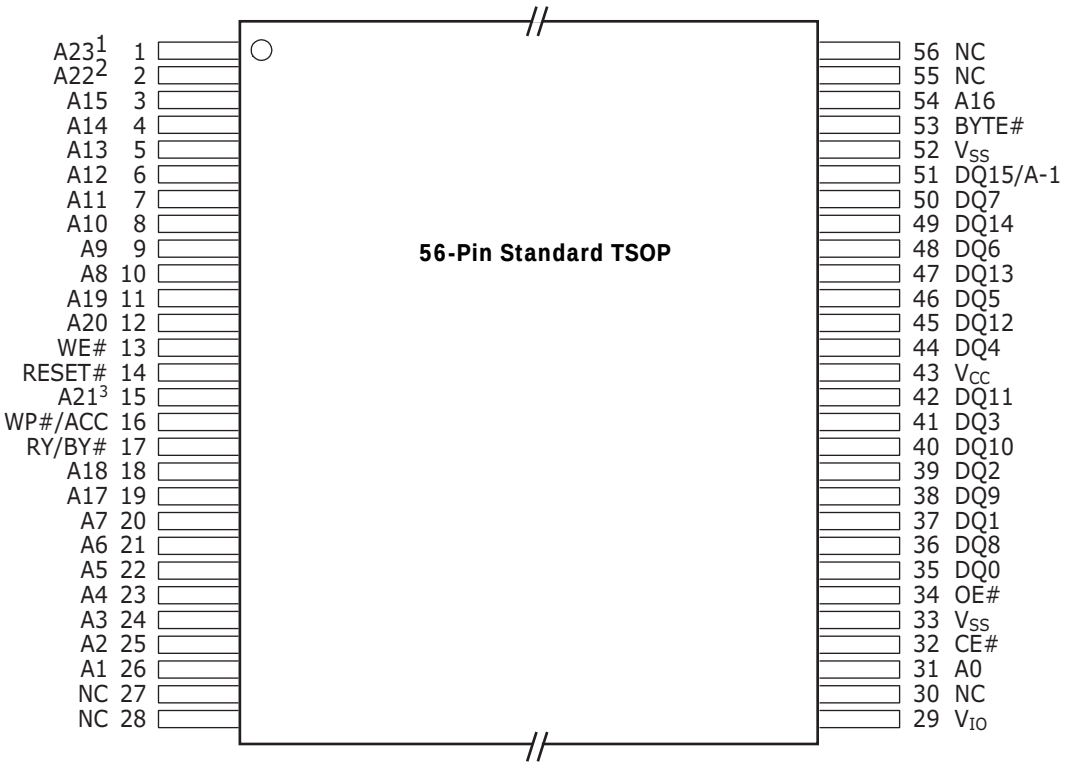
1. *Pin 13 is NC on S29GL032M.*
2. *Pin 9 is A21, Pin 13 is ACC, Pin 14 is WP#, Pin 15 is A19, and Pin 47 is V_{IO} on S29GL064M (models R6, R7).*

Connection Diagrams

For S29GL064M (model R0) only.



Connection Diagrams

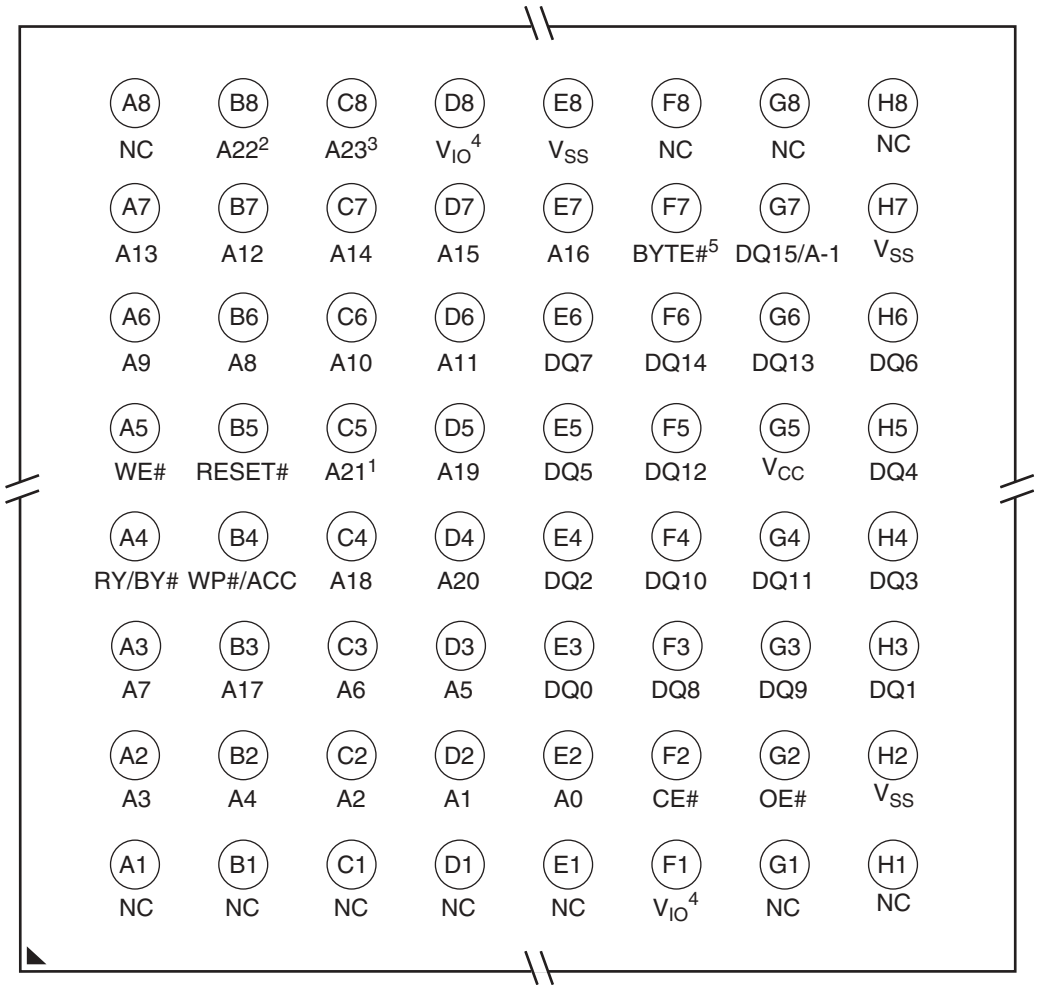


Notes:

1. *Pin 1 is NC on S29GL128M, 29GL064M, and S29GL032M.*
2. *Pin 2 is NC on S29GL064M, and S29GL032M.*
3. *Pin 15 is NC on S29GL032M.*

Connection Diagrams

64-ball Fortified BGA
Top View, Balls Facing Down



Notes:

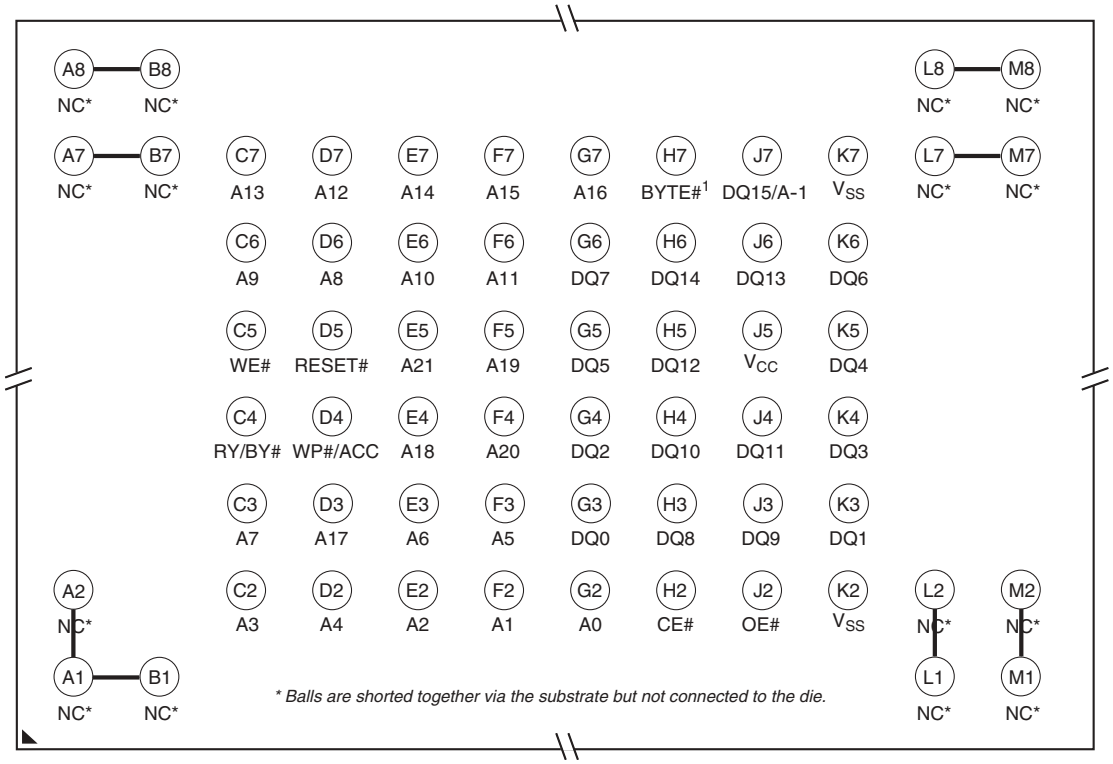
1. *Ball C5 is NC on S29GL032M.*
2. *Ball B8 is NC on S29GL064M and S29GL032M.*
3. *Ball C8 is NC on S29GL128M, S29GL064M and S29GL032M.*
4. *Ball D8 and Ball F1 are NC on S29GL064M (models R3, R4) and S29GL032M (models R3, R4).*
5. *Ball F7 is NC on S29GL064M (model R5).*

Special Package Handling Instructions

Special handling is required for Flash Memory products in moulded packages (TSOP and BGA). The package and/or data integrity may be compromised if the package body is exposed to temperatures above 150°C for prolonged periods of time.

Connection Diagrams

63-Ball Fine-Pitch BGA
Top View, Balls Facing Down



Notes:
1. Ball H7 is V_{IO} on S29GL064M (model R5).

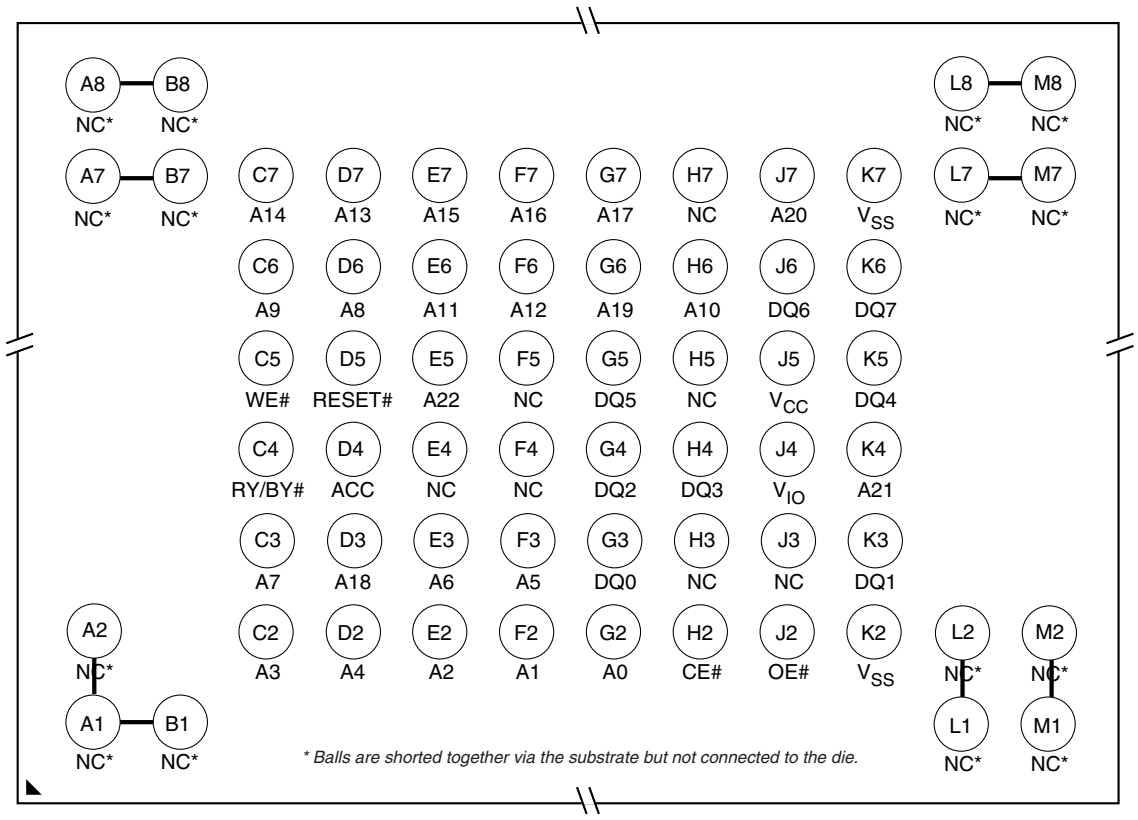
Special Package Handling Instructions

Special handling is required for Flash Memory products in molded packages (TSOP and BGA). The package and/or data integrity may be compromised if the package body is exposed to temperatures above 150°C for prolonged periods of time.

Connection Diagrams

For S29GL064M (model R0) only.

63-Ball Fine-Pitch BGA
Top View, Balls Facing Down

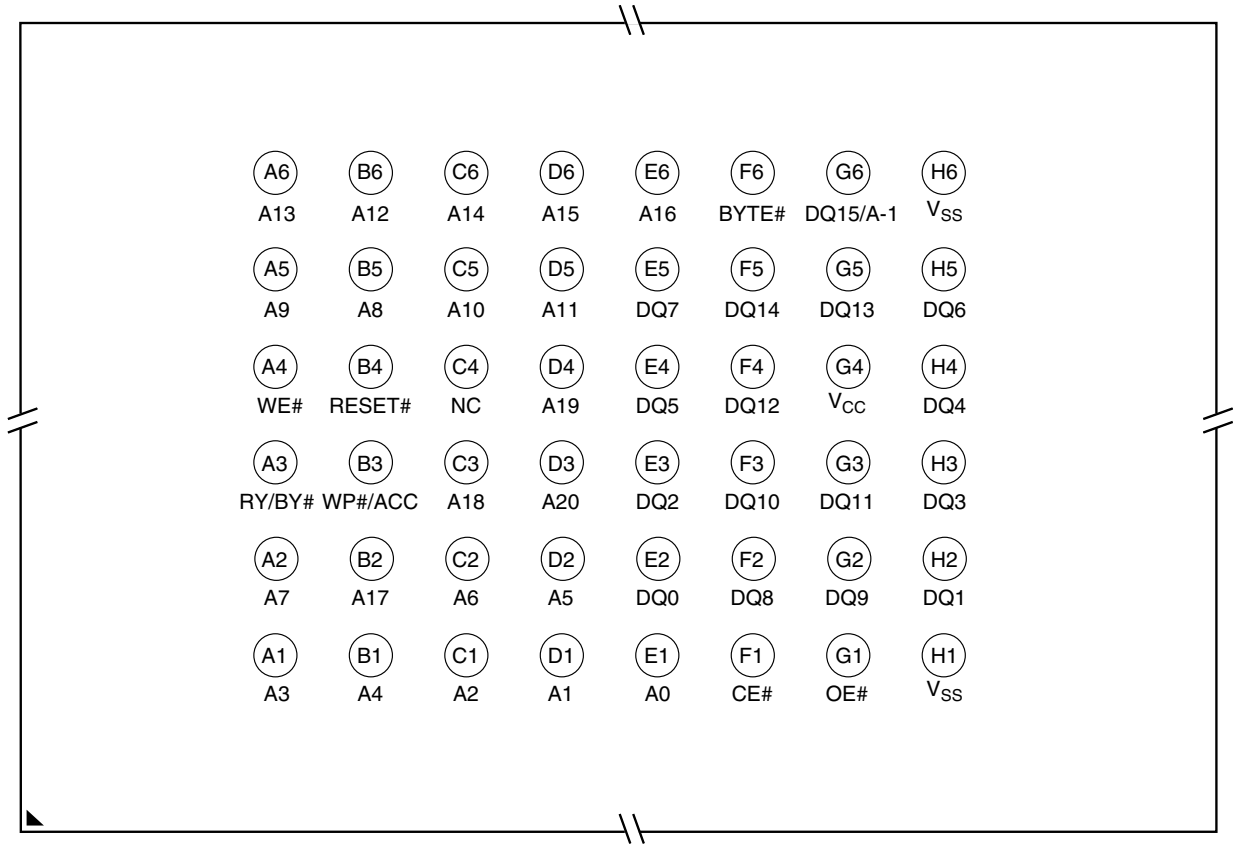


Special Package Handling Instructions

Special handling is required for Flash Memory products in molded packages (TSOP and BGA). The package and/or data integrity may be compromised if the package body is exposed to temperatures above 150°C for prolonged periods of time.

Connection Diagrams

48-ball Fine-pitch BGA
Top View, Balls Facing Down



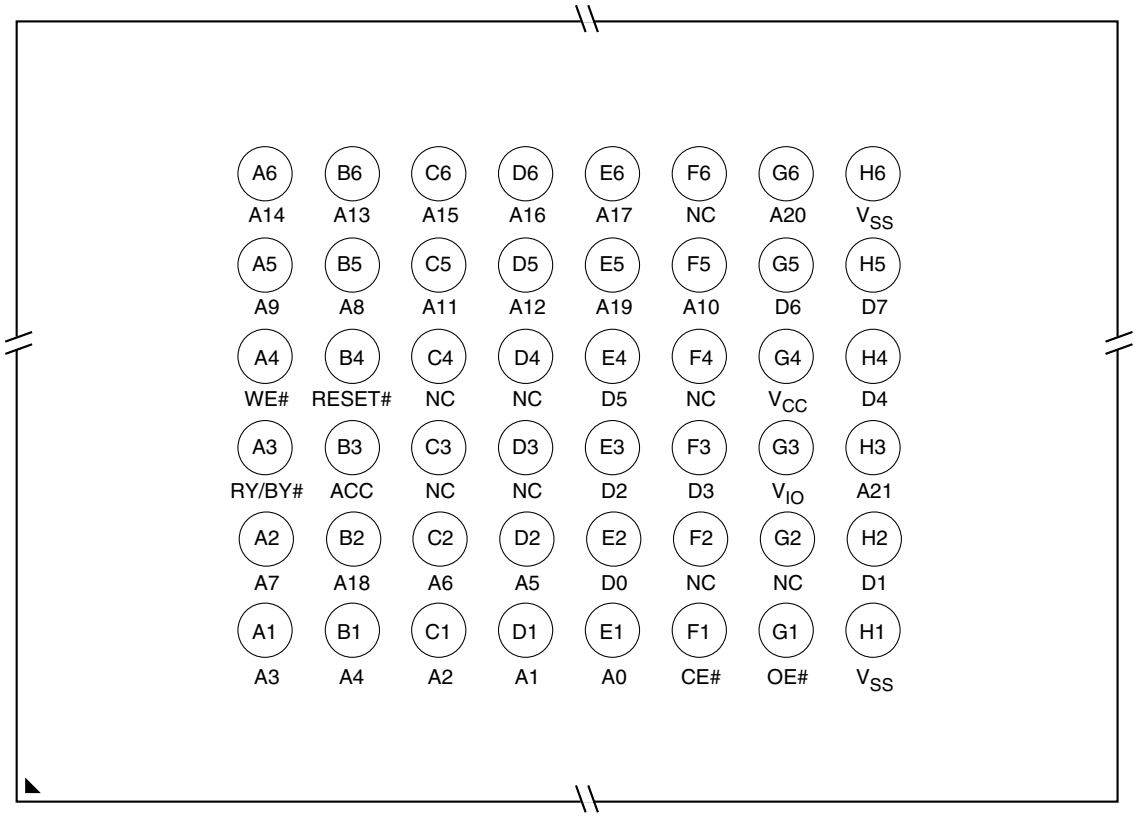
Special Package Handling Instructions

Special handling is required for Flash Memory products in molded packages (TSOP and BGA). The package and/or data integrity may be compromised if the package body is exposed to temperatures above 150°C for prolonged periods of time.

Connection Diagrams

For S29GL032M (model R0) only.

48-Ball Fine-Pitch BGA
Top View, Balls Facing Down



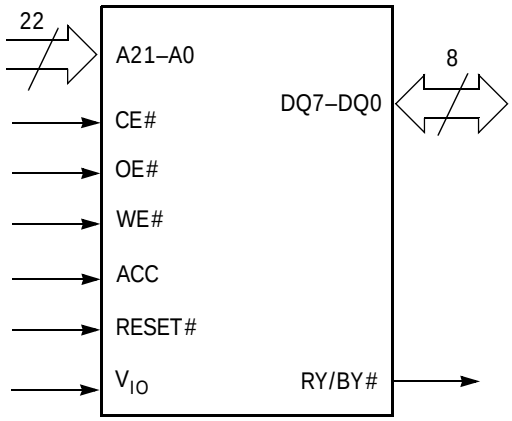
Special Package Handling Instructions

Special handling is required for Flash Memory products in molded packages (TSOP and BGA). The package and/or data integrity may be compromised if the package body is exposed to temperatures above 150°C for prolonged periods of time.

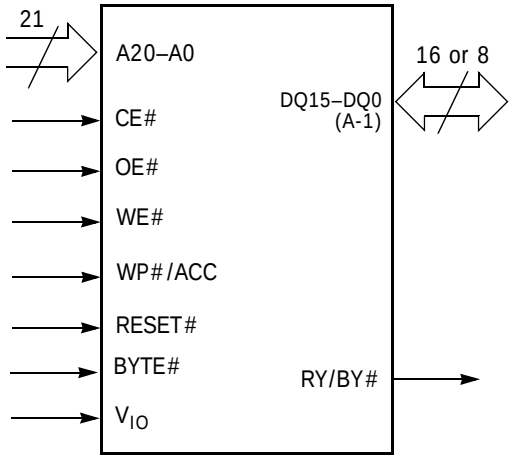
Pin Description

A23–A0	=	24 Address inputs
A22–A0	=	23 Address inputs
A21–A0	=	22 Address inputs
A20–A0	=	21 Address inputs
DQ7–DQ0	=	8 Data inputs/outputs
DQ14–DQ0	=	15 Data inputs/outputs
DQ15/A-1	=	DQ15 (Data input/output, word mode), A-1 (LSB Address input, byte mode)
CE#	=	Chip Enable input
OE#	=	Output Enable input
WE#	=	Write Enable input
WP#/ACC	=	Hardware Write Protect input/Programming Acceleration input
ACC	=	Acceleration input
WP#	=	Hardware Write Protect input
RESET#	=	Hardware Reset Pin input
RY/BY#	=	Ready/Busy output
BYTE#	=	Selects 8-bit or 16-bit mode
V_{CC}	=	3.0 volt-only single power supply (see Product Selector Guide for speed options and voltage supply tolerances)
V_{SS}	=	Device Ground
NC	=	Pin Not Connected Internally
V_{IO}	=	Output Buffer Power

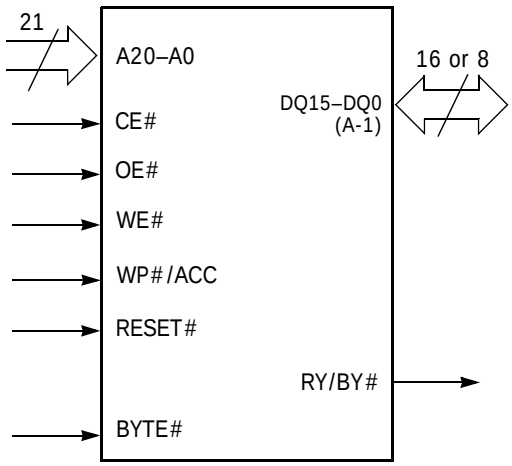
Logic Symbol-S29GL032M (Model R0)



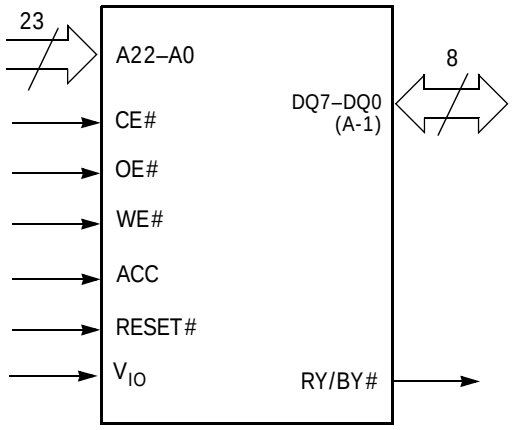
Logic Symbol-S29GL032M (Models R1, R2)



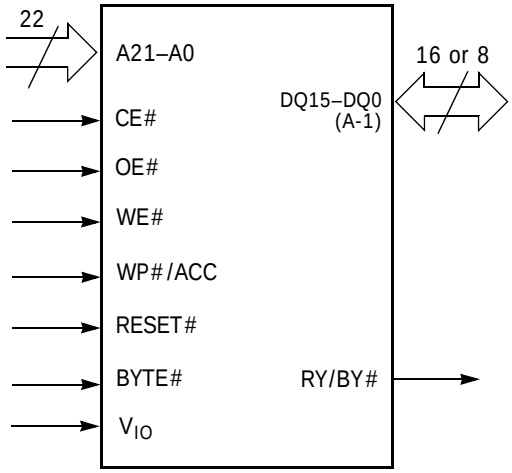
Logic Symbol-S29GL032M (Models R3, R4, R5, R6)



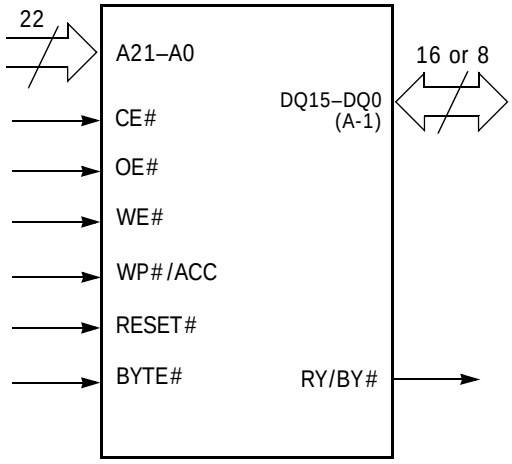
Logic Symbol-S29GL064M (Models R0)



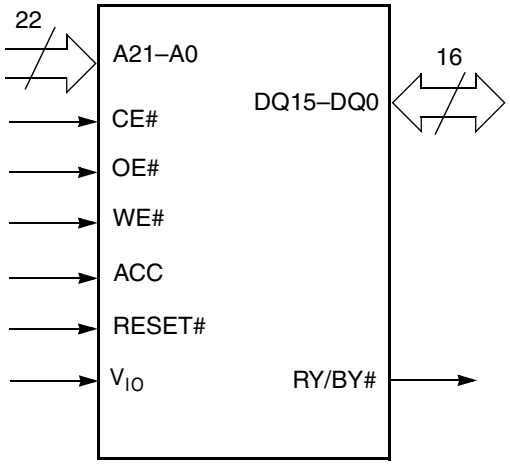
Logic Symbol-S29GL064M (Models R1, R2, R8, R9)



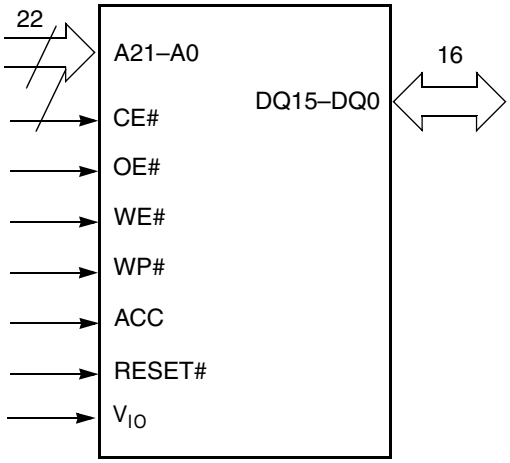
Logic Symbol-S29GL064M (Models R3, R4)



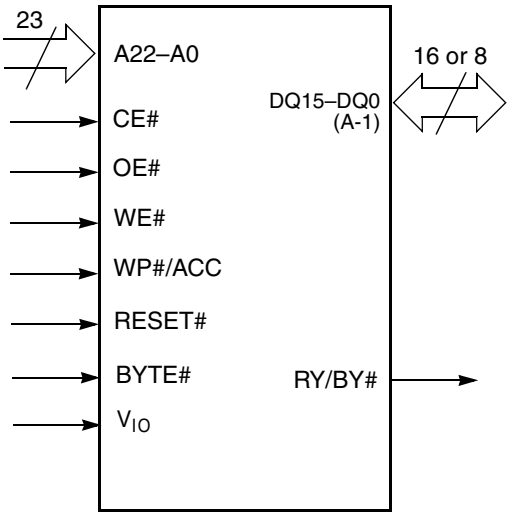
Logic Symbol-S29GL064M (Model R5)



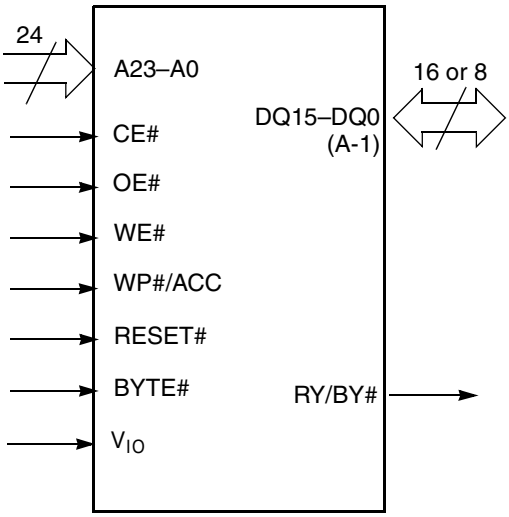
Logic Symbol-S29GL064M (Model R6, R7)



Logic Symbol-S29GL128M



Logic Symbol-S29GL256M



Ordering Information-S29GL032M

S29GL032M Standard Products

Standard products are available in several packages and operating ranges. The order number (Valid Combination) is formed by a combination of the following:

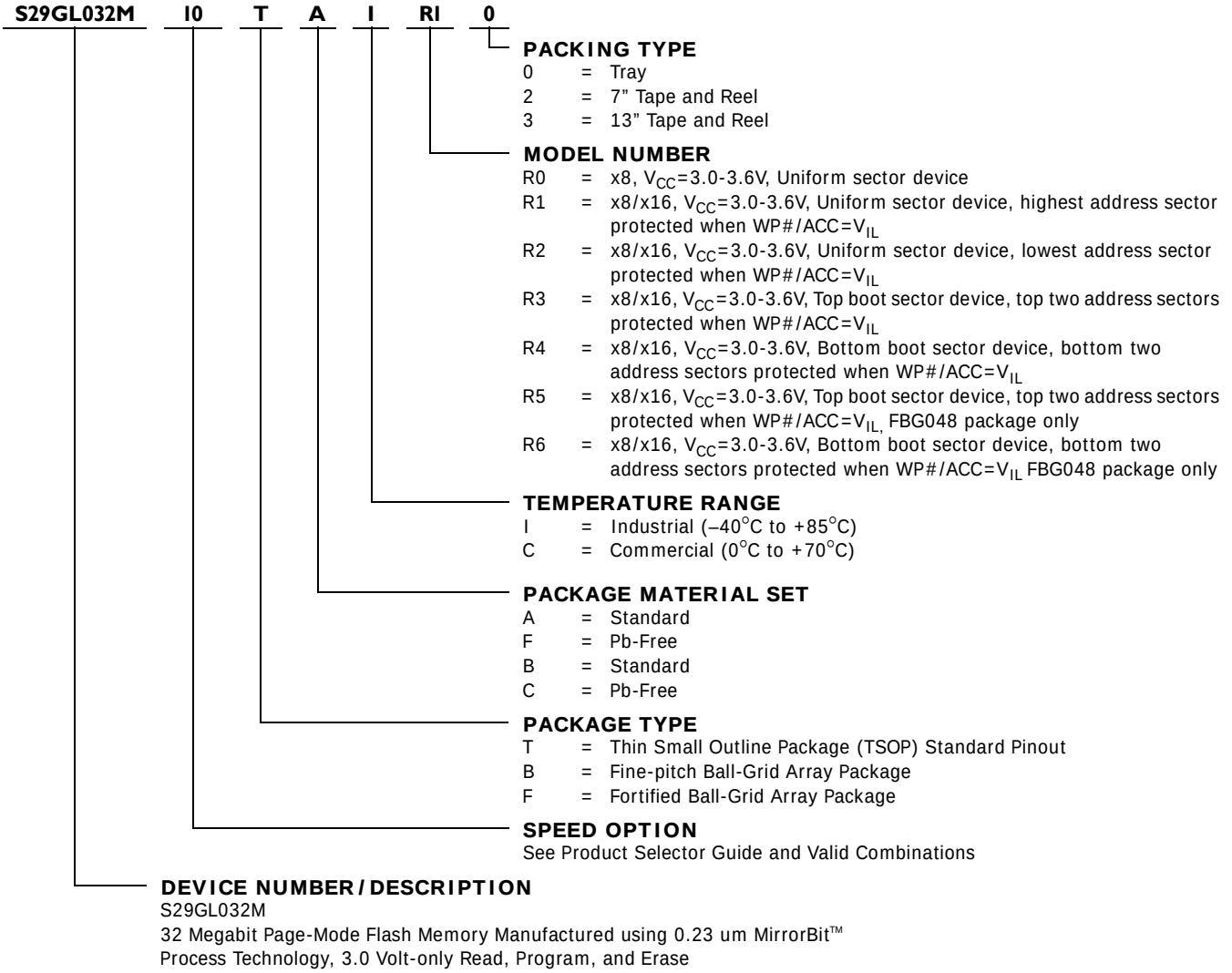


Table I. S29GL032M Ordering Options

S29GL032M Valid Combinations					Package Description	
Device Number	Speed Option	Package, Material, & Temperature Range	Model Number	Packing Type		
S29GL032M	90	TAC,TFC	R0	0,2,3 (note 1)	TS040 (note 2, 3, 5)	TSOP
		BAC,BFC			FBC048 (note 4)	Fine-Pitch BGA
		TAC,TFC	R1,R2		TS056 (note 2, 3, 5)	TSOP
		FAC,FFC			LAA064 (note 4)	Fortified BGA
		TAC,TFC	R3,R4		TS048 (note 2, 3, 5)	TSOP
		BAC,BFC			FBC048 ((note 4)	Fine-Pitch BGA
		FAC,FFC			LAA064 (note 4)	Fortified BGA
	90, I0, I1	TAI,TFI	R0		TS040 (note 2, 3, 5)	TSOP
		BAI,BFI			FBC048 (note 4)	Fine-Pitch BGA
		TAI,TFI	R1,R2		TS056 (note 2, 3, 5)	TSOP
		FAI,FFI			LAA064 (note 4)	Fortified BGA
		TAI,TFI	R3,R4		TS048 (note 2, 3, 5)	TSOP
		BAI,BFI			FBC048 (note 4)	Fine-Pitch BGA
		FAI,FFI			LAA064 (note 4)	Fortified BGA
		TBI,TCI			FPT-48P-MI9 (note 3, 6)	TSOP
		BAI,BFI	R5,R6		FBG048 (note 4)	Fine-Pitch BGA

Notes:

1. *Type 0 is standard. Specify others as required: TSOPs can be packed in Types 0 and 3; BGAs can be packed in Types 0, 2, or 3.*
2. *This package is recommended for new designs using TSOPs.*
3. *TSOP package marking omits packing type designator from the ordering part number.*
4. *BGA package marking omits leading "S29" and packing type designator from the ordering part number.*
5. *100% Matte Sn is used for Pb-free TSOP plating.*
6. *SnBi is used for Pb-free TSOP plating.*

Valid Combinations

Valid Combinations list configurations planned to be supported in volume for this device. Consult your local sales office to confirm availability of specific valid combinations and to check on newly released combinations.

Ordering Information-S29GL064M

S29GL064M Standard Products

Standard products are available in several packages and operating ranges. The order number (Valid Combination) is formed by a combination of the following:

S29GL064M 90 T A I RI 0

PACKING TYPE
0 = Tray
2 = 7” Tape and Reel
3 = 13” Tape and Reel

MODEL NUMBER
R0 = x8, V_{CC}=3.0-3.6V, Uniform sector device
R1 = x8/x16, V_{CC}=3.0-3.6V, Uniform sector device, highest address sector protected when WP#/ACC=V_{IL}
R2 = x8/x16, V_{CC}=3.0-3.6V, Uniform sector device, lowest address sector protected when WP#/ACC=V_{IL}
R3 = x8/x16, V_{CC}=3.0-3.6V, Top boot sector device, top two address sectors protected when WP#/ACC=V_{IL}
R4 = x8/x16, V_{CC}=3.0-3.6V, Bottom boot sector device, bottom two address sectors protected when WP#/ACC=V_{IL}
R5 = x16, V_{CC}=3.0-3.6V, Uniform sector device
R6 = x16, V_{CC}=3.0-3.6V, Uniform sector device, highest address sector protected when WP#=V_{IL}
R7 = x16, V_{CC}=3.0-3.6V, Uniform sector device, lowest address sector protected when WP#=V_{IL}
R8 = x8/x16, V_{CC}=3.0-3.6V, Uniform sector device, highest address sector protected when WP#/ACC=V_{IL}, FPT-56P-M01 package only
R9 = x8/x16, V_{CC}=3.0-3.6V, Uniform sector device, lowest address sector protected when WP#/ACC=V_{IL}, FPT-56P-M01 package only

TEMPERATURE RANGE
I = Industrial (–40°C to +85°C)

PACKAGE MATERIAL SET
A = Standard
F = Pb-Free
B = Standard
C = Pb-Free
D = Pb-Free

PACKAGE TYPE
T = Thin Small Outline Package (TSOP) Standard Pinout
B = Fine-pitch Ball-Grid Array Package
F = Fortified Ball-Grid Array Package

SPEED OPTION
See Product Selector Guide and Valid Combinations

DEVICE NUMBER/DESCRIPTION
S29GL064M
64 Megabit Page-Mode Flash Memory Manufactured using 0.23 um MirrorBit™ Process Technology, 3.0 Volt-only Read, Program, and Erase

Valid Combinations

Valid Combinations list configurations planned to be supported in volume for this device. Consult your local sales office to confirm availability of specific valid combinations and to check on newly released combinations.

Table 2. S29GL064M Ordering Options

S29GL064M Valid Combinations					Package Description	
Device Number	Speed Option	Package, Material, & Temperature Range	Model Number	Packing Type		
S29GL064M	90, I0, II	TAI,TFI	R0,R3,R4, R6,R7	0,2,3 (note I)	TS048 (note 2, 3, 5)	TSOP
					TS056 (note 2, 3, 5)	TSOP
		TBI,TCI	RI,R2		FPT-48P-MI9 (note 3, 6)	TSOP
		TAI,TDI	R2,R7		FPT-56P-M0I (note 3, 6)	TSOP
		BAI,BFI	R9		FBE063 (note 4)	Fine-Pitch BGA
		FAI,FFI	RI,R2,R3,R4,R5		LAA064 (note 4)	Fortified BGA

Notes:

1. *Type 0 is standard. Specify others as required: TSOPs can be packed in Types 0 and 3; BGAs can be packed in Types 0, 2, or 3.*
2. *This package is recommended for new designs using TSOPs.*
3. *TSOP package marking omits packing type designator from the ordering part number.*
4. *BGA package marking omits leading "S29" and packing type designator from the ordering part number.*
5. *100% Matte Sn is used for Pb-free TSOP plating.*
6. *SnBi is used for Pb-free TSOP plating.*

Ordering Information-S29GL128M

S29GLI28M Standard Products

Standard products are available in several packages and operating ranges. The order number (Valid Combination) is formed by a combination of the following:

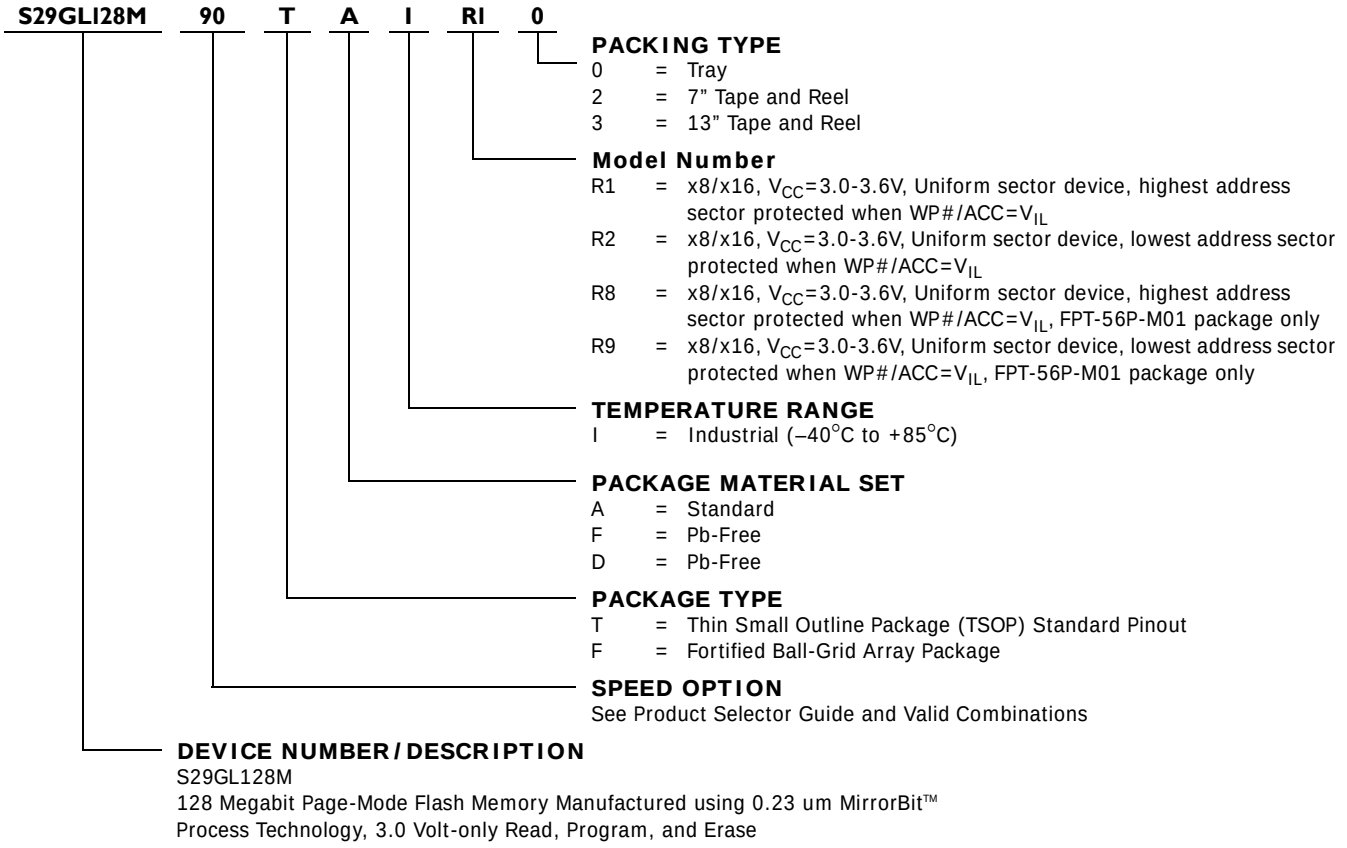


Table 3. S29GL128M Ordering Options

S29GL128M Valid Combinations					Package Description	
Device Number	Speed Option	Package, Material, & Temperature Range	Model Number	Packing Type		
S29GL128M	90, 10, 11	TAI,TFI	RI,R2	0,2,3 (note 1)	TS056 (note 2, 3, 5)	TSOP
		FAI,FFI			LAA064 (note 4)	Fortified BGA
		TAI,TDI	R9		FPT-56P-M01 (note 3, 6)	TSOP

Notes:

1. *Type 0 is standard. Specify others as required: TSOPs can be packed in Types 0 and 3; BGAs can be packed in Types 0, 2, or 3.*
2. *This package is recommended for new designs using TSOPs.*
3. *TSOP package marking omits packing type designator from the ordering part number.*
4. *BGA package marking omits leading "S29" and packing type designator from the ordering part number.*
5. *100% Matte Sn is used for Pb-free TSOP plating.*
6. *SnBi is used for Pb-free TSOP plating.*

Valid Combinations

Valid Combinations list configurations planned to be supported in volume for this device. Consult your local sales office to confirm availability of specific valid combinations and to check on newly released combinations.

Ordering Information-S29GL256M

S29GL256M Standard Products

Standard products are available in several packages and operating ranges. The order number (Valid Combination) is formed by a combination of the following:

S29GL256M **I0** **T** **A** **I** **RI** **0**

PACKING TYPE
0 = Tray
2 = 7” Tape and Reel
3 = 13” Tape and Reel

Model Number
R1 = x8/x16, V_{CC}=3.0-3.6V, Uniform sector device, highest address sector protected when WP#/ACC=V_{IL}
R2 = x8/x16, V_{CC}=3.0-3.6V, Uniform sector device, lowest address sector protected when WP#/ACC=V_{IL}

TEMPERATURE RANGE
I = Industrial (–40°C to +85°C)

PACKAGE MATERIAL SET
A = Standard
F = Pb-Free

PACKAGE TYPE
T = Thin Small Outline Package (TSOP) Standard Pinout
F = Fortified Ball-Grid Array Package

SPEED OPTION
See Product Selector Guide and Valid Combinations

DEVICE NUMBER/DESCRIPTION
S29GL1256M
256 Megabit Page-Mode Flash Memory Manufactured using 0.23 um MirrorBit™ Process Technology, 3.0 Volt-only Read, Program, and Erase

Table 4. S29GL256M Ordering Options

S29GL256M Valid Combinations					Package Description	
Device Number	Speed Option	Package, Material, & Temperature Range	Model Number	Packing Type		
S29GL256M	I0, I1	TAI,TFI	RI,R2	0,2,3 (note 1)	TS056 (note 2, 3, 4)	TSOP
		FAI,FFI			LAC064 (note 3)	Fortified BGA

Notes:

1. *Type 0 is standard. Specify others as required: TSOPs can be packed in Types 0 and 3; BGAs can be packed in Types 0, 2, or 3.*
2. *TSOP package marking omits the packing type designator from the ordering part number.*
3. *BGA package marking omits leading "S29" and packing type designator from the ordering part number.*
4. *100% Matte Sn is used for Pb-free TSOP plating.*

Valid Combinations

Valid Combinations list configurations planned to be supported in volume for this device. Consult your local sales office to confirm availability of specific valid combinations and to check on newly released combinations.

Device Bus Operations

This section describes the requirements and use of the device bus operations, which are initiated through the internal command register. The command register itself does not occupy any addressable memory location. The register is a latch used to store the commands, along with the address and data information needed to execute the command. The contents of the register serve as inputs to the internal state machine. The state machine outputs dictate the function of the device. Table 1 lists the device bus operations, the inputs and control levels they require, and the resulting output. The following subsections describe each of these operations in further detail.

Table 5. Device Bus Operations

Operation	CE#	OE#	WE #	RESET#	WP#	ACC	Addresses (Note 1)	DQ0–DQ7	DQ8–DQ15	
									BYTE# = V_{IH}	BYTE# = V_{IL}
Read	L	L	H	H	X	X	A_{IN}	D_{OUT}	D_{OUT}	DQ8–DQ14 = High-Z, DQ15 = A-1
Write (Program/Erase)	L	H	L	H	(Note 3)	X	A_{IN}	(Note 4)	(Note 4)	
Accelerated Program	L	H	L	H	(Note 3)	V_{HH}	A_{IN}	(Note 4)	(Note 4)	
Standby	V_{CC} ±0.3 V	X	X	V_{CC} ± 0.3 V	X	H	X	High-Z	High-Z	High-Z
Output Disable	L	H	H	H	X	X	X	High-Z	High-Z	High-Z
Reset	X	X	X	L	X	X	X	High-Z	High-Z	High-Z
Sector Group Protect (Note 2)	L	H	L	V_{ID}	H	X	SA, A6 =L, A3=L, A2=L, A1=H, A0=L	(Note 4)	X	X
Sector Group Unprotect (Note 2)	L	H	L	V_{ID}	H	X	SA, A6=H, A3=L, A2=L, A1=H, A0=L	(Note 4)	X	X
Temporary Sector Group Unprotect	X	X	X	V_{ID}	H	X	A_{IN}	(Note 4)	(Note 4)	High-Z

Legend: *L = Logic Low = V_{IL}, H = Logic High = V_{IH}, V_{ID} = 11.5–12.5 V, V_{HH} = 11.5–12.5 V, X = Don't Care, SA = Sector Address, A_{IN} = Address In, D_{IN} = Data In, D_{OUT} = Data Out*

Notes:

1. *Addresses are Amax:A0 in word mode; Amax:A-1 in byte mode. Sector addresses are Amax:A15 in both modes.*
2. *The sector protect and sector unprotect functions may also be implemented via programming equipment. See the "Sector Group Protection and Unprotection" section.*
3. *If WP# = V_{IL}, the first or last sector remains protected (for uniform sector devices), and the two outer boot sectors are protected (for boot sector devices). If WP# = V_{IH}, the first or last sector, or the two outer boot sectors will be protected or unprotected as determined by the method described in "Sector Group Protection and Unprotection". All sectors are unprotected when shipped from the factory (The SecSi Sector may be factory protected depending on version ordered.)*
4. *D_{IN} or D_{OUT} as required by command sequence, data polling, or sector protect algorithm (see Figure 2).*

Word/Byte Configuration

The BYTE# pin controls whether the device data I/O pins operate in the byte or word configuration. If the BYTE# pin is set at logic '1', the device is in word configuration, DQ0–DQ15 are active and controlled by CE# and OE#.

If the BYTE# pin is set at logic '0', the device is in byte configuration, and only data I/O pins DQ0–DQ7 are active and controlled by CE# and OE#. The data I/O pins DQ8–DQ14 are tri-stated, and the DQ15 pin is used as an input for the LSB (A-1) address function.

Requirements for Reading Array Data

To read array data from the outputs, the system must drive the CE# and OE# pins to V_{IL}. CE# is the power control and selects the device. OE# is the output control and gates array data to the output pins. WE# should remain at V_{IH}.

The internal state machine is set for reading array data upon device power-up, or after a hardware reset. This ensures that no spurious alteration of the memory content occurs during the power transition. No command is necessary in this mode to obtain array data. Standard microprocessor read cycles that assert valid addresses on the device address inputs produce valid data on the device data outputs. The device remains enabled for read access until the command register contents are altered.

See "Reading Array Data" for more information. Refer to the AC Read-Only Operations table for timing specifications and the timing diagram. Refer to the DC Characteristics table for the active current specification on reading array data.

Page Mode Read

The device is capable of fast page mode read and is compatible with the page mode Mask ROM read operation. This mode provides faster read access speed for random locations within a page. The page size of the device is 4 words/8 bytes. The appropriate page is selected by the higher address bits A(max)–A2. Address bits A1–A0 in word mode (A1–A-1 in byte mode) determine the specific word within a page. This is an asynchronous operation; the microprocessor supplies the specific word location.

The random or initial page access is equal to t_{ACC} or t_{CE} and subsequent page read accesses (as long as the locations specified by the microprocessor falls within that page) is equivalent to t_{PACC}. When CE# is deasserted and reasserted for a subsequent access, the access time is t_{ACC} or t_{CE}. Fast page mode accesses are obtained by keeping the "read-page addresses" constant and changing the "intra-read page" addresses.

Writing Commands/Command Sequences

To write a command or command sequence (which includes programming data to the device and erasing sectors of memory), the system must drive WE# and CE# to V_{IL}, and OE# to V_{IH}.

The device features an **Unlock Bypass** mode to facilitate faster programming. Once the device enters the Unlock Bypass mode, only two write cycles are required to program a word, instead of four. The "Word Program Command Sequence" section has details on programming data to the device using both standard and Unlock Bypass command sequences.

An erase operation can erase one sector, multiple sectors, or the entire device. Table 6-Table 17 indicates the address space that each sector occupies.

Refer to the DC Characteristics table for the active current specification for the write mode. The AC Characteristics section contains timing specification tables and timing diagrams for write operations.

Write Buffer

Write Buffer Programming allows the system write to a maximum of 16 words/32 bytes in one programming operation. This results in faster effective programming time than the standard programming algorithms. See "Write Buffer" for more information.

Accelerated Program Operation

The device offers accelerated program operations through the ACC function. This is one of two functions provided by the WP#/ACC or ACC pin, depending on model number. This function is primarily intended to allow faster manufacturing throughput at the factory.

If the system asserts V_{HH} on this pin, the device automatically enters the aforementioned Unlock Bypass mode, temporarily unprotects any protected sector groups, and uses the higher voltage on the pin to reduce the time required for program operations. The system would use a two-cycle program command sequence as required by the Unlock Bypass mode. Removing V_{HH} from the WP#/ACC or ACC pin, depending on model number, returns the device to normal operation. *Note that the WP#/ACC or ACC pin must not be at V_{HH} for operations other than accelerated programming, or device damage may result. WP# has an internal pullup; when unconnected, WP# is at V_{IH}.*

Autoselect Functions

If the system writes the autoselect command sequence, the device enters the autoselect mode. The system can then read autoselect codes from the internal register (which is separate from the memory array) on DQ7–DQ0. Standard read cycle timings apply in this mode. Refer to the "Autoselect Mode" section on page 79 and "Autoselect Command Sequence" section on page 104 sections for more information.

Standby Mode

When the system is not reading or writing to the device, it can place the device in the standby mode. In this mode, current consumption is greatly reduced, and the outputs are placed in the high impedance state, independent of the OE# input.

The device enters the CMOS standby mode when the CE# and RESET# pins are both held at V_{IO} ± 0.3 V. (Note that this is a more restricted voltage range than V_{IH}.) If CE# and RESET# are held at V_{IH}, but not within V_{IO} ± 0.3 V, the device will be in the standby mode, but the standby current will be greater. The device requires standard access time (t_{CE}) for read access when the device is in either of these standby modes, before it is ready to read data.

If the device is deselected during erasure or programming, the device draws active current until the operation is completed.

Refer to the "DC Characteristics" section on page 122 for the standby current specification.

Automatic Sleep Mode

The automatic sleep mode minimizes Flash device energy consumption. The device automatically enables this mode when addresses remain stable for t_{ACC} + 30 ns. The automatic sleep mode is independent of the CE#, WE#, and OE# control signals. Standard address access timings provide new data when addresses are changed. While in sleep mode, output data is latched and always available to the system. Refer to the "DC Characteristics" section on page 122 for the automatic sleep mode current specification.

RESET#: Hardware Reset Pin

The RESET# pin provides a hardware method of resetting the device to reading array data. When the RESET# pin is driven low for at least a period of t_{RP}, the device immediately terminates any operation in progress, tristates all output pins, and ignores all read/write commands for the duration of the RESET# pulse. The device also resets the internal state machine to reading array data. The operation that was interrupted should be reinitiated once the device is ready to accept another command sequence, to ensure data integrity.

Current is reduced for the duration of the RESET# pulse. When RESET# is held at V_{SS}±0.3 V, the device draws CMOS standby current (I_{CC5}). If RESET# is held at V_{IL} but not within V_{SS}±0.3 V, the standby current will be greater.

The RESET# pin may be tied to the system reset circuitry. A system reset would thus also reset the Flash memory, enabling the system to read the boot-up firmware from the Flash memory.

Refer to the AC Characteristics tables for RESET# parameters and to 15 for the timing diagram.

Output Disable Mode

When the OE# input is at V_{IH}, output from the device is disabled. The output pins are placed in the high impedance state.

Table 6. S29GL032M (Model R0) Sector Address Table

Sector	A21	A20	A19	A18	A17	A16	8-bit Address Range (in hexadecimal)
SA0	0	0	0	0	0	0	000000–00FFFF
SA1	0	0	0	0	0	1	010000–01FFFF
SA2	0	0	0	0	1	0	020000–02FFFF
SA3	0	0	0	0	1	1	030000–03FFFF
SA4	0	0	0	1	0	0	040000–04FFFF
SA5	0	0	0	1	0	1	050000–05FFFF
SA6	0	0	0	1	1	0	060000–06FFFF
SA7	0	0	0	1	1	1	070000–07FFFF
SA8	0	0	1	0	0	0	080000–08FFFF
SA9	0	0	1	0	0	1	090000–09FFFF
SA10	0	0	1	0	1	0	0A0000–0AFFFF
SA11	0	0	1	0	1	1	0B0000–0BFFFF
SA12	0	0	1	1	0	0	0C0000–0CFFFF
SA13	0	0	1	1	0	1	0D0000–0DFFFF
SA14	0	0	1	1	1	0	0E0000–0EFFFF
SA15	0	0	1	1	1	1	0F0000–0FFFFF
SA16	0	1	0	0	0	0	100000–10FFFF
SA17	0	1	0	0	0	1	110000–11FFFF
SA18	0	1	0	0	1	0	120000–12FFFF
SA19	0	1	0	0	1	1	130000–13FFFF
SA20	0	1	0	1	0	0	140000–14FFFF
SA21	0	1	0	1	0	1	150000–15FFFF
SA22	0	1	0	1	1	0	160000–16FFFF
SA23	0	1	0	1	1	1	170000–17FFFF
SA24	0	1	1	0	0	0	180000–18FFFF
SA25	0	1	1	0	0	1	190000–19FFFF
SA26	0	1	1	0	1	0	1A0000–1AFFFF
SA27	0	1	1	0	1	1	1B0000–1BFFFF
SA28	0	1	1	1	0	0	1C0000–1CFFFF
SA29	0	1	1	1	0	1	1D0000–1DFFFF
SA30	0	1	1	1	1	0	1E0000–1EFFFF
SA31	0	1	1	1	1	1	1F0000–1FFFFF

Table 6. S29GL032M (Model R0) Sector Address Table (Continued)

Sector	A21	A20	A19	A18	A17	A16	8-bit Address Range (in hexadecimal)
SA32	1	0	0	0	0	0	200000–20FFFF
SA33	1	0	0	0	0	1	210000–21FFFF
SA34	1	0	0	0	1	0	220000–22FFFF
SA35	1	0	0	0	1	1	230000–23FFFF
SA36	1	0	0	1	0	0	240000–24FFFF
SA37	1	0	0	1	0	1	250000–25FFFF
SA38	1	0	0	1	1	0	260000–26FFFF
SA39	1	0	0	1	1	1	270000–27FFFF
SA40	1	0	1	0	0	0	280000–28FFFF
SA41	1	0	1	0	0	1	290000–29FFFF
SA42	1	0	1	0	1	0	2A0000–2AFFFF
SA43	1	0	1	0	1	1	2B0000–2BFFFF
SA44	1	0	1	1	0	0	2C0000–2CFFFF
SA45	1	0	1	1	0	1	2D0000–2DFFFF
SA46	1	0	1	1	1	0	2E0000–2EFFFF
SA47	1	0	1	1	1	1	2F0000–2FFFFF
SA48	1	1	0	0	0	0	300000–30FFFF
SA49	1	1	0	0	0	1	310000–31FFFF
SA50	1	1	0	0	1	0	320000–32FFFF
SA51	1	1	0	0	1	1	330000–33FFFF
SA52	1	1	0	1	0	0	340000–34FFFF
SA53	1	1	0	1	0	1	350000–35FFFF
SA54	1	1	0	1	1	0	360000–36FFFF
SA55	1	1	0	1	1	1	370000–37FFFF
SA56	1	1	1	0	0	0	380000–38FFFF
SA57	1	1	1	0	0	1	390000–39FFFF
SA58	1	1	1	0	1	0	3A0000–3AFFFF
SA59	1	1	1	0	1	1	3B0000–3BFFFF
SA60	1	1	1	1	0	0	3C0000–3CFFFF
SA61	1	1	1	1	0	1	3D0000–3DFFFF
SA62	1	1	1	1	1	0	3E0000–3EFFFF
SA63	1	1	1	1	1	1	3F0000–3FFFFF

Table 7. S29GL032M (Models RI, R2) Sector Address Table

Sector	A20-A15						Sector Size (Kbytes/Kwords)	8-bit Address Range (in hexadecimal)	16-bit Address Range (in hexadecimal)
SA0	0	0	0	0	0	0	64/32	000000–00FFFF	000000–007FFF
SA1	0	0	0	0	0	1	64/32	010000–01FFFF	008000–00FFFF
SA2	0	0	0	0	1	0	64/32	020000–02FFFF	010000–017FFF
SA3	0	0	0	0	1	1	64/32	030000–03FFFF	018000–01FFFF
SA4	0	0	0	1	0	0	64/32	040000–04FFFF	020000–027FFF
SA5	0	0	0	1	0	1	64/32	050000–05FFFF	028000–02FFFF
SA6	0	0	0	1	1	0	64/32	060000–06FFFF	030000–037FFF
SA7	0	0	0	1	1	1	64/32	070000–07FFFF	038000–03FFFF
SA8	0	0	1	0	0	0	64/32	080000–08FFFF	040000–047FFF
SA9	0	0	1	0	0	1	64/32	090000–09FFFF	048000–04FFFF
SA10	0	0	1	0	1	0	64/32	0A0000–0AFFFF	050000–057FFF
SA11	0	0	1	0	1	1	64/32	0B0000–0BFFFF	058000–05FFFF
SA12	0	0	1	1	0	0	64/32	0C0000–0CFFFF	060000–067FFF
SA13	0	0	1	1	0	1	64/32	0D0000–0DFFFF	068000–06FFFF
SA14	0	0	1	1	1	0	64/32	0E0000–0EFFFF	070000–077FFF
SA15	0	0	1	1	1	1	64/32	0F0000–0FFFFF	078000–07FFFF
SA16	0	1	0	0	0	0	64/32	100000–10FFFF	080000–087FFF
SA17	0	1	0	0	0	1	64/32	110000–11FFFF	088000–08FFFF
SA18	0	1	0	0	1	0	64/32	120000–12FFFF	090000–097FFF
SA19	0	1	0	0	1	1	64/32	130000–13FFFF	098000–09FFFF
SA20	0	1	0	1	0	0	64/32	140000–14FFFF	0A0000–0A7FFF
SA21	0	1	0	1	0	1	64/32	150000–15FFFF	0A8000–0AFFFF
SA22	0	1	0	1	1	0	64/32	160000–16FFFF	0B0000–0B7FFF
SA23	0	1	0	1	1	1	64/32	170000–17FFFF	0B8000–0BFFFF
SA24	0	1	1	0	0	0	64/32	180000–18FFFF	0C0000–0C7FFF
SA25	0	1	1	0	0	1	64/32	190000–19FFFF	0C8000–0CFFFF
SA26	0	1	1	0	1	0	64/32	1A0000–1AFFFF	0D0000–0D7FFF
SA27	0	1	1	0	1	1	64/32	1B0000–1BFFFF	0D8000–0DFFFF
SA28	0	1	1	1	0	0	64/32	1C0000–1CFFFF	0E0000–0E7FFF
SA29	0	1	1	1	0	1	64/32	1D0000–1DFFFF	0E8000–0EFFFF
SA30	0	1	1	1	1	0	64/32	1E0000–1EFFFF	0F0000–0F7FFF
SA31	0	1	1	1	1	1	64/32	1F0000–1FFFFF	0F8000–0FFFFF
SA32	1	0	0	0	0	0	64/32	200000–20FFFF	100000–107FFF
SA33	1	0	0	0	0	1	64/32	210000–21FFFF	108000–10FFFF
SA34	1	0	0	0	1	0	64/32	220000–22FFFF	110000–117FFF
SA35	1	0	0	0	1	1	64/32	230000–23FFFF	118000–11FFFF
SA36	1	0	0	1	0	0	64/32	240000–24FFFF	120000–127FFF
SA37	1	0	0	1	0	1	64/32	250000–25FFFF	128000–12FFFF
SA38	1	0	0	1	1	0	64/32	260000–26FFFF	130000–137FFF
SA39	1	0	0	1	1	1	64/32	270000–27FFFF	138000–13FFFF
SA40	1	0	1	0	0	0	64/32	280000–28FFFF	140000–147FFF
SA41	1	0	1	0	0	1	64/32	290000–29FFFF	148000–14FFFF
SA42	1	0	1	0	1	0	64/32	2A0000–2AFFFF	150000–157FFF
SA43	1	0	1	0	1	1	64/32	2B0000–2BFFFF	158000–15FFFF
SA44	1	0	1	1	0	0	64/32	2C0000–2CFFFF	160000–167FFF

Table 7. S29GL032M (Models RI, R2) Sector Address Table (Continued)

Sector	A20-A15						Sector Size (Kbytes/Kwords)	8-bit Address Range (in hexadecimal)	16-bit Address Range (in hexadecimal)
SA45	1	0	1	1	0	1	64/32	2D0000–2DFFFF	168000–16FFFF
SA46	1	0	1	1	1	0	64/32	2E0000–2EFFFF	170000–177FFF
SA47	1	0	1	1	1	1	64/32	2F0000–2FFFFF	178000–17FFFF
SA48	1	1	0	0	0	0	64/32	300000–30FFFF	180000–187FFF
SA49	1	1	0	0	0	1	64/32	310000–31FFFF	188000–18FFFF
SA50	1	1	0	0	1	0	64/32	320000–32FFFF	190000–197FFF
SA51	1	1	0	0	1	1	64/32	330000–33FFFF	198000–19FFFF
SA52	1	1	0	1	0	0	64/32	340000–34FFFF	1A0000–1A7FFF
SA53	1	1	0	1	0	1	64/32	350000–35FFFF	1A8000–1AFFFF
SA54	1	1	0	1	1	0	64/32	360000–36FFFF	1B0000–1B7FFF
SA55	1	1	0	1	1	1	64/32	370000–37FFFF	1B8000–1BFFFF
SA56	1	1	1	0	0	0	64/32	380000–38FFFF	1C0000–1C7FFF
SA57	1	1	1	0	0	1	64/32	390000–39FFFF	1C8000–1CFFFF
SA58	1	1	1	0	1	0	64/32	3A0000–3AFFFF	1D0000–1D7FFF
SA59	1	1	1	0	1	1	64/32	3B0000–3BFFFF	1D8000–1DFFFF
SA60	1	1	1	1	0	0	64/32	3C0000–3CFFFF	1E0000–1E7FFF
SA61	1	1	1	1	0	1	64/32	3D0000–3DFFFF	1E8000–1EFFFF
SA62	1	1	1	1	1	0	64/32	3E0000–3EFFFF	1F0000–1F7FFF
SA63	1	1	1	1	1	1	64/32	3F0000–3FFFFF	1F8000–1FFFFF

Table 8. S29GL032M (Model R3) Top Boot Sector Architecture

Sector	Sector Address A20–A12	Sector Size (Kbytes/Kwords)	(x8) Address Range	(x16) Address Range
SA0	000000xxx	64/32	000000h–00FFFFh	00000h–07FFFh
SA1	000001xxx	64/32	010000h–01FFFFh	08000h–0FFFFh
SA2	000010xxx	64/32	020000h–02FFFFh	10000h–17FFFh
SA3	000011xxx	64/32	030000h–03FFFFh	18000h–1FFFFh
SA4	000100xxx	64/32	040000h–04FFFFh	20000h–27FFFh
SA5	000101xxx	64/32	050000h–05FFFFh	28000h–2FFFFh
SA6	000110xxx	64/32	060000h–06FFFFh	30000h–37FFFh
SA7	000111xxx	64/32	070000h–07FFFFh	38000h–3FFFFh
SA8	001000xxx	64/32	080000h–08FFFFh	40000h–47FFFh
SA9	001001xxx	64/32	090000h–09FFFFh	48000h–4FFFFh
SA10	001010xxx	64/32	0A0000h–0AFFFFh	50000h–57FFFh
SA11	001011xxx	64/32	0B0000h–0BFFFFh	58000h–5FFFFh
SA12	001100xxx	64/32	0C0000h–0CFFFFh	60000h–67FFFh
SA13	001101xxx	64/32	0D0000h–0DFFFFh	68000h–6FFFFh
SA14	001101xxx	64/32	0E0000h–0EFFFFh	70000h–77FFFh
SA15	001111xxx	64/32	0F0000h–0FFFFFh	78000h–7FFFFh
SA16	010000xxx	64/32	100000h–00FFFFh	80000h–87FFFh
SA17	010001xxx	64/32	110000h–11FFFFh	88000h–8FFFFh
SA18	010010xxx	64/32	120000h–12FFFFh	90000h–97FFFh
SA19	010011xxx	64/32	130000h–13FFFFh	98000h–9FFFFh
SA20	010100xxx	64/32	140000h–14FFFFh	A0000h–A7FFFh
SA21	010101xxx	64/32	150000h–15FFFFh	A8000h–AFFFFh
SA22	010110xxx	64/32	160000h–16FFFFh	B0000h–B7FFFh
SA23	010111xxx	64/32	170000h–17FFFFh	B8000h–BFFFFh
SA24	011000xxx	64/32	180000h–18FFFFh	C0000h–C7FFFh
SA25	011001xxx	64/32	190000h–19FFFFh	C8000h–CFFFFh
SA26	011010xxx	64/32	1A0000h–1AFFFFh	D0000h–D7FFFh
SA27	011011xxx	64/32	1B0000h–1BFFFFh	D8000h–DFFFFh
SA28	011000xxx	64/32	1C0000h–1CFFFFh	E0000h–E7FFFh
SA29	011101xxx	64/32	1D0000h–1DFFFFh	E8000h–EFFFFh
SA30	011110xxx	64/32	1E0000h–1EFFFFh	F0000h–F7FFFh
SA31	011111xxx	64/32	1F0000h–1FFFFFh	F8000h–FFFFFh
SA32	100000xxx	64/32	200000h–20FFFFh	F9000h–107FFFh
SA33	100001xxx	64/32	210000h–21FFFFh	108000h–10FFFFh
SA34	100010xxx	64/32	220000h–22FFFFh	110000h–117FFFh
SA35	101011xxx	64/32	230000h–23FFFFh	118000h–11FFFFh

Table 8. S29GL032M (Model R3) Top Boot Sector Architecture (Continued)

Sector	Sector Address A20–A12	Sector Size (Kbytes/Kwords)	(x8) Address Range	(x16) Address Range
SA36	100100xxx	64/32	240000h–24FFFFh	120000h–127FFFh
SA37	100101xxx	64/32	250000h–25FFFFh	128000h–12FFFFh
SA38	100110xxx	64/32	260000h–26FFFFh	130000h–137FFFh
SA39	100111xxx	64/32	270000h–27FFFFh	138000h–13FFFFh
SA40	101000xxx	64/32	280000h–28FFFFh	140000h–147FFFh
SA41	101001xxx	64/32	290000h–29FFFFh	148000h–14FFFFh
SA42	101010xxx	64/32	2A0000h–2AFFFFh	150000h–157FFFh
SA43	101011xxx	64/32	2B0000h–2BFFFFh	158000h–15FFFFh
SA44	101100xxx	64/32	2C0000h–2CFFFFh	160000h–167FFFh
SA45	101101xxx	64/32	2D0000h–2DFFFFh	168000h–16FFFFh
SA46	101110xxx	64/32	2E0000h–2EFFFFh	170000h–177FFFh
SA47	101111xxx	64/32	2F0000h–2FFFFFh	178000h–17FFFFh
SA48	110000xxx	64/32	300000h–30FFFFh	180000h–187FFFh
SA49	110001xxx	64/32	310000h–31FFFFh	188000h–18FFFFh
SA50	110010xxx	64/32	320000h–32FFFFh	190000h–197FFFh
SA51	110011xxx	64/32	330000h–33FFFFh	198000h–19FFFFh
SA52	100100xxx	64/32	340000h–34FFFFh	1A0000h–1A7FFFh
SA53	110101xxx	64/32	350000h–35FFFFh	1A8000h–1AFFFFh
SA54	110110xxx	64/32	360000h–36FFFFh	1B0000h–1B7FFFh
SA55	110111xxx	64/32	370000h–37FFFFh	1B8000h–1BFFFFh
SA56	111000xxx	64/32	380000h–38FFFFh	1C0000h–1C7FFFh
SA57	111001xxx	64/32	390000h–39FFFFh	1C8000h–1CFFFFh
SA58	111010xxx	64/32	3A0000h–3AFFFFh	1D0000h–1D7FFFh
SA59	111011xxx	64/32	3B0000h–3BFFFFh	1D8000h–1DFFFFh
SA60	111100xxx	64/32	3C0000h–3CFFFFh	1E0000h–1E7FFFh
SA61	111101xxx	64/32	3D0000h–3DFFFFh	1E8000h–1EFFFFh
SA62	111110xxx	64/32	3E0000h–3EFFFFh	1F0000h–1F7FFFh
SA63	111111000	8/4	3F0000h–3F1FFFh	1F8000h–1F8FFFh
SA64	111111001	8/4	3F2000h–3F3FFFh	1F9000h–1F9FFFh
SA65	111111010	8/4	3F4000h–3F5FFFh	1FA000h–1FAFFFh
SA66	111111011	8/4	3F6000h–3F7FFFh	1FB000h–1FBFFFh
SA67	111111100	8/4	3F8000h–3F9FFFh	1FC000h–1FCFFFh
SA68	111111101	8/4	3FA000h–3FBFFFh	1FD000h–1FDFFFh
SA69	111111110	8/4	3FC000h–3FDFFFh	1FE000h–1FEFFFh
SA70	111111111	8/4	3FE000h–3FFFFFh	1FF000h–1FFFFFh

Table 9. S29GL032M (Model R4) Bottom Boot Sector Architecture

Sector	Sector Address A20–AI2	Sector Size (Kbytes/Kwords)	(x8) Address Range	(x16) Address Range
SA0	000000000	8/4	000000h–00IFFFh	00000h–00FFFh
SAI	00000000I	8/4	002000h–003FFFh	01000h–01FFFh
SA2	000000010	8/4	004000h–005FFFh	02000h–02FFFh
SA3	00000001I	8/4	006000h–007FFFh	03000h–03FFFh
SA4	000000100	8/4	008000h–009FFFh	04000h–04FFFh
SA5	00000010I	8/4	00A000h–00BFFFh	05000h–05FFFh
SA6	000000110	8/4	00C000h–00DFFFh	06000h–06FFFh
SA7	000000111	8/4	00E000h–00FFFFh	07000h–07FFFh
SA8	00000Ixxx	64/32	010000h–01FFFFh	08000h–0FFFFh
SA9	0000I0xxx	64/32	020000h–02FFFFh	10000h–17FFFh
SAI0	0000I1xxx	64/32	030000h–03FFFFh	18000h–1FFFFh
SAI1	000I00xxx	64/32	040000h–04FFFFh	20000h–27FFFh
SAI2	000I01xxx	64/32	050000h–05FFFFh	28000h–2FFFFh
SAI3	000I10xxx	64/32	060000h–06FFFFh	30000h–37FFFh
SAI4	000I11xxx	64/32	070000h–07FFFFh	38000h–3FFFFh
SAI5	001000xxx	64/32	080000h–08FFFFh	40000h–47FFFh
SAI6	00I001xxx	64/32	090000h–09FFFFh	48000h–4FFFFh
SAI7	00I010xxx	64/32	0A0000h–0AFFFFh	50000h–57FFFh
SAI8	00I011xxx	64/32	0B0000h–0BFFFFh	58000h–5FFFFh
SAI9	00I100xxx	64/32	0C0000h–0CFFFFh	60000h–67FFFh
SA20	00I101xxx	64/32	0D0000h–0DFFFFh	68000h–6FFFFh
SA2I	00I110xxx	64/32	0E0000h–0EFFFFh	70000h–77FFFh
SA22	00I111xxx	64/32	0F0000h–0FFFFFh	78000h–7FFFFh
SA23	010000xxx	64/32	100000h–00FFFFh	80000h–87FFFh
SA24	01000Ixxx	64/32	110000h–11FFFFh	88000h–8FFFFh
SA25	0100I0xxx	64/32	120000h–12FFFFh	90000h–97FFFh
SA26	0100I1xxx	64/32	130000h–13FFFFh	98000h–9FFFFh
SA27	010I00xxx	64/32	140000h–14FFFFh	A0000h–A7FFFh
SA28	010I01xxx	64/32	150000h–15FFFFh	A8000h–AFFFFh
SA29	010I10xxx	64/32	160000h–16FFFFh	B0000h–B7FFFh
SA30	010I11xxx	64/32	170000h–17FFFFh	B8000h–BFFFFh
SA3I	011000xxx	64/32	180000h–18FFFFh	C0000h–C7FFFh
SA32	01I001xxx	64/32	190000h–19FFFFh	C8000h–CFFFFh
SA33	01I010xxx	64/32	1A0000h–1AFFFFh	D0000h–D7FFFh
SA34	01I011xxx	64/32	1B0000h–1BFFFFh	D8000h–DFFFFh
SA35	011000xxx	64/32	1C0000h–1CFFFFh	E0000h–E7FFFh

Table 9. S29GL032M (Model R4) Bottom Boot Sector Architecture (Continued)

Sector	Sector Address A20–A12	Sector Size (Kbytes/Kwords)	(x8) Address Range	(x16) Address Range
SA36	011101xxx	64/32	1D0000h–1DFFFFh	E8000h–EFFFFh
SA37	011110xxx	64/32	1E0000h–1EFFFFh	F0000h–F7FFFh
SA38	011111xxx	64/32	1F0000h–1FFFFFh	F8000h–FFFFFh
SA39	100000xxx	64/32	200000h–20FFFFh	F9000h–107FFFh
SA40	100001xxx	64/32	210000h–21FFFFh	108000h–10FFFFh
SA41	100010xxx	64/32	220000h–22FFFFh	110000h–117FFFh
SA42	101011xxx	64/32	230000h–23FFFFh	118000h–11FFFFh
SA43	100100xxx	64/32	240000h–24FFFFh	120000h–127FFFh
SA44	100101xxx	64/32	250000h–25FFFFh	128000h–12FFFFh
SA45	100110xxx	64/32	260000h–26FFFFh	130000h–137FFFh
SA46	100111xxx	64/32	270000h–27FFFFh	138000h–13FFFFh
SA47	101000xxx	64/32	280000h–28FFFFh	140000h–147FFFh
SA48	101001xxx	64/32	290000h–29FFFFh	148000h–14FFFFh
SA49	101010xxx	64/32	2A0000h–2AFFFFh	150000h–157FFFh
SA50	101011xxx	64/32	2B0000h–2BFFFFh	158000h–15FFFFh
SA51	101100xxx	64/32	2C0000h–2CFFFFh	160000h–167FFFh
SA52	101101xxx	64/32	2D0000h–2DFFFFh	168000h–16FFFFh
SA53	101110xxx	64/32	2E0000h–2EFFFFh	170000h–177FFFh
SA54	101111xxx	64/32	2F0000h–2FFFFFh	178000h–17FFFFh
SA55	110000xxx	64/32	300000h–30FFFFh	180000h–187FFFh
SA56	110001xxx	64/32	310000h–31FFFFh	188000h–18FFFFh
SA57	110010xxx	64/32	320000h–32FFFFh	190000h–197FFFh
SA58	110011xxx	64/32	330000h–33FFFFh	198000h–19FFFFh
SA59	100100xxx	64/32	340000h–34FFFFh	1A0000h–1A7FFFh
SA60	110101xxx	64/32	350000h–35FFFFh	1A8000h–1AFFFFh
SA61	110110xxx	64/32	360000h–36FFFFh	1B0000h–1B7FFFh
SA62	110111xxx	64/32	370000h–37FFFFh	1B8000h–1BFFFFh
SA63	111000xxx	64/32	380000h–38FFFFh	1C0000h–1C7FFFh
SA64	111001xxx	64/32	390000h–39FFFFh	1C8000h–1CFFFFh
SA65	111010xxx	64/32	3A0000h–3AFFFFh	1D0000h–1D7FFFh
SA66	111011xxx	64/32	3B0000h–3BFFFFh	1D8000h–1DFFFFh
SA67	111100xxx	64/32	3C0000h–3CFFFFh	1E0000h–1E7FFFh
SA68	111101xxx	64/32	3D0000h–3DFFFFh	1E8000h–1EFFFFh
SA69	111110xxx	64/32	3E0000h–3EFFFFh	1F0000h–1F7FFFh
SA70	111111xxx	64/32	3F0000h–3FFFFFh	1F8000h–1FFFFFh

Table 10. S29GL064M (Model R0) Sector Address Table

Sector	A22	A21	A20	A19	A18	A17	A16	8-bit Address Range (in hexadecimal)
SA0	0	0	0	0	0	0	0	000000–00FFFF
SA1	0	0	0	0	0	0	1	010000–01FFFF
SA2	0	0	0	0	0	1	0	020000–02FFFF
SA3	0	0	0	0	0	1	1	030000–03FFFF
SA4	0	0	0	0	1	0	0	040000–04FFFF
SA5	0	0	0	0	1	0	1	050000–05FFFF
SA6	0	0	0	0	1	1	0	060000–06FFFF
SA7	0	0	0	0	1	1	1	070000–07FFFF
SA8	0	0	0	1	0	0	0	080000–08FFFF
SA9	0	0	0	1	0	0	1	090000–09FFFF
SA10	0	0	0	1	0	1	0	0A0000–0AFFFF
SA11	0	0	0	1	0	1	1	0B0000–0BFFFF
SA12	0	0	0	1	1	0	0	0C0000–0CFFFF
SA13	0	0	0	1	1	0	1	0D0000–0DFFFF
SA14	0	0	0	1	1	1	0	0E0000–0EFFFF
SA15	0	0	0	1	1	1	1	0F0000–0FFFFF
SA16	0	0	1	0	0	0	0	100000–10FFFF
SA17	0	0	1	0	0	0	1	110000–11FFFF
SA18	0	0	1	0	0	1	0	120000–12FFFF
SA19	0	0	1	0	0	1	1	130000–13FFFF
SA20	0	0	1	0	1	0	0	140000–14FFFF
SA21	0	0	1	0	1	0	1	150000–15FFFF
SA22	0	0	1	0	1	1	0	160000–16FFFF
SA23	0	0	1	0	1	1	1	170000–17FFFF
SA24	0	0	1	1	0	0	0	180000–18FFFF
SA25	0	0	1	1	0	0	1	190000–19FFFF
SA26	0	0	1	1	0	1	0	1A0000–1AFFFF
SA27	0	0	1	1	0	1	1	1B0000–1BFFFF
SA28	0	0	1	1	1	0	0	1C0000–1CFFFF
SA29	0	0	1	1	1	0	1	1D0000–1DFFFF
SA30	0	0	1	1	1	1	0	1E0000–1EFFFF
SA31	0	0	1	1	1	1	1	1F0000–1FFFFF
SA32	0	1	0	0	0	0	0	200000–20FFFF
SA33	0	1	0	0	0	0	1	210000–21FFFF
SA34	0	1	0	0	0	1	0	220000–22FFFF

Table 10. S29GL064M (Model R0) Sector Address Table (Continued)

Sector	A22	A21	A20	A19	A18	A17	A16	8-bit Address Range (in hexadecimal)
SA35	0	1	0	0	0	1	1	230000–23FFFF
SA36	0	1	0	0	1	0	0	240000–24FFFF
SA37	0	1	0	0	1	0	1	250000–25FFFF
SA38	0	1	0	0	1	1	0	260000–26FFFF
SA39	0	1	0	0	1	1	1	270000–27FFFF
SA40	0	1	0	1	0	0	0	280000–28FFFF
SA41	0	1	0	1	0	0	1	290000–29FFFF
SA42	0	1	0	1	0	1	0	2A0000–2AFFFF
SA43	0	1	0	1	0	1	1	2B0000–2BFFFF
SA44	0	1	0	1	1	0	0	2C0000–2CFFFF
SA45	0	1	0	1	1	0	1	2D0000–2DFFFF
SA46	0	1	0	1	1	1	0	2E0000–2EFFFF
SA47	0	1	0	1	1	1	1	2F0000–2FFFFF
SA48	0	1	1	0	0	0	0	300000–30FFFF
SA49	0	1	1	0	0	0	1	310000–31FFFF
SA50	0	1	1	0	0	1	0	320000–32FFFF
SA51	0	1	1	0	0	1	1	330000–33FFFF
SA52	0	1	1	0	1	0	0	340000–34FFFF
SA53	0	1	1	0	1	0	1	350000–35FFFF
SA54	0	1	1	0	1	1	0	360000–36FFFF
SA55	0	1	1	0	1	1	1	370000–37FFFF
SA56	0	1	1	1	0	0	0	380000–38FFFF
SA57	0	1	1	1	0	0	1	390000–39FFFF
SA58	0	1	1	1	0	1	0	3A0000–3AFFFF
SA59	0	1	1	1	0	1	1	3B0000–3BFFFF
SA60	0	1	1	1	1	0	0	3C0000–3CFFFF
SA61	0	1	1	1	1	0	1	3D0000–3DFFFF
SA62	0	1	1	1	1	1	0	3E0000–3EFFFF
SA63	0	1	1	1	1	1	1	3F0000–3FFFFF
SA64	1	0	0	0	0	0	0	400000–40FFFF
SA65	1	0	0	0	0	0	1	410000–41FFFF
SA66	1	0	0	0	0	1	0	420000–42FFFF
SA67	1	0	0	0	0	1	1	430000–43FFFF
SA68	1	0	0	0	1	0	0	440000–44FFFF
SA69	1	0	0	0	1	0	1	450000–45FFFF

Table 10. S29GL064M (Model R0) Sector Address Table (Continued)

Sector	A22	A21	A20	A19	A18	A17	A16	8-bit Address Range (in hexadecimal)
SA70	1	0	0	0	1	1	0	460000–46FFFF
SA71	1	0	0	0	1	1	1	470000–47FFFF
SA72	1	0	0	1	0	0	0	480000–48FFFF
SA73	1	0	0	1	0	0	1	490000–49FFFF
SA74	1	0	0	1	0	1	0	4A0000–4AFFFF
SA75	1	0	0	1	0	1	1	4B0000–4BFFFF
SA76	1	0	0	1	1	0	0	4C0000–4CFFFF
SA77	1	0	0	1	1	0	1	4D0000–4DFFFF
SA78	1	0	0	1	1	1	0	4E0000–4EFFFF
SA79	1	0	0	1	1	1	1	4F0000–4FFFFF
SA80	1	0	1	0	0	0	0	500000–50FFFF
SA81	1	0	1	0	0	0	1	510000–51FFFF
SA82	1	0	1	0	0	1	0	520000–52FFFF
SA83	1	0	1	0	0	1	1	530000–53FFFF
SA84	1	0	1	0	1	0	0	540000–54FFFF
SA85	1	0	1	0	1	0	1	550000–55FFFF
SA86	1	0	1	0	1	1	0	560000–56FFFF
SA87	1	0	1	0	1	1	1	570000–57FFFF
SA88	1	0	1	1	0	0	0	580000–58FFFF
SA89	1	0	1	1	0	0	1	590000–59FFFF
SA90	1	0	1	1	0	1	0	5A0000–5AFFFF
SA91	1	0	1	1	0	1	1	5B0000–5BFFFF
SA92	1	0	1	1	1	0	0	5C0000–5CFFFF
SA93	1	0	1	1	1	0	1	5D0000–5DFFFF
SA94	1	0	1	1	1	1	0	5E0000–5EFFFF
SA95	1	0	1	1	1	1	1	5F0000–5FFFFF
SA96	1	1	0	0	0	0	0	600000–60FFFF
SA97	1	1	0	0	0	0	1	610000–61FFFF
SA98	1	1	0	0	0	1	0	620000–62FFFF
SA99	1	1	0	0	0	1	1	630000–63FFFF
SA100	1	1	0	0	1	0	0	640000–64FFFF
SA101	1	1	0	0	1	0	1	650000–65FFFF
SA102	1	1	0	0	1	1	0	660000–66FFFF
SA103	1	1	0	0	1	1	1	670000–67FFFF
SA104	1	1	0	1	0	0	0	680000–68FFFF

Table 10. S29GL064M (Model R0) Sector Address Table (Continued)

Sector	A22	A21	A20	A19	A18	A17	A16	8-bit Address Range (in hexadecimal)
SA105	1	1	0	1	0	0	1	690000–69FFFF
SA106	1	1	0	1	0	1	0	6A0000–6AFFFF
SA107	1	1	0	1	0	1	1	6B0000–6BFFFF
SA108	1	1	0	1	1	0	0	6C0000–6CFFFF
SA109	1	1	0	1	1	0	1	6D0000–6DFFFF
SA110	1	1	0	1	1	1	0	6E0000–6EFFFF
SA111	1	1	0	1	1	1	1	6F0000–6FFFFF
SA112	1	1	1	0	0	0	0	700000–70FFFF
SA113	1	1	1	0	0	0	1	710000–71FFFF
SA114	1	1	1	0	0	1	0	720000–72FFFF
SA115	1	1	1	0	0	1	1	730000–73FFFF
SA116	1	1	1	0	1	0	0	740000–74FFFF
SA117	1	1	1	0	1	0	1	750000–75FFFF
SA118	1	1	1	0	1	1	0	760000–76FFFF
SA119	1	1	1	0	1	1	1	770000–77FFFF
SA120	1	1	1	1	0	0	0	780000–78FFFF
SA121	1	1	1	1	0	0	1	790000–79FFFF
SA122	1	1	1	1	0	1	0	7A0000–7AFFFF
SA123	1	1	1	1	0	1	1	7B0000–7BFFFF
SA124	1	1	1	1	1	0	0	7C0000–7CFFFF
SA125	1	1	1	1	1	0	1	7D0000–7DFFFF
SA126	1	1	1	1	1	1	0	7E0000–7EFFFF
SA127	1	1	1	1	1	1	1	7F0000–7FFFFF

Table II. S29GL064M (Model RI, R2) Sector Address Table

Sector	A21–A15							Sector Size (Kbytes/ Kwords)	8-bit Address Range (in hexadecimal)	16-bit Address Range (in hexadecimal)
SA0	0	0	0	0	0	0	0	64/32	000000–00FFFF	000000–007FFF
SA1	0	0	0	0	0	0	1	64/32	010000–01FFFF	008000–00FFFF
SA2	0	0	0	0	0	1	0	64/32	020000–02FFFF	010000–017FFF
SA3	0	0	0	0	0	1	1	64/32	030000–03FFFF	018000–01FFFF
SA4	0	0	0	0	1	0	0	64/32	040000–04FFFF	020000–027FFF
SA5	0	0	0	0	1	0	1	64/32	050000–05FFFF	028000–02FFFF
SA6	0	0	0	0	1	1	0	64/32	060000–06FFFF	030000–037FFF
SA7	0	0	0	0	1	1	1	64/32	070000–07FFFF	038000–03FFFF
SA8	0	0	0	1	0	0	0	64/32	080000–08FFFF	040000–047FFF
SA9	0	0	0	1	0	0	1	64/32	090000–09FFFF	048000–04FFFF
SA10	0	0	0	1	0	1	0	64/32	0A0000–0AFFFF	050000–057FFF
SA11	0	0	0	1	0	1	1	64/32	0B0000–0BFFFF	058000–05FFFF
SA12	0	0	0	1	1	0	0	64/32	0C0000–0CFFFF	060000–067FFF
SA13	0	0	0	1	1	0	1	64/32	0D0000–0DFFFF	068000–06FFFF
SA14	0	0	0	1	1	1	0	64/32	0E0000–0EFFFF	070000–077FFF
SA15	0	0	0	1	1	1	1	64/32	0F0000–0FFFFF	078000–07FFFF
SA16	0	0	1	0	0	0	0	64/32	100000–10FFFF	080000–087FFF
SA17	0	0	1	0	0	0	1	64/32	110000–11FFFF	088000–08FFFF
SA18	0	0	1	0	0	1	0	64/32	120000–12FFFF	090000–097FFF
SA19	0	0	1	0	0	1	1	64/32	130000–13FFFF	098000–09FFFF
SA20	0	0	1	0	1	0	0	64/32	140000–14FFFF	0A0000–0A7FFF
SA21	0	0	1	0	1	0	1	64/32	150000–15FFFF	0A8000–0AFFFF
SA22	0	0	1	0	1	1	0	64/32	160000–16FFFF	0B0000–0B7FFF
SA23	0	0	1	0	1	1	1	64/32	170000–17FFFF	0B8000–0BFFFF
SA24	0	0	1	1	0	0	0	64/32	180000–18FFFF	0C0000–0C7FFF
SA25	0	0	1	1	0	0	1	64/32	190000–19FFFF	0C8000–0CFFFF
SA26	0	0	1	1	0	1	0	64/32	1A0000–1AFFFF	0D0000–0D7FFF
SA27	0	0	1	1	0	1	1	64/32	1B0000–1BFFFF	0D8000–0DFFFF
SA28	0	0	1	1	1	0	0	64/32	1C0000–1CFFFF	0E0000–0E7FFF
SA29	0	0	1	1	1	0	1	64/32	1D0000–1DFFFF	0E8000–0EFFFF
SA30	0	0	1	1	1	1	0	64/32	1E0000–1EFFFF	0F0000–0F7FFF
SA31	0	0	1	1	1	1	1	64/32	1F0000–1FFFFF	0F8000–0FFFFF
SA32	0	1	0	0	0	0	0	64/32	200000–20FFFF	100000–107FFF
SA33	0	1	0	0	0	0	1	64/32	210000–21FFFF	108000–10FFFF

Table II. S29GL064M (Model RI, R2) Sector Address Table (Continued)

Sector	A21–A15							Sector Size (Kbytes/ Kwords)	8-bit Address Range (in hexadecimal)	16-bit Address Range (in hexadecimal)
SA34	0	1	0	0	0	1	0	64/32	220000–22FFFF	110000–117FFF
SA35	0	1	0	0	0	1	1	64/32	230000–23FFFF	118000–11FFFF
SA36	0	1	0	0	1	0	0	64/32	240000–24FFFF	120000–127FFF
SA37	0	1	0	0	1	0	1	64/32	250000–25FFFF	128000–12FFFF
SA38	0	1	0	0	1	1	0	64/32	260000–26FFFF	130000–137FFF
SA39	0	1	0	0	1	1	1	64/32	270000–27FFFF	138000–13FFFF
SA40	0	1	0	1	0	0	0	64/32	280000–28FFFF	140000–147FFF
SA41	0	1	0	1	0	0	1	64/32	290000–29FFFF	148000–14FFFF
SA42	0	1	0	1	0	1	0	64/32	2A0000–2AFFFF	150000–157FFF
SA43	0	1	0	1	0	1	1	64/32	2B0000–2BFFFF	158000–15FFFF
SA44	0	1	0	1	1	0	0	64/32	2C0000–2CFFFF	160000–167FFF
SA45	0	1	0	1	1	0	1	64/32	2D0000–2DFFFF	168000–16FFFF
SA46	0	1	0	1	1	1	0	64/32	2E0000–2EFFFF	170000–177FFF
SA47	0	1	0	1	1	1	1	64/32	2F0000–2FFFFF	178000–17FFFF
SA48	0	1	1	0	0	0	0	64/32	300000–30FFFF	180000–187FFF
SA49	0	1	1	0	0	0	1	64/32	310000–31FFFF	188000–18FFFF
SA50	0	1	1	0	0	1	0	64/32	320000–32FFFF	190000–197FFF
SA51	0	1	1	0	0	1	1	64/32	330000–33FFFF	198000–19FFFF
SA52	0	1	1	0	1	0	0	64/32	340000–34FFFF	1A0000–1A7FFF
SA53	0	1	1	0	1	0	1	64/32	350000–35FFFF	1A8000–1AFFFF
SA54	0	1	1	0	1	1	0	64/32	360000–36FFFF	1B0000–1B7FFF
SA55	0	1	1	0	1	1	1	64/32	370000–37FFFF	1B8000–1BFFFF
SA56	0	1	1	1	0	0	0	64/32	380000–38FFFF	1C0000–1C7FFF
SA57	0	1	1	1	0	0	1	64/32	390000–39FFFF	1C8000–1CFFFF
SA58	0	1	1	1	0	1	0	64/32	3A0000–3AFFFF	1D0000–1D7FFF
SA59	0	1	1	1	0	1	1	64/32	3B0000–3BFFFF	1D8000–1DFFFF
SA60	0	1	1	1	1	0	0	64/32	3C0000–3CFFFF	1E0000–1E7FFF
SA61	0	1	1	1	1	0	1	64/32	3D0000–3DFFFF	1E8000–1EFFFF
SA62	0	1	1	1	1	1	0	64/32	3E0000–3EFFFF	1F0000–1F7FFF
SA63	0	1	1	1	1	1	1	64/32	3F0000–3FFFFF	1F8000–1FFFFF
SA64	1	0	0	0	0	0	0	64/32	400000–40FFFF	200000–207FFF
SA65	1	0	0	0	0	0	1	64/32	410000–41FFFF	208000–20FFFF
SA66	1	0	0	0	0	1	0	64/32	420000–42FFFF	210000–217FFF
SA67	1	0	0	0	0	1	1	64/32	430000–43FFFF	218000–21FFFF
SA68	1	0	0	0	1	0	0	64/32	440000–44FFFF	220000–227FFF

Table II. S29GL064M (Model RI, R2) Sector Address Table (Continued)

Sector	A21–A15							Sector Size (Kbytes/ Kwords)	8-bit Address Range (in hexadecimal)	16-bit Address Range (in hexadecimal)
SA69	1	0	0	0	1	0	1	64/32	450000–45FFFF	228000–22FFFF
SA70	1	0	0	0	1	1	0	64/32	460000–46FFFF	230000–237FFF
SA71	1	0	0	0	1	1	1	64/32	470000–47FFFF	238000–23FFFF
SA72	1	0	0	1	0	0	0	64/32	480000–48FFFF	240000–247FFF
SA73	1	0	0	1	0	0	1	64/32	490000–49FFFF	248000–24FFFF
SA74	1	0	0	1	0	1	0	64/32	4A0000–4AFFFF	250000–257FFF
SA75	1	0	0	1	0	1	1	64/32	4B0000–4BFFFF	258000–25FFFF
SA76	1	0	0	1	1	0	0	64/32	4C0000–4CFFFF	260000–267FFF
SA77	1	0	0	1	1	0	1	64/32	4D0000–4DFFFF	268000–26FFFF
SA78	1	0	0	1	1	1	0	64/32	4E0000–4EFFFF	270000–277FFF
SA79	1	0	0	1	1	1	1	64/32	4F0000–4FFFFF	278000–27FFFF
SA80	1	0	1	0	0	0	0	64/32	500000–50FFFF	280000–287FFF
SA81	1	0	1	0	0	0	1	64/32	510000–51FFFF	288000–28FFFF
SA82	1	0	1	0	0	1	0	64/32	520000–52FFFF	290000–297FFF
SA83	1	0	1	0	0	1	1	64/32	530000–53FFFF	298000–29FFFF
SA84	1	0	1	0	1	0	0	64/32	540000–54FFFF	2A0000–2A7FFF
SA85	1	0	1	0	1	0	1	64/32	550000–55FFFF	2A8000–2AFFFF
SA86	1	0	1	0	1	1	0	64/32	560000–56FFFF	2B0000–2B7FFF
SA87	1	0	1	0	1	1	1	64/32	570000–57FFFF	2B8000–2BFFFF
SA88	1	0	1	1	0	0	0	64/32	580000–58FFFF	2C0000–2C7FFF
SA89	1	0	1	1	0	0	1	64/32	590000–59FFFF	2C8000–2CFFFF
SA90	1	0	1	1	0	1	0	64/32	5A0000–5AFFFF	2D0000–2D7FFF
SA91	1	0	1	1	0	1	1	64/32	5B0000–5BFFFF	2D8000–2DFFFF
SA92	1	0	1	1	1	0	0	64/32	5C0000–5CFFFF	2E0000–2E7FFF
SA93	1	0	1	1	1	0	1	64/32	5D0000–5DFFFF	2E8000–2EFFFF
SA94	1	0	1	1	1	1	0	64/32	5E0000–5EFFFF	2F0000–2F7FFF
SA95	1	0	1	1	1	1	1	64/32	5F0000–5FFFFF	2F8000–2FFFFF
SA96	1	1	0	0	0	0	0	64/32	600000–60FFFF	300000–307FFF
SA97	1	1	0	0	0	0	1	64/32	610000–61FFFF	308000–30FFFF
SA98	1	1	0	0	0	1	0	64/32	620000–62FFFF	310000–317FFF
SA99	1	1	0	0	0	1	1	64/32	630000–63FFFF	318000–31FFFF
SA100	1	1	0	0	1	0	0	64/32	640000–64FFFF	320000–327FFF
SA101	1	1	0	0	1	0	1	64/32	650000–65FFFF	328000–32FFFF
SA102	1	1	0	0	1	1	0	64/32	660000–66FFFF	330000–337FFF
SA103	1	1	0	0	1	1	1	64/32	670000–67FFFF	338000–33FFFF

Table II. S29GL064M (Model RI, R2) Sector Address Table (Continued)

Sector	A21–A15							Sector Size (Kbytes/ Kwords)	8-bit Address Range (in hexadecimal)	16-bit Address Range (in hexadecimal)
SA104	1	1	0	1	0	0	0	64/32	680000–68FFFF	340000–347FFF
SA105	1	1	0	1	0	0	1	64/32	690000–69FFFF	348000–34FFFF
SA106	1	1	0	1	0	1	0	64/32	6A0000–6AFFFF	350000–357FFF
SA107	1	1	0	1	0	1	1	64/32	6B0000–6BFFFF	358000–35FFFF
SA108	1	1	0	1	1	0	0	64/32	6C0000–6CFFFF	360000–367FFF
SA109	1	1	0	1	1	0	1	64/32	6D0000–6DFFFF	368000–36FFFF
SA110	1	1	0	1	1	1	0	64/32	6E0000–6EFFFF	370000–377FFF
SA111	1	1	0	1	1	1	1	64/32	6F0000–6FFFFF	378000–37FFFF
SA112	1	1	1	0	0	0	0	64/32	700000–70FFFF	380000–387FFF
SA113	1	1	1	0	0	0	1	64/32	710000–71FFFF	388000–38FFFF
SA114	1	1	1	0	0	1	0	64/32	720000–72FFFF	390000–397FFF
SA115	1	1	1	0	0	1	1	64/32	730000–73FFFF	398000–39FFFF
SA116	1	1	1	0	1	0	0	64/32	740000–74FFFF	3A0000–3A7FFF
SA117	1	1	1	0	1	0	1	64/32	750000–75FFFF	3A8000–3AFFFF
SA118	1	1	1	0	1	1	0	64/32	760000–76FFFF	3B0000–3B7FFF
SA119	1	1	1	0	1	1	1	64/32	770000–77FFFF	3B8000–3BFFFF
SA120	1	1	1	1	0	0	0	64/32	780000–78FFFF	3C0000–3C7FFF
SA121	1	1	1	1	0	0	1	64/32	790000–79FFFF	3C8000–3CFFFF
SA122	1	1	1	1	0	1	0	64/32	7A0000–7AFFFF	3D0000–3D7FFF
SA123	1	1	1	1	0	1	1	64/32	7B0000–7BFFFF	3D8000–3DFFFF
SA124	1	1	1	1	1	0	0	64/32	7C0000–7CFFFF	3E0000–3E7FFF
SA125	1	1	1	1	1	0	1	64/32	7D0000–7DFFFF	3E8000–3EFFFF
SA126	1	1	1	1	1	1	0	64/32	7E0000–7EFFFF	3F0000–3F7FFF
SA127	1	1	1	1	1	1	1	64/32	7F0000–7FFFFF	3F8000–3FFFFF

Table 12. S29GL064M (Model R3) Top Boot Sector Architecture

Sector	Sector Address A21–A12	Sector Size (Kbytes/Kwords)	(x8) Address Range	(x16) Address Range
SA0	0000000xxx	64/32	000000h–00FFFFh	00000h–07FFFh
SA1	0000001xxx	64/32	010000h–01FFFFh	08000h–0FFFFh
SA2	0000010xxx	64/32	020000h–02FFFFh	10000h–17FFFh
SA3	0000011xxx	64/32	030000h–03FFFFh	18000h–1FFFFh
SA4	0000100xxx	64/32	040000h–04FFFFh	20000h–27FFFh
SA5	0000101xxx	64/32	050000h–05FFFFh	28000h–2FFFFh
SA6	0000110xxx	64/32	060000h–06FFFFh	30000h–37FFFh
SA7	0000111xxx	64/32	070000h–07FFFFh	38000h–3FFFFh
SA8	0001000xxx	64/32	080000h–08FFFFh	40000h–47FFFh
SA9	0001001xxx	64/32	090000h–09FFFFh	48000h–4FFFFh
SA10	0001010xxx	64/32	0A0000h–0AFFFFh	50000h–57FFFh
SA11	0001011xxx	64/32	0B0000h–0BFFFFh	58000h–5FFFFh
SA12	0001100xxx	64/32	0C0000h–0CFFFFh	60000h–67FFFh
SA13	0001101xxx	64/32	0D0000h–0DFFFFh	68000h–6FFFFh
SA14	0001101xxx	64/32	0E0000h–0EFFFFh	70000h–77FFFh
SA15	0001111xxx	64/32	0F0000h–0FFFFFh	78000h–7FFFFh
SA16	0010000xxx	64/32	100000h–10FFFFh	80000h–87FFFh
SA17	0010001xxx	64/32	110000h–11FFFFh	88000h–8FFFFh
SA18	0010010xxx	64/32	120000h–12FFFFh	90000h–97FFFh
SA19	0010011xxx	64/32	130000h–13FFFFh	98000h–9FFFFh
SA20	0010100xxx	64/32	140000h–14FFFFh	A0000h–A7FFFh
SA21	0010101xxx	64/32	150000h–15FFFFh	A8000h–AFFFFh
SA22	0010110xxx	64/32	160000h–16FFFFh	B0000h–B7FFFh
SA23	0010111xxx	64/32	170000h–17FFFFh	B8000h–BFFFFh
SA24	0011000xxx	64/32	180000h–18FFFFh	C0000h–C7FFFh
SA25	0011001xxx	64/32	190000h–19FFFFh	C8000h–CFFFFh
SA26	0011010xxx	64/32	1A0000h–1AFFFFh	D0000h–D7FFFh
SA27	0011011xxx	64/32	1B0000h–1BFFFFh	D8000h–DFFFFh
SA28	0011000xxx	64/32	1C0000h–1CFFFFh	E0000h–E7FFFh
SA29	0011101xxx	64/32	1D0000h–1DFFFFh	E8000h–EFFFFh
SA30	0011110xxx	64/32	1E0000h–1EFFFFh	F0000h–F7FFFh
SA31	0011111xxx	64/32	1F0000h–1FFFFFh	F8000h–FFFFFh
SA32	0100000xxx	64/32	200000h–20FFFFh	F9000h–107FFFh
SA33	0100001xxx	64/32	210000h–21FFFFh	108000h–10FFFFh
SA34	0100010xxx	64/32	220000h–22FFFFh	110000h–117FFFh
SA35	0101011xxx	64/32	230000h–23FFFFh	118000h–11FFFFh

Table 12. S29GL064M (Model R3) Top Boot Sector Architecture (Continued)

Sector	Sector Address A21–A12	Sector Size (Kbytes/Kwords)	(x8) Address Range	(x16) Address Range
SA36	0100100xxx	64/32	240000h–24FFFFh	120000h–127FFFh
SA37	0100101xxx	64/32	250000h–25FFFFh	128000h–12FFFFh
SA38	0100110xxx	64/32	260000h–26FFFFh	130000h–137FFFh
SA39	0100111xxx	64/32	270000h–27FFFFh	138000h–13FFFFh
SA40	0101000xxx	64/32	280000h–28FFFFh	140000h–147FFFh
SA41	0101001xxx	64/32	290000h–29FFFFh	148000h–14FFFFh
SA42	0101010xxx	64/32	2A0000h–2AFFFFh	150000h–157FFFh
SA43	0101011xxx	64/32	2B0000h–2BFFFFh	158000h–15FFFFh
SA44	0101100xxx	64/32	2C0000h–2CFFFFh	160000h–167FFFh
SA45	0101101xxx	64/32	2D0000h–2DFFFFh	168000h–16FFFFh
SA46	0101110xxx	64/32	2E0000h–2EFFFFh	170000h–177FFFh
SA47	0101111xxx	64/32	2F0000h–2FFFFFh	178000h–17FFFFh
SA48	0110000xxx	64/32	300000h–30FFFFh	180000h–187FFFh
SA49	0110001xxx	64/32	310000h–31FFFFh	188000h–18FFFFh
SA50	0110010xxx	64/32	320000h–32FFFFh	190000h–197FFFh
SA51	0110011xxx	64/32	330000h–33FFFFh	198000h–19FFFFh
SA52	0110100xxx	64/32	340000h–34FFFFh	1A0000h–1A7FFFh
SA53	0110101xxx	64/32	350000h–35FFFFh	1A8000h–1AFFFFh
SA54	0110110xxx	64/32	360000h–36FFFFh	1B0000h–1B7FFFh
SA55	0110111xxx	64/32	370000h–37FFFFh	1B8000h–1BFFFFh
SA56	0111000xxx	64/32	380000h–38FFFFh	1C0000h–1C7FFFh
SA57	0111001xxx	64/32	390000h–39FFFFh	1C8000h–1CFFFFh
SA58	0111010xxx	64/32	3A0000h–3AFFFFh	1D0000h–1D7FFFh
SA59	0111011xxx	64/32	3B0000h–3BFFFFh	1D8000h–1DFFFFh
SA60	0111100xxx	64/32	3C0000h–3CFFFFh	1E0000h–1E7FFFh
SA61	0111101xxx	64/32	3D0000h–3DFFFFh	1E8000h–1EFFFFh
SA62	0111110xxx	64/32	3E0000h–3EFFFFh	1F0000h–1F7FFFh
SA63	0111111xxx	64/32	3F0000h–3FFFFFh	1F8000h–1FFFFFh
SA64	1000000xxx	64/32	400000h–40FFFFh	200000h–207FFFh
SA65	1000001xxx	64/32	410000h–41FFFFh	208000h–20FFFFh
SA66	1000010xxx	64/32	420000h–42FFFFh	210000h–217FFFh
SA67	1000011xxx	64/32	430000h–43FFFFh	218000h–21FFFFh
SA68	1000100xxx	64/32	440000h–44FFFFh	220000h–227FFFh
SA69	1000101xxx	64/32	450000h–45FFFFh	228000h–22FFFFh
SA70	1000110xxx	64/32	460000h–46FFFFh	230000h–237FFFh
SA71	1000111xxx	64/32	470000h–47FFFFh	238000h–23FFFFh

Table 12. S29GL064M (Model R3) Top Boot Sector Architecture (Continued)

Sector	Sector Address A21–A12	Sector Size (Kbytes/Kwords)	(x8) Address Range	(x16) Address Range
SA72	100100xxx	64/32	480000h–48FFFFh	240000h–247FFFh
SA73	100101xxx	64/32	490000h–49FFFFh	248000h–24FFFFh
SA74	100110xxx	64/32	4A0000h–4AFFFFh	250000h–257FFFh
SA75	100111xxx	64/32	4B0000h–4BFFFFh	258000h–25FFFFh
SA76	101100xxx	64/32	4C0000h–4CFFFFh	260000h–267FFFh
SA77	101101xxx	64/32	4D0000h–4DFFFFh	268000h–26FFFFh
SA78	101110xxx	64/32	4E0000h–4EFFFFh	270000h–277FFFh
SA79	101111xxx	64/32	4F0000h–4FFFFFh	278000h–27FFFFh
SA80	110000xxx	64/32	500000h–50FFFFh	280000h–28FFFFh
SA81	110001xxx	64/32	510000h–51FFFFh	288000h–28FFFFh
SA82	110010xxx	64/32	520000h–52FFFFh	290000h–297FFFh
SA83	110011xxx	64/32	530000h–53FFFFh	298000h–29FFFFh
SA84	110100xxx	64/32	540000h–54FFFFh	2A0000h–2A7FFFh
SA85	110101xxx	64/32	550000h–55FFFFh	2A8000h–2AFFFFh
SA86	110110xxx	64/32	560000h–56FFFFh	2B0000h–2B7FFFh
SA87	110111xxx	64/32	570000h–57FFFFh	2B8000h–2BFFFFh
SA88	111000xxx	64/32	580000h–58FFFFh	2C0000h–2C7FFFh
SA89	111001xxx	64/32	590000h–59FFFFh	2C8000h–2CFFFFh
SA90	111010xxx	64/32	5A0000h–5AFFFFh	2D0000h–2D7FFFh
SA91	111011xxx	64/32	5B0000h–5BFFFFh	2D8000h–2DFFFFh
SA92	111100xxx	64/32	5C0000h–5CFFFFh	2E0000h–2E7FFFh
SA93	111101xxx	64/32	5D0000h–5DFFFFh	2E8000h–2EFFFFh
SA94	111110xxx	64/32	5E0000h–5EFFFFh	2F0000h–2FFFFFh
SA95	111111xxx	64/32	5F0000h–5FFFFFh	2F8000h–2FFFFFh
SA96	1100000xxx	64/32	600000h–60FFFFh	300000h–307FFFh
SA97	110001xxx	64/32	610000h–61FFFFh	308000h–30FFFFh
SA98	110010xxx	64/32	620000h–62FFFFh	310000h–317FFFh
SA99	110011xxx	64/32	630000h–63FFFFh	318000h–31FFFFh
SA100	110100xxx	64/32	640000h–64FFFFh	320000h–327FFFh
SA101	110101xxx	64/32	650000h–65FFFFh	328000h–32FFFFh
SA102	110110xxx	64/32	660000h–66FFFFh	330000h–337FFFh
SA103	110111xxx	64/32	670000h–67FFFFh	338000h–33FFFFh
SA104	111000xxx	64/32	680000h–68FFFFh	340000h–347FFFh
SA105	111001xxx	64/32	690000h–69FFFFh	348000h–34FFFFh
SA106	111010xxx	64/32	6A0000h–6AFFFFh	350000h–357FFFh
SA107	111011xxx	64/32	6B0000h–6BFFFFh	358000h–35FFFFh

Table 12. S29GL064M (Model R3) Top Boot Sector Architecture (Continued)

Sector	Sector Address A21–A12	Sector Size (Kbytes/Kwords)	(x8) Address Range	(x16) Address Range
SA108	110110xxx	64/32	6C0000h–6CFFFFh	360000h–367FFFh
SA109	110111xxx	64/32	6D0000h–6DFFFFh	368000h–36FFFFh
SA110	111000xxx	64/32	6E0000h–6EFFFFh	370000h–377FFFh
SA111	111001xxx	64/32	6F0000h–6FFFFFh	378000h–37FFFFh
SA112	111010xxx	64/32	700000h–70FFFFh	380000h–387FFFh
SA113	111011xxx	64/32	710000h–71FFFFh	388000h–38FFFFh
SA114	111100xxx	64/32	720000h–72FFFFh	390000h–397FFFh
SA115	111101xxx	64/32	730000h–73FFFFh	398000h–39FFFFh
SA116	111110xxx	64/32	740000h–74FFFFh	3A0000h–3A7FFFh
SA117	111111xxx	64/32	750000h–75FFFFh	3A8000h–3AFFFFh
SA118	111111xxx	64/32	760000h–76FFFFh	3B0000h–3B7FFFh
SA119	111111xxx	64/32	770000h–77FFFFh	3B8000h–3BFFFFh
SA120	111111xxx	64/32	780000h–78FFFFh	3C0000h–3C7FFFh
SA121	111111xxx	64/32	790000h–79FFFFh	3C8000h–3CFFFFh
SA122	111111xxx	64/32	7A0000h–7AFFFFh	3D0000h–3D7FFFh
SA123	111111xxx	64/32	7B0000h–7BFFFFh	3D8000h–3DFFFFh
SA124	111111xxx	64/32	7C0000h–7CFFFFh	3E0000h–3E7FFFh
SA125	111111xxx	64/32	7D0000h–7DFFFFh	3E8000h–3EFFFFh
SA126	111111xxx	64/32	7E0000h–7EFFFFh	3F0000h–3F7FFFh
SA127	111111000	8/4	7F0000h–7F1FFFh	3F8000h–3F8FFFh
SA128	111111001	8/4	7F2000h–7F3FFFh	3F9000h–3F9FFFh
SA129	111111010	8/4	7F4000h–7F5FFFh	3FA000h–3FAFFFh
SA130	111111011	8/4	7F6000h–7F7FFFh	3FB000h–3FBFFFh
SA131	111111100	8/4	7F8000h–7F9FFFh	3FC000h–3FCFFFh
SA132	111111101	8/4	7FA000h–7FBFFFh	3FD000h–3FDFFFh
SA133	111111110	8/4	7FC000h–7FDFFFh	3FE000h–3FEFFFh
SA134	111111111	8/4	7FE000h–7FFFFFh	3FF000h–3FFFFFh

Table 13. S29GL064M (Model R4) Bottom Boot Sector Architecture

Sector	Sector Address A21–A12	Sector Size (Kbytes/Kwords)	(x8) Address Range	(x16) Address Range
SA0	0000000000	8/4	000000h–001FFFh	00000h–00FFFh
SA1	0000000001	8/4	002000h–003FFFh	01000h–01FFFh
SA2	0000000010	8/4	004000h–005FFFh	02000h–02FFFh
SA3	0000000011	8/4	006000h–007FFFh	03000h–03FFFh
SA4	0000000100	8/4	008000h–009FFFh	04000h–04FFFh
SA5	0000000101	8/4	00A000h–00BFFFh	05000h–05FFFh
SA6	0000000110	8/4	00C000h–00DFFFh	06000h–06FFFh
SA7	0000000111	8/4	00E000h–00FFFFh	07000h–07FFFh
SA8	000000 1xxx	64/32	010000h–01FFFFh	08000h–0FFFFh
SA9	00000 10xxx	64/32	020000h–02FFFFh	10000h–17FFFh
SA10	00000 11xxx	64/32	030000h–03FFFFh	18000h–1FFFFh
SA11	0000 100xxx	64/32	040000h–04FFFFh	20000h–27FFFh
SA12	0000 101xxx	64/32	050000h–05FFFFh	28000h–2FFFFh
SA13	0000 110xxx	64/32	060000h–06FFFFh	30000h–37FFFh
SA14	0000 111xxx	64/32	070000h–07FFFFh	38000h–3FFFFh
SA15	0001 000xxx	64/32	080000h–08FFFFh	40000h–47FFFh
SA16	0001 001xxx	64/32	090000h–09FFFFh	48000h–4FFFFh
SA17	0001 010xxx	64/32	0A0000h–0AFFFFh	50000h–57FFFh
SA18	0001 011xxx	64/32	0B0000h–0BFFFFh	58000h–5FFFFh
SA19	0001 100xxx	64/32	0C0000h–0CFFFFh	60000h–67FFFh
SA20	0001 101xxx	64/32	0D0000h–0DFFFFh	68000h–6FFFFh
SA21	0001 110xxx	64/32	0E0000h–0EFFFFh	70000h–77FFFh
SA22	0001 111xxx	64/32	0F0000h–0FFFFFh	78000h–7FFFFh
SA23	0010 000xxx	64/32	100000h–00FFFFh	80000h–87FFFh
SA24	0010 001xxx	64/32	110000h–11FFFFh	88000h–8FFFFh
SA25	0010 010xxx	64/32	120000h–12FFFFh	90000h–97FFFh
SA26	0010 011xxx	64/32	130000h–13FFFFh	98000h–9FFFFh
SA27	0010 100xxx	64/32	140000h–14FFFFh	A0000h–A7FFFh
SA28	0010 101xxx	64/32	150000h–15FFFFh	A8000h–AFFFFh
SA29	0010 110xxx	64/32	160000h–16FFFFh	B0000h–B7FFFh
SA30	0010 111xxx	64/32	170000h–17FFFFh	B8000h–BFFFFh
SA31	0011 000xxx	64/32	180000h–18FFFFh	C0000h–C7FFFh
SA32	0011 001xxx	64/32	190000h–19FFFFh	C8000h–CFFFFh
SA33	0011 010xxx	64/32	1A0000h–1AFFFFh	D0000h–D7FFFh
SA34	0011 011xxx	64/32	1B0000h–1BFFFFh	D8000h–DFFFFh
SA35	0011 000xxx	64/32	1C0000h–1CFFFFh	E0000h–E7FFFh

Table 13. S29GL064M (Model R4) Bottom Boot Sector Architecture (Continued)

Sector	Sector Address A21–A12	Sector Size (Kbytes/Kwords)	(x8) Address Range	(x16) Address Range
SA36	001111101xxx	64/32	1D0000h–1DFFFFh	E8000h–EFFFFh
SA37	001111110xxx	64/32	1E0000h–1EFFFFh	F0000h–F7FFFh
SA38	001111111xxx	64/32	1F0000h–1FFFFFh	F8000h–FFFFFh
SA39	010000000xxx	64/32	200000h–20FFFFh	F9000h–107FFFh
SA40	010000101xxx	64/32	210000h–21FFFFh	108000h–10FFFFh
SA41	010001010xxx	64/32	220000h–22FFFFh	110000h–117FFFh
SA42	010101101xxx	64/32	230000h–23FFFFh	118000h–11FFFFh
SA43	010010010xxx	64/32	240000h–24FFFFh	120000h–127FFFh
SA44	010010101xxx	64/32	250000h–25FFFFh	128000h–12FFFFh
SA45	010011010xxx	64/32	260000h–26FFFFh	130000h–137FFFh
SA46	010011101xxx	64/32	270000h–27FFFFh	138000h–13FFFFh
SA47	010100000xxx	64/32	280000h–28FFFFh	140000h–147FFFh
SA48	010100101xxx	64/32	290000h–29FFFFh	148000h–14FFFFh
SA49	010101010xxx	64/32	2A0000h–2AFFFFh	150000h–157FFFh
SA50	010101101xxx	64/32	2B0000h–2BFFFFh	158000h–15FFFFh
SA51	010110010xxx	64/32	2C0000h–2CFFFFh	160000h–167FFFh
SA52	010110101xxx	64/32	2D0000h–2DFFFFh	168000h–16FFFFh
SA53	010111010xxx	64/32	2E0000h–2EFFFFh	170000h–177FFFh
SA54	010111101xxx	64/32	2F0000h–2FFFFFh	178000h–17FFFFh
SA55	011000000xxx	64/32	300000h–30FFFFh	180000h–187FFFh
SA56	011000101xxx	64/32	310000h–31FFFFh	188000h–18FFFFh
SA57	011001010xxx	64/32	320000h–32FFFFh	190000h–197FFFh
SA58	011001101xxx	64/32	330000h–33FFFFh	198000h–19FFFFh
SA59	010010010xxx	64/32	340000h–34FFFFh	1A0000h–1A7FFFh
SA60	011010101xxx	64/32	350000h–35FFFFh	1A8000h–1AFFFFh
SA61	011011010xxx	64/32	360000h–36FFFFh	1B0000h–1B7FFFh
SA62	011011101xxx	64/32	370000h–37FFFFh	1B8000h–1BFFFFh
SA63	011100000xxx	64/32	380000h–38FFFFh	1C0000h–1C7FFFh
SA64	011100101xxx	64/32	390000h–39FFFFh	1C8000h–1CFFFFh
SA65	011101010xxx	64/32	3A0000h–3AFFFFh	1D0000h–1D7FFFh
SA66	011101101xxx	64/32	3B0000h–3BFFFFh	1D8000h–1DFFFFh
SA67	011110010xxx	64/32	3C0000h–3CFFFFh	1E0000h–1E7FFFh
SA68	011110101xxx	64/32	3D0000h–3DFFFFh	1E8000h–1EFFFFh
SA69	011111010xxx	64/32	3E0000h–3EFFFFh	1F0000h–1F7FFFh
SA70	011111101xxx	64/32	3F0000h–3FFFFFh	1F8000h–1FFFFFh
SA71	100000000xxx	64/32	400000h–40FFFFh	200000h–207FFFh

Table 13. S29GL064M (Model R4) Bottom Boot Sector Architecture (Continued)

Sector	Sector Address A21–A12	Sector Size (Kbytes/Kwords)	(x8) Address Range	(x16) Address Range
SA72	100000xxx	64/32	410000h–41FFFFh	208000h–20FFFFh
SA73	100001xxx	64/32	420000h–42FFFFh	210000h–217FFFh
SA74	100010xxx	64/32	430000h–43FFFFh	218000h–21FFFFh
SA75	100011xxx	64/32	440000h–44FFFFh	220000h–227FFFh
SA76	100100xxx	64/32	450000h–45FFFFh	228000h–22FFFFh
SA77	100101xxx	64/32	460000h–46FFFFh	230000h–237FFFh
SA78	100110xxx	64/32	470000h–47FFFFh	238000h–23FFFFh
SA79	100111xxx	64/32	480000h–48FFFFh	240000h–247FFFh
SA80	101000xxx	64/32	490000h–49FFFFh	248000h–24FFFFh
SA81	101001xxx	64/32	4A0000h–4AFFFFh	250000h–257FFFh
SA82	101010xxx	64/32	4B0000h–4BFFFFh	258000h–25FFFFh
SA83	101011xxx	64/32	4C0000h–4CFFFFh	260000h–267FFFh
SA84	101100xxx	64/32	4D0000h–4DFFFFh	268000h–26FFFFh
SA85	101101xxx	64/32	4E0000h–4EFFFFh	270000h–277FFFh
SA86	101110xxx	64/32	4F0000h–4FFFFFh	278000h–27FFFFh
SA87	101111xxx	64/32	500000h–50FFFFh	280000h–28FFFFh
SA88	110000xxx	64/32	510000h–51FFFFh	288000h–28FFFFh
SA89	110001xxx	64/32	520000h–52FFFFh	290000h–297FFFh
SA90	110010xxx	64/32	530000h–53FFFFh	298000h–29FFFFh
SA91	110011xxx	64/32	540000h–54FFFFh	2A0000h–2A7FFFh
SA92	110100xxx	64/32	550000h–55FFFFh	2A8000h–2AFFFFh
SA93	110101xxx	64/32	560000h–56FFFFh	2B0000h–2B7FFFh
SA94	110110xxx	64/32	570000h–57FFFFh	2B8000h–2BFFFFh
SA95	110111xxx	64/32	580000h–58FFFFh	2C0000h–2C7FFFh
SA96	111000xxx	64/32	590000h–59FFFFh	2C8000h–2CFFFFh
SA97	111001xxx	64/32	5A0000h–5AFFFFh	2D0000h–2D7FFFh
SA98	111010xxx	64/32	5B0000h–5BFFFFh	2D8000h–2DFFFFh
SA99	111011xxx	64/32	5C0000h–5CFFFFh	2E0000h–2E7FFFh
SA100	111100xxx	64/32	5D0000h–5DFFFFh	2E8000h–2EFFFFh
SA101	111101xxx	64/32	5E0000h–5EFFFFh	2F0000h–2FFFFFh
SA102	111110xxx	64/32	5F0000h–5FFFFFh	2F8000h–2FFFFFh
SA103	111111xxx	64/32	600000h–60FFFFh	300000h–307FFFh
SA104	1100000xxx	64/32	610000h–61FFFFh	308000h–30FFFFh
SA105	1100001xxx	64/32	620000h–62FFFFh	310000h–317FFFh
SA106	1100010xxx	64/32	630000h–63FFFFh	318000h–31FFFFh
SA107	1100011xxx	64/32	640000h–64FFFFh	320000h–327FFFh

Table 13. S29GL064M (Model R4) Bottom Boot Sector Architecture (Continued)

Sector	Sector Address A21–A12	Sector Size (Kbytes/Kwords)	(x8) Address Range	(x16) Address Range
SA108	110010xxx	64/32	650000h–65FFFFh	328000h–32FFFFh
SA109	110011xxx	64/32	660000h–66FFFFh	330000h–337FFFh
SA110	110011xxx	64/32	670000h–67FFFFh	338000h–33FFFFh
SA111	110100xxx	64/32	680000h–68FFFFh	340000h–347FFFh
SA112	110100xxx	64/32	690000h–69FFFFh	348000h–34FFFFh
SA113	110101xxx	64/32	6A0000h–6AFFFFh	350000h–357FFFh
SA114	110101xxx	64/32	6B0000h–6BFFFFh	358000h–35FFFFh
SA115	110110xxx	64/32	6C0000h–6CFFFFh	360000h–367FFFh
SA116	110110xxx	64/32	6D0000h–6DFFFFh	368000h–36FFFFh
SA117	110111xxx	64/32	6E0000h–6EFFFFh	370000h–377FFFh
SA118	110111xxx	64/32	6F0000h–6FFFFFh	378000h–37FFFFh
SA119	111000xxx	64/32	700000h–70FFFFh	380000h–387FFFh
SA120	111000xxx	64/32	710000h–71FFFFh	388000h–38FFFFh
SA121	111001xxx	64/32	720000h–72FFFFh	390000h–397FFFh
SA122	111001xxx	64/32	730000h–73FFFFh	398000h–39FFFFh
SA123	111010xxx	64/32	740000h–74FFFFh	3A0000h–3A7FFFh
SA124	111010xxx	64/32	750000h–75FFFFh	3A8000h–3AFFFFh
SA125	111011xxx	64/32	760000h–76FFFFh	3B0000h–3B7FFFh
SA126	111011xxx	64/32	770000h–77FFFFh	3B8000h–3BFFFFh
SA127	111100xxx	64/32	780000h–78FFFFh	3C0000h–3C7FFFh
SA128	111100xxx	64/32	790000h–79FFFFh	3C8000h–3CFFFFh
SA129	111101xxx	64/32	7A0000h–7AFFFFh	3D0000h–3D7FFFh
SA130	111101xxx	64/32	7B0000h–7BFFFFh	3D8000h–3DFFFFh
SA131	111110xxx	64/32	7C0000h–7CFFFFh	3E0000h–3E7FFFh
SA132	111110xxx	64/32	7D0000h–7DFFFFh	3E8000h–3EFFFFh
SA133	111111xxx	64/32	7E0000h–7EFFFFh	3F0000h–3F7FFFh
SA134	111111000	64/32	7F0000h–7FFFFFh	3F8000h–3FFFFFh

Table 14. S29GL064M (Model R5) Sector Address Table

Sector	A21–A15							16-bit Address Range (in hexadecimal)
SA0	0	0	0	0	0	0	0	000000–007FFF
SA1	0	0	0	0	0	0	1	008000–00FFFF
SA2	0	0	0	0	0	1	0	010000–017FFF
SA3	0	0	0	0	0	1	1	018000–01FFFF
SA4	0	0	0	0	1	0	0	020000–027FFF
SA5	0	0	0	0	1	0	1	028000–02FFFF
SA6	0	0	0	0	1	1	0	030000–037FFF
SA7	0	0	0	0	1	1	1	038000–03FFFF
SA8	0	0	0	1	0	0	0	040000–047FFF
SA9	0	0	0	1	0	0	1	048000–04FFFF
SA10	0	0	0	1	0	1	0	050000–057FFF
SA11	0	0	0	1	0	1	1	058000–05FFFF
SA12	0	0	0	1	1	0	0	060000–067FFF
SA13	0	0	0	1	1	0	1	068000–06FFFF
SA14	0	0	0	1	1	1	0	070000–077FFF
SA15	0	0	0	1	1	1	1	078000–07FFFF
SA16	0	0	1	0	0	0	0	080000–087FFF
SA17	0	0	1	0	0	0	1	088000–08FFFF
SA18	0	0	1	0	0	1	0	090000–097FFF
SA19	0	0	1	0	0	1	1	098000–09FFFF
SA20	0	0	1	0	1	0	0	0A0000–0A7FFF
SA21	0	0	1	0	1	0	1	0A8000–0AFFFF
SA22	0	0	1	0	1	1	0	0B0000–0B7FFF
SA23	0	0	1	0	1	1	1	0B8000–0BFFFF
SA24	0	0	1	1	0	0	0	0C0000–0C7FFF
SA25	0	0	1	1	0	0	1	0C8000–0CFFFF
SA26	0	0	1	1	0	1	0	0D0000–0D7FFF
SA27	0	0	1	1	0	1	1	0D8000–0DFFFF
SA28	0	0	1	1	1	0	0	0E0000–0E7FFF
SA29	0	0	1	1	1	0	1	0E8000–0EFFFF
SA30	0	0	1	1	1	1	0	0F0000–0F7FFF
SA31	0	0	1	1	1	1	1	0F8000–0FFFFF
SA64	1	0	0	0	0	0	0	200000–207FFF
SA65	1	0	0	0	0	0	1	208000–20FFFF
SA66	1	0	0	0	0	1	0	210000–217FFF
SA67	1	0	0	0	0	1	1	218000–21FFFF
SA68	1	0	0	0	1	0	0	220000–227FFF
SA69	1	0	0	0	1	0	1	228000–22FFFF
SA70	1	0	0	0	1	1	0	230000–237FFF
SA71	1	0	0	0	1	1	1	238000–23FFFF
SA72	1	0	0	1	0	0	0	240000–247FFF
SA73	1	0	0	1	0	0	1	248000–24FFFF
SA74	1	0	0	1	0	1	0	250000–257FFF
SA75	1	0	0	1	0	1	1	258000–25FFFF
SA76	1	0	0	1	1	0	0	260000–267FFF

Table 14. S29GL064M (Model R5) Sector Address Table (Continued)

Sector	A21–A15							16-bit Address Range (in hexadecimal)
SA77	1	0	0	1	1	0	1	268000–26FFFF
SA78	1	0	0	1	1	1	0	270000–277FFF
SA79	1	0	0	1	1	1	1	278000–27FFFF
SA80	1	0	1	0	0	0	0	280000–287FFF
SA81	1	0	1	0	0	0	1	288000–28FFFF
SA82	1	0	1	0	0	1	0	290000–297FFF
SA83	1	0	1	0	0	1	1	298000–29FFFF
SA84	1	0	1	0	1	0	0	2A0000–2A7FFF
SA85	1	0	1	0	1	0	1	2A8000–2AFFFF
SA86	1	0	1	0	1	1	0	2B0000–2B7FFF
SA87	1	0	1	0	1	1	1	2B8000–2BFFFF
SA88	1	0	1	1	0	0	0	2C0000–2C7FFF
SA89	1	0	1	1	0	0	1	2C8000–2CFFFF
SA90	1	0	1	1	0	1	0	2D0000–2D7FFF
SA91	1	0	1	1	0	1	1	2D8000–2DFFFF
SA92	1	0	1	1	1	0	0	2E0000–2E7FFF
SA93	1	0	1	1	1	0	1	2E8000–2EFFFF
SA94	1	0	1	1	1	1	0	2F0000–2F7FFF
SA95	1	0	1	1	1	1	1	2F8000–2FFFFF
SA32	0	1	0	0	0	0	0	100000–107FFF
SA33	0	1	0	0	0	0	1	108000–10FFFF
SA34	0	1	0	0	0	1	0	110000–117FFF
SA35	0	1	0	0	0	1	1	118000–11FFFF
SA36	0	1	0	0	1	0	0	120000–127FFF
SA37	0	1	0	0	1	0	1	128000–12FFFF
SA38	0	1	0	0	1	1	0	130000–137FFF
SA39	0	1	0	0	1	1	1	138000–13FFFF
SA40	0	1	0	1	0	0	0	140000–147FFF
SA41	0	1	0	1	0	0	1	148000–14FFFF
SA42	0	1	0	1	0	1	0	150000–157FFF
SA43	0	1	0	1	0	1	1	158000–15FFFF
SA44	0	1	0	1	1	0	0	160000–167FFF
SA45	0	1	0	1	1	0	1	168000–16FFFF
SA46	0	1	0	1	1	1	0	170000–177FFF
SA47	0	1	0	1	1	1	1	178000–17FFFF
SA48	0	1	1	0	0	0	0	180000–187FFF
SA49	0	1	1	0	0	0	1	188000–18FFFF
SA50	0	1	1	0	0	1	0	190000–197FFF
SA51	0	1	1	0	0	1	1	198000–19FFFF
SA52	0	1	1	0	1	0	0	1A0000–1A7FFF
SA53	0	1	1	0	1	0	1	1A8000–1AFFFF
SA54	0	1	1	0	1	1	0	1B0000–1B7FFF
SA55	0	1	1	0	1	1	1	1B8000–1BFFFF
SA56	0	1	1	1	0	0	0	1C0000–1C7FFF
SA57	0	1	1	1	0	0	1	1C8000–1CFFFF

Table 14. S29GL064M (Model R5) Sector Address Table (Continued)

Sector	A21–A15							16-bit Address Range (in hexadecimal)
SA58	0	1	1	1	0	1	0	1D0000–1D7FFF
SA59	0	1	1	1	0	1	1	1D8000–1DFFFF
SA60	0	1	1	1	1	0	0	1E0000–1E7FFF
SA61	0	1	1	1	1	0	1	1E8000–1EFFFF
SA62	0	1	1	1	1	1	0	1F0000–1F7FFF
SA63	0	1	1	1	1	1	1	1F8000–1FFFFF
SA96	1	1	0	0	0	0	0	300000–307FFF
SA97	1	1	0	0	0	0	1	308000–30FFFF
SA98	1	1	0	0	0	1	0	310000–317FFF
SA99	1	1	0	0	0	1	1	318000–31FFFF
SA100	1	1	0	0	1	0	0	320000–327FFF
SA101	1	1	0	0	1	0	1	328000–32FFFF
SA102	1	1	0	0	1	1	0	330000–337FFF
SA103	1	1	0	0	1	1	1	338000–33FFFF
SA104	1	1	0	1	0	0	0	340000–347FFF
SA105	1	1	0	1	0	0	1	348000–34FFFF
SA106	1	1	0	1	0	1	0	350000–357FFF
SA107	1	1	0	1	0	1	1	358000–35FFFF
SA108	1	1	0	1	1	0	0	360000–367FFF
SA109	1	1	0	1	1	0	1	368000–36FFFF
SA110	1	1	0	1	1	1	0	370000–377FFF
SA111	1	1	0	1	1	1	1	378000–37FFFF
SA112	1	1	1	0	0	0	0	380000–387FFF
SA113	1	1	1	0	0	0	1	388000–38FFFF
SA114	1	1	1	0	0	1	0	390000–397FFF
SA115	1	1	1	0	0	1	1	398000–39FFFF
SA116	1	1	1	0	1	0	0	3A0000–3A7FFF
SA117	1	1	1	0	1	0	1	3A8000–3AFFFF
SA118	1	1	1	0	1	1	0	3B0000–3B7FFF
SA119	1	1	1	0	1	1	1	3B8000–3BFFFF
SA120	1	1	1	1	0	0	0	3C0000–3C7FFF
SA121	1	1	1	1	0	0	1	3C8000–3CFFFF
SA122	1	1	1	1	0	1	0	3D0000–3D7FFF
SA123	1	1	1	1	0	1	1	3D8000–3DFFFF
SA124	1	1	1	1	1	0	0	3E0000–3E7FFF
SA125	1	1	1	1	1	0	1	3E8000–3EFFFF
SA126	1	1	1	1	1	1	0	3F0000–3F7FFF
SA127	1	1	1	1	1	1	1	3F8000–3FFFFF

Table 15. S29GL064M (Model R6, R7) Sector Address Table

Sector	A21–A15							16-bit Address Range (in hexadecimal)
SA0	0	0	0	0	0	0	0	000000–007FFF
SA1	0	0	0	0	0	0	1	008000–00FFFF
SA2	0	0	0	0	0	1	0	010000–017FFF
SA3	0	0	0	0	0	1	1	018000–01FFFF
SA4	0	0	0	0	1	0	0	020000–027FFF
SA5	0	0	0	0	1	0	1	028000–02FFFF
SA6	0	0	0	0	1	1	0	030000–037FFF
SA7	0	0	0	0	1	1	1	038000–03FFFF
SA8	0	0	0	1	0	0	0	040000–047FFF
SA9	0	0	0	1	0	0	1	048000–04FFFF
SA10	0	0	0	1	0	1	0	050000–057FFF
SA11	0	0	0	1	0	1	1	058000–05FFFF
SA12	0	0	0	1	1	0	0	060000–067FFF
SA13	0	0	0	1	1	0	1	068000–06FFFF
SA14	0	0	0	1	1	1	0	070000–077FFF
SA15	0	0	0	1	1	1	1	078000–07FFFF
SA16	0	0	1	0	0	0	0	080000–087FFF
SA17	0	0	1	0	0	0	1	088000–08FFFF
SA18	0	0	1	0	0	1	0	090000–097FFF
SA19	0	0	1	0	0	1	1	098000–09FFFF
SA20	0	0	1	0	1	0	0	0A0000–0A7FFF
SA21	0	0	1	0	1	0	1	0A8000–0AFFFF
SA22	0	0	1	0	1	1	0	0B0000–0B7FFF
SA23	0	0	1	0	1	1	1	0B8000–0BFFFF
SA24	0	0	1	1	0	0	0	0C0000–0C7FFF
SA25	0	0	1	1	0	0	1	0C8000–0CFFFF
SA26	0	0	1	1	0	1	0	0D0000–0D7FFF
SA27	0	0	1	1	0	1	1	0D8000–0DFFFF
SA28	0	0	1	1	1	0	0	0E0000–0E7FFF
SA29	0	0	1	1	1	0	1	0E8000–0EFFFF
SA30	0	0	1	1	1	1	0	0F0000–0F7FFF
SA31	0	0	1	1	1	1	1	0F8000–0FFFFF
SA64	1	0	0	0	0	0	0	200000–207FFF
SA65	1	0	0	0	0	0	1	208000–20FFFF
SA66	1	0	0	0	0	1	0	210000–217FFF
SA67	1	0	0	0	0	1	1	218000–21FFFF
SA68	1	0	0	0	1	0	0	220000–227FFF
SA69	1	0	0	0	1	0	1	228000–22FFFF
SA70	1	0	0	0	1	1	0	230000–237FFF
SA71	1	0	0	0	1	1	1	238000–23FFFF
SA72	1	0	0	1	0	0	0	240000–247FFF
SA73	1	0	0	1	0	0	1	248000–24FFFF
SA74	1	0	0	1	0	1	0	250000–257FFF
SA75	1	0	0	1	0	1	1	258000–25FFFF
SA76	1	0	0	1	1	0	0	260000–267FFF

Table 15. S29GL064M (Model R6, R7) Sector Address Table (Continued)

Sector	A21–A15							16-bit Address Range (in hexadecimal)
SA77	1	0	0	1	1	0	1	268000–26FFFF
SA78	1	0	0	1	1	1	0	270000–277FFF
SA79	1	0	0	1	1	1	1	278000–27FFFF
SA80	1	0	1	0	0	0	0	280000–287FFF
SA81	1	0	1	0	0	0	1	288000–28FFFF
SA82	1	0	1	0	0	1	0	290000–297FFF
SA83	1	0	1	0	0	1	1	298000–29FFFF
SA84	1	0	1	0	1	0	0	2A0000–2A7FFF
SA85	1	0	1	0	1	0	1	2A8000–2AFFFF
SA86	1	0	1	0	1	1	0	2B0000–2B7FFF
SA87	1	0	1	0	1	1	1	2B8000–2BFFFF
SA88	1	0	1	1	0	0	0	2C0000–2C7FFF
SA89	1	0	1	1	0	0	1	2C8000–2CFFFF
SA90	1	0	1	1	0	1	0	2D0000–2D7FFF
SA91	1	0	1	1	0	1	1	2D8000–2DFFFF
SA92	1	0	1	1	1	0	0	2E0000–2E7FFF
SA93	1	0	1	1	1	0	1	2E8000–2EFFFF
SA94	1	0	1	1	1	1	0	2F0000–2F7FFF
SA95	1	0	1	1	1	1	1	2F8000–2FFFFF
SA32	0	1	0	0	0	0	0	100000–107FFF
SA33	0	1	0	0	0	0	1	108000–10FFFF
SA34	0	1	0	0	0	1	0	110000–117FFF
SA35	0	1	0	0	0	1	1	118000–11FFFF
SA36	0	1	0	0	1	0	0	120000–127FFF
SA37	0	1	0	0	1	0	1	128000–12FFFF
SA38	0	1	0	0	1	1	0	130000–137FFF
SA39	0	1	0	0	1	1	1	138000–13FFFF
SA40	0	1	0	1	0	0	0	140000–147FFF
SA41	0	1	0	1	0	0	1	148000–14FFFF
SA42	0	1	0	1	0	1	0	150000–157FFF
SA43	0	1	0	1	0	1	1	158000–15FFFF
SA44	0	1	0	1	1	0	0	160000–167FFF
SA45	0	1	0	1	1	0	1	168000–16FFFF
SA46	0	1	0	1	1	1	0	170000–177FFF
SA47	0	1	0	1	1	1	1	178000–17FFFF
SA48	0	1	1	0	0	0	0	180000–187FFF
SA49	0	1	1	0	0	0	1	188000–18FFFF
SA50	0	1	1	0	0	1	0	190000–197FFF
SA51	0	1	1	0	0	1	1	198000–19FFFF
SA52	0	1	1	0	1	0	0	1A0000–1A7FFF
SA53	0	1	1	0	1	0	1	1A8000–1AFFFF
SA54	0	1	1	0	1	1	0	1B0000–1B7FFF
SA55	0	1	1	0	1	1	1	1B8000–1BFFFF
SA56	0	1	1	1	0	0	0	1C0000–1C7FFF
SA57	0	1	1	1	0	0	1	1C8000–1CFFFF

Table 15. S29GL064M (Model R6, R7) Sector Address Table (Continued)

Sector	A21–A15							16-bit Address Range (in hexadecimal)
SA58	0	1	1	1	0	1	0	1D0000–1D7FFF
SA59	0	1	1	1	0	1	1	1D8000–1DFFFF
SA60	0	1	1	1	1	0	0	1E0000–1E7FFF
SA61	0	1	1	1	1	0	1	1E8000–1EFFFF
SA62	0	1	1	1	1	1	0	1F0000–1F7FFF
SA63	0	1	1	1	1	1	1	1F8000–1FFFFF
SA96	1	1	0	0	0	0	0	300000–307FFF
SA97	1	1	0	0	0	0	1	308000–30FFFF
SA98	1	1	0	0	0	1	0	310000–317FFF
SA99	1	1	0	0	0	1	1	318000–31FFFF
SA100	1	1	0	0	1	0	0	320000–327FFF
SA101	1	1	0	0	1	0	1	328000–32FFFF
SA102	1	1	0	0	1	1	0	330000–337FFF
SA103	1	1	0	0	1	1	1	338000–33FFFF
SA104	1	1	0	1	0	0	0	340000–347FFF
SA105	1	1	0	1	0	0	1	348000–34FFFF
SA106	1	1	0	1	0	1	0	350000–357FFF
SA107	1	1	0	1	0	1	1	358000–35FFFF
SA108	1	1	0	1	1	0	0	360000–367FFF
SA109	1	1	0	1	1	0	1	368000–36FFFF
SA110	1	1	0	1	1	1	0	370000–377FFF
SA111	1	1	0	1	1	1	1	378000–37FFFF
SA112	1	1	1	0	0	0	0	380000–387FFF
SA113	1	1	1	0	0	0	1	388000–38FFFF
SA114	1	1	1	0	0	1	0	390000–397FFF
SA115	1	1	1	0	0	1	1	398000–39FFFF
SA116	1	1	1	0	1	0	0	3A0000–3A7FFF
SA117	1	1	1	0	1	0	1	3A8000–3AFFFF
SA118	1	1	1	0	1	1	0	3B0000–3B7FFF
SA119	1	1	1	0	1	1	1	3B8000–3BFFFF
SA120	1	1	1	1	0	0	0	3C0000–3C7FFF
SA121	1	1	1	1	0	0	1	3C8000–3CFFFF
SA122	1	1	1	1	0	1	0	3D0000–3D7FFF
SA123	1	1	1	1	0	1	1	3D8000–3DFFFF
SA124	1	1	1	1	1	0	0	3E0000–3E7FFF
SA125	1	1	1	1	1	0	1	3E8000–3EFFFF
SA126	1	1	1	1	1	1	0	3F0000–3F7FFF
SA127	1	1	1	1	1	1	1	3F8000–3FFFFF

Table 16. S29GL128M Sector Address Table

Sector	A22–A15								Sector Size (Kbytes/ Kwords)	8-bit Address Range (in hexadecimal)	16-bit Address Range (in hexadecimal)
SA0	0	0	0	0	0	0	0	0	64/32	000000–00FFFF	000000–007FFF
SA1	0	0	0	0	0	0	0	1	64/32	010000–01FFFF	008000–00FFFF
SA2	0	0	0	0	0	0	1	0	64/32	020000–02FFFF	010000–017FFF
SA3	0	0	0	0	0	0	1	1	64/32	030000–03FFFF	018000–01FFFF
SA4	0	0	0	0	0	1	0	0	64/32	040000–04FFFF	020000–027FFF
SA5	0	0	0	0	0	1	0	1	64/32	050000–05FFFF	028000–02FFFF
SA6	0	0	0	0	0	1	1	0	64/32	060000–06FFFF	030000–037FFF
SA7	0	0	0	0	0	1	1	1	64/32	070000–07FFFF	038000–03FFFF
SA8	0	0	0	0	1	0	0	0	64/32	080000–08FFFF	040000–047FFF
SA9	0	0	0	0	1	0	0	1	64/32	090000–09FFFF	048000–04FFFF
SA10	0	0	0	0	1	0	1	0	64/32	0A0000–0AFFFF	050000–057FFF
SA11	0	0	0	0	1	0	1	1	64/32	0B0000–0BFFFF	058000–05FFFF
SA12	0	0	0	0	1	1	0	0	64/32	0C0000–0CFFFF	060000–067FFF
SA13	0	0	0	0	1	1	0	1	64/32	0D0000–0DFFFF	068000–06FFFF
SA14	0	0	0	0	1	1	1	0	64/32	0E0000–0EFFFF	070000–077FFF
SA15	0	0	0	0	1	1	1	1	64/32	0F0000–0FFFFF	078000–07FFFF
SA16	0	0	0	1	0	0	0	0	64/32	100000–10FFFF	080000–087FFF
SA17	0	0	0	1	0	0	0	1	64/32	110000–11FFFF	088000–08FFFF
SA18	0	0	0	1	0	0	1	0	64/32	120000–12FFFF	090000–097FFF
SA19	0	0	0	1	0	0	1	1	64/32	130000–13FFFF	098000–09FFFF
SA20	0	0	0	1	0	1	0	0	64/32	140000–14FFFF	0A0000–0A7FFF
SA21	0	0	0	1	0	1	0	1	64/32	150000–15FFFF	0A8000–0AFFFF
SA22	0	0	0	1	0	1	1	0	64/32	160000–16FFFF	0B0000–0B7FFF
SA23	0	0	0	1	0	1	1	1	64/32	170000–17FFFF	0B8000–0BFFFF
SA24	0	0	0	1	1	0	0	0	64/32	180000–18FFFF	0C0000–0C7FFF
SA25	0	0	0	1	1	0	0	1	64/32	190000–19FFFF	0C8000–0CFFFF
SA26	0	0	0	1	1	0	1	0	64/32	1A0000–1AFFFF	0D0000–0D7FFF
SA27	0	0	0	1	1	0	1	1	64/32	1B0000–1BFFFF	0D8000–0DFFFF
SA28	0	0	0	1	1	1	0	0	64/32	1C0000–1CFFFF	0E0000–0E7FFF
SA29	0	0	0	1	1	1	0	1	64/32	1D0000–1DFFFF	0E8000–0EFFFF
SA30	0	0	0	1	1	1	1	0	64/32	1E0000–1EFFFF	0F0000–0F7FFF
SA31	0	0	0	1	1	1	1	1	64/32	1F0000–1FFFFF	0F8000–0FFFFF
SA32	0	0	1	0	0	0	0	0	64/32	200000–20FFFF	100000–107FFF
SA33	0	0	1	0	0	0	0	1	64/32	210000–21FFFF	108000–10FFFF
SA34	0	0	1	0	0	0	1	0	64/32	220000–22FFFF	110000–117FFF
SA35	0	0	1	0	0	0	1	1	64/32	230000–23FFFF	118000–11FFFF
SA36	0	0	1	0	0	1	0	0	64/32	240000–24FFFF	120000–127FFF
SA37	0	0	1	0	0	1	0	1	64/32	250000–25FFFF	128000–12FFFF
SA38	0	0	1	0	0	1	1	0	64/32	260000–26FFFF	130000–137FFF
SA39	0	0	1	0	0	1	1	1	64/32	270000–27FFFF	138000–13FFFF
SA40	0	0	1	0	1	0	0	0	64/32	280000–28FFFF	140000–147FFF
SA41	0	0	1	0	1	0	0	1	64/32	290000–29FFFF	148000–14FFFF
SA42	0	0	1	0	1	0	1	0	64/32	2A0000–2AFFFF	150000–157FFF
SA43	0	0	1	0	1	0	1	1	64/32	2B0000–2BFFFF	158000–15FFFF
SA44	0	0	1	0	1	1	0	0	64/32	2C0000–2CFFFF	160000–167FFF

Table 16. S29GL128M Sector Address Table (Continued)

Sector	A22–A15								Sector Size (Kbytes/ Kwords)	8-bit Address Range (in hexadecimal)	16-bit Address Range (in hexadecimal)
SA45	0	0	1	0	1	1	0	1	64/32	2D0000–2DFFFF	168000–16FFFF
SA46	0	0	1	0	1	1	1	0	64/32	2E0000–2EFFFF	170000–177FFF
SA47	0	0	1	0	1	1	1	1	64/32	2F0000–2FFFFF	178000–17FFFF
SA48	0	0	1	1	0	0	0	0	64/32	300000–30FFFF	180000–187FFF
SA49	0	0	1	1	0	0	0	1	64/32	310000–31FFFF	188000–18FFFF
SA50	0	0	1	1	0	0	1	0	64/32	320000–32FFFF	190000–197FFF
SA51	0	0	1	1	0	0	1	1	64/32	330000–33FFFF	198000–19FFFF
SA52	0	0	1	1	0	1	0	0	64/32	340000–34FFFF	1A0000–1A7FFF
SA53	0	0	1	1	0	1	0	1	64/32	350000–35FFFF	1A8000–1AFFFF
SA54	0	0	1	1	0	1	1	0	64/32	360000–36FFFF	1B0000–1B7FFF
SA55	0	0	1	1	0	1	1	1	64/32	370000–37FFFF	1B8000–1BFFFF
SA56	0	0	1	1	1	0	0	0	64/32	380000–38FFFF	1C0000–1C7FFF
SA57	0	0	1	1	1	0	0	1	64/32	390000–39FFFF	1C8000–1CFFFF
SA58	0	0	1	1	1	0	1	0	64/32	3A0000–3AFFFF	1D0000–1D7FFF
SA59	0	0	1	1	1	0	1	1	64/32	3B0000–3BFFFF	1D8000–1DFFFF
SA60	0	0	1	1	1	1	0	0	64/32	3C0000–3CFFFF	1E0000–1E7FFF
SA61	0	0	1	1	1	1	0	1	64/32	3D0000–3DFFFF	1E8000–1EFFFF
SA62	0	0	1	1	1	1	1	0	64/32	3E0000–3EFFFF	1F0000–1F7FFF
SA63	0	0	1	1	1	1	1	1	64/32	3F0000–3FFFFF	1F8000–1FFFFF
SA64	0	1	0	0	0	0	0	0	64/32	400000–40FFFF	200000–207FFF
SA65	0	1	0	0	0	0	0	1	64/32	410000–41FFFF	208000–20FFFF
SA66	0	1	0	0	0	0	1	0	64/32	420000–42FFFF	210000–217FFF
SA67	0	1	0	0	0	0	1	1	64/32	430000–43FFFF	218000–21FFFF
SA68	0	1	0	0	0	1	0	0	64/32	440000–44FFFF	220000–227FFF
SA69	0	1	0	0	0	1	0	1	64/32	450000–45FFFF	228000–22FFFF
SA70	0	1	0	0	0	1	1	0	64/32	460000–46FFFF	230000–237FFF
SA71	0	1	0	0	0	1	1	1	64/32	470000–47FFFF	238000–23FFFF
SA72	0	1	0	0	1	0	0	0	64/32	480000–48FFFF	240000–247FFF
SA73	0	1	0	0	1	0	0	1	64/32	490000–49FFFF	248000–24FFFF
SA74	0	1	0	0	1	0	1	0	64/32	4A0000–4AFFFF	250000–257FFF
SA75	0	1	0	0	1	0	1	1	64/32	4B0000–4BFFFF	258000–25FFFF
SA76	0	1	0	0	1	1	0	0	64/32	4C0000–4CFFFF	260000–267FFF
SA77	0	1	0	0	1	1	0	1	64/32	4D0000–4DFFFF	268000–26FFFF
SA78	0	1	0	0	1	1	1	0	64/32	4E0000–4EFFFF	270000–277FFF
SA79	0	1	0	0	1	1	1	1	64/32	4F0000–4FFFFF	278000–27FFFF
SA80	0	1	0	1	0	0	0	0	64/32	500000–50FFFF	280000–287FFF
SA81	0	1	0	1	0	0	0	1	64/32	510000–51FFFF	288000–28FFFF
SA82	0	1	0	1	0	0	1	0	64/32	520000–52FFFF	290000–297FFF
SA83	0	1	0	1	0	0	1	1	64/32	530000–53FFFF	298000–29FFFF
SA84	0	1	0	1	0	1	0	0	64/32	540000–54FFFF	2A0000–2A7FFF
SA85	0	1	0	1	0	1	0	1	64/32	550000–55FFFF	2A8000–2AFFFF
SA86	0	1	0	1	0	1	1	0	64/32	560000–56FFFF	2B0000–2B7FFF
SA87	0	1	0	1	0	1	1	1	64/32	570000–57FFFF	2B8000–2BFFFF
SA88	0	1	0	1	1	0	0	0	64/32	580000–58FFFF	2C0000–2C7FFF
SA89	0	1	0	1	1	0	0	1	64/32	590000–59FFFF	2C8000–2CFFFF

Table 16. S29GL128M Sector Address Table (Continued)

Sector	A22–A15								Sector Size (Kbytes/ Kwords)	8-bit Address Range (in hexadecimal)	16-bit Address Range (in hexadecimal)
SA90	0	1	0	1	1	0	1	0	64/32	5A0000–5AFFFF	2D0000–2D7FFF
SA91	0	1	0	1	1	0	1	1	64/32	5B0000–5BFFFF	2D8000–2DFFFF
SA92	0	1	0	1	1	1	0	0	64/32	5C0000–5CFFFF	2E0000–2E7FFF
SA93	0	1	0	1	1	1	0	1	64/32	5D0000–5DFFFF	2E8000–2EFFFF
SA94	0	1	0	1	1	1	1	0	64/32	5E0000–5EFFFF	2F0000–2F7FFF
SA95	0	1	0	1	1	1	1	1	64/32	5F0000–5FFFFF	2F8000–2FFFFF
SA96	0	1	1	0	0	0	0	0	64/32	600000–60FFFF	300000–307FFF
SA97	0	1	1	0	0	0	0	1	64/32	610000–61FFFF	308000–30FFFF
SA98	0	1	1	0	0	0	1	0	64/32	620000–62FFFF	310000–317FFF
SA99	0	1	1	0	0	0	1	1	64/32	630000–63FFFF	318000–31FFFF
SA100	0	1	1	0	0	1	0	0	64/32	640000–64FFFF	320000–327FFF
SA101	0	1	1	0	0	1	0	1	64/32	650000–65FFFF	328000–32FFFF
SA102	0	1	1	0	0	1	1	0	64/32	660000–66FFFF	330000–337FFF
SA103	0	1	1	0	0	1	1	1	64/32	670000–67FFFF	338000–33FFFF
SA104	0	1	1	0	1	0	0	0	64/32	680000–68FFFF	340000–347FFF
SA105	0	1	1	0	1	0	0	1	64/32	690000–69FFFF	348000–34FFFF
SA106	0	1	1	0	1	0	1	0	64/32	6A0000–6AFFFF	350000–357FFF
SA107	0	1	1	0	1	0	1	1	64/32	6B0000–6BFFFF	358000–35FFFF
SA108	0	1	1	0	1	1	0	0	64/32	6C0000–6CFFFF	360000–367FFF
SA109	0	1	1	0	1	1	0	1	64/32	6D0000–6DFFFF	368000–36FFFF
SA110	0	1	1	0	1	1	1	0	64/32	6E0000–6EFFFF	370000–377FFF
SA111	0	1	1	0	1	1	1	1	64/32	6F0000–6FFFFF	378000–37FFFF
SA112	0	1	1	1	0	0	0	0	64/32	700000–70FFFF	380000–387FFF
SA113	0	1	1	1	0	0	0	1	64/32	710000–71FFFF	388000–38FFFF
SA114	0	1	1	1	0	0	1	0	64/32	720000–72FFFF	390000–397FFF
SA115	0	1	1	1	0	0	1	1	64/32	730000–73FFFF	398000–39FFFF
SA116	0	1	1	1	0	1	0	0	64/32	740000–74FFFF	3A0000–3A7FFF
SA117	0	1	1	1	0	1	0	1	64/32	750000–75FFFF	3A8000–3AFFFF
SA118	0	1	1	1	0	1	1	0	64/32	760000–76FFFF	3B0000–3B7FFF
SA119	0	1	1	1	0	1	1	1	64/32	770000–77FFFF	3B8000–3BFFFF
SA120	0	1	1	1	1	0	0	0	64/32	780000–78FFFF	3C0000–3C7FFF
SA121	0	1	1	1	1	0	0	1	64/32	790000–79FFFF	3C8000–3CFFFF
SA122	0	1	1	1	1	0	1	0	64/32	7A0000–7AFFFF	3D0000–3D7FFF
SA123	0	1	1	1	1	0	1	1	64/32	7B0000–7BFFFF	3D8000–3DFFFF
SA124	0	1	1	1	1	1	0	0	64/32	7C0000–7CFFFF	3E0000–3E7FFF
SA125	0	1	1	1	1	1	0	1	64/32	7D0000–7DFFFF	3E8000–3EFFFF
SA126	0	1	1	1	1	1	1	0	64/32	7E0000–7EFFFF	3F0000–3F7FFF
SA127	0	1	1	1	1	1	1	1	64/32	7F0000–7FFFFF	3F8000–3FFFFF
SA128	1	0	0	0	0	0	0	0	64/32	800000–80FFFF	400000–407FFF
SA129	1	0	0	0	0	0	0	1	64/32	810000–81FFFF	408000–40FFFF
SA130	1	0	0	0	0	0	1	0	64/32	820000–82FFFF	410000–417FFF
SA131	1	0	0	0	0	0	1	1	64/32	830000–83FFFF	418000–41FFFF
SA132	1	0	0	0	0	1	0	0	64/32	840000–84FFFF	420000–427FFF
SA133	1	0	0	0	0	1	0	1	64/32	850000–85FFFF	428000–42FFFF
SA134	1	0	0	0	0	1	1	0	64/32	860000–86FFFF	430000–437FFF

Table 16. S29GL128M Sector Address Table (Continued)

Sector	A22–A15								Sector Size (Kbytes/ Kwords)	8-bit Address Range (in hexadecimal)	16-bit Address Range (in hexadecimal)
SA135	1	0	0	0	0	1	1	1	64/32	870000–87FFFF	438000–43FFFF
SA136	1	0	0	0	1	0	0	0	64/32	880000–88FFFF	440000–447FFF
SA137	1	0	0	0	1	0	0	1	64/32	890000–89FFFF	448000–44FFFF
SA138	1	0	0	0	1	0	1	0	64/32	8A0000–8AFFFF	450000–457FFF
SA139	1	0	0	0	1	0	1	1	64/32	8B0000–8BFFFF	458000–45FFFF
SA140	1	0	0	0	1	1	0	0	64/32	8C0000–8CFFFF	460000–467FFF
SA141	1	0	0	0	1	1	0	1	64/32	8D0000–8DFFFF	468000–46FFFF
SA142	1	0	0	0	1	1	1	0	64/32	8E0000–8EFFFF	470000–477FFF
SA143	1	0	0	0	1	1	1	1	64/32	8F0000–8FFFFF	478000–47FFFF
SA144	1	0	0	1	0	0	0	0	64/32	900000–90FFFF	480000–487FFF
SA145	1	0	0	1	0	0	0	1	64/32	910000–91FFFF	488000–48FFFF
SA146	1	0	0	1	0	0	1	0	64/32	920000–92FFFF	490000–497FFF
SA147	1	0	0	1	0	0	1	1	64/32	930000–93FFFF	498000–49FFFF
SA148	1	0	0	1	0	1	0	0	64/32	940000–94FFFF	4A0000–4A7FFF
SA149	1	0	0	1	0	1	0	1	64/32	950000–95FFFF	4A8000–4AFFFF
SA150	1	0	0	1	0	1	1	0	64/32	960000–96FFFF	4B0000–4B7FFF
SA151	1	0	0	1	0	1	1	1	64/32	970000–97FFFF	4B8000–4BFFFF
SA152	1	0	0	1	1	0	0	0	64/32	980000–98FFFF	4C0000–4C7FFF
SA153	1	0	0	1	1	0	0	1	64/32	990000–99FFFF	4C8000–4CFFFF
SA154	1	0	0	1	1	0	1	0	64/32	9A0000–9AFFFF	4D0000–4D7FFF
SA155	1	0	0	1	1	0	1	1	64/32	9B0000–9BFFFF	4D8000–4DFFFF
SA156	1	0	0	1	1	1	0	0	64/32	9C0000–9CFFFF	4E0000–4E7FFF
SA157	1	0	0	1	1	1	0	1	64/32	9D0000–9DFFFF	4E8000–4EFFFF
SA158	1	0	0	1	1	1	1	0	64/32	9E0000–9EFFFF	4F0000–4F7FFF
SA159	1	0	0	1	1	1	1	1	64/32	9F0000–9FFFFF	4F8000–4FFFFF
SA160	1	0	1	0	0	0	0	0	64/32	A00000–A0FFFF	500000–507FFF
SA161	1	0	1	0	0	0	0	1	64/32	A10000–A1FFFF	508000–50FFFF
SA162	1	0	1	0	0	0	1	0	64/32	A20000–A2FFFF	510000–517FFF
SA163	1	0	1	0	0	0	1	1	64/32	A30000–A3FFFF	518000–51FFFF
SA164	1	0	1	0	0	1	0	0	64/32	A40000–A4FFFF	520000–527FFF
SA165	1	0	1	0	0	1	0	1	64/32	A50000–A5FFFF	528000–52FFFF
SA166	1	0	1	0	0	1	1	0	64/32	A60000–A6FFFF	530000–537FFF
SA167	1	0	1	0	0	1	1	1	64/32	A70000–A7FFFF	538000–53FFFF
SA168	1	0	1	0	1	0	0	0	64/32	A80000–A8FFFF	540000–547FFF
SA169	1	0	1	0	1	0	0	1	64/32	A90000–A9FFFF	548000–54FFFF
SA170	1	0	1	0	1	0	1	0	64/32	AA0000–AAFFFF	550000–557FFF
SA171	1	0	1	0	1	0	1	1	64/32	AB0000–ABFFFF	558000–55FFFF
SA172	1	0	1	0	1	1	0	0	64/32	AC0000–ACFFFF	560000–567FFF
SA173	1	0	1	0	1	1	0	1	64/32	AD0000–ADFFFF	568000–56FFFF
SA174	1	0	1	0	1	1	1	0	64/32	AE0000–AEFFFF	570000–577FFF
SA175	1	0	1	0	1	1	1	1	64/32	AF0000–AFFFFF	578000–57FFFF
SA176	1	0	1	1	0	0	0	0	64/32	B00000–B0FFFF	580000–587FFF
SA177	1	0	1	1	0	0	0	1	64/32	B10000–B1FFFF	588000–58FFFF
SA178	1	0	1	1	0	0	1	0	64/32	B20000–B2FFFF	590000–597FFF
SA179	1	0	1	1	0	0	1	1	64/32	B30000–B3FFFF	598000–59FFFF

Table 16. S29GL128M Sector Address Table (Continued)

Sector	A22–A15								Sector Size (Kbytes/ Kwords)	8-bit Address Range (in hexadecimal)	16-bit Address Range (in hexadecimal)
SA180	1	0	1	1	0	1	0	0	64/32	B40000–B4FFFF	5A0000–5A7FFF
SA181	1	0	1	1	0	1	0	1	64/32	B50000–B5FFFF	5A8000–5AFFFF
SA182	1	0	1	1	0	1	1	0	64/32	B60000–B6FFFF	5B0000–5B7FFF
SA183	1	0	1	1	0	1	1	1	64/32	B70000–B7FFFF	5B8000–5BFFFF
SA184	1	0	1	1	1	0	0	0	64/32	B80000–B8FFFF	5C0000–5C7FFF
SA185	1	0	1	1	1	0	0	1	64/32	B90000–B9FFFF	5C8000–5CFFFF
SA186	1	0	1	1	1	0	1	0	64/32	BA0000–BAFFFF	5D0000–5D7FFF
SA187	1	0	1	1	1	0	1	1	64/32	BB0000–BBFFFF	5D8000–5DFFFF
SA188	1	0	1	1	1	1	0	0	64/32	BC0000–BCFFFF	5E0000–5E7FFF
SA189	1	0	1	1	1	1	0	1	64/32	BD0000–BDFFFF	5E8000–5EFFFF
SA190	1	0	1	1	1	1	1	0	64/32	BE0000–BEFFFF	5F0000–5F7FFF
SA191	1	0	1	1	1	1	1	1	64/32	BF0000–BFFFFF	5F8000–5FFFFF
SA192	1	1	0	0	0	0	0	0	64/32	C00000–C0FFFF	600000–607FFF
SA193	1	1	0	0	0	0	0	1	64/32	C10000–C1FFFF	608000–60FFFF
SA194	1	1	0	0	0	0	1	0	64/32	C20000–C2FFFF	610000–617FFF
SA195	1	1	0	0	0	0	1	1	64/32	C30000–C3FFFF	618000–61FFFF
SA196	1	1	0	0	0	1	0	0	64/32	C40000–C4FFFF	620000–627FFF
SA197	1	1	0	0	0	1	0	1	64/32	C50000–C5FFFF	628000–62FFFF
SA198	1	1	0	0	0	1	1	0	64/32	C60000–C6FFFF	630000–637FFF
SA199	1	1	0	0	0	1	1	1	64/32	C70000–C7FFFF	638000–63FFFF
SA200	1	1	0	0	1	0	0	0	64/32	C80000–C8FFFF	640000–647FFF
SA201	1	1	0	0	1	0	0	1	64/32	C90000–C9FFFF	648000–64FFFF
SA202	1	1	0	0	1	0	1	0	64/32	CA0000–CAFFFF	650000–657FFF
SA203	1	1	0	0	1	0	1	1	64/32	CB0000–CBFFFF	658000–65FFFF
SA204	1	1	0	0	1	1	0	0	64/32	CC0000–CCFFFF	660000–667FFF
SA205	1	1	0	0	1	1	0	1	64/32	CD0000–CDFFFF	668000–66FFFF
SA206	1	1	0	0	1	1	1	0	64/32	CE0000–CEFFFF	670000–677FFF
SA207	1	1	0	0	1	1	1	1	64/32	CF0000–CFFFFF	678000–67FFFF
SA208	1	1	0	1	0	0	0	0	64/32	D00000–D0FFFF	680000–687FFF
SA209	1	1	0	1	0	0	0	1	64/32	D10000–D1FFFF	688000–68FFFF
SA210	1	1	0	1	0	0	1	0	64/32	D20000–D2FFFF	690000–697FFF
SA211	1	1	0	1	0	0	1	1	64/32	D30000–D3FFFF	698000–69FFFF
SA212	1	1	0	1	0	1	0	0	64/32	D40000–D4FFFF	6A0000–6A7FFF
SA213	1	1	0	1	0	1	0	1	64/32	D50000–D5FFFF	6A8000–6AFFFF
SA214	1	1	0	1	0	1	1	0	64/32	D60000–D6FFFF	6B0000–6B7FFF
SA215	1	1	0	1	0	1	1	1	64/32	D70000–D7FFFF	6B8000–6BFFFF
SA216	1	1	0	1	1	0	0	0	64/32	D80000–D8FFFF	6C0000–6C7FFF
SA217	1	1	0	1	1	0	0	1	64/32	D90000–D9FFFF	6C8000–6CFFFF
SA218	1	1	0	1	1	0	1	0	64/32	DA0000–DAFFFF	6D0000–6D7FFF
SA219	1	1	0	1	1	0	1	1	64/32	DB0000–DBFFFF	6D8000–6DFFFF
SA220	1	1	0	1	1	1	0	0	64/32	DC0000–DCFFFF	6E0000–6E7FFF
SA221	1	1	0	1	1	1	0	1	64/32	DD0000–DDFFFF	6E8000–6EFFFF
SA222	1	1	0	1	1	1	1	0	64/32	DE0000–DEFFFF	6F0000–6F7FFF
SA223	1	1	0	1	1	1	1	1	64/32	DF0000–DFFFFF	6F8000–6FFFFF
SA224	1	1	1	0	0	0	0	0	64/32	E00000–E0FFFF	700000–707FFF

Table 16. S29GL128M Sector Address Table (Continued)

Sector	A22–A15								Sector Size (Kbytes/ Kwords)	8-bit Address Range (in hexadecimal)	16-bit Address Range (in hexadecimal)
SA225	1	1	1	0	0	0	0	1	64/32	E10000–E1FFFF	708000–70FFFF
SA226	1	1	1	0	0	0	1	0	64/32	E20000–E2FFFF	710000–717FFF
SA227	1	1	1	0	0	0	1	1	64/32	E30000–E3FFFF	718000–71FFFF
SA228	1	1	1	0	0	1	0	0	64/32	E40000–E4FFFF	720000–727FFF
SA229	1	1	1	0	0	1	0	1	64/32	E50000–E5FFFF	728000–72FFFF
SA230	1	1	1	0	0	1	1	0	64/32	E60000–E6FFFF	730000–737FFF
SA231	1	1	1	0	0	1	1	1	64/32	E70000–E7FFFF	738000–73FFFF
SA232	1	1	1	0	1	0	0	0	64/32	E80000–E8FFFF	740000–747FFF
SA233	1	1	1	0	1	0	0	1	64/32	E90000–E9FFFF	748000–74FFFF
SA234	1	1	1	0	1	0	1	0	64/32	EA0000–EAFFFF	750000–757FFF
SA235	1	1	1	0	1	0	1	1	64/32	EB0000–EBFFFF	758000–75FFFF
SA236	1	1	1	0	1	1	0	0	64/32	EC0000–ECFFFF	760000–767FFF
SA237	1	1	1	0	1	1	0	1	64/32	ED0000–EDFFFF	768000–76FFFF
SA238	1	1	1	0	1	1	1	0	64/32	EE0000–EEFFFF	770000–777FFF
SA239	1	1	1	0	1	1	1	1	64/32	EF0000–EFFFFF	778000–77FFFF
SA240	1	1	1	1	0	0	0	0	64/32	F00000–F0FFFF	780000–787FFF
SA241	1	1	1	1	0	0	0	1	64/32	F10000–F1FFFF	788000–78FFFF
SA242	1	1	1	1	0	0	1	0	64/32	F20000–F2FFFF	790000–797FFF
SA243	1	1	1	1	0	0	1	1	64/32	F30000–F3FFFF	798000–79FFFF
SA244	1	1	1	1	0	1	0	0	64/32	F40000–F4FFFF	7A0000–7A7FFF
SA245	1	1	1	1	0	1	0	1	64/32	F50000–F5FFFF	7A8000–7AFFFF
SA246	1	1	1	1	0	1	1	0	64/32	F60000–F6FFFF	7B0000–7B7FFF
SA247	1	1	1	1	0	1	1	1	64/32	F70000–F7FFFF	7B8000–7BFFFF
SA248	1	1	1	1	1	0	0	0	64/32	F80000–F8FFFF	7C0000–7C7FFF
SA249	1	1	1	1	1	0	0	1	64/32	F90000–F9FFFF	7C8000–7CFFFF
SA250	1	1	1	1	1	0	1	0	64/32	FA0000–FAFFFF	7D0000–7D7FFF
SA251	1	1	1	1	1	0	1	1	64/32	FB0000–FBFFFF	7D8000–7DFFFF
SA252	1	1	1	1	1	1	0	0	64/32	FC0000–FCFFFF	7E0000–7E7FFF
SA253	1	1	1	1	1	1	0	1	64/32	FD0000–FDFFFF	7E8000–7EFFFF
SA254	1	1	1	1	1	1	1	0	64/32	FE0000–FEFFFF	7F0000–7F7FFF
SA255	1	1	1	1	1	1	1	1	64/32	FF0000–FFFFFF	7F8000–7FFFFF

Table 17. S29GL256M Sector Address Table

Sector	A23–A15									Sector Size (Kbytes/ Kwords)	8-bit Address Range (in hexadecimal)	16-bit Address Range (in hexadecimal)
SA0	0	0	0	0	0	0	0	0	0	64/32	0000000–000FFFF	000000–007FFF
SA1	0	0	0	0	0	0	0	0	1	64/32	0010000–001FFFF	008000–00FFFF
SA2	0	0	0	0	0	0	0	1	0	64/32	0020000–002FFFF	010000–017FFF
SA3	0	0	0	0	0	0	0	1	1	64/32	0030000–003FFFF	018000–01FFFF
SA4	0	0	0	0	0	0	1	0	0	64/32	0040000–004FFFF	020000–027FFF
SA5	0	0	0	0	0	0	1	0	1	64/32	0050000–005FFFF	028000–02FFFF
SA6	0	0	0	0	0	0	1	1	0	64/32	0060000–006FFFF	030000–037FFF
SA7	0	0	0	0	0	0	1	1	1	64/32	0070000–007FFFF	038000–03FFFF
SA8	0	0	0	0	0	1	0	0	0	64/32	0080000–008FFFF	040000–047FFF
SA9	0	0	0	0	0	1	0	0	1	64/32	0090000–009FFFF	048000–04FFFF
SA10	0	0	0	0	0	1	0	1	0	64/32	00A0000–00AFFFF	050000–057FFF
SA11	0	0	0	0	0	1	0	1	1	64/32	00B0000–00BFFFF	058000–05FFFF
SA12	0	0	0	0	0	1	1	0	0	64/32	00C0000–00CFFFF	060000–067FFF
SA13	0	0	0	0	0	1	1	0	1	64/32	00D0000–00DFFFF	068000–06FFFF
SA14	0	0	0	0	0	1	1	1	0	64/32	00E0000–00EFFFF	070000–077FFF
SA15	0	0	0	0	0	1	1	1	1	64/32	00F0000–00FFFFF	078000–07FFFF
SA16	0	0	0	0	1	0	0	0	0	64/32	0100000–010FFFF	080000–087FFF
SA17	0	0	0	0	1	0	0	0	1	64/32	0110000–011FFFF	088000–08FFFF
SA18	0	0	0	0	1	0	0	1	0	64/32	0120000–012FFFF	090000–097FFF
SA19	0	0	0	0	1	0	0	1	1	64/32	0130000–013FFFF	098000–09FFFF
SA20	0	0	0	0	1	0	1	0	0	64/32	0140000–014FFFF	0A0000–0A7FFF
SA21	0	0	0	0	1	0	1	0	1	64/32	0150000–015FFFF	0A8000–0AFFFF
SA22	0	0	0	0	1	0	1	1	0	64/32	0160000–016FFFF	0B0000–0B7FFF
SA23	0	0	0	0	1	0	1	1	1	64/32	0170000–017FFFF	0B8000–0BFFFF
SA24	0	0	0	0	1	1	0	0	0	64/32	0180000–018FFFF	0C0000–0C7FFF
SA25	0	0	0	0	1	1	0	0	1	64/32	0190000–019FFFF	0C8000–0CFFFF
SA26	0	0	0	0	1	1	0	1	0	64/32	01A0000–01AFFFF	0D0000–0D7FFF
SA27	0	0	0	0	1	1	0	1	1	64/32	01B0000–01BFFFF	0D8000–0DFFFF
SA28	0	0	0	0	1	1	1	0	0	64/32	01C0000–01CFFFF	0E0000–0E7FFF
SA29	0	0	0	0	1	1	1	0	1	64/32	01D0000–01DFFFF	0E8000–0EFFFF
SA30	0	0	0	0	1	1	1	1	0	64/32	01E0000–01EFFFF	0F0000–0F7FFF
SA31	0	0	0	0	1	1	1	1	1	64/32	01F0000–01FFFFF	0F8000–0FFFFF
SA32	0	0	0	1	0	0	0	0	0	64/32	0200000–020FFFF	100000–107FFF
SA33	0	0	0	1	0	0	0	0	1	64/32	0210000–021FFFF	108000–10FFFF
SA34	0	0	0	1	0	0	0	1	0	64/32	0220000–022FFFF	110000–117FFF
SA35	0	0	0	1	0	0	0	1	1	64/32	0230000–023FFFF	118000–11FFFF
SA36	0	0	0	1	0	0	1	0	0	64/32	0240000–024FFFF	120000–127FFF
SA37	0	0	0	1	0	0	1	0	1	64/32	0250000–025FFFF	128000–12FFFF
SA38	0	0	0	1	0	0	1	1	0	64/32	0260000–026FFFF	130000–137FFF
SA39	0	0	0	1	0	0	1	1	1	64/32	0270000–027FFFF	138000–13FFFF
SA40	0	0	0	1	0	1	0	0	0	64/32	0280000–028FFFF	140000–147FFF
SA41	0	0	0	1	0	1	0	0	1	64/32	0290000–029FFFF	148000–14FFFF
SA42	0	0	0	1	0	1	0	1	0	64/32	02A0000–02AFFFF	150000–157FFF
SA43	0	0	0	1	0	1	0	1	1	64/32	02B0000–02BFFFF	158000–15FFFF
SA44	0	0	0	1	0	1	1	0	0	64/32	02C0000–02CFFFF	160000–167FFF

Table 17. S29GL256M Sector Address Table (Continued)

Sector	A23–A15									Sector Size (Kbytes/ Kwords)	8-bit Address Range (in hexadecimal)	16-bit Address Range (in hexadecimal)
SA45	0	0	0	1	0	1	1	0	1	64/32	02D0000–02DFFFF	168000–16FFFF
SA46	0	0	0	1	0	1	1	1	0	64/32	02E0000–02EFFFF	170000–177FFF
SA47	0	0	0	1	0	1	1	1	1	64/32	02F0000–02FFFFF	178000–17FFFF
SA48	0	0	0	1	1	0	0	0	0	64/32	0300000–030FFFF	180000–187FFF
SA49	0	0	0	1	1	0	0	0	1	64/32	0310000–031FFFF	188000–18FFFF
SA50	0	0	0	1	1	0	0	1	0	64/32	0320000–032FFFF	190000–197FFF
SA51	0	0	0	1	1	0	0	1	1	64/32	0330000–033FFFF	198000–19FFFF
SA52	0	0	0	1	1	0	1	0	0	64/32	0340000–034FFFF	1A0000–1A7FFF
SA53	0	0	0	1	1	0	1	0	1	64/32	0350000–035FFFF	1A8000–1AFFFF
SA54	0	0	0	1	1	0	1	1	0	64/32	0360000–036FFFF	1B0000–1B7FFF
SA55	0	0	0	1	1	0	1	1	1	64/32	0370000–037FFFF	1B8000–1BFFFF
SA56	0	0	0	1	1	1	0	0	0	64/32	0380000–038FFFF	1C0000–1C7FFF
SA57	0	0	0	1	1	1	0	0	1	64/32	0390000–039FFFF	1C8000–1CFFFF
SA58	0	0	0	1	1	1	0	1	0	64/32	03A0000–03AFFFF	1D0000–1D7FFF
SA59	0	0	0	1	1	1	0	1	1	64/32	03B0000–03BFFFF	1D8000–1DFFFF
SA60	0	0	0	1	1	1	1	0	0	64/32	03C0000–03CFFFF	1E0000–1E7FFF
SA61	0	0	0	1	1	1	1	0	1	64/32	03D0000–03DFFFF	1E8000–1EFFFF
SA62	0	0	0	1	1	1	1	1	0	64/32	03E0000–03EFFFF	1F0000–1F7FFF
SA63	0	0	0	1	1	1	1	1	1	64/32	03F0000–03FFFFF	1F8000–1FFFFF
SA64	0	0	1	0	0	0	0	0	0	64/32	0400000–040FFFF	200000–207FFF
SA65	0	0	1	0	0	0	0	0	1	64/32	0410000–041FFFF	208000–20FFFF
SA66	0	0	1	0	0	0	0	1	0	64/32	0420000–042FFFF	210000–217FFF
SA67	0	0	1	0	0	0	0	1	1	64/32	0430000–043FFFF	218000–21FFFF
SA68	0	0	1	0	0	0	1	0	0	64/32	0440000–044FFFF	220000–227FFF
SA69	0	0	1	0	0	0	1	0	1	64/32	0450000–045FFFF	228000–22FFFF
SA70	0	0	1	0	0	0	1	1	0	64/32	0460000–046FFFF	230000–237FFF
SA71	0	0	1	0	0	0	1	1	1	64/32	0470000–047FFFF	238000–23FFFF
SA72	0	0	1	0	0	1	0	0	0	64/32	0480000–048FFFF	240000–247FFF
SA73	0	0	1	0	0	1	0	0	1	64/32	0490000–049FFFF	248000–24FFFF
SA74	0	0	1	0	0	1	0	1	0	64/32	04A0000–04AFFFF	250000–257FFF
SA75	0	0	1	0	0	1	0	1	1	64/32	04B0000–04BFFFF	258000–25FFFF
SA76	0	0	1	0	0	1	1	0	0	64/32	04C0000–04CFFFF	260000–267FFF
SA77	0	0	1	0	0	1	1	0	1	64/32	04D0000–04DFFFF	268000–26FFFF
SA78	0	0	1	0	0	1	1	1	0	64/32	04E0000–04EFFFF	270000–277FFF
SA79	0	0	1	0	0	1	1	1	1	64/32	04F0000–04FFFFF	278000–27FFFF
SA80	0	0	1	0	1	0	0	0	0	64/32	0500000–050FFFF	280000–287FFF
SA81	0	0	1	0	1	0	0	0	1	64/32	0510000–051FFFF	288000–28FFFF
SA82	0	0	1	0	1	0	0	1	0	64/32	0520000–052FFFF	290000–297FFF
SA83	0	0	1	0	1	0	0	1	1	64/32	0530000–053FFFF	298000–29FFFF
SA84	0	0	1	0	1	0	1	0	0	64/32	0540000–054FFFF	2A0000–2A7FFF
SA85	0	0	1	0	1	0	1	0	1	64/32	0550000–055FFFF	2A8000–2AFFFF
SA86	0	0	1	0	1	0	1	1	0	64/32	0560000–056FFFF	2B0000–2B7FFF
SA87	0	0	1	0	1	0	1	1	1	64/32	0570000–057FFFF	2B8000–2BFFFF
SA88	0	0	1	0	1	1	0	0	0	64/32	0580000–058FFFF	2C0000–2C7FFF
SA89	0	0	1	0	1	1	0	0	1	64/32	0590000–059FFFF	2C8000–2CFFFF

Table 17. S29GL256M Sector Address Table (Continued)

Sector	A23–A15									Sector Size (Kbytes/ Kwords)	8-bit Address Range (in hexadecimal)	16-bit Address Range (in hexadecimal)
SA90	0	0	1	0	1	1	0	1	0	64/32	05A0000–05AFFFF	2D0000–2D7FFF
SA91	0	0	1	0	1	1	0	1	1	64/32	05B0000–05BFFFF	2D8000–2DFFFF
SA92	0	0	1	0	1	1	1	0	0	64/32	05C0000–05CFFFF	2E0000–2E7FFF
SA93	0	0	1	0	1	1	1	0	1	64/32	05D0000–05DFFFF	2E8000–2EFFFF
SA94	0	0	1	0	1	1	1	1	0	64/32	05E0000–05EFFFF	2F0000–2F7FFF
SA95	0	0	1	0	1	1	1	1	1	64/32	05F0000–05FFFFF	2F8000–2FFFFF
SA96	0	0	1	1	0	0	0	0	0	64/32	0600000–060FFFF	300000–307FFF
SA97	0	0	1	1	0	0	0	0	1	64/32	0610000–061FFFF	308000–30FFFF
SA98	0	0	1	1	0	0	0	1	0	64/32	0620000–062FFFF	310000–317FFF
SA99	0	0	1	1	0	0	0	1	1	64/32	0630000–063FFFF	318000–31FFFF
SA100	0	0	1	1	0	0	1	0	0	64/32	0640000–064FFFF	320000–327FFF
SA101	0	0	1	1	0	0	1	0	1	64/32	0650000–065FFFF	328000–32FFFF
SA102	0	0	1	1	0	0	1	1	0	64/32	0660000–066FFFF	330000–337FFF
SA103	0	0	1	1	0	0	1	1	1	64/32	0670000–067FFFF	338000–33FFFF
SA104	0	0	1	1	0	1	0	0	0	64/32	0680000–068FFFF	340000–347FFF
SA105	0	0	1	1	0	1	0	0	1	64/32	0690000–069FFFF	348000–34FFFF
SA106	0	0	1	1	0	1	0	1	0	64/32	06A0000–06AFFFF	350000–357FFF
SA107	0	0	1	1	0	1	0	1	1	64/32	06B0000–06BFFFF	358000–35FFFF
SA108	0	0	1	1	0	1	1	0	0	64/32	06C0000–06CFFFF	360000–367FFF
SA109	0	0	1	1	0	1	1	0	1	64/32	06D0000–06DFFFF	368000–36FFFF
SA110	0	0	1	1	0	1	1	1	0	64/32	06E0000–06EFFFF	370000–377FFF
SA111	0	0	1	1	0	1	1	1	1	64/32	06F0000–06FFFFF	378000–37FFFF
SA112	0	0	1	1	1	0	0	0	0	64/32	0700000–070FFFF	380000–387FFF
SA113	0	0	1	1	1	0	0	0	1	64/32	0710000–071FFFF	388000–38FFFF
SA114	0	0	1	1	1	0	0	1	0	64/32	0720000–072FFFF	390000–397FFF
SA115	0	0	1	1	1	0	0	1	1	64/32	0730000–073FFFF	398000–39FFFF
SA116	0	0	1	1	1	0	1	0	0	64/32	0740000–074FFFF	3A0000–3A7FFF
SA117	0	0	1	1	1	0	1	0	1	64/32	0750000–075FFFF	3A8000–3AFFFF
SA118	0	0	1	1	1	0	1	1	0	64/32	0760000–076FFFF	3B0000–3B7FFF
SA119	0	0	1	1	1	0	1	1	1	64/32	0770000–077FFFF	3B8000–3BFFFF
SA120	0	0	1	1	1	1	0	0	0	64/32	0780000–078FFFF	3C0000–3C7FFF
SA121	0	0	1	1	1	1	0	0	1	64/32	0790000–079FFFF	3C8000–3CFFFF
SA122	0	0	1	1	1	1	0	1	0	64/32	07A0000–07AFFFF	3D0000–3D7FFF
SA123	0	0	1	1	1	1	0	1	1	64/32	07B0000–07BFFFF	3D8000–3DFFFF
SA124	0	0	1	1	1	1	1	0	0	64/32	07C0000–07CFFFF	3E0000–3E7FFF
SA125	0	0	1	1	1	1	1	0	1	64/32	07D0000–07DFFFF	3E8000–3EFFFF
SA126	0	0	1	1	1	1	1	1	0	64/32	07E0000–07EFFFF	3F0000–3F7FFF
SA127	0	0	1	1	1	1	1	1	1	64/32	07F0000–07FFFFF	3F8000–3FFFFF
SA128	0	1	0	0	0	0	0	0	0	64/32	0800000–080FFFF	400000–407FFF
SA129	0	1	0	0	0	0	0	0	1	64/32	0810000–081FFFF	408000–40FFFF
SA130	0	1	0	0	0	0	0	1	0	64/32	0820000–082FFFF	410000–417FFF
SA131	0	1	0	0	0	0	0	1	1	64/32	0830000–083FFFF	418000–41FFFF
SA132	0	1	0	0	0	0	1	0	0	64/32	0840000–084FFFF	420000–427FFF
SA133	0	1	0	0	0	0	1	0	1	64/32	0850000–085FFFF	428000–42FFFF
SA134	0	1	0	0	0	0	1	1	0	64/32	0860000–086FFFF	430000–437FFF

Table 17. S29GL256M Sector Address Table (Continued)

Sector	A23–A15									Sector Size (Kbytes/ Kwords)	8-bit Address Range (in hexadecimal)	16-bit Address Range (in hexadecimal)
SA135	0	1	0	0	0	0	1	1	1	64/32	0870000–087FFFF	438000–43FFFF
SA136	0	1	0	0	0	1	0	0	0	64/32	0880000–088FFFF	440000–447FFF
SA137	0	1	0	0	0	1	0	0	1	64/32	0890000–089FFFF	448000–44FFFF
SA138	0	1	0	0	0	1	0	1	0	64/32	08A0000–08AFFFF	450000–457FFF
SA139	0	1	0	0	0	1	0	1	1	64/32	08B0000–08BFFFF	458000–45FFFF
SA140	0	1	0	0	0	1	1	0	0	64/32	08C0000–08CFFFF	460000–467FFF
SA141	0	1	0	0	0	1	1	0	1	64/32	08D0000–08DFFFF	468000–46FFFF
SA142	0	1	0	0	0	1	1	1	0	64/32	08E0000–08EFFFF	470000–477FFF
SA143	0	1	0	0	0	1	1	1	1	64/32	08F0000–08FFFFF	478000–47FFFF
SA144	0	1	0	0	1	0	0	0	0	64/32	0900000–090FFFF	480000–487FFF
SA145	0	1	0	0	1	0	0	0	1	64/32	0910000–091FFFF	488000–48FFFF
SA146	0	1	0	0	1	0	0	1	0	64/32	0920000–092FFFF	490000–497FFF
SA147	0	1	0	0	1	0	0	1	1	64/32	0930000–093FFFF	498000–49FFFF
SA148	0	1	0	0	1	0	1	0	0	64/32	0940000–094FFFF	4A0000–4A7FFF
SA149	0	1	0	0	1	0	1	0	1	64/32	0950000–095FFFF	4A8000–4AFFFF
SA150	0	1	0	0	1	0	1	1	0	64/32	0960000–096FFFF	4B0000–4B7FFF
SA151	0	1	0	0	1	0	1	1	1	64/32	0970000–097FFFF	4B8000–4BFFFF
SA152	0	1	0	0	1	1	0	0	0	64/32	0980000–098FFFF	4C0000–4C7FFF
SA153	0	1	0	0	1	1	0	0	1	64/32	0990000–099FFFF	4C8000–4CFFFF
SA154	0	1	0	0	1	1	0	1	0	64/32	09A0000–09AFFFF	4D0000–4D7FFF
SA155	0	1	0	0	1	1	0	1	1	64/32	09B0000–09BFFFF	4D8000–4DFFFF
SA156	0	1	0	0	1	1	1	0	0	64/32	09C0000–09CFFFF	4E0000–4E7FFF
SA157	0	1	0	0	1	1	1	0	1	64/32	09D0000–09DFFFF	4E8000–4EFFFF
SA158	0	1	0	0	1	1	1	1	0	64/32	09E0000–09EFFFF	4F0000–4F7FFF
SA159	0	1	0	0	1	1	1	1	1	64/32	09F0000–09FFFFF	4F8000–4FFFFF
SA160	0	1	0	1	0	0	0	0	0	64/32	0A00000–0A0FFFF	500000–507FFF
SA161	0	1	0	1	0	0	0	0	1	64/32	0A10000–0A1FFFF	508000–50FFFF
SA162	0	1	0	1	0	0	0	1	0	64/32	0A20000–0A2FFFF	510000–517FFF
SA163	0	1	0	1	0	0	0	1	1	64/32	0A30000–0A3FFFF	518000–51FFFF
SA164	0	1	0	1	0	0	1	0	0	64/32	0A40000–0A4FFFF	520000–527FFF
SA165	0	1	0	1	0	0	1	0	1	64/32	0A50000–0A5FFFF	528000–52FFFF
SA166	0	1	0	1	0	0	1	1	0	64/32	0A60000–0A6FFFF	530000–537FFF
SA167	0	1	0	1	0	0	1	1	1	64/32	0A70000–0A7FFFF	538000–53FFFF
SA168	0	1	0	1	0	1	0	0	0	64/32	0A80000–0A8FFFF	540000–547FFF
SA169	0	1	0	1	0	1	0	0	1	64/32	0A90000–0A9FFFF	548000–54FFFF
SA170	0	1	0	1	0	1	0	1	0	64/32	0AA0000–0AAFFFF	550000–557FFF
SA171	0	1	0	1	0	1	0	1	1	64/32	0AB0000–0ABFFFF	558000–55FFFF
SA172	0	1	0	1	0	1	1	0	0	64/32	0AC0000–0ACFFFF	560000–567FFF
SA173	0	1	0	1	0	1	1	0	1	64/32	0AD0000–0ADFFFF	568000–56FFFF
SA174	0	1	0	1	0	1	1	1	0	64/32	0AE0000–0AEFFFF	570000–577FFF
SA175	0	1	0	1	0	1	1	1	1	64/32	0AF0000–0AFFFFF	578000–57FFFF
SA176	0	1	0	1	1	0	0	0	0	64/32	0B00000–0B0FFFF	580000–587FFF
SA177	0	1	0	1	1	0	0	0	1	64/32	0B10000–0B1FFFF	588000–58FFFF
SA178	0	1	0	1	1	0	0	1	0	64/32	0B20000–0B2FFFF	590000–597FFF
SA179	0	1	0	1	1	0	0	1	1	64/32	0B30000–0B3FFFF	598000–59FFFF

Table 17. S29GL256M Sector Address Table (Continued)

Sector	A23–A15									Sector Size (Kbytes/ Kwords)	8-bit Address Range (in hexadecimal)	16-bit Address Range (in hexadecimal)
SA180	0	1	0	1	1	0	1	0	0	64/32	0B40000–0B4FFFF	5A0000–5A7FFF
SA181	0	1	0	1	1	0	1	0	1	64/32	0B50000–0B5FFFF	5A8000–5AFFFF
SA182	0	1	0	1	1	0	1	1	0	64/32	0B60000–0B6FFFF	5B0000–5B7FFF
SA183	0	1	0	1	1	0	1	1	1	64/32	0B70000–0B7FFFF	5B8000–5BFFFF
SA184	0	1	0	1	1	1	0	0	0	64/32	0B80000–0B8FFFF	5C0000–5C7FFF
SA185	0	1	0	1	1	1	0	0	1	64/32	0B90000–0B9FFFF	5C8000–5CFFFF
SA186	0	1	0	1	1	1	0	1	0	64/32	0BA0000–0BAFFFF	5D0000–5D7FFF
SA187	0	1	0	1	1	1	0	1	1	64/32	0BB0000–0BBFFFF	5D8000–5DFFFF
SA188	0	1	0	1	1	1	1	0	0	64/32	0BC0000–0BCFFFF	5E0000–5E7FFF
SA189	0	1	0	1	1	1	1	0	1	64/32	0BD0000–0BDFFFF	5E8000–5EFFFF
SA190	0	1	0	1	1	1	1	1	0	64/32	0BE0000–0BEFFFF	5F0000–5F7FFF
SA191	0	1	0	1	1	1	1	1	1	64/32	0BF0000–0BFFFFF	5F8000–5FFFFF
SA192	0	1	1	0	0	0	0	0	0	64/32	0C00000–0C0FFFF	600000–607FFF
SA193	0	1	1	0	0	0	0	0	1	64/32	0C10000–0C1FFFF	608000–60FFFF
SA194	0	1	1	0	0	0	0	1	0	64/32	0C20000–0C2FFFF	610000–617FFF
SA195	0	1	1	0	0	0	0	1	1	64/32	0C30000–0C3FFFF	618000–61FFFF
SA196	0	1	1	0	0	0	1	0	0	64/32	0C40000–0C4FFFF	620000–627FFF
SA197	0	1	1	0	0	0	1	0	1	64/32	0C50000–0C5FFFF	628000–62FFFF
SA198	0	1	1	0	0	0	1	1	0	64/32	0C60000–0C6FFFF	630000–637FFF
SA199	0	1	1	0	0	0	1	1	1	64/32	0C70000–0C7FFFF	638000–63FFFF
SA200	0	1	1	0	0	1	0	0	0	64/32	0C80000–0C8FFFF	640000–647FFF
SA201	0	1	1	0	0	1	0	0	1	64/32	0C90000–0C9FFFF	648000–64FFFF
SA202	0	1	1	0	0	1	0	1	0	64/32	0CA0000–0CAFFFF	650000–657FFF
SA203	0	1	1	0	0	1	0	1	1	64/32	0CB0000–0CBFFFF	658000–65FFFF
SA204	0	1	1	0	0	1	1	0	0	64/32	0CC0000–0CCFFFF	660000–667FFF
SA205	0	1	1	0	0	1	1	0	1	64/32	0CD0000–0CDFFFF	668000–66FFFF
SA206	0	1	1	0	0	1	1	1	0	64/32	0CE0000–0CEFFFF	670000–677FFF
SA207	0	1	1	0	0	1	1	1	1	64/32	0CF0000–0CFFFFF	678000–67FFFF
SA208	0	1	1	0	1	0	0	0	0	64/32	0D00000–0D0FFFF	680000–687FFF
SA209	0	1	1	0	1	0	0	0	1	64/32	0D10000–0D1FFFF	688000–68FFFF
SA210	0	1	1	0	1	0	0	1	0	64/32	0D20000–0D2FFFF	690000–697FFF
SA211	0	1	1	0	1	0	0	1	1	64/32	0D30000–0D3FFFF	698000–69FFFF
SA212	0	1	1	0	1	0	1	0	0	64/32	0D40000–0D4FFFF	6A0000–6A7FFF
SA213	0	1	1	0	1	0	1	0	1	64/32	0D50000–0D5FFFF	6A8000–6AFFFF
SA214	0	1	1	0	1	0	1	1	0	64/32	0D60000–0D6FFFF	6B0000–6B7FFF
SA215	0	1	1	0	1	0	1	1	1	64/32	0D70000–0D7FFFF	6B8000–6BFFFF
SA216	0	1	1	0	1	1	0	0	0	64/32	0D80000–0D8FFFF	6C0000–6C7FFF
SA217	0	1	1	0	1	1	0	0	1	64/32	0D90000–0D9FFFF	6C8000–6CFFFF
SA218	0	1	1	0	1	1	0	1	0	64/32	0DA0000–0DAFFFF	6D0000–6D7FFF
SA219	0	1	1	0	1	1	0	1	1	64/32	0DB0000–0DBFFFF	6D8000–6DFFFF
SA220	0	1	1	0	1	1	1	0	0	64/32	0DC0000–0DCFFFF	6E0000–6E7FFF
SA221	0	1	1	0	1	1	1	0	1	64/32	0DD0000–0DDFFFF	6E8000–6EFFFF
SA222	0	1	1	0	1	1	1	1	0	64/32	0DE0000–0DEFFFF	6F0000–6F7FFF
SA223	0	1	1	0	1	1	1	1	1	64/32	0DF0000–0DFFFFF	6F8000–6FFFFF
SA224	0	1	1	1	0	0	0	0	0	64/32	0E00000–0E0FFFF	700000–707FFF

Table 17. S29GL256M Sector Address Table (Continued)

Sector	A23–A15									Sector Size (Kbytes/ Kwords)	8-bit Address Range (in hexadecimal)	16-bit Address Range (in hexadecimal)
SA225	0	1	1	1	0	0	0	0	1	64/32	0E10000–0E1FFFF	708000–70FFFF
SA226	0	1	1	1	0	0	0	1	0	64/32	0E20000–0E2FFFF	710000–717FFF
SA227	0	1	1	1	0	0	0	1	1	64/32	0E30000–0E3FFFF	718000–71FFFF
SA228	0	1	1	1	0	0	1	0	0	64/32	0E40000–0E4FFFF	720000–727FFF
SA229	0	1	1	1	0	0	1	0	1	64/32	0E50000–0E5FFFF	728000–72FFFF
SA230	0	1	1	1	0	0	1	1	0	64/32	0E60000–0E6FFFF	730000–737FFF
SA231	0	1	1	1	0	0	1	1	1	64/32	0E70000–0E7FFFF	738000–73FFFF
SA232	0	1	1	1	0	1	0	0	0	64/32	0E80000–0E8FFFF	740000–747FFF
SA233	0	1	1	1	0	1	0	0	1	64/32	0E90000–0E9FFFF	748000–74FFFF
SA234	0	1	1	1	0	1	0	1	0	64/32	0EA0000–0EAFFFF	750000–757FFF
SA235	0	1	1	1	0	1	0	1	1	64/32	0EB0000–0EBFFFF	758000–75FFFF
SA236	0	1	1	1	0	1	1	0	0	64/32	0EC0000–0ECFFFF	760000–767FFF
SA237	0	1	1	1	0	1	1	0	1	64/32	0ED0000–0EDFFFF	768000–76FFFF
SA238	0	1	1	1	0	1	1	1	0	64/32	0EE0000–0EEFFFF	770000–777FFF
SA239	0	1	1	1	0	1	1	1	1	64/32	0EF0000–0EFFFFF	778000–77FFFF
SA240	0	1	1	1	1	0	0	0	0	64/32	0F00000–0F0FFFF	780000–787FFF
SA241	0	1	1	1	1	0	0	0	1	64/32	0F10000–0F1FFFF	788000–78FFFF
SA242	0	1	1	1	1	0	0	1	0	64/32	0F20000–0F2FFFF	790000–797FFF
SA243	0	1	1	1	1	0	0	1	1	64/32	0F30000–0F3FFFF	798000–79FFFF
SA244	0	1	1	1	1	0	1	0	0	64/32	0F40000–0F4FFFF	7A0000–7A7FFF
SA245	0	1	1	1	1	0	1	0	1	64/32	0F50000–0F5FFFF	7A8000–7AFFFF
SA246	0	1	1	1	1	0	1	1	0	64/32	0F60000–0F6FFFF	7B0000–7B7FFF
SA247	0	1	1	1	1	0	1	1	1	64/32	0F70000–0F7FFFF	7B8000–7BFFFF
SA248	0	1	1	1	1	1	0	0	0	64/32	0F80000–0F8FFFF	7C0000–7C7FFF
SA249	0	1	1	1	1	1	0	0	1	64/32	0F90000–0F9FFFF	7C8000–7CFFFF
SA250	0	1	1	1	1	1	0	1	0	64/32	0FA0000–0FAFFFF	7D0000–7D7FFF
SA251	0	1	1	1	1	1	0	1	1	64/32	0FB0000–0FBFFFF	7D8000–7DFFFF
SA252	0	1	1	1	1	1	1	0	0	64/32	0FC0000–0FCFFFF	7E0000–7E7FFF
SA253	0	1	1	1	1	1	1	0	1	64/32	0FD0000–0FDFFFF	7E8000–7EFFFF
SA254	0	1	1	1	1	1	1	1	0	64/32	0FE0000–0FEFFFF	7F0000–7F7FFF
SA255	0	1	1	1	1	1	1	1	1	64/32	0FF0000–0FFFFFF	7F8000–7FFFFF
SA256	1	0	0	0	0	0	0	0	0	64/32	1000000–100FFFF	800000–807FFF
SA257	1	0	0	0	0	0	0	0	1	64/32	1010000–101FFFF	808000–80FFFF
SA258	1	0	0	0	0	0	0	1	0	64/32	1020000–102FFFF	810000–817FFF
SA259	1	0	0	0	0	0	0	1	1	64/32	1030000–103FFFF	818000–81FFFF
SA260	1	0	0	0	0	0	1	0	0	64/32	1040000–104FFFF	820000–827FFF
SA261	1	0	0	0	0	0	1	0	1	64/32	1050000–105FFFF	828000–82FFFF
SA262	1	0	0	0	0	0	1	1	0	64/32	1060000–106FFFF	830000–837FFF
SA263	1	0	0	0	0	0	1	1	1	64/32	1070000–107FFFF	838000–83FFFF
SA264	1	0	0	0	0	1	0	0	0	64/32	1080000–108FFFF	840000–847FFF
SA265	1	0	0	0	0	1	0	0	1	64/32	1090000–109FFFF	848000–84FFFF
SA266	1	0	0	0	0	1	0	1	0	64/32	10A0000–10AFFFF	850000–857FFF
SA267	1	0	0	0	0	1	0	1	1	64/32	10B0000–10BFFFF	858000–85FFFF
SA268	1	0	0	0	0	1	1	0	0	64/32	10C0000–10CFFFF	860000–867FFF
SA269	1	0	0	0	0	1	1	0	1	64/32	10D0000–10DFFFF	868000–86FFFF

Table 17. S29GL256M Sector Address Table (Continued)

Sector	A23–A15									Sector Size (Kbytes/ Kwords)	8-bit Address Range (in hexadecimal)	16-bit Address Range (in hexadecimal)
SA270	1	0	0	0	0	1	1	1	0	64/32	10E0000–10EFFFF	870000–877FFF
SA271	1	0	0	0	0	1	1	1	1	64/32	10F0000–10FFFFF	878000–87FFFF
SA272	1	0	0	0	1	0	0	0	0	64/32	1100000–110FFFF	880000–887FFF
SA273	1	0	0	0	1	0	0	0	1	64/32	1110000–111FFFF	888000–88FFFF
SA274	1	0	0	0	1	0	0	1	0	64/32	1120000–112FFFF	890000–897FFF
SA275	1	0	0	0	1	0	0	1	1	64/32	1130000–113FFFF	898000–89FFFF
SA276	1	0	0	0	1	0	1	0	0	64/32	1140000–114FFFF	8A0000–8A7FFF
SA277	1	0	0	0	1	0	1	0	1	64/32	1150000–115FFFF	8A8000–8AFFFF
SA278	1	0	0	0	1	0	1	1	0	64/32	1160000–116FFFF	8B0000–8B7FFF
SA279	1	0	0	0	1	0	1	1	1	64/32	1170000–117FFFF	8B8000–8BFFFF
SA280	1	0	0	0	1	1	0	0	0	64/32	1180000–118FFFF	8C0000–8C7FFF
SA281	1	0	0	0	1	1	0	0	1	64/32	1190000–119FFFF	8C8000–8CFFFF
SA282	1	0	0	0	1	1	0	1	0	64/32	11A0000–11AFFFF	8D0000–8D7FFF
SA283	1	0	0	0	1	1	0	1	1	64/32	11B0000–11BFFFF	8D8000–8DFFFF
SA284	1	0	0	0	1	1	1	0	0	64/32	11C0000–11CFFFF	8E0000–8E7FFF
SA285	1	0	0	0	1	1	1	0	1	64/32	11D0000–11DFFFF	8E8000–8EFFFF
SA286	1	0	0	0	1	1	1	1	0	64/32	11E0000–11EFFFF	8F0000–8F7FFF
SA287	1	0	0	0	1	1	1	1	1	64/32	11F0000–11FFFFF	8F8000–8FFFFF
SA288	1	0	0	1	0	0	0	0	0	64/32	1200000–120FFFF	900000–907FFF
SA289	1	0	0	1	0	0	0	0	1	64/32	1210000–121FFFF	908000–90FFFF
SA290	1	0	0	1	0	0	0	1	0	64/32	1220000–122FFFF	910000–917FFF
SA291	1	0	0	1	0	0	0	1	1	64/32	1230000–123FFFF	918000–91FFFF
SA292	1	0	0	1	0	0	1	0	0	64/32	1240000–124FFFF	920000–927FFF
SA293	1	0	0	1	0	0	1	0	1	64/32	1250000–125FFFF	928000–92FFFF
SA294	1	0	0	1	0	0	1	1	0	64/32	1260000–126FFFF	930000–937FFF
SA295	1	0	0	1	0	0	1	1	1	64/32	1270000–127FFFF	938000–93FFFF
SA296	1	0	0	1	0	1	0	0	0	64/32	1280000–128FFFF	940000–947FFF
SA297	1	0	0	1	0	1	0	0	1	64/32	1290000–129FFFF	948000–94FFFF
SA298	1	0	0	1	0	1	0	1	0	64/32	12A0000–12AFFFF	950000–957FFF
SA299	1	0	0	1	0	1	0	1	1	64/32	12B0000–12BFFFF	958000–95FFFF
SA300	1	0	0	1	0	1	1	0	0	64/32	12C0000–12CFFFF	960000–967FFF
SA301	1	0	0	1	0	1	1	0	1	64/32	12D0000–12DFFFF	968000–96FFFF
SA302	1	0	0	1	0	1	1	1	0	64/32	12E0000–12EFFFF	970000–977FFF
SA303	1	0	0	1	0	1	1	1	1	64/32	12F0000–12FFFFF	978000–97FFFF
SA304	1	0	0	1	1	0	0	0	0	64/32	1300000–130FFFF	980000–987FFF
SA305	1	0	0	1	1	0	0	0	1	64/32	1310000–131FFFF	988000–98FFFF
SA306	1	0	0	1	1	0	0	1	0	64/32	1320000–132FFFF	990000–997FFF
SA307	1	0	0	1	1	0	0	1	1	64/32	1330000–133FFFF	998000–99FFFF
SA308	1	0	0	1	1	0	1	0	0	64/32	1340000–134FFFF	9A0000–9A7FFF
SA309	1	0	0	1	1	0	1	0	1	64/32	1350000–135FFFF	9A8000–9AFFFF
SA310	1	0	0	1	1	0	1	1	0	64/32	1360000–136FFFF	9B0000–9B7FFF
SA311	1	0	0	1	1	0	1	1	1	64/32	1370000–137FFFF	9B8000–9BFFFF
SA312	1	0	0	1	1	1	0	0	0	64/32	1380000–138FFFF	9C0000–9C7FFF
SA313	1	0	0	1	1	1	0	0	1	64/32	1390000–139FFFF	9C8000–9CFFFF
SA314	1	0	0	1	1	1	0	1	0	64/32	13A0000–13AFFFF	9D0000–9D7FFF

Table 17. S29GL256M Sector Address Table (Continued)

Sector	A23–A15									Sector Size (Kbytes/ Kwords)	8-bit Address Range (in hexadecimal)	16-bit Address Range (in hexadecimal)
SA315	1	0	0	1	1	1	0	1	1	64/32	13B0000–13BFFFF	9D8000–9DFFFF
SA316	1	0	0	1	1	1	1	0	0	64/32	13C0000–13CFFFF	9E0000–9E7FFF
SA317	1	0	0	1	1	1	1	0	1	64/32	13D0000–13DFFFF	9E8000–9EFFFF
SA318	1	0	0	1	1	1	1	1	0	64/32	13E0000–13EFFFF	9F0000–9F7FFF
SA319	1	0	0	1	1	1	1	1	1	64/32	13F0000–13FFFFF	9F8000–9FFFFF
SA320	1	0	1	0	0	0	0	0	0	64/32	1400000–140FFFF	A00000–A07FFF
SA321	1	0	1	0	0	0	0	0	1	64/32	1410000–141FFFF	A08000–A0FFFF
SA322	1	0	1	0	0	0	0	1	0	64/32	1420000–142FFFF	A10000–A17FFF
SA323	1	0	1	0	0	0	0	1	1	64/32	1430000–143FFFF	A18000–A1FFFF
SA324	1	0	1	0	0	0	1	0	0	64/32	1440000–144FFFF	A20000–A27FFF
SA325	1	0	1	0	0	0	1	0	1	64/32	1450000–145FFFF	A28000–A2FFFF
SA326	1	0	1	0	0	0	1	1	0	64/32	1460000–146FFFF	A30000–A37FFF
SA327	1	0	1	0	0	0	1	1	1	64/32	1470000–147FFFF	A38000–A3FFFF
SA328	1	0	1	0	0	1	0	0	0	64/32	1480000–148FFFF	A40000–A47FFF
SA329	1	0	1	0	0	1	0	0	1	64/32	1490000–149FFFF	A48000–A4FFFF
SA330	1	0	1	0	0	1	0	1	0	64/32	14A0000–14AFFFF	A50000–A57FFF
SA331	1	0	1	0	0	1	0	1	1	64/32	14B0000–14BFFFF	A58000–A5FFFF
SA332	1	0	1	0	0	1	1	0	0	64/32	14C0000–14CFFFF	A60000–A67FFF
SA333	1	0	1	0	0	1	1	0	1	64/32	14D0000–14DFFFF	A68000–A6FFFF
SA334	1	0	1	0	0	1	1	1	0	64/32	14E0000–14EFFFF	A70000–A77FFF
SA335	1	0	1	0	0	1	1	1	1	64/32	14F0000–14FFFFF	A78000–A7FFFF
SA336	1	0	1	0	1	0	0	0	0	64/32	1500000–150FFFF	A80000–A87FFF
SA337	1	0	1	0	1	0	0	0	1	64/32	1510000–151FFFF	A88000–A8FFFF
SA338	1	0	1	0	1	0	0	1	0	64/32	1520000–152FFFF	A90000–A97FFF
SA339	1	0	1	0	1	0	0	1	1	64/32	1530000–153FFFF	A98000–A9FFFF
SA340	1	0	1	0	1	0	1	0	0	64/32	1540000–154FFFF	AA0000–AA7FFF
SA341	1	0	1	0	1	0	1	0	1	64/32	1550000–155FFFF	AA8000–AAFFFF
SA342	1	0	1	0	1	0	1	1	0	64/32	1560000–156FFFF	AB0000–AB7FFF
SA343	1	0	1	0	1	0	1	1	1	64/32	1570000–157FFFF	AB8000–ABFFFF
SA344	1	0	1	0	1	1	0	0	0	64/32	1580000–158FFFF	AC0000–AC7FFF
SA345	1	0	1	0	1	1	0	0	1	64/32	1590000–159FFFF	AC8000–ACFFFF
SA346	1	0	1	0	1	1	0	1	0	64/32	15A0000–15AFFFF	AD0000–AD7FFF
SA347	1	0	1	0	1	1	0	1	1	64/32	15B0000–15BFFFF	AD8000–ADFFFF
SA348	1	0	1	0	1	1	1	0	0	64/32	15C0000–15CFFFF	AE0000–AE7FFF
SA349	1	0	1	0	1	1	1	0	1	64/32	15D0000–15DFFFF	AE8000–AEFFFF
SA350	1	0	1	0	1	1	1	1	0	64/32	15E0000–15EFFFF	AF0000–AF7FFF
SA351	1	0	1	0	1	1	1	1	1	64/32	15F0000–15FFFFF	AF8000–AFFFFF
SA352	1	0	1	1	0	0	0	0	0	64/32	1600000–160FFFF	B00000–B07FFF
SA353	1	0	1	1	0	0	0	0	1	64/32	1610000–161FFFF	B08000–B0FFFF
SA354	1	0	1	1	0	0	0	1	0	64/32	1620000–162FFFF	B10000–B17FFF
SA355	1	0	1	1	0	0	0	1	1	64/32	1630000–163FFFF	B18000–B1FFFF
SA356	1	0	1	1	0	0	1	0	0	64/32	1640000–164FFFF	B20000–B27FFF
SA357	1	0	1	1	0	0	1	0	1	64/32	1650000–165FFFF	B28000–B2FFFF
SA358	1	0	1	1	0	0	1	1	0	64/32	1660000–166FFFF	B30000–B37FFF
SA359	1	0	1	1	0	0	1	1	1	64/32	1670000–167FFFF	B38000–B3FFFF

Table 17. S29GL256M Sector Address Table (Continued)

Sector	A23–A15									Sector Size (Kbytes/ Kwords)	8-bit Address Range (in hexadecimal)	16-bit Address Range (in hexadecimal)
SA360	1	0	1	1	0	1	0	0	0	64/32	1680000–168FFFF	B40000–B47FFF
SA361	1	0	1	1	0	1	0	0	1	64/32	1690000–169FFFF	B48000–B4FFFF
SA362	1	0	1	1	0	1	0	1	0	64/32	16A0000–16AFFFF	B50000–B57FFF
SA363	1	0	1	1	0	1	0	1	1	64/32	16B0000–16BFFFF	B58000–B5FFFF
SA364	1	0	1	1	0	1	1	0	0	64/32	16C0000–16CFFFF	B60000–B67FFF
SA365	1	0	1	1	0	1	1	0	1	64/32	16D0000–16DFFFF	B68000–B6FFFF
SA366	1	0	1	1	0	1	1	1	0	64/32	16E0000–16EFFFF	B70000–B77FFF
SA367	1	0	1	1	0	1	1	1	1	64/32	16F0000–16FFFFF	B78000–B7FFFF
SA368	1	0	1	1	1	0	0	0	0	64/32	1700000–170FFFF	B80000–B87FFF
SA369	1	0	1	1	1	0	0	0	1	64/32	1710000–171FFFF	B88000–B8FFFF
SA370	1	0	1	1	1	0	0	1	0	64/32	1720000–172FFFF	B90000–B97FFF
SA371	1	0	1	1	1	0	0	1	1	64/32	1730000–173FFFF	B98000–B9FFFF
SA372	1	0	1	1	1	0	1	0	0	64/32	1740000–174FFFF	BA0000–BA7FFF
SA373	1	0	1	1	1	0	1	0	1	64/32	1750000–175FFFF	BA8000–BAFFFF
SA374	1	0	1	1	1	0	1	1	0	64/32	1760000–176FFFF	BB0000–BB7FFF
SA375	1	0	1	1	1	0	1	1	1	64/32	1770000–177FFFF	BB8000–BBFFFF
SA376	1	0	1	1	1	1	0	0	0	64/32	1780000–178FFFF	BC0000–BC7FFF
SA377	1	0	1	1	1	1	0	0	1	64/32	1790000–179FFFF	BC8000–BCFFFF
SA378	1	0	1	1	1	1	0	1	0	64/32	17A0000–17AFFFF	BD0000–BD7FFF
SA379	1	0	1	1	1	1	0	1	1	64/32	17B0000–17BFFFF	BD8000–BDFFFF
SA380	1	0	1	1	1	1	1	0	0	64/32	17C0000–17CFFFF	BE0000–BE7FFF
SA381	1	0	1	1	1	1	1	0	1	64/32	17D0000–17DFFFF	BE8000–BEFFFF
SA382	1	0	1	1	1	1	1	1	0	64/32	17E0000–17EFFFF	BF0000–BF7FFF
SA383	1	0	1	1	1	1	1	1	1	64/32	17F0000–17FFFFF	BF8000–BFFFFF
SA384	1	1	0	0	0	0	0	0	0	64/32	1800000–180FFFF	C00000–C07FFF
SA385	1	1	0	0	0	0	0	0	1	64/32	1810000–181FFFF	C08000–C0FFFF
SA386	1	1	0	0	0	0	0	1	0	64/32	1820000–182FFFF	C10000–C17FFF
SA387	1	1	0	0	0	0	0	1	1	64/32	1830000–183FFFF	C18000–C1FFFF
SA388	1	1	0	0	0	0	1	0	0	64/32	1840000–184FFFF	C20000–C27FFF
SA389	1	1	0	0	0	0	1	0	1	64/32	1850000–185FFFF	C28000–C2FFFF
SA390	1	1	0	0	0	0	1	1	0	64/32	1860000–186FFFF	C30000–C37FFF
SA391	1	1	0	0	0	0	1	1	1	64/32	1870000–187FFFF	C38000–C3FFFF
SA392	1	1	0	0	0	1	0	0	0	64/32	1880000–188FFFF	C40000–C47FFF
SA393	1	1	0	0	0	1	0	0	1	64/32	1890000–189FFFF	C48000–C4FFFF
SA394	1	1	0	0	0	1	0	1	0	64/32	18A0000–18AFFFF	C50000–C57FFF
SA395	1	1	0	0	0	1	0	1	1	64/32	18B0000–18BFFFF	C58000–C5FFFF
SA396	1	1	0	0	0	1	1	0	0	64/32	18C0000–18CFFFF	C60000–C67FFF
SA397	1	1	0	0	0	1	1	0	1	64/32	18D0000–18DFFFF	C68000–C6FFFF
SA398	1	1	0	0	0	1	1	1	0	64/32	18E0000–18EFFFF	C70000–C77FFF
SA399	1	1	0	0	0	1	1	1	1	64/32	18F0000–18FFFFF	C78000–C7FFFF
SA400	1	1	0	0	1	0	0	0	0	64/32	1900000–190FFFF	C80000–C87FFF
SA401	1	1	0	0	1	0	0	0	1	64/32	1910000–191FFFF	C88000–C8FFFF
SA402	1	1	0	0	1	0	0	1	0	64/32	1920000–192FFFF	C90000–C97FFF
SA403	1	1	0	0	1	0	0	1	1	64/32	1930000–193FFFF	C98000–C9FFFF
SA404	1	1	0	0	1	0	1	0	0	64/32	1940000–194FFFF	CA0000–CA7FFF

Table 17. S29GL256M Sector Address Table (Continued)

Sector	A23–A15									Sector Size (Kbytes/ Kwords)	8-bit Address Range (in hexadecimal)	16-bit Address Range (in hexadecimal)
SA405	1	1	0	0	1	0	1	0	1	64/32	1950000–195FFFF	CA8000–CAFFFF
SA406	1	1	0	0	1	0	1	1	0	64/32	1960000–196FFFF	CB0000–CB7FFF
SA407	1	1	0	0	1	0	1	1	1	64/32	1970000–197FFFF	CB8000–CBFFFF
SA408	1	1	0	0	1	1	0	0	0	64/32	1980000–198FFFF	CC0000–CC7FFF
SA409	1	1	0	0	1	1	0	0	1	64/32	1990000–199FFFF	CC8000–CCFFFF
SA410	1	1	0	0	1	1	0	1	0	64/32	19A0000–19AFFFF	CD0000–CD7FFF
SA411	1	1	0	0	1	1	0	1	1	64/32	19B0000–19BFFFF	CD8000–CDFFFF
SA412	1	1	0	0	1	1	1	0	0	64/32	19C0000–19CFFFF	CE0000–CE7FFF
SA413	1	1	0	0	1	1	1	0	1	64/32	19D0000–19DFFFF	CE8000–CEFFFF
SA414	1	1	0	0	1	1	1	1	0	64/32	19E0000–19EFFFF	CF0000–CF7FFF
SA415	1	1	0	0	1	1	1	1	1	64/32	19F0000–19FFFFF	CF8000–CFFFFF
SA416	1	1	0	1	0	0	0	0	0	64/32	1A00000–1A0FFFF	D00000–D07FFF
SA417	1	1	0	1	0	0	0	0	1	64/32	1A10000–1A1FFFF	D08000–D0FFFF
SA418	1	1	0	1	0	0	0	1	0	64/32	1A20000–1A2FFFF	D10000–D17FFF
SA419	1	1	0	1	0	0	0	1	1	64/32	1A30000–1A3FFFF	D18000–D1FFFF
SA420	1	1	0	1	0	0	1	0	0	64/32	1A40000–1A4FFFF	D20000–D27FFF
SA421	1	1	0	1	0	0	1	0	1	64/32	1A50000–1A5FFFF	D28000–D2FFFF
SA422	1	1	0	1	0	0	1	1	0	64/32	1A60000–1A6FFFF	D30000–D37FFF
SA423	1	1	0	1	0	0	1	1	1	64/32	1A70000–1A7FFFF	D38000–D3FFFF
SA424	1	1	0	1	0	1	0	0	0	64/32	1A80000–1A8FFFF	D40000–D47FFF
SA425	1	1	0	1	0	1	0	0	1	64/32	1A90000–1A9FFFF	D48000–D4FFFF
SA426	1	1	0	1	0	1	0	1	0	64/32	1AA0000–1AAFFFF	D50000–D57FFF
SA427	1	1	0	1	0	1	0	1	1	64/32	1AB0000–1ABFFFF	D58000–D5FFFF
SA428	1	1	0	1	0	1	1	0	0	64/32	1AC0000–1ACFFFF	D60000–D67FFF
SA429	1	1	0	1	0	1	1	0	1	64/32	1AD0000–1ADFFFF	D68000–D6FFFF
SA430	1	1	0	1	0	1	1	1	0	64/32	1AE0000–1AEFFFF	D70000–D77FFF
SA431	1	1	0	1	0	1	1	1	1	64/32	1AF0000–1AFFFFF	D78000–D7FFFF
SA432	1	1	0	1	1	0	0	0	0	64/32	1B00000–1B0FFFF	D80000–D87FFF
SA433	1	1	0	1	1	0	0	0	1	64/32	1B10000–1B1FFFF	D88000–D8FFFF
SA434	1	1	0	1	1	0	0	1	0	64/32	1B20000–1B2FFFF	D90000–D97FFF
SA435	1	1	0	1	1	0	0	1	1	64/32	1B30000–1B3FFFF	D98000–D9FFFF
SA436	1	1	0	1	1	0	1	0	0	64/32	1B40000–1B4FFFF	DA0000–DA7FFF
SA437	1	1	0	1	1	0	1	0	1	64/32	1B50000–1B5FFFF	DA8000–DAFFFF
SA438	1	1	0	1	1	0	1	1	0	64/32	1B60000–1B6FFFF	DB0000–DB7FFF
SA439	1	1	0	1	1	0	1	1	1	64/32	1B70000–1B7FFFF	DB8000–DBFFFF
SA440	1	1	0	1	1	1	0	0	0	64/32	1B80000–1B8FFFF	DC0000–DC7FFF
SA441	1	1	0	1	1	1	0	0	1	64/32	1B90000–1B9FFFF	DC8000–DCFFFF
SA442	1	1	0	1	1	1	0	1	0	64/32	1BA0000–1BAFFFF	DD0000–DD7FFF
SA443	1	1	0	1	1	1	0	1	1	64/32	1BB0000–1BBFFFF	DD8000–DDFFFF
SA444	1	1	0	1	1	1	1	0	0	64/32	1BC0000–1BCFFFF	DE0000–DE7FFF
SA445	1	1	0	1	1	1	1	0	1	64/32	1BD0000–1BDFFFF	DE8000–DEFFFF
SA446	1	1	0	1	1	1	1	1	0	64/32	1BE0000–1BEFFFF	DF0000–DF7FFF
SA447	1	1	0	1	1	1	1	1	1	64/32	1BF0000–1BFFFFF	DF8000–DFFFFF
SA448	1	1	1	0	0	0	0	0	0	64/32	1C00000–1C0FFFF	E00000–E07FFF
SA449	1	1	1	0	0	0	0	0	1	64/32	1C10000–1C1FFFF	E08000–E0FFFF

Table 17. S29GL256M Sector Address Table (Continued)

Sector	A23–A15									Sector Size (Kbytes/ Kwords)	8-bit Address Range (in hexadecimal)	16-bit Address Range (in hexadecimal)
SA450	1	1	1	0	0	0	0	1	0	64/32	1C20000–1C2FFFF	E10000–E17FFF
SA451	1	1	1	0	0	0	0	1	1	64/32	1C30000–1C3FFFF	E18000–E1FFFF
SA452	1	1	1	0	0	0	1	0	0	64/32	1C40000–1C4FFFF	E20000–E27FFF
SA453	1	1	1	0	0	0	1	0	1	64/32	1C50000–1C5FFFF	E28000–E2FFFF
SA454	1	1	1	0	0	0	1	1	0	64/32	1C60000–1C6FFFF	E30000–E37FFF
SA455	1	1	1	0	0	0	1	1	1	64/32	1C70000–1C7FFFF	E38000–E3FFFF
SA456	1	1	1	0	0	1	0	0	0	64/32	1C80000–1C8FFFF	E40000–E47FFF
SA457	1	1	1	0	0	1	0	0	1	64/32	1C90000–1C9FFFF	E48000–E4FFFF
SA458	1	1	1	0	0	1	0	1	0	64/32	1CA0000–1CAFFFF	E50000–E57FFF
SA459	1	1	1	0	0	1	0	1	1	64/32	1CB0000–1CBFFFF	E58000–E5FFFF
SA460	1	1	1	0	0	1	1	0	0	64/32	1CC0000–1CCFFFF	E60000–E67FFF
SA461	1	1	1	0	0	1	1	0	1	64/32	1CD0000–1CDFFFF	E68000–E6FFFF
SA462	1	1	1	0	0	1	1	1	0	64/32	1CE0000–1CEFFFF	E70000–E77FFF
SA463	1	1	1	0	0	1	1	1	1	64/32	1CF0000–1CFFFFF	E78000–E7FFFF
SA464	1	1	1	0	1	0	0	0	0	64/32	1D00000–1D0FFFF	E80000–E87FFF
SA465	1	1	1	0	1	0	0	0	1	64/32	1D10000–1D1FFFF	E88000–E8FFFF
SA466	1	1	1	0	1	0	0	1	0	64/32	1D20000–1D2FFFF	E90000–E97FFF
SA467	1	1	1	0	1	0	0	1	1	64/32	1D30000–1D3FFFF	E98000–E9FFFF
SA468	1	1	1	0	1	0	1	0	0	64/32	1D40000–1D4FFFF	EA0000–EA7FFF
SA469	1	1	1	0	1	0	1	0	1	64/32	1D50000–1D5FFFF	EA8000–EAFFFF
SA470	1	1	1	0	1	0	1	1	0	64/32	1D60000–1D6FFFF	EB0000–EB7FFF
SA471	1	1	1	0	1	0	1	1	1	64/32	1D70000–1D7FFFF	EB8000–EBFFFF
SA472	1	1	1	0	1	1	0	0	0	64/32	1D80000–1D8FFFF	EC0000–EC7FFF
SA473	1	1	1	0	1	1	0	0	1	64/32	1D90000–1D9FFFF	EC8000–ECFFFF
SA474	1	1	1	0	1	1	0	1	0	64/32	1DA0000–1DAFFFF	ED0000–ED7FFF
SA475	1	1	1	0	1	1	0	1	1	64/32	1DB0000–1DBFFFF	ED8000–EDFFFF
SA476	1	1	1	0	1	1	1	0	0	64/32	1DC0000–1DCFFFF	EE0000–EE7FFF
SA477	1	1	1	0	1	1	1	0	1	64/32	1DD0000–1DDFFFF	EE8000–EEFFFF
SA478	1	1	1	0	1	1	1	1	0	64/32	1DE0000–1DEFFFF	EF0000–EF7FFF
SA479	1	1	1	0	1	1	1	1	1	64/32	1DF0000–1DFFFFF	EF8000–EFFFFF
SA480	1	1	1	1	0	0	0	0	0	64/32	1E00000–1E0FFFF	F00000–F07FFF
SA481	1	1	1	1	0	0	0	0	1	64/32	1E10000–1E1FFFF	F08000–F0FFFF
SA482	1	1	1	1	0	0	0	1	0	64/32	1E20000–1E2FFFF	F10000–F17FFF
SA483	1	1	1	1	0	0	0	1	1	64/32	1E30000–1E3FFFF	F18000–F1FFFF
SA484	1	1	1	1	0	0	1	0	0	64/32	1E40000–1E4FFFF	F20000–F27FFF
SA485	1	1	1	1	0	0	1	0	1	64/32	1E50000–1E5FFFF	F28000–F2FFFF
SA486	1	1	1	1	0	0	1	1	0	64/32	1E60000–1E6FFFF	F30000–F37FFF
SA487	1	1	1	1	0	0	1	1	1	64/32	1E70000–1E7FFFF	F38000–F3FFFF
SA488	1	1	1	1	0	1	0	0	0	64/32	1E80000–1E8FFFF	F40000–F47FFF
SA489	1	1	1	1	0	1	0	0	1	64/32	1E90000–1E9FFFF	F48000–F4FFFF
SA490	1	1	1	1	0	1	0	1	0	64/32	1EA0000–1EAFFFF	F50000–F57FFF
SA491	1	1	1	1	0	1	0	1	1	64/32	1EB0000–1EBFFFF	F58000–F5FFFF
SA492	1	1	1	1	0	1	1	0	0	64/32	1EC0000–1ECFFFF	F60000–F67FFF
SA493	1	1	1	1	0	1	1	0	1	64/32	1ED0000–1EDFFFF	F68000–F6FFFF
SA494	1	1	1	1	0	1	1	1	0	64/32	1EE0000–1EEFFFF	F70000–F77FFF

Table 17. S29GL256M Sector Address Table (Continued)

Sector	A23–A15									Sector Size (Kbytes/ Kwords)	8-bit Address Range (in hexadecimal)	16-bit Address Range (in hexadecimal)
SA495	1	1	1	1	0	1	1	1	1	64/32	1EF0000–1EFFFFF	F78000–F7FFFF
SA496	1	1	1	1	1	0	0	0	0	64/32	1F00000–1F0FFFF	F80000–F87FFF
SA497	1	1	1	1	1	0	0	0	1	64/32	1F10000–1F1FFFF	F88000–F8FFFF
SA498	1	1	1	1	1	0	0	1	0	64/32	1F20000–1F2FFFF	F90000–F97FFF
SA499	1	1	1	1	1	0	0	1	1	64/32	1F30000–1F3FFFF	F98000–F9FFFF
SA500	1	1	1	1	1	0	1	0	0	64/32	1F40000–1F4FFFF	FA0000–FA7FFF
SA501	1	1	1	1	1	0	1	0	1	64/32	1F50000–1F5FFFF	FA8000–FAFFFF
SA502	1	1	1	1	1	0	1	1	0	64/32	1F60000–1F6FFFF	FB0000–FB7FFF
SA503	1	1	1	1	1	0	1	1	1	64/32	1F70000–1F7FFFF	FB8000–FBFFFF
SA504	1	1	1	1	1	1	0	0	0	64/32	1F80000–1F8FFFF	FC0000–FC7FFF
SA505	1	1	1	1	1	1	0	0	1	64/32	1F90000–1F9FFFF	FC8000–FCFFFF
SA506	1	1	1	1	1	1	0	1	0	64/32	1FA0000–1FAFFFF	FD0000–FD7FFF
SA507	1	1	1	1	1	1	0	1	1	64/32	1FB0000–1FBFFFF	FD8000–FDFFFF
SA508	1	1	1	1	1	1	1	0	0	64/32	1FC0000–1FCFFFF	FE0000–FE7FFF
SA509	1	1	1	1	1	1	1	0	1	64/32	1FD0000–1FDFFFF	FE8000–FEFFFF
SA510	1	1	1	1	1	1	1	1	0	64/32	1FE0000–1FEFFFF	FF0000–FF7FFF
SA511	1	1	1	1	1	1	1	1	1	64/32	1FF0000–1FFFFFF	FF8000–FFFFFF

Autoselect Mode

The autoselect mode provides manufacturer and device identification, and sector group protection verification, through identifier codes output on DQ7–DQ0. This mode is primarily intended for programming equipment to automatically match a device to be programmed with its corresponding programming algorithm. However, the autoselect codes can also be accessed in-system through the command register.

When using programming equipment, the autoselect mode requires VID on address pin A9. Address pins A6, A3, A2, A1, and A0 must be as shown in Table 18. In addition, when verifying sector protection, the sector address must appear on the appropriate highest order address bits (see Table 6-Table 17). Table 18 shows the remaining address bits that are don't care. When all necessary bits have been set as required, the programming equipment may then read the corresponding identifier code on DQ7–DQ0.

To access the autoselect codes in-system, the host system can issue the autoselect command via the command register, as shown in Table 35 and Table 36. This method does not require V_{ID}. Refer to the Autoselect Command Sequence section for more information.

Table 18. Autoselect Codes, (High Voltage Method)

Description		CE#	OE#	WE#	A22 to A15	A14 to A10	A9	A8 to A7	A6	A5 to A4	A3 to A2	A1	A0	DQ8 to DQI5		DQ7 to DQ0			
																Model Number			
														BYTE# = V_{IH}	BYTE# = V_{IL}	R0	R1,R2, R8, R9	R3,R4	R5,R6,R7
Manufacturer ID: Spansion Products		L	L	H	X	X	V_{ID}	X	L	X	L	L	L	00	X	01h	01h	01h	01h
S29GL256M	Cycle 1	L	L	H	X	X	V_{ID}	X	L	X	L	L	H	22	X		7Eh		
	Cycle 2										H	H	L	22	X		12h		
	Cycle 3										H	H	H	22	X		01h		
S29GL128M	Cycle 1	L	L	H	X	X	V_{ID}	X	L	X	L	L	H	22	X		7Eh		
	Cycle 2										H	H	L	22	X		12h		
	Cycle 3										H	H	H	22	X		00h		
S29GL064M	Cycle 1	L	L	H	X	X	V_{ID}	X	L	X	L	L	H	22	X	7Eh	7Eh	7Eh	7Eh
	Cycle 2										H	H	L	22	X	13h	0Ch	10h	13h
	Cycle 3										H	H	H	22	X	00h	01h	00h (-R4, bottom boot) 01h (-R3, top boot)	01h
S29GL032M	Cycle 1	L	L	H	X	X	V_{ID}	X	L	X	L	L	H	22	X	7Eh	7Eh	7Eh	7Eh
	Cycle 2										H	H	L	22	X	1Ch	1Dh	1Ah	1Ah
	Cycle 3										H	H	H	22	X	00h	00h	00h (-R4, bottom boot) 01h (-R3, top boot)	00h (-R6 bottom boot) 01h (-R5, top boot)
Sector Group Protection Verification		L	L	H	SA	X	V_{ID}	X	L	X	L	H	L	X	X	01h (protected), 00h (unprotected)			
SecSi Sector Indicator Bit (DQ7), WP# protects highest address sector		L	L	H	X	X	V_{ID}	X	L	X	L	H	H	X	X	98h (factory locked), 18h (not factory locked)			
SecSi Sector Indicator Bit (DQ7), WP# protects lowest address sector		L	L	H	X	X	V_{ID}	X	L	X	L	H	H	X	X	88h (factory locked), 08h (not factory locked)			

Legend: *L = Logic Low = V_{IL}, H = Logic High = V_{IH}, SA = Sector Address, X = Don't care.*

Sector Group Protection and Unprotection

The hardware sector group protection feature disables both program and erase operations in any sector group. In this device, a sector group consists of four adjacent sectors that are protected or unprotected at the same time (see Table 4). The hardware sector group unprotection feature re-enables both program and erase operations in previously protected sector groups. Sector group protection/unprotection can be implemented via two methods.

Sector protection/unprotection requires V_{ID} on the RESET# pin only, and can be implemented either in-system or via programming equipment. Figure 2 shows the algorithms and Figure 24 shows the timing diagram. This method uses standard microprocessor bus cycle timing. For sector group unprotect, all unprotected sector groups must first be protected prior to the first sector group unprotect write cycle.

The device is shipped with all sector groups unprotected. Spansion offers the option of programming and protecting sector groups at its factory prior to shipping the device through Spansion Programming Service. Contact a Spansion representative for details.

It is possible to determine whether a sector group is protected or unprotected. See the Autoselect Mode section for details.

Table 19. S29GL032M (Model R0) Sector Group Protection/Unprotection Address Table

Sector Group	A22–A18
SA0–SA3	00000
SA4–SA7	00001
SA8–SA11	00010
SA12–SA15	00011
SA16–SA19	00100
SA20–SA23	00101
SA24–SA27	00110
SA28–SA31	00111
SA32–SA35	01000
SA36–SA39	01001
SA40–SA43	01010
SA44–SA47	01011
SA48–SA51	01100
SA52–SA55	01101
SA56–SA59	01110
SA60–SA63	01111

Note: *All sector groups are 256 Kbytes in size.*

Table 20. S29GL032M (Model RI) Top Boot Sector Protection

Sector	A20–AI2	Sector/ Sector Block Size
SA0-SA3	0000XXXXXh	256 (4x64) Kbytes
SA4-SA7	000IXXXXXh	256 (4x64) Kbytes
SA8-SAII	00I0XXXXXh	256 (4x64) Kbytes
SAI2-SAI5	00IIXXXXXh	256 (4x64) Kbytes
SAI6-SAI9	0I00XXXXXh	256 (4x64) Kbytes
SA20-SA23	0I0IXXXXXh	256 (4x64) Kbytes
SA24-SA27	0II0XXXXXh	256 (4x64) Kbytes
SA28-SA3I	0IIIXXXXXh	256 (4x64) Kbytes
SA32–SA35	I000XXXXXh,	256 (4x64) Kbytes
SA36–SA39	I00IXXXXXh	256 (4x64) Kbytes
SA40–SA43	I0I0XXXXXh	256 (4x64) Kbytes
SA44–SA47	I0IIXXXXXh	256 (4x64) Kbytes
SA48–SA5I	II00XXXXXh	256 (4x64) Kbytes
SA52-SA55	II0IXXXXXh	256 (4x64) Kbytes
SA56-SA59	III0XXXXXh	256 (4x64) Kbytes
SA60-SA62	IIII00XXXh IIII0IXXXh IIII10XXXh	I92 (3x64) Kbytes
SA63	IIIIII000h	8 Kbytes
SA64	IIIIII00Ih	8 Kbytes
SA65	IIIIII0I0h	8 Kbytes
SA66	IIIIII0IIh	8 Kbytes
SA67	IIIIIII00h	8 Kbytes
SA68	IIIIIII0Ih	8 Kbytes
SA69	IIIIIIII0h	8 Kbytes
SA70	IIIIIIIIh	8 Kbytes

Table 21. S29GL032M (Model R2) Bottom Boot Sector Protection

Sector	A20–A12	Sector/ Sector Block Size
SA0	000000000h	8 Kbytes
SA1	000000001h	8 Kbytes
SA2	000000010h	8 Kbytes
SA3	000000011h	8 Kbytes
SA4	000000100h	8 Kbytes
SA5	000000101h	8 Kbytes
SA6	000000110h	8 Kbytes
SA7	000000111h	8 Kbytes
SA8–SA10	00000100Xh, 00000101Xh, 00000110Xh,	192 (3x64) Kbytes
SA11–SA14	00001XXXXh	256 (4x64) Kbytes
SA15–SA18	00010XXXXh	256 (4x64) Kbytes
SA19–SA22	00011XXXXh	256 (4x64) Kbytes
SA23–SA26	00100XXXXh	256 (4x64) Kbytes
SA27-SA30	00101XXXXh	256 (4x64) Kbytes
SA31-SA34	00110XXXXh	256 (4x64) Kbytes
SA35-SA38	00111XXXXh	256 (4x64) Kbytes
SA39-SA42	01000XXXXh	256 (4x64) Kbytes
SA43-SA46	01001XXXXh	256 (4x64) Kbytes
SA47-SA50	01010XXXXh	256 (4x64) Kbytes
SA51-SA54	01011XXXXh	256 (4x64) Kbytes
SA55–SA58	01100XXXXh	256 (4x64) Kbytes
SA59–SA62	01101XXXXh	256 (4x64) Kbytes
SA63–SA66	01110XXXXh	256 (4x64) Kbytes
SA67–SA70	01111XXXXh	256 (4x64) Kbytes

Table 22. S29GL032M (Models R3, R4) Sector Group Protection/Unprotection Address Table

Sector Group	A20–A15
SA0	000000
SA1	000001
SA2	000010
SA3	000011
SA4–SA7	0001xx
SA8–SA11	0010xx
SA12–SA15	0011xx
SA16–SA19	0100xx
SA20–SA23	0101xx
SA24–SA27	0110xx
SA28–SA31	0111xx
SA32–SA35	1000xx
SA36–SA39	1001xx
SA40–SA43	1010xx
SA44–SA47	1011xx

Sector Group	A20–A15
SA48–SA51	1100xx
SA52–SA55	1101xx
SA56–SA59	1110xx
SA60	111100
SA61	111101
SA62	111110
SA63	111111

Table 23. S29GL065M (Model 00) Sector Group Protection/Unprotection Address Table

Sector Group	A22–A18
SA0–SA3	00000
SA4–SA7	00001
SA8–SA11	00010
SA12–SA15	00011
SA16–SA19	00100
SA20–SA23	00101
SA24–SA27	00110
SA28–SA31	00111
SA32–SA35	01000
SA36–SA39	01001
SA40–SA43	01010
SA44–SA47	01011
SA48–SA51	01100
SA52–SA55	01101
SA56–SA59	01110
SA60–SA63	01111
SA64–SA67	10000
SA68–SA71	10001
SA72–SA75	10010
SA76–SA79	10011
SA80–SA83	10100
SA84–SA87	10101
SA88–SA91	10110
SA92–SA95	10111
SA96–SA99	11000
SA100–SA103	11001
SA104–SA107	11010
SA108–SA111	11011
SA112–SA115	11100
SA116–SA119	11101
SA120–SA123	11110
SA124–SA127	11111

Note: *All sector groups are 256 Kbytes in size.*

Table 24. S29GL064M (Model RI) Top Boot Sector Protection

Sector	A21–A12	Sector/ Sector Block Size
SA0-SA3	00000XXXXX	256 (4x64) Kbytes
SA4-SA7	0000IXXXXX	256 (4x64) Kbytes
SA8-SAII	000I0XXXXX	256 (4x64) Kbytes
SAI2-SAI5	000IIXXXXX	256 (4x64) Kbytes
SAI6-SAI9	00I00XXXXX	256 (4x64) Kbytes
SA20-SA23	00I0IXXXXX	256 (4x64) Kbytes
SA24-SA27	00II0XXXXX	256 (4x64) Kbytes
SA28-SA3I	00IIIXXXXX	256 (4x64) Kbytes
SA32-SA35	0I000XXXXX	256 (4x64) Kbytes
SA36-SA39	0I00IXXXXX	256 (4x64) Kbytes
SA40-SA43	0I0I0XXXXX	256 (4x64) Kbytes
SA44-SA47	0I0IIXXXXX	256 (4x64) Kbytes
SA48-SA5I	0II00XXXXX	256 (4x64) Kbytes
SA52-SA55	0II0IXXXXX	256 (4x64) Kbytes
SA56-SA59	0III0XXXXX	256 (4x64) Kbytes
SA60-SA63	0IIIIXXXXX	256 (4x64) Kbytes
SA64-SA67	I0000XXXXX	256 (4x64) Kbytes
SA68-SA7I	I000IXXXXX	256 (4x64) Kbytes
SA72-SA75	I00I0XXXXX	256 (4x64) Kbytes
SA76-SA79	I00IIXXXXX	256 (4x64) Kbytes
SA80-SA83	I0I00XXXXX	256 (4x64) Kbytes
SA84-SA87	I0I0IXXXXX	256 (4x64) Kbytes
SA88-SA9I	I0II0XXXXX	256 (4x64) Kbytes
SA92-SA95	I0IIIXXXXX	256 (4x64) Kbytes
SA96-SA99	II000XXXXX	256 (4x64) Kbytes
SAI00-SAI03	II00IXXXXX	256 (4x64) Kbytes
SAI04-SAI07	II0I0XXXXX	256 (4x64) Kbytes
SAI08-SAIII	II0IIXXXXX	256 (4x64) Kbytes
SAII2-SAII5	III00XXXXX	256 (4x64) Kbytes
SAII6-SAII9	III0IXXXXX	256 (4x64) Kbytes
SAI20-SAI23	IIII0XXXXX	256 (4x64) Kbytes
SAI24-SAI26	IIIII00XXX IIIII0IXXX IIIII0XXX	192 (3x64) Kbytes
SAI27	IIIIIII000	8 Kbytes
SAI28	IIIIIII00I	8 Kbytes
SAI29	IIIIIII0I0	8 Kbytes
SAI30	IIIIIII0II	8 Kbytes
SAI3I	IIIIIIII00	8 Kbytes
SAI32	IIIIIIII0I	8 Kbytes
SAI33	IIIIIIII0	8 Kbytes
SAI34	IIIIIIIII	8 Kbytes

Table 25. S29GL064M (Model R2) Bottom Boot Sector Protection

Sector	A21–AI2	Sector/ Sector Block Size
SA0	0000000000	8 Kbytes
SAI	000000000I	8 Kbytes
SA2	00000000I0	8 Kbytes
SA3	00000000II	8 Kbytes
SA4	0000000I00	8 Kbytes
SA5	0000000I0I	8 Kbytes
SA6	0000000II0	8 Kbytes
SA7	0000000III	8 Kbytes
SA8–SAI0	000000IXXX, 00000I0XXX, 00000IIXXX,	I92 (3x64) Kbytes
SAII–SAI4	0000IXXXXX	256 (4x64) Kbytes
SAI5–SAI8	000I0XXXXX	256 (4x64) Kbytes
SAI9–SA22	000IIXXXXX	256 (4x64) Kbytes
SA23–SA26	00I00XXXXX	256 (4x64) Kbytes
SA27-SA30	00I0IXXXXX	256 (4x64) Kbytes
SA3I-SA34	00II0XXXXX	256 (4x64) Kbytes
SA35-SA38	00IIIXXXXX	256 (4x64) Kbytes
SA39-SA42	0I000XXXXX	256 (4x64) Kbytes
SA43-SA46	0I00IXXXXX	256 (4x64) Kbytes
SA47-SA50	0I0I0XXXXX	256 (4x64) Kbytes
SA5I-SA54	0I0IIXXXXX	256 (4x64) Kbytes
SA55–SA58	0II00XXXXX	256 (4x64) Kbytes
SA59–SA62	0II0IXXXXX	256 (4x64) Kbytes
SA63–SA66	0III0XXXXX	256 (4x64) Kbytes
SA67–SA70	0IIIIXXXXX	256 (4x64) Kbytes
SA7I–SA74	I0000XXXXX	256 (4x64) Kbytes
SA75–SA78	I000IXXXXX	256 (4x64) Kbytes
SA79–SA82	I00I0XXXXX	256 (4x64) Kbytes
SA83–SA86	I00IIXXXXX	256 (4x64) Kbytes
SA87–SA90	I0I00XXXXX	256 (4x64) Kbytes
SA9I–SA94	I0I0IXXXXX	256 (4x64) Kbytes
SA95–SA98	I0II0XXXXX	256 (4x64) Kbytes
SA99–SAI02	I0IIIXXXXX	256 (4x64) Kbytes
SAI03–SAI06	II000XXXXX	256 (4x64) Kbytes
SAI07–SAII0	II00IXXXXX	256 (4x64) Kbytes
SAIII–SAII4	II0I0XXXXX	256 (4x64) Kbytes
SAII5–SAII8	II0IIXXXXX	256 (4x64) Kbytes
SAII9–SAI22	III00XXXXX	256 (4x64) Kbytes
SAI23–SAI26	III0IXXXXX	256 (4x64) Kbytes
SAI27–SAI30	IIII0XXXXX	256 (4x64) Kbytes
SAI3I–SAI34	IIIIIXXXXX	256 (4x64) Kbytes

Table 26. S29GL064M (Models R3, R4) Sector Group Protection/Unprotection Address Table

Sector Group	A21–A15
SA0	0000000
SA1	0000001
SA2	0000010
SA3	0000011
SA4–SA7	00001xx
SA8–SA11	00010xx
SA12–SA15	00011xx
SA16–SA19	00100xx
SA20–SA23	00101xx
SA24–SA27	00110xx
SA28–SA31	00111xx
SA32–SA35	01000xx
SA36–SA39	01001xx
SA40–SA43	01010xx
SA44–SA47	01011xx
SA48–SA51	01100xx
SA52–SA55	01101xx
SA56–SA59	01110xx
SA60–SA63	01111xx
SA64–SA67	10000xx
SA68–SA71	10001xx
SA72–SA75	10010xx
SA76–SA79	10011xx
SA80–SA83	10100xx
SA84–SA87	10101xx
SA88–SA91	10110xx
SA92–SA95	10111xx
SA96–SA99	11000xx
SA100–SA103	11001xx
SA104–SA107	11010xx
SA108–SA111	11011xx
SA112–SA115	11100xx
SA116–SA119	11101xx
SA120–SA123	11110xx
SA124	1111100
SA125	1111101
SA126	1111110
SA127	1111111

Table 27. S29GL064M (Model R5) Sector Group Protection/Unprotection Address Table

Sector Group	A21–A17
SA0–SA3	00000
SA4–SA7	00001
SA8–SA11	00010
SA12–SA15	00011
SA16–SA19	00100
SA20–SA23	00101
SA24–SA27	00110
SA28–SA31	00111
SA32–SA35	01000
SA36–SA39	01001
SA40–SA43	01010
SA44–SA47	01011
SA48–SA51	01100
SA52–SA55	01101
SA56–SA59	01110
SA60–SA63	01111
SA64–SA67	10000
SA68–SA71	10001
SA72–SA75	10010
SA76–SA79	10011
SA80–SA83	10100
SA84–SA87	10101
SA88–SA91	10110
SA92–SA95	10111
SA96–SA99	11000
SA100–SA103	11001
SA104–SA107	11010
SA108–SA111	11011
SA112–SA115	11100
SA116–SA119	11101
SA120–SA123	11110
SA124–SA127	11111

Note: *All sector groups are 128 Kwords in size.*

Table 28. S29GL064M (Models R6, R7) Sector Group Protection/Unprotection Address Table

Sector Group	A21–A17
SA0–SA3	00000
SA4–SA7	00001
SA8–SA11	00010
SA12–SA15	00011
SA16–SA19	00100
SA20–SA23	00101
SA24–SA27	00110
SA28–SA31	00111
SA32–SA35	01000
SA36–SA39	01001
SA40–SA43	01010
SA44–SA47	01011
SA48–SA51	01100
SA52–SA55	01101
SA56–SA59	01110
SA60–SA63	01111
SA64–SA67	10000
SA68–SA71	10001
SA72–SA75	10010
SA76–SA79	10011
SA80–SA83	10100
SA84–SA87	10101
SA88–SA91	10110
SA92–SA95	10111
SA96–SA99	11000
SA100–SA103	11001
SA104–SA107	11010
SA108–SA111	11011
SA112–SA115	11100
SA116–SA119	11101
SA120–SA123	11110
SA124–SA127	11111

Note: *All sector groups are 128 Kwords in size.*

Table 29. S29GLI28M Sector Group Protection/Unprotection Address Table

Sector Group	A22–A15
SA0	00000000
SA1	00000001
SA2	00000010
SA3	00000011
SA4–SA7	000001xx
SA8–SA11	000010xx
SA12–SA15	000011xx
SA16–SA19	000100xx
SA20–SA23	000101xx
SA24–SA27	000110xx
SA28–SA31	000111xx
SA32–SA35	001000xx
SA36–SA39	001001xx
SA40–SA43	001010xx
SA44–SA47	001011xx
SA48–SA51	001100xx
SA52–SA55	001101xx
SA56–SA59	001110xx
SA60–SA63	001111xx
SA64–SA67	010000xx
SA68–SA71	010001xx
SA72–SA75	010010xx
SA76–SA79	010011xx
SA80–SA83	010100xx
SA84–SA87	010101xx
SA88–SA91	010110xx
SA92–SA95	010111xx
SA96–SA99	011000xx
SA100–SA103	011001xx
SA104–SA107	011010xx
SA108–SA111	011011xx
SA112–SA115	011100xx
SA116–SA119	011101xx
SA120–SA123	011110xx
SA124–SA127	011111xx
SA128–SA131	100000xx
SA132–SA135	100001xx
SA136–SA139	100010xx
SA140–SA143	100011xx
SA144–SA147	100100xx
SA148–SA151	100101xx

Table 29. S29GLI28M Sector Group Protection/Unprotection Address Table (Continued)

Sector Group	A22–A15
SA152–SA155	100110xx
SA156–SA159	100111xx
SA160–SA163	101000xx
SA164–SA167	101001xx
SA168–SA171	101010xx
SA172–SA175	101011xx
SA176–SA179	101100xx
SA180–SA183	101101xx
SA184–SA187	101110xx
SA188–SA191	101111xx
SA192–SA195	110000xx
SA196–SA199	110001xx
SA200–SA203	110010xx
SA204–SA207	110011xx
SA208–SA211	110100xx
SA212–SA215	110101xx
SA216–SA219	110110xx
SA220–SA223	110111xx
SA224–SA227	111000xx
SA228–SA231	111001xx
SA232–SA235	111010xx
SA236–SA239	111011xx
SA240–SA243	111100xx
SA244–SA247	111101xx
SA248–SA251	111110xx
SA252	11111100
SA253	11111101
SA254	11111110
SA255	11111111

Table 30. S29GL256M Sector Group Protection/Unprotection Address Table

Sector Group	A23–A15
SA0	000000000
SA1	000000001
SA2	000000010
SA3	000000011
SA4–SA7	0000001xx
SA8–SA11	0000010xx
SA12–SA15	0000011xx
SA16–SA19	0000100xx
SA20–SA23	0000101xx
SA24–SA27	0000110xx
SA28–SA31	0000111xx
SA32–SA35	0001000xx
SA36–SA39	0001001xx
SA40–SA43	0001010xx
SA44–SA47	0001011xx
SA48–SA51	0001100xx
SA52–SA55	0001101xx
SA56–SA59	0001110xx
SA60–SA63	0001111xx
SA64–SA67	0010000xx
SA68–SA71	0010001xx
SA72–SA75	0010010xx
SA76–SA79	0010011xx
SA80–SA83	0010100xx
SA84–SA87	0010101xx
SA88–SA91	0010110xx
SA92–SA95	0010111xx
SA96–SA99	0011000xx
SA100–SA103	0011001xx
SA104–SA107	0011010xx
SA108–SA111	0011011xx
SA112–SA115	0011100xx
SA116–SA119	0011101xx
SA120–SA123	0011110xx
SA124–SA127	0011111xx
SA128–SA131	0100000xx
SA132–SA135	0100001xx
SA136–SA139	0100010xx
SA140–SA143	0100011xx
SA144–SA147	0100100xx
SA148–SA151	0100101xx

Table 30. S29GL256M Sector Group Protection/Unprotection Address Table (Continued)

Sector Group	A23–A15
SA152–SA155	0100110xx
SA156–SA159	0100111xx
SA160–SA163	0101000xx
SA164–SA167	0101001xx
SA168–SA171	0101010xx
SA172–SA175	0101011xx
SA176–SA179	0101100xx
SA180–SA183	0101101xx
SA184–SA187	0101110xx
SA188–SA191	0101111xx
SA192–SA195	0110000xx
SA196–SA199	0110001xx
SA200–SA203	0110010xx
SA204–SA207	0110011xx
SA208–SA211	0110100xx
SA212–SA215	0110101xx
SA216–SA219	0110110xx
SA220–SA223	0110111xx
SA224–SA227	0111000xx
SA228–SA231	0111001xx
SA232–SA235	0111010xx
SA236–SA239	0111011xx
SA240–SA243	0111100xx
SA244–SA247	0111101xx
SA248–SA251	0111110xx
SA252–SA255	0111111xx
SA256–SA259	1000000xx
SA260–SA263	1000001xx
SA264–SA267	1000010xx
SA268–SA271	1000011xx
SA272–SA275	1000100xx
SA276–SA279	1000101xx
SA280–SA283	1000110xx
SA284–SA287	1000111xx
SA288–SA291	1001000xx
SA292–SA295	1001001xx
SA296–SA299	1001010xx
SA300–SA303	1001011xx
SA304–SA307	1001100xx
SA308–SA311	1001101xx
SA312–SA315	1001110xx

Table 30. S29GL256M Sector Group Protection/Unprotection Address Table (Continued)

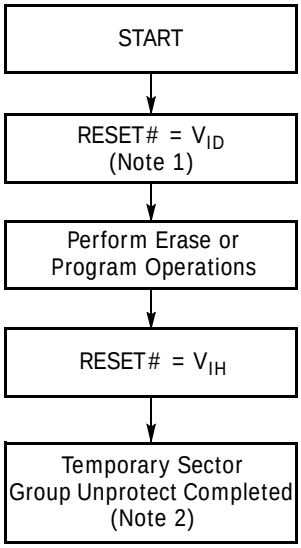
Sector Group	A23–A15
SA316–SA319	1001111xx
SA320–SA323	1010000xx
SA324–SA327	1010001xx
SA328–SA331	1010010xx
SA332–SA335	1010011xx
SA336–SA339	1010100xx
SA340–SA343	1010101xx
SA344–SA347	1010110xx
SA348–SA351	1010111xx
SA352–SA355	1011000xx
SA356–SA359	1011001xx
SA360–SA363	1011010xx
SA364–SA367	1011011xx
SA368–SA371	1011100xx
SA372–SA375	1011101xx
SA376–SA379	1011110xx
SA380–SA383	1011111xx
SA384–SA387	1100000xx
SA388–SA391	1100001xx
SA392–SA395	1100010xx
SA396–SA399	1100011xx
SA400–SA403	1100100xx
SA404–SA407	1100101xx
SA408–SA411	1100110xx
SA412–SA415	1100111xx
SA416–SA419	1101000xx
SA420–SA423	1101001xx
SA424–SA427	1101010xx
SA428–SA431	1101011xx
SA432–SA435	1101100xx
SA436–SA439	1101101xx
SA440–SA443	1101110xx
SA444–SA447	1101111xx
SA448–SA451	1110000xx
SA452–SA455	1110001xx
SA456–SA459	1110010xx
SA460–SA463	1110011xx
SA464–SA467	1110100xx
SA468–SA471	1110101xx
SA472–SA475	1110110xx
SA476–SA479	1110111xx

Table 30. S29GL256M Sector Group Protection/Unprotection Address Table (Continued)

Sector Group	A23–A15
SA480–SA483	1111000xx
SA484–SA487	1111001xx
SA488–SA491	1111010xx
SA492–SA495	1111011xx
SA496–SA499	1111100xx
SA500–SA503	1111101xx
SA504–SA507	1111110xx
SA508	111111100
SA509	111111101
SA510	111111110
SA511	111111111

Temporary Sector Group Unprotect

This feature allows temporary unprotection of previously protected sector groups to change data in-system. The Sector Group Unprotect mode is activated by setting the RESET# pin to V_{ID}. During this mode, formerly protected sector groups can be programmed or erased by selecting the sector group addresses. Once V_{ID} is removed from the RESET# pin, all the previously protected sector groups are protected again. Figure 1 shows the algorithm, and Figure 23 shows the timing diagrams, for this feature.



Notes:

1. *All protected sector groups unprotected (If WP# = V_{IL}, the first or last sector will remain protected).*
2. *All previously protected sector groups are protected once again.*

Figure I. Temporary Sector Group Unprotect Operation

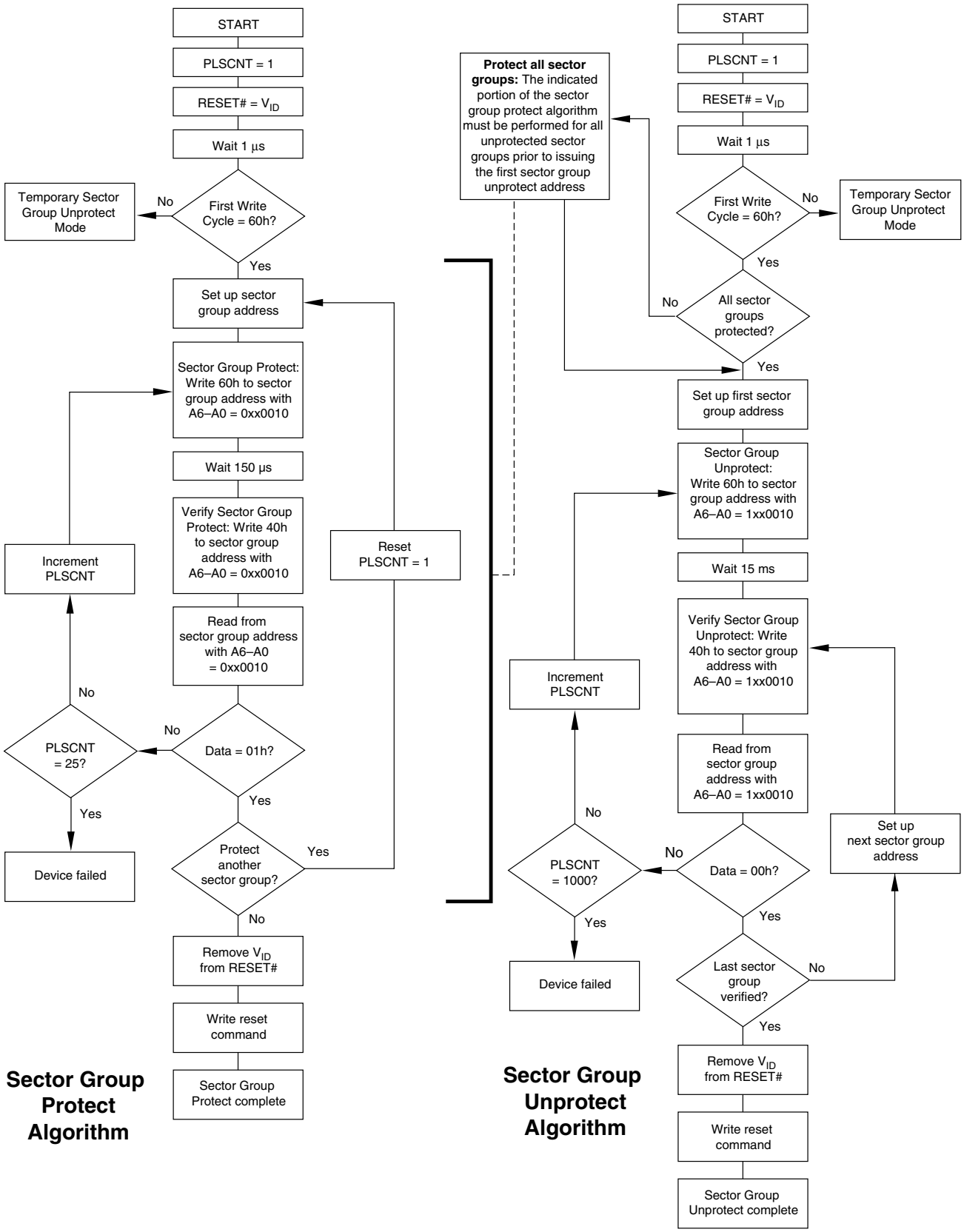


Figure 2. In-System Sector Group Protect/Unprotect Algorithms

SecSi (Secured Silicon) Sector Flash Memory Region

The SecSi (Secured Silicon) Sector feature provides a Flash memory region that enables permanent part identification through an Electronic Serial Number (ESN). The SecSi Sector is 256 bytes in length, and uses a SecSi Sector Indicator Bit (DQ7) to indicate whether or not the SecSi Sector is locked when shipped from the factory. This bit is permanently set at the factory and cannot be changed, which prevents cloning of a factory locked part. This ensures the security of the ESN once the product is shipped to the field.

The factory offers the device with the SecSi Sector either customer lockable (standard shipping option) or factory locked (contact a Spansion sales representative for ordering information). The customer-lockable version is shipped with the SecSi Sector unprotected, allowing customers to program the sector after receiving the device. The customer-lockable version also has the SecSi Sector Indicator Bit permanently set to a "0." The factory-locked version is always protected when shipped from the factory, and has the SecSi (Secured Silicon) Sector Indicator Bit permanently set to a "1." Thus, the SecSi Sector Indicator Bit prevents customer-lockable devices from being used to replace devices that are factory locked. *Note that the ACC function and unlock bypass modes are not available when the SecSi Sector is enabled.*

The SecSi sector address space in this device is allocated as follows:

SecSi Sector Address Range	Customer Lockable	ESN Factory Locked	ExpressFlash Factory Locked
000000h–000007h	Determined by customer	ESN	ESN or determined by customer
000008h–00007Fh		Unavailable	Determined by customer

The system accesses the SecSi Sector through a command sequence (see "Write Protect (WP#)"). After the system has written the Enter SecSi Sector command sequence, it may read the SecSi Sector by using the addresses normally occupied by the first sector (SA0). This mode of operation continues until the system issues the Exit SecSi Sector command sequence, or until power is removed from the device. On power-up, or following a hardware reset, the device reverts to sending commands to sector SA0.

Customer Lockable: SecSi Sector NOT Programmed or Protected At the Factory

Unless otherwise specified, the device is shipped such that the customer may program and protect the 256-byte SecSi sector.

The system may program the SecSi Sector using the write-buffer, accelerated and/or unlock bypass methods, in addition to the standard programming command sequence. See Command Definitions.

Programming and protecting the SecSi Sector must be used with caution since, once protected, there is no procedure available for unprotecting the SecSi Sector area and none of the bits in the SecSi Sector memory space can be modified in any way.

The SecSi Sector area can be protected using one of the following procedures:

- Write the three-cycle Enter SecSi Sector Region command sequence, and then follow the in-system sector protect algorithm as shown in Figure 2, except that *RESET# may be at either V_{IH} or V_{ID}*. This allows in-system protection of the SecSi Sector without raising any device pin to a high voltage. Note that this method is only applicable to the SecSi Sector.

- To verify the protect/unprotect status of the SecSi Sector, follow the algorithm shown in Figure 1.

Once the SecSi Sector is programmed, locked and verified, the system must write the Exit SecSi Sector Region command sequence to return to reading and writing within the remainder of the array.

Factory Locked: SecSi Sector Programmed and Protected At the Factory

In devices with an ESN, the SecSi Sector is protected when the device is shipped from the factory. The SecSi Sector cannot be modified in any way. An ESN Factory Locked device has an 16-byte random ESN at addresses 000000h–000007h. Please contact your sales representative for details on ordering ESN Factory Locked devices.

Customers may opt to have their code programmed by the factory through the Spansion programming service (Customer Factory Locked). The devices are then shipped from the factory with the SecSi Sector permanently locked. Contact your sales representative for details on using the Spansion programming service.

Write Protect (WP#)

The Write Protect function provides a hardware method of protecting the first or last sector group without using V_{ID}. Write Protect is one of two functions provided by the WP#/ACC input.

If the system asserts V_{IL} on the WP#/ACC pin, the device disables program and erase functions in the first or last sector group independently of whether those sector groups were protected or unprotected. Note that if WP#/ACC is at V_{IL} when the device is in the standby mode, the maximum input load current is increased. See the table in "DC Characteristics" section on page 122.

Note: If the system asserts V_{IH} on the WP#/ACC pin, the device reverts to whether the first or last sector was previously set to be protected or unprotected using the method described in "Sector Group Protection and Unprotection". Note that WP# has an internal pullup; when unconnected, WP# is at V_{IH}.

Hardware Data Protection

The command sequence requirement of unlock cycles for programming or erasing provides data protection against inadvertent writes (refer to Tables 16 and 17 for command definitions). In addition, the following hardware data protection measures prevent accidental erasure or programming, which might otherwise be caused by spurious system level signals during V_{CC} power-up and power-down transitions, or from system noise.

Low V_{CC} Write Inhibit

When V_{CC} is less than V_{LKO}, the device does not accept any write cycles. This protects data during V_{CC} power-up and power-down. The command register and all internal program/erase circuits are disabled, and the device resets to the read mode. Subsequent writes are ignored until V_{CC} is greater than V_{LKO}. The system must provide the proper signals to the control pins to prevent unintentional writes when V_{CC} is greater than V_{LKO}.

Write Pulse "Glitch" Protection

Noise pulses of less than 3 ns (typical) on OE#, CE# or WE# do not initiate a write cycle.

Logical Inhibit

Write cycles are inhibited by holding any one of OE# = V_{IL}, CE# = V_{IH} or WE# = V_{IH}. To initiate a write cycle, CE# and WE# must be a logical zero while OE# is a logical one.

Power-Up Write Inhibit

If WE# = CE# = V_{IL} and OE# = V_{IH} during power up, the device does not accept commands on the rising edge of WE#. The internal state machine is automatically reset to the read mode on power-up.

Common Flash Memory Interface (CFI)

The Common Flash Interface (CFI) specification outlines device and host system software interrogation handshake, which allows specific vendor-specified software algorithms to be used for entire families of devices. Software support can then be device-independent, JEDEC ID-independent, and forward- and backward-compatible for the specified flash device families. Flash vendors can standardize their existing interfaces for long-term compatibility.

This device enters the CFI Query mode when the system writes the CFI Query command, 98h, to address 55h, any time the device is ready to read array data. The system can read CFI information at the addresses given in Tables 27-30. To terminate reading CFI data, the system must write the reset command.

The system can also write the CFI query command when the device is in the autoselect mode. The device enters the CFI query mode, and the system can read CFI data at the addresses given in Tables 27-30. The system must write the reset command to return the device to reading array data.

For further information, please refer to the CFI Specification and CFI Publication 100, available via the World Wide Web at http://www.amd.com/flash/cfi. Alternatively, contact your sales representative for copies of these documents.

Table 3I. CFI Query Identification String

Addresses (x16)	Addresses (x8)	Data	Description
10h 11h 12h	20h 22h 24h	0051h 0052h 0059h	Query Unique ASCII string “QRY”
13h 14h	26h 28h	0002h 0000h	Primary OEM Command Set
15h 16h	2Ah 2Ch	0040h 0000h	Address for Primary Extended Table
17h 18h	2Eh 30h	0000h 0000h	Alternate OEM Command Set (00h = none exists)
19h 1Ah	32h 34h	0000h 0000h	Address for Alternate OEM Extended Table (00h = none exists)

Table 32. System Interface String

Addresses (x16)	Addresses (x8)	Data	Description
1Bh	36h	0027h	V_{CC} Min. (write/erase) D7–D4: volt, D3–D0: 100 millivolt
1Ch	38h	0036h	V_{CC} Max. (write/erase) D7–D4: volt, D3–D0: 100 millivolt
1Dh	3Ah	0000h	V_{PP} Min. voltage (00h = no V_{PP} pin present)
1Eh	3Ch	0000h	V_{PP} Max. voltage (00h = no V_{PP} pin present)
1Fh	3Eh	0007h	Reserved for future use
20h	40h	0007h	Typical timeout for Min. size buffer write 2^N µs (00h = not supported)
21h	42h	000Ah	Typical timeout per individual block erase 2^N ms
22h	44h	0000h	Typical timeout for full chip erase 2^N ms (00h = not supported)
23h	46h	0001h	Reserved for future use
24h	48h	0005h	Max. timeout for buffer write 2^N times typical
25h	4Ah	0004h	Max. timeout per individual block erase 2^N times typical
26h	4Ch	0000h	Max. timeout for full chip erase 2^N times typical (00h = not supported)

Note: *CFI data related to V_{CC} and time-outs may differ from actual VCC and time-outs of the product. Please consult the Ordering Information tables to obtain the V_{CC} range for particular part numbers. Please contact the Erase and Programming Performance table for typical timeout specifications.*

Table 33. Device Geometry Definition

Addresses (x16)	Addresses (x8)	Data	Description
27h	4Eh	0019h 0018h 0017h 0016h	Device Size = 2^N byte 19 = 256 Mb, 18 = 128 Mb, 17 = 64 Mb, 16 = 32 Mb
28h 29h	50h 52h	000xh 0000h	Flash Device Interface description (refer to CFI publication 100) 0000h = x8-only bus devices 0001h = x16-only bus devices 0002h = x8/x16 bus devices
2Ah 2Bh	54h 56h	0005h 0000h	Max. number of byte in multi-byte write = 2^N (00h = not supported)
2Ch	58h	0001h 0002h	Number of Erase Block Regions within device (01h = uniform device, 02h = boot device)
2Dh 2Eh 2Fh 30h	5Ah 5Ch 5Eh 60h	00xxh 000xh 00x0h 000xh	Erase Block Region 1 Information (refer to the CFI specification or CFI publication 100) 003Fh, 0000h, 0001h = 32 Mb (-R0, -R3, -R4) 007Fh, 0000h, 0020h, 0000h = 32 Mb (-R1, -R2), 64 Mb (-R1, -R2) 007Fh, 0000h, 0000h, 0001h = 64 Mb (-R0, -R3, -R4, -R5, -R6, -R7) 00FFh, 0000h, 0000h, 0001h = 128 Mb 00FFh, 0001h, 0000h, 0001h = 256 Mb
31h 32h 33h 34h	60h 64h 66h 68h	00xxh 0000h 0000h 000xh	Erase Block Region 2 Information (refer to CFI publication 100) 003Eh, 0000h, 0000h, 0001h = 32 Mb (-R1, -R2) 007Eh, 0000h, 0000h, 0001h = 64 Mb (-R1, -R2) 0000h, 0000h, 0000h, 0000h = all others
35h 36h 37h 38h	6Ah 6Ch 6Eh 70h	0000h 0000h 0000h 0000h	Erase Block Region 3 Information (refer to CFI publication 100)
39h 3Ah 3Bh 3Ch	72h 74h 76h 78h	0000h 0000h 0000h 0000h	Erase Block Region 4 Information (refer to CFI publication 100)

Table 34. Primary Vendor-Specific Extended Query

Addresses (x16)	Addresses (x8)	Data	Description
40h 41h 42h	80h 82h 84h	0050h 0052h 0049h	Query-unique ASCII string “PRI”
43h	86h	0031h	Major version number, ASCII
44h	88h	0033h	Minor version number, ASCII
45h	8Ah	000xh	Address Sensitive Unlock (Bits 1-0) 0 = Required, 1 = Not Required Process Technology (Bits 7-2) 0010b = 0.23 µm MirrorBit 0009h = x8-only bus devices 0008h = all other devices
46h	8Ch	0002h	Erase Suspend 0 = Not Supported, 1 = To Read Only, 2 = To Read & Write
47h	8Eh	0001h	Sector Protect 0 = Not Supported, X = Number of sectors in per group
48h	90h	0000h	Sector Temporary Unprotect 00 = Not Supported, 01 = Supported
49h	92h	0004h	Sector Protect/Unprotect scheme 0004h = Standard Mode (Refer to Text)
4Ah	94h	0000h	Simultaneous Operation 00 = Not Supported, X = Number of Sectors in Bank
4Bh	96h	0000h	Burst Mode Type 00 = Not Supported, 01 = Supported
4Ch	98h	0001h	Page Mode Type 00 = Not Supported, 01 = 4 Word Page, 02 = 8 Word Page
4Dh	9Ah	00B5h	ACC (Acceleration) Supply Minimum 00h = Not Supported, D7-D4: Volt, D3-D0: 100 mV
4Eh	9Ch	00C5h	ACC (Acceleration) Supply Maximum 00h = Not Supported, D7-D4: Volt, D3-D0: 100 mV
4Fh	9Eh	00xxh	Top/Bottom Boot Sector Flag 00h = Uniform Device without WP# protect, 02h = Bottom Boot Device, 03h = Top Boot Device, 04h = Uniform sectors bottom WP# protect, 05h = Uniform sectors top WP# protect
50h	A0h	0001h	Program Suspend 00h = Not Supported, 01h = Supported

Command Definitions

Writing specific address and data commands or sequences into the command register initiates device operations. Table 35 and Table 36 define the valid register command sequences. *Writing incorrect address and data values or writing them in the improper sequence may place the device in an unknown state.* A reset command is then required to return the device to reading array data.

All addresses are latched on the falling edge of WE# or CE#, whichever happens later. All data is latched on the rising edge of WE# or CE#, whichever happens first. Refer to the AC Characteristics section for timing diagrams.

Reading Array Data

The device is automatically set to reading array data after device power-up. No commands are required to retrieve data. The device is ready to read array data after completing an Embedded Program or Embedded Erase algorithm.

After the device accepts an Erase Suspend command, the device enters the erase-suspend-read mode, after which the system can read data from any non-erase-suspended sector. After completing a programming operation in the Erase Suspend mode, the system may once again read array data with the same exception. See the Erase Suspend/Erase Resume Commands section for more information.

The system *must* issue the reset command to return the device to the read (or erase-suspend-read) mode if DQ5 goes high during an active program or erase operation, or if the device is in the autoselect mode. See the next section, Reset Command, for more information.

See also Requirements for Reading Array Data in the Device Bus Operations section for more information. The Read-Only Operations–“AC Characteristics” section on page 124 provides the read parameters, and 13 shows the timing diagram.

Reset Command

Writing the reset command resets the device to the read or erase-suspend-read mode. Address bits are don’t cares for this command.

The reset command may be written between the sequence cycles in an erase command sequence before erasing begins. This resets the device to the read mode. Once erasure begins, however, the device ignores reset commands until the operation is complete.

The reset command may be written between the sequence cycles in a program command sequence before programming begins. This resets the device to the read mode. If the program command sequence is written while the device is in the Erase Suspend mode, writing the reset command returns the device to the erase-suspend-read mode. Once programming begins, however, the device ignores reset commands until the operation is complete.

The reset command may be written between the sequence cycles in an autoselect command sequence. Once in the autoselect mode, the reset command must be written to return to the read mode. If the device entered the autoselect mode while in the Erase Suspend mode, writing the reset command returns the device to the erase-suspend-read mode.

If DQ5 goes high during a program or erase operation, writing the reset command returns the device to the read mode (or erase-suspend-read mode if the device was in Erase Suspend).

Note that if DQ1 goes high during a Write Buffer Programming operation, the system must write the Write-to-Buffer-Abort Reset command sequence to reset the device for the next operation.

Autoselect Command Sequence

The autoselect command sequence allows the host system to read several identifier codes at specific addresses:

Identifier Code	A7:A0 (x16)	A6:A-1 (x8)
Manufacturer ID	00h	00h
Device ID, Cycle 1	01h	02h
Device ID, Cycle 2	0Eh	1Ch
Device ID, Cycle 3	0Fh	1Eh
SecSi Sector Factory Protect	03h	06h
Sector Protect Verify	(SA)02h	(SA)04h

Note: *The device ID is read over three cycles. SA = Sector Address*

The autoselect command sequence is initiated by first writing two unlock cycles. This is followed by a third write cycle that contains the autoselect command. The device then enters the autoselect mode. The system may read at any address any number of times without initiating another autoselect command sequence:

The system must write the reset command to return to the read mode (or erase-suspend-read mode if the device was previously in Erase Suspend).

Enter SecSi Sector/Exit SecSi Sector Command Sequence

The SecSi Sector region provides a secured data area containing an 8-word/16-byte random Electronic Serial Number (ESN). The system can access the SecSi Sector region by issuing the three-cycle Enter SecSi Sector command sequence. The device continues to access the SecSi Sector region until the system issues the four-cycle Exit SecSi Sector command sequence. The Exit SecSi Sector command sequence returns the device to normal operation. Table 35 and Table 36 show the address and data requirements for both command sequences. See also “SecSi (Secured Silicon) Sector Flash Memory Region” for further information. *Note that the ACC function and unlock bypass modes are not available when the SecSi Sector is enabled.*

Word Program Command Sequence

Programming is a four-bus-cycle operation. The program command sequence is initiated by writing two unlock write cycles, followed by the program set-up command. The program address and data are written next, which in turn initiate the Embedded Program algorithm. The system is not required to provide further controls or timings. The device automatically provides internally generated program pulses and verifies the programmed cell margin. Tables 31 and 32 show the address and data requirements for the word program command sequence, respectively.

When the Embedded Program algorithm is complete, the device then returns to the read mode and addresses are no longer latched. The system can determine the status of the program operation by using DQ7 or DQ6. Refer to the Write Operation Status section for information on these status bits. Any commands written to the device during the Embedded Program Algorithm are ignored. *Note that the SecSi Sector, autoselect, and CFI functions are unavailable when a program operation is in progress.* Note that a **hardware reset** immediately terminates the program operation. The program command sequence should be reinitiated once the device has returned to the read mode, to ensure data integrity.

Programming is allowed in any sequence of address locations and across sector boundaries. Programming to the same word address multiple times without intervening erases (incremental bit programming) requires a modified programming method. For such application requirements, please contact your local Spansion representative. Word programming is supported for backward compatibility with existing Flash driver software and for occasional writing of individual words. Use of write buffer programming (see below) is strongly recommended for general programming use when more than a few words are to be programmed. The effective word programming time using write buffer programming is approximately four times shorter than the single word programming time.

Any bit in a word cannot be programmed from "0" back to a "1." Attempting to do so may cause the device to set DQ5=1, or cause DQ7 and DQ6 status bits to indicate the operation was successful. However, a succeeding read will show that the data is still "0." Only erase operations can convert a "0" to a "1."

Unlock Bypass Command Sequence

The unlock bypass feature allows the system to program words to the device faster than using the standard program command sequence. The unlock bypass command sequence is initiated by first writing two unlock cycles. This is followed by a third write cycle containing the unlock bypass command, 20h. The device then enters the unlock bypass mode. A two-cycle unlock bypass mode command sequence is all that is required to program in this mode. The first cycle in this sequence contains the unlock bypass program command, A0h; the second cycle contains the program address and data. Additional data is programmed in the same manner. This mode dispenses with the initial two unlock cycles required in the standard program command sequence, resulting in faster total programming time. Tables 31 and 32 show the requirements for the command sequence.

During the unlock bypass mode, only the Unlock Bypass Program and Unlock Bypass Reset commands are valid. To exit the unlock bypass mode, the system must issue the two-cycle unlock bypass reset command sequence. The first cycle must contain the data 90h. The second cycle must contain the data 00h. The device then returns to the read mode.

Write Buffer Programming

Write Buffer Programming allows the system write to a maximum of 16 words/32 bytes in one programming operation. This results in faster effective programming time than the standard programming algorithms. The Write Buffer Programming command sequence is initiated by first writing two unlock cycles. This is followed by a third write cycle containing the Write Buffer Load command written at the Sector Address in which programming will occur. The fourth cycle writes the sector address and the number of word locations, minus one, to be programmed. For example, if the system will program 6 unique address locations, then 05h should be written to the device. This tells the device how many write buffer addresses will be loaded with data and therefore when to expect the Program Buffer to Flash command. The number of locations to program cannot exceed the size of the write buffer or the operation will abort.

The fifth cycle writes the first address location and data to be programmed. The write-buffer-page is selected by address bits A_{MAX}–A_4. All subsequent address/data pairs must fall within the selected-write-buffer-page. The system then writes the remaining address/data pairs into the write buffer. Write buffer locations may be loaded in any order.

The write-buffer-page address must be the same for all address/data pairs loaded into the write buffer. (This means Write Buffer Programming cannot be performed across multiple write-buffer pages.) This also means that Write Buffer Programming cannot be performed across multiple sectors. If the system attempts to load programming data outside of the selected write-buffer page, the operation will abort.

Note that if a Write Buffer address location is loaded multiple times, the address/data pair counter will be decremented for every data load operation. The host system must therefore account for loading a write-buffer location more than once. The counter decrements for each data load operation, not for each unique write-buffer-address location. Note also that if an address location is loaded more than once into the buffer, the final data loaded for that address will be programmed.

Once the specified number of write buffer locations have been loaded, the system must then write the Program Buffer to Flash command at the sector address. Any other address and data combination aborts the Write Buffer Programming operation. The device then begins programming. Data polling should be used while monitoring the last address location loaded into the write buffer. DQ7, DQ6, DQ5, and DQ1 should be monitored to determine the device status during Write Buffer Programming.

The write-buffer programming operation can be suspended using the standard program suspend/resume commands. Upon successful completion of the Write Buffer Programming operation, the device is ready to execute the next command.

The Write Buffer Programming Sequence can be aborted in the following ways:

- Load a value that is greater than the page buffer size during the Number of Locations to Program step.
- Write to an address in a sector different than the one specified during the Write-Buffer-Load command.
- Write an Address/Data pair to a different write-buffer-page than the one selected by the Starting Address during the write buffer data loading stage of the operation.
- Write data other than the Confirm Command after the specified number of data load cycles.

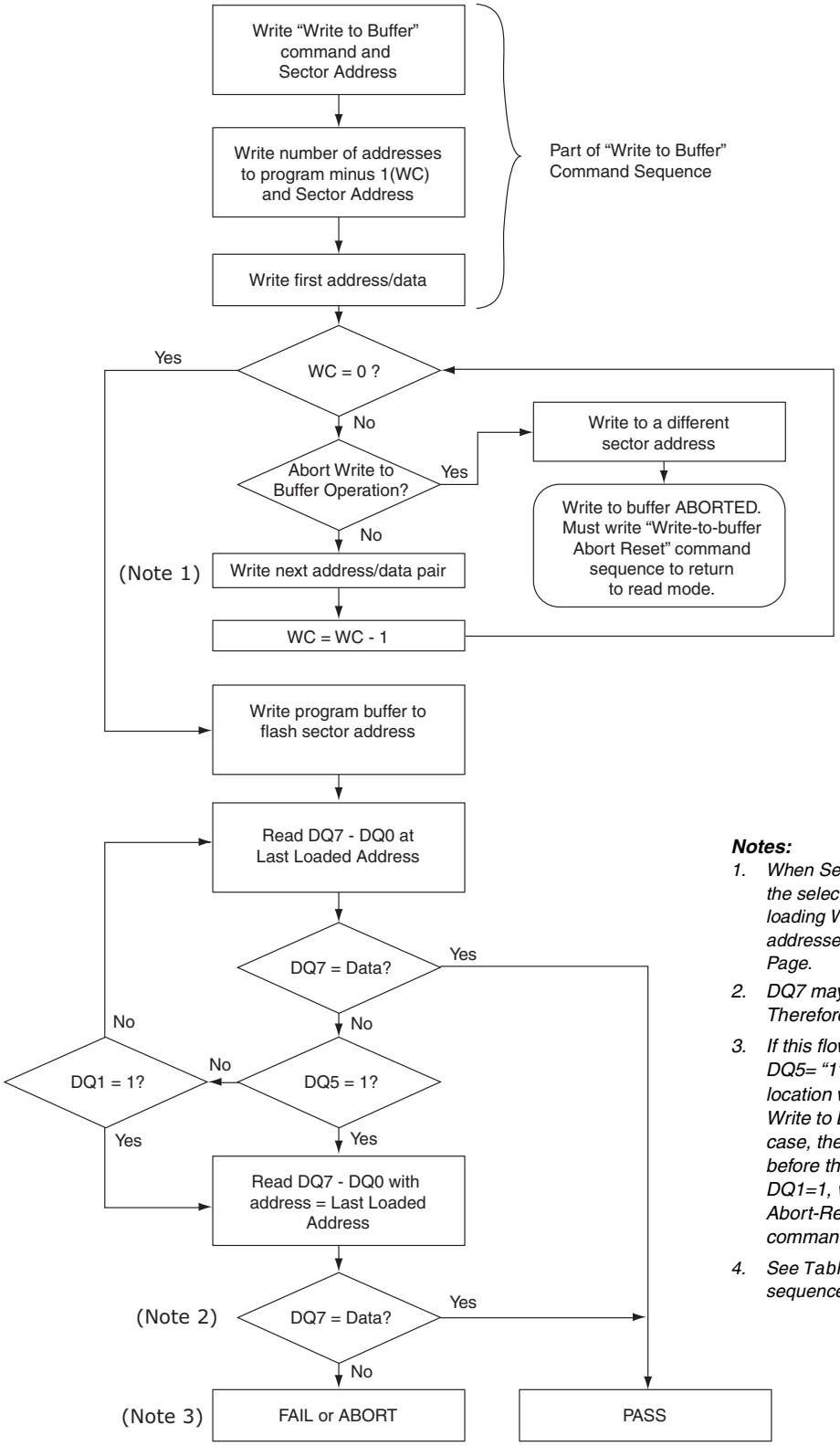
The abort condition is indicated by DQ1 = 1, DQ7 = DATA# (for the last address location loaded), DQ6 = toggle, and DQ5=0. A Write-to-Buffer-Abort Reset command sequence must be written to reset the device for the next operation.

*Note that the SecSi Sector, autoselect, and CFI functions are unavailable when a program operation is in progress.*This flash device is capable of handling multiple write buffer programming operations on the same write buffer address range without intervening erases. For applications requiring incremental bit programming, a modified programming method is required; please contact your local Spansion representative. **Any bit in a write buffer address range cannot be programmed from "0" back to a "1."** Attempting to do so may cause the device to set DQ5=1, of cause the DQ7 and DQ6 status bits to indicate the operation was successful. However, a succeeding read will show that the data is still "0." Only erase operations can convert a "0" to a "1."

Accelerated Program

The device offers accelerated program operations through the WP#/ACC or ACC pin depending on the particular product. When the system asserts V_{HH} on the WP#/ACC or ACC pin. The device uses the higher voltage on the WP#/ACC or ACC pin to accelerate the operation. *Note that the* WP#/*ACC pin must not be at V_{HH} for operations other than accelerated programming, or device damage may result. WP# has an internal pullup; when unconnected, WP# is at V_{IH}.*

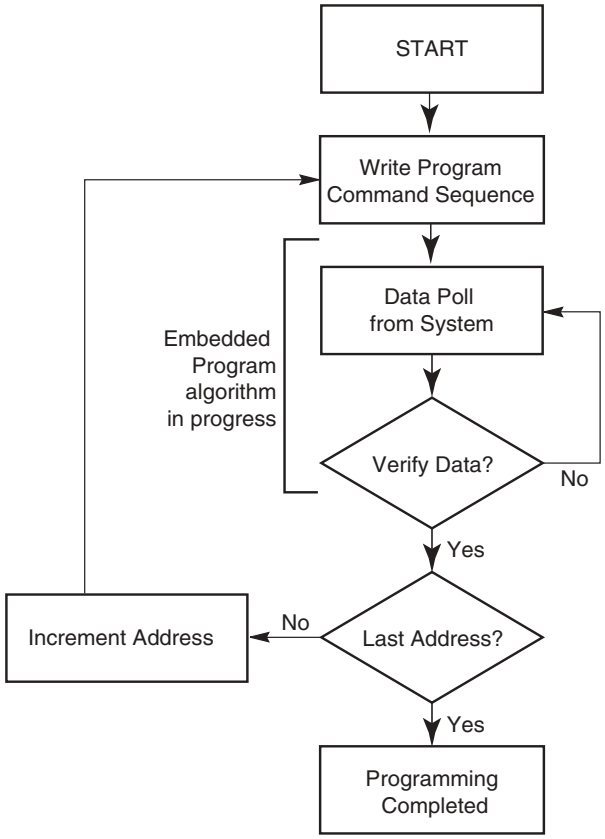
Figure 3 illustrates the algorithm for the program operation. Refer to the Erase and Program Operations–"AC Characteristics" section on page 124 section for parameters, and Figure 14 for timing diagrams.



Notes:

1. *When Sector Address is specified, any address in the selected sector is acceptable. However, when loading Write-Buffer address locations with data, all addresses must fall within the selected Write-Buffer Page.*
2. *DQ7 may change simultaneously with DQ5. Therefore, DQ7 should be verified.*
3. *If this flowchart location was reached because DQ5= "1", then the device FAILED. If this flowchart location was reached because DQ1= "1", then the Write to Buffer operation was ABORTED. In either case, the proper reset command must be written before the device can begin another operation. If DQ1=1, write the Write-Buffer-Programming-Abort-Reset command. if DQ5=1, write the Reset command.*
4. *See Table 35 and Table 36 for command sequences required for write buffer programming.*

Figure 3. Write Buffer Programming Operation



Note: *See Table 35 and Table 36 for program command sequence.*

Figure 4. Program Operation

Program Suspend/Program Resume Command Sequence

The Program Suspend command allows the system to interrupt a programming operation or a Write to Buffer programming operation so that data can be read from any non-suspended sector. When the Program Suspend command is written during a programming process, the device halts the program operation within 15 µs maximum (5µs typical) and updates the status bits. Addresses are not required when writing the Program Suspend command.

After the programming operation has been suspended, the system can read array data from any non-suspended sector. The Program Suspend command may also be issued during a programming operation while an erase is suspended. In this case, data may be read from any addresses not in Erase Suspend or Program Suspend. If a read is needed from the SecSi Sector area (One-time Program area), then user must use the proper command sequences to enter and exit this region. Note that the SecSi Sector, autoselect, and CFI functions are unavailable when a program operation is in progress.

The system may also write the autoselect command sequence when the device is in the Program Suspend mode. The system can read as many autoselect codes as required. When the device exits the autoselect mode, the device reverts to the Program Suspend mode, and is ready for another valid operation. See Autoselect Command Sequence for more information.

After the Program Resume command is written, the device reverts to programming. The system can determine the status of the program operation using the DQ7 or DQ6 status bits, just as in the standard program operation. See Write Operation Status for more information.

The system must write the Program Resume command (address bits are don't care) to exit the Program Suspend mode and continue the programming operation. Further writes of the Resume command are ignored. Another Program Suspend command can be written after the device has resumed programming.

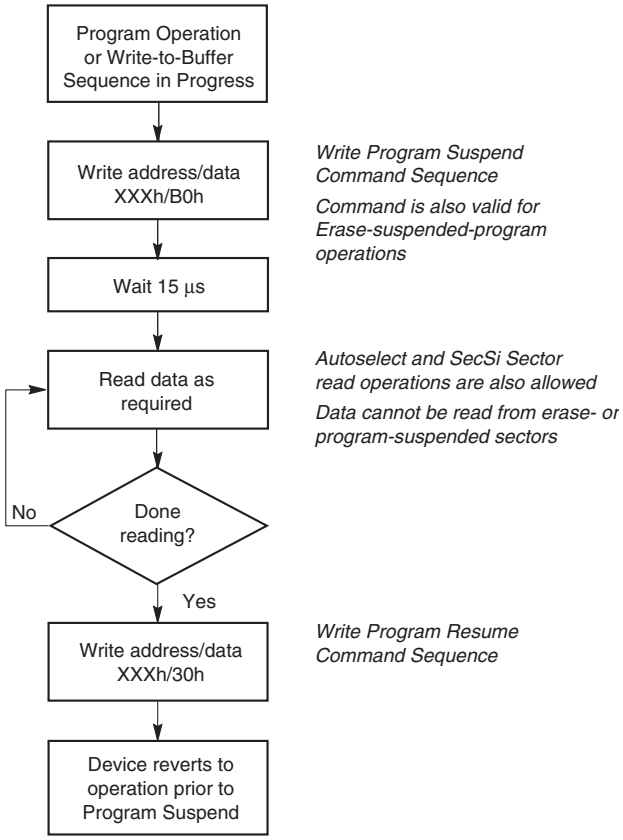


Figure 5. Program Suspend/Program Resume

Chip Erase Command Sequence

Chip erase is a six bus cycle operation. The chip erase command sequence is initiated by writing two unlock cycles, followed by a set-up command. Two additional unlock write cycles are then followed by the chip erase command, which in turn invokes the Embedded Erase algorithm. The device does *not* require the system to preprogram prior to erase. The Embedded Erase algorithm automatically preprograms and verifies the entire memory for an all zero data pattern prior to electrical erase. The system is not required to provide any controls or timings during these operations. Table 35 and Table 36 show the address and data requirements for the chip erase command sequence.

When the Embedded Erase algorithm is complete, the device returns to the read mode and addresses are no longer latched. The system can determine the status of the erase operation by using DQ7, DQ6, or DQ2. Refer to the Write Operation Status section for information on these status bits.

Any commands written during the chip erase operation are ignored. However, note that a **hardware reset** immediately terminates the erase operation. If that occurs, the chip erase command sequence should be reinitiated once the device has returned to reading array data, to ensure data integrity.

6 illustrates the algorithm for the erase operation. Refer to the Erase and Program Operations table in the AC Characteristics section for parameters, and 18 section for timing diagrams.

Sector Erase Command Sequence

Sector erase is a six bus cycle operation. The sector erase command sequence is initiated by writing two unlock cycles, followed by a set-up command. Two additional unlock cycles are written, and are then followed by the address of the sector to be erased, and the sector erase command. Table 35 and Table 36 shows the address and data requirements for the sector erase command sequence.

The device does *not* require the system to preprogram prior to erase. The Embedded Erase algorithm automatically programs and verifies the entire memory for an all zero data pattern prior to electrical erase. The system is not required to provide any controls or timings during these operations.

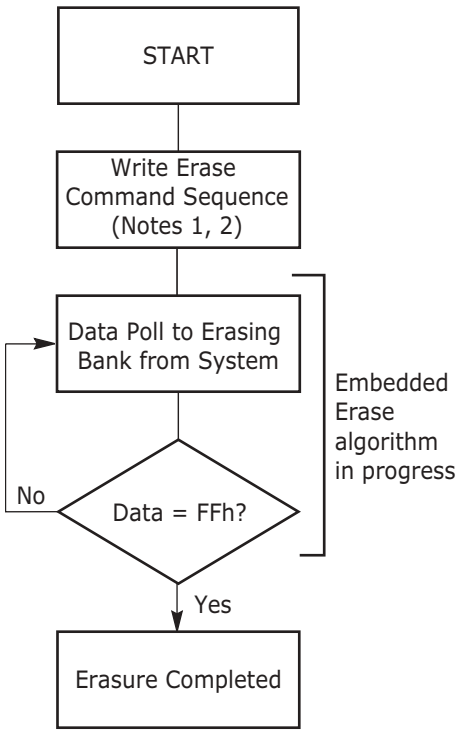
After the command sequence is written, a sector erase time-out of 50 µs occurs. During the time-out period, additional sector addresses and sector erase commands may be written. Loading the sector erase buffer may be done in any sequence, and the number of sectors may be from one sector to all sectors. The time between these additional cycles must be less than 50 µs, otherwise erasure may begin. Any sector erase address and command following the exceeded time-out may or may not be accepted. It is recommended that processor interrupts be disabled during this time to ensure all commands are accepted. The interrupts can be re-enabled after the last Sector Erase command is written. **Any command other than Sector Erase or Erase Suspend during the time-out period resets the device to the read mode.** *Note that the SecSi Sector, autoselect, and CFI functions are unavailable when an erase operation is in progress.* The system must rewrite the command sequence and any additional addresses and commands.

The system can monitor DQ3 to determine if the sector erase timer has timed out (See the section on DQ3: Sector Erase Timer.). The time-out begins from the rising edge of the final WE# pulse in the command sequence.

When the Embedded Erase algorithm is complete, the device returns to reading array data and addresses are no longer latched. The system can determine the status of the erase operation by reading DQ7, DQ6, or DQ2 in the erasing sector. Refer to the Write Operation Status section for information on these status bits.

Once the sector erase operation has begun, only the Erase Suspend command is valid. All other commands are ignored. However, note that a **hardware reset** immediately terminates the erase operation. If that occurs, the sector erase command sequence should be reinitiated once the device has returned to reading array data, to ensure data integrity.

6 illustrates the algorithm for the erase operation. Refer to the Erase and Program Operations table in the AC Characteristics section for parameters, and 18 section for timing diagrams.



Notes:

1. *See Table 35 and Table 36 for program command sequence.*
2. *See the section on DQ3 for information on the sector erase timer.*

Figure 6. Erase Operation

Erase Suspend/Erase Resume Commands

The Erase Suspend command, B0h, allows the system to interrupt a sector erase operation and then read data from, or program data to, any sector not selected for erasure. This command is valid only during the sector erase operation, including the 50 µs time-out period during the sector erase command sequence. The Erase Suspend command is ignored if written during the chip erase operation or Embedded Program algorithm.

When the Erase Suspend command is written during the sector erase operation, the device requires a typical of 5 µs (maximum of 20 µs) to suspend the erase operation. However, when the Erase Suspend command is written during the sector erase time-out, the device immediately terminates the time-out period and suspends the erase operation.

After the erase operation has been suspended, the device enters the erase-suspend-read mode. The system can read data from or program data to any sector not selected for erasure. (The device “erase suspends” all sectors selected for erasure.) Reading at any address within erase-suspended sectors produces status information on DQ7–DQ0. The system can use DQ7, or DQ6 and DQ2 together, to determine if a sector is actively erasing or is erase-suspended. Refer to the Write Operation Status section for information on these status bits.

After an erase-suspended program operation is complete, the device returns to the erase-suspend-read mode. The system can determine the status of the program operation using the DQ7 or DQ6 status bits, just as in the standard word program operation. Refer to the Write Operation Status section for more information.

In the erase-suspend-read mode, the system can also issue the autoselect command sequence. Refer to the “Autoselect Mode” section on page 79 and “Autoselect Command Sequence” section on page 104 sections for details.

To resume the sector erase operation, the system must write the Erase Resume command. Further writes of the Resume command are ignored. Another Erase Suspend command can be written after the chip has resumed erasing.

Note: During an erase operation, this flash device performs multiple internal operations which are invisible to the system. When an erase operation is suspended, any of the internal operations that were not fully completed must be restarted. As such, if this flash device is continually issued suspend/resume commands in rapid succession, erase progress will be impeded as a function of the number of suspends. The result will be a longer cumulative erase time than without suspends. Note that the additional suspends do not affect device reliability or future performance. In most systems rapid erase/suspend activity occurs only briefly. In such cases, erase performance will not be significantly impacted.

Command Definitions

Table 35. Command Definitions (x16 Mode, BYTE# = V_{IH})

Command Sequence (Note 1)		Cycles	Bus Cycles (Notes 2–5)											
			First		Second		Third		Fourth		Fifth		Sixth	
			Addr	Data	Addr	Data	Addr	Data	Addr	Data	Addr	Data	Addr	Data
Read (Note 6)		1	RA	RD										
Reset (Note 7)		1	XXX	F0										
Autoselect (Note 8)	Manufacturer ID	4	555	AA	2AA	55	555	90	X00	0001				
	Device ID (Note 9)	4	555	AA	2AA	55	555	90	X01	227E	X0E	(Note 18)	X0F	(Note 18)
	SecSi‰ Sector Factory Protect (Note 10)	4	555	AA	2AA	55	555	90	X03	(Note 10)				
	Sector Group Protect Verify (Note 12)	4	555	AA	2AA	55	555	90	(SA)X02	00/01				
Enter SecSi Sector Region		3	555	AA	2AA	55	555	88						
Exit SecSi Sector Region		4	555	AA	2AA	55	555	90	XXX	00				
Program		4	555	AA	2AA	55	555	A0	PA	PD				
Write to Buffer (Note 11)		3	555	AA	2AA	55	SA	25	SA	WC	PA	PD	WBL	PD
Program Buffer to Flash		1	SA	29										
Write to Buffer Abort Reset (Note 13)		3	555	AA	2AA	55	555	F0						
Unlock Bypass		3	555	AA	2AA	55	555	20						
Unlock Bypass Program (Note 14)		2	XXX	A0	PA	PD								
Unlock Bypass Reset (Note 15)		2	XXX	90	XXX	00								
Chip Erase		6	555	AA	2AA	55	555	80	555	AA	2AA	55	555	10
Sector Erase		6	555	AA	2AA	55	555	80	555	AA	2AA	55	SA	30
Program/Erase Suspend (Note 16)		1	XXX	B0										
Program/Erase Resume (Note 17)		1	XXX	30										
CFI Query (Note 18)		1	55	98										

Legend:

X = Don't care
RA = Read Address of memory location to be read.
RD = Read Data read from location RA during read operation.
PA = Program Address. Addresses latch on falling edge of WE# or CE# pulse, whichever happens later.
PD = Program Data for location PA. Data latches on rising edge of WE# or CE# pulse, whichever happens first.
SA = Sector Address of sector to be verified (in autoselect mode) or erased. Address bits A21–A15 uniquely select any sector.
WBL = Write Buffer Location. Address must be within same write buffer page as PA.
WC = Word Count. Number of write buffer locations to load minus 1.

Notes:

1. *See Table 1 for description of bus operations.*
2. *All values are in hexadecimal.*
3. *Shaded cells indicate read cycles. All others are write cycles.*
4. *During unlock and command cycles, when lower address bits are 555 or 2AA as shown in table, address bits above A11 and data bits above DQ7 are don't care.*
5. *No unlock or command cycles required when device is in read mode.*
6. *Reset command is required to return to read mode (or to erase-suspend-read mode if previously in Erase Suspend) when device is in autoselect mode, or if DQ5 goes high while device is providing status information.*
7. *Fourth cycle of the autoselect command sequence is a read cycle. Data bits DQ15–DQ8 are don't care. Except for RD, PD and WC. See Autoselect Command Sequence section for more information.*
8. *Device ID must be read in three cycles.*
9. *If WP# protects highest address sector, data is 98h for factory locked and 18h for not factory locked. If WP# protects lowest address sector, data is 88h for factory locked and 08h for not factor locked.*
10. *Data is 00h for an unprotected sector group and 01h for a protected sector group.*
11. *Total number of cycles in command sequence is determined by number of words written to write buffer. Maximum number of cycles in command sequence is 21, including "Program Buffer to Flash" command.*
12. *Command sequence resets device for next command after aborted write-to-buffer operation.*
13. *Unlock Bypass command is required prior to Unlock Bypass Program command.*
14. *Unlock Bypass Reset command is required to return to read mode when device is in unlock bypass mode.*
15. *System may read and program in non-erasing sectors, or enter autoselect mode, when in Erase Suspend mode. Erase Suspend command is valid only during a sector erase operation.*
16. *Erase Resume command is valid only during Erase Suspend mode.*
17. *Command is valid when device is ready to read array data or when device is in autoselect mode.*
18. *Refer to Table 18, AutoSelect Codes for individual Device IDs per device density and model number.*

Table 36. Command Definitions (x8 Mode, BYTE# = V_{IL})

Command Sequence (Note 1)		Cycles	Bus Cycles (Notes 2–5)											
			First		Second		Third		Fourth		Fifth		Sixth	
			Addr	Data	Addr	Data	Addr	Data	Addr	Data	Addr	Data	Addr	Data
Read (Note 6)		1	RA	RD										
Reset (Note 7)		1	XXX	F0										
Autoselect (Note 8)	Manufacturer ID	4	AAA	AA	555	55	AAA	90	X00	01				
	Device ID (Note 9)	4	AAA	AA	555	55	AAA	90	X02	7E	X1C	(Note 17)	X1E	(Note 17)
	SecSi ‰ Sector Factory Protect (Note 10)	4	AAA	AA	555	55	AAA	90	X06	(Note 10)				
	Sector Group Protect Verify (Note 12)	4	AAA	AA	555	55	AAA	90	(SA)X04	00/01				
Enter SecSi Sector Region		3	AAA	AA	555	55	AAA	88						
Exit SecSi Sector Region		4	AAA	AA	555	55	AAA	90	XXX	00				
Write to Buffer (Note 11)		3	AAA	AA	555	55	SA	25	SA	BC	PA	PD	WBL	PD
Program Buffer to Flash		1	SA	29										
Write to Buffer Abort Reset (Note 13)		3	AAA	AA	555	55	AAA	F0						
Chip Erase		6	AAA	AA	555	55	AAA	80	AAA	AA	555	55	AAA	10
Sector Erase		6	AAA	AA	555	55	AAA	80	AAA	AA	555	55	SA	30
Program/Erase Suspend (Note 14)		1	XXX	B0										
Program/Erase Resume (Note 15)		1	XXX	30										
CFI Query (Note 16)		1	AA	98										

Legend:

X = Don't care

RA = Read Address of memory location to be read.

RD = Read Data read from location RA during read operation.

PA = Program Address. Addresses latch on falling edge of WE# or CE# pulse, whichever happens later.

PD = Program Data for location PA. Data latches on rising edge of WE# or CE# pulse, whichever happens first.

SA = Sector Address of sector to be verified (in autoselect mode) or erased. Address bits A21–A15 uniquely select any sector.

WBL = Write Buffer Location. Address must be within same write buffer page as PA.

BC = Byte Count. Number of write buffer locations to load minus 1.

Notes:

1. *See Table 1 for description of bus operations.*
2. *All values are in hexadecimal.*
3. *Shaded cells indicate read cycles. All others are write cycles.*
4. *During unlock and command cycles, when lower address bits are 555 or AAA as shown in table, address bits above A11 are don't care.*
5. *Unless otherwise noted, address bits A21–A11 are don't cares.*
6. *No unlock or command cycles required when device is in read mode.*
7. *Reset command is required to return to read mode (or to erase-suspend-read mode if previously in Erase Suspend) when device is in autoselect mode, or if DQ5 goes high while device is providing status information.*
8. *Fourth cycle of autoselect command sequence is a read cycle. Data bits DQ15–DQ8 are don't care. See Autoselect Command Sequence section or more information.*
9. *Device ID must be read in three cycles.*
10. *If WP# protects highest address sector, data is 98h for factory locked and 18h for not factory locked. If WP# protects lowest address sector, data is 88h for factory locked and 08h for not factor locked.*
11. *Data is 00h for an unprotected sector group and 01h for a protected sector group.*
12. *Total number of cycles in command sequence is determined by number of bytes written to write buffer. Maximum number of cycles in command sequence is 37, including "Program Buffer to Flash" command.*
13. *Command sequence resets device for next command after aborted write-to-buffer operation.*
14. *System may read and program in non-erasing sectors, or enter autoselect mode, when in Erase Suspend mode. Erase Suspend command is valid only during a sector erase operation.*
15. *Erase Resume command is valid only during Erase Suspend mode.*
16. *Command is valid when device is ready to read array data or when device is in autoselect mode.*
17. *Refer to Table 18, AutoSelect Codes for individual Device IDs per device density and model number.*

Write Operation Status

The device provides several bits to determine the status of a program or erase operation: DQ2, DQ3, DQ5, DQ6, and DQ7. Table 19 and the following subsections describe the function of these bits. DQ7 and DQ6 each offer a method for determining whether a program or erase operation is complete or in progress. The device also provides a hardware-based output signal, RY/BY#, to determine whether an Embedded Program or Erase operation is in progress or has been completed.

DQ7: Data# Polling

The Data# Polling bit, DQ7, indicates to the host system whether an Embedded Program or Erase algorithm is in progress or completed, or whether the device is in Erase Suspend. Data# Polling is valid after the rising edge of the final WE# pulse in the command sequence.

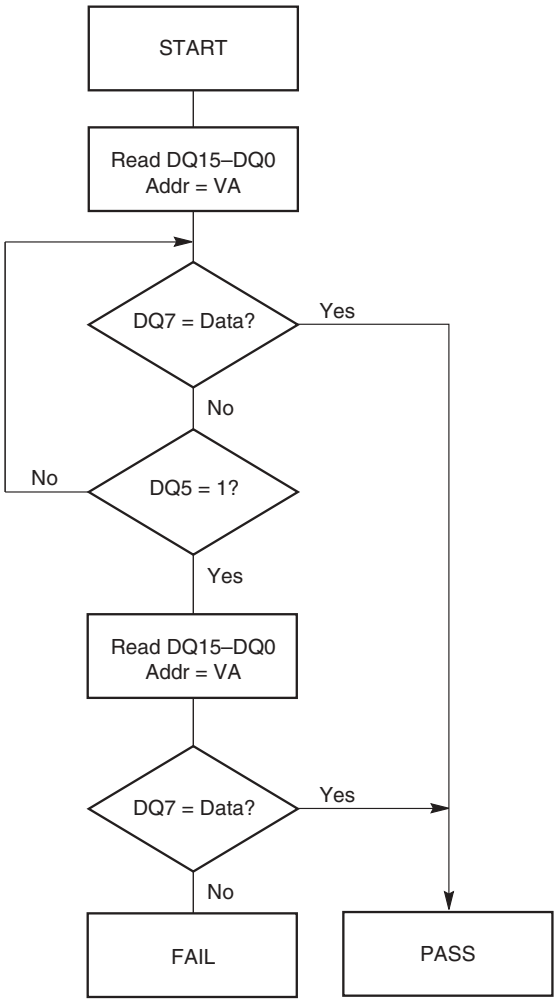
During the Embedded Program algorithm, the device outputs on DQ7 the complement of the datum programmed to DQ7. This DQ7 status also applies to programming during Erase Suspend. When the Embedded Program algorithm is complete, the device outputs the datum programmed to DQ7. The system must provide the program address to read valid status information on DQ7. If a program address falls within a protected sector, Data# Polling on DQ7 is active for approximately 1 µs, then the device returns to the read mode.

During the Embedded Erase algorithm, Data# Polling produces a “0” on DQ7. When the Embedded Erase algorithm is complete, or if the device enters the Erase Suspend mode, Data# Polling produces a “1” on DQ7. The system must provide an address within any of the sectors selected for erasure to read valid status information on DQ7.

After an erase command sequence is written, if all sectors selected for erasing are protected, Data# Polling on DQ7 is active for approximately 100 µs, then the device returns to the read mode. If not all selected sectors are protected, the Embedded Erase algorithm erases the unprotected sectors, and ignores the selected sectors that are protected. However, if the system reads DQ7 at an address within a protected sector, the status may not be valid.

Just prior to the completion of an Embedded Program or Erase operation, DQ7 may change asynchronously with DQ0–DQ6 while Output Enable (OE#) is asserted low. That is, the device may change from providing status information to valid data on DQ7. Depending on when the system samples the DQ7 output, it may read the status or valid data. Even if the device has completed the program or erase operation and DQ7 has valid data, the data outputs on DQ0–DQ6 may be still invalid. Valid data on DQ0–DQ7 will appear on successive read cycles.

Table 37 shows the outputs for Data# Polling on DQ7. Figure 7 shows the Data# Polling algorithm. Figure 17 in the AC Characteristics section shows the Data# Polling timing diagram.



Notes:

1. *VA = Valid address for programming. During a sector erase operation, a valid address is any sector address within the sector being erased. During chip erase, a valid address is any non-protected sector address.*
2. *DQ7 should be rechecked even if DQ5 = "1" because DQ7 may change simultaneously with DQ5.*

Figure 7. Data# Polling Algorithm

RY/BY#: Ready/Busy#

The RY/BY# is a dedicated, open-drain output pin which indicates whether an Embedded Algorithm is in progress or complete. The RY/BY# status is valid after the rising edge of the final WE# pulse in the command sequence. Since RY/BY# is an open-drain output, several RY/BY# pins can be tied together in parallel with a pull-up resistor to V_{CC}.

If the output is low (Busy), the device is actively erasing or programming. (This includes programming in the Erase Suspend mode.) If the output is high (Ready), the device is in the read mode, the standby mode, or in the erase-suspend-read mode. Table 37 shows the outputs for RY/BY#.

DQ6: Toggle Bit I

Toggle Bit I on DQ6 indicates whether an Embedded Program or Erase algorithm is in progress or complete, or whether the device has entered the Erase Suspend mode. Toggle Bit I may be read at any address, and is valid after the rising edge of the final WE# pulse in the command sequence (prior to the program or erase operation), and during the sector erase time-out.

During an Embedded Program or Erase algorithm operation, successive read cycles to any address cause DQ6 to toggle. The system may use either OE# or CE# to control the read cycles. When the operation is complete, DQ6 stops toggling.

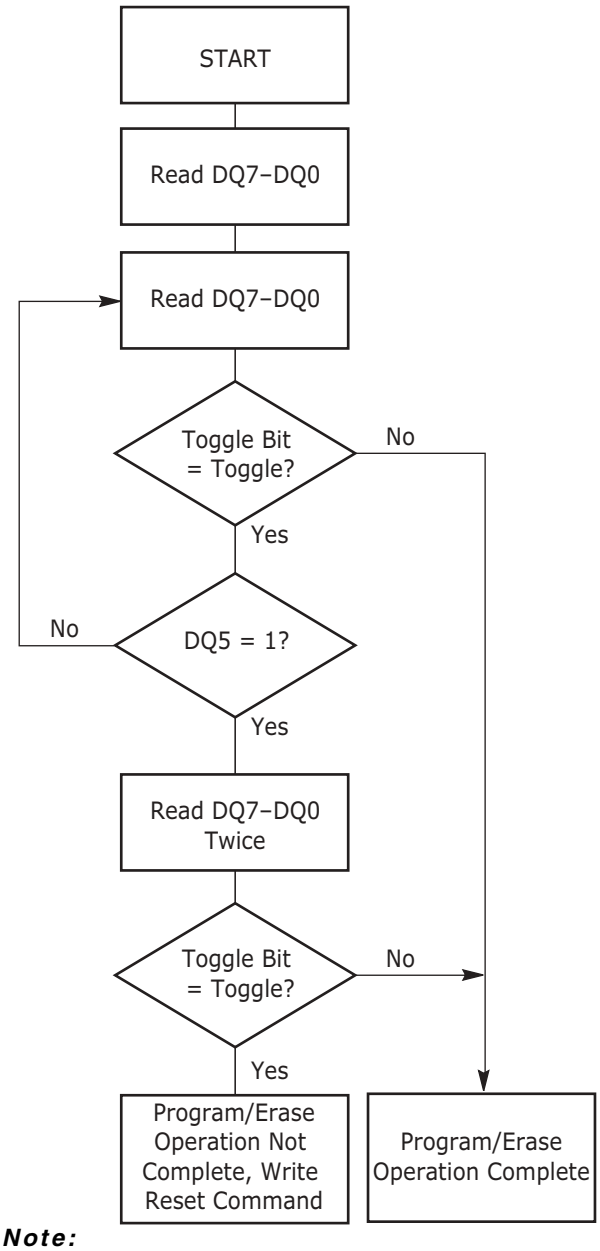
After an erase command sequence is written, if all sectors selected for erasing are protected, DQ6 toggles for approximately 100 µs, then returns to reading array data. If not all selected sectors are protected, the Embedded Erase algorithm erases the unprotected sectors, and ignores the selected sectors that are protected.

The system can use DQ6 and DQ2 together to determine whether a sector is actively erasing or is erase-suspended. When the device is actively erasing (that is, the Embedded Erase algorithm is in progress), DQ6 toggles. When the device enters the Erase Suspend mode, DQ6 stops toggling. However, the system must also use DQ2 to determine which sectors are erasing or erase-suspended. Alternatively, the system can use DQ7 (see the subsection on DQ7: Data# Polling).

If a program address falls within a protected sector, DQ6 toggles for approximately 1 µs after the program command sequence is written, then returns to reading array data.

DQ6 also toggles during the erase-suspend-program mode, and stops toggling once the Embedded Program algorithm is complete.

Table 37 shows the outputs for Toggle Bit I on DQ6. Figure 8 shows the toggle bit algorithm. 20 in the “AC Characteristics” section shows the toggle bit timing diagrams. 21 shows the differences between DQ2 and DQ6 in graphical form. See also the subsection on DQ2: Toggle Bit II.



Note:
The system should recheck the toggle bit even if DQ5 = "1" because the toggle bit may stop toggling as DQ5 changes to "1." See the subsections on DQ6 and DQ2 for more information.

Figure 8. Toggle Bit Algorithm

DQ2: Toggle Bit II

The “Toggle Bit II” on DQ2, when used with DQ6, indicates whether a particular sector is actively erasing (that is, the Embedded Erase algorithm is in progress), or whether that sector is erase-suspended. Toggle Bit II is valid after the rising edge of the final WE# pulse in the command sequence.

DQ2 toggles when the system reads at addresses within those sectors that have been selected for erasure. (The system may use either OE# or CE# to control the read cycles.) But DQ2 cannot distinguish whether the sector is actively erasing or is erase-suspended. DQ6, by comparison, indicates whether the device is actively erasing, or is in Erase Suspend, but cannot distinguish which sectors are selected for erasure. Thus, both status bits are required for sector and mode information. Refer to Table 37 to compare outputs for DQ2 and DQ6.

 8 shows the toggle bit algorithm in flowchart form, and the section “DQ2: Toggle Bit II” explains the algorithm. See also the RY/BY#: Ready/Busy# subsection. 20 shows the toggle bit timing diagram. 21 shows the differences between DQ2 and DQ6 in graphical form.

Reading Toggle Bits DQ6/DQ2

Refer to 8 for the following discussion. Whenever the system initially begins reading toggle bit status, it must read DQ7–DQ0 at least twice in a row to determine whether a toggle bit is toggling. Typically, the system would note and store the value of the toggle bit after the first read. After the second read, the system would compare the new value of the toggle bit with the first. If the toggle bit is not toggling, the device has completed the program or erase operation. The system can read array data on DQ7–DQ0 on the following read cycle.

However, if after the initial two read cycles, the system determines that the toggle bit is still toggling, the system also should note whether the value of DQ5 is high (see the section on DQ5). If it is, the system should then determine again whether the toggle bit is toggling, since the toggle bit may have stopped toggling just as DQ5 went high. If the toggle bit is no longer toggling, the device has successfully completed the program or erase operation. If it is still toggling, the device did not completed the operation successfully, and the system must write the reset command to return to reading array data.

The remaining scenario is that the system initially determines that the toggle bit is toggling and DQ5 has not gone high. The system may continue to monitor the toggle bit and DQ5 through successive read cycles, determining the status as described in the previous paragraph. Alternatively, it may choose to perform other system tasks. In this case, the system must start at the beginning of the algorithm when it returns to determine the status of the operation (top of Figure 6).

DQ5: Exceeded Timing Limits

DQ5 indicates whether the program, erase, or write-to-buffer time has exceeded a specified internal pulse count limit. Under these conditions DQ5 produces a “1,” indicating that the program or erase cycle was not successfully completed.

The device may output a “1” on DQ5 if the system tries to program a “1” to a location that was previously programmed to “0.” **Only an erase operation can change a “0” back to a “1.”** Under this condition, the device halts the operation, and when the timing limit has been exceeded, DQ5 produces a “1.”

In all these cases, the system must write the reset command to return the device to the reading the array (or to erase-suspend-read if the device was previously in the erase-suspend-program mode).

DQ3: Sector Erase Timer

After writing a sector erase command sequence, the system may read DQ3 to determine whether or not erasure has begun. (The sector erase timer does not apply to the chip erase command.) If additional sectors are selected for erasure, the entire time-out also applies after each additional sector erase command. When the time-out period is complete, DQ3 switches from a “0” to a “1.” If the time between additional sector erase commands from the system can be assumed to be less than 50 µs, the system need not monitor DQ3. See also the Sector Erase Command Sequence section.

After the sector erase command is written, the system should read the status of DQ7 (Data# Polling) or DQ6 (Toggle Bit I) to ensure that the device has accepted the command sequence, and then read DQ3. If DQ3 is “1,” the Embedded Erase algorithm has begun; all further commands (except Erase Suspend) are ignored until the erase operation is complete. If DQ3 is “0,” the device will accept additional sector erase commands. To ensure the command has been accepted, the system software should check the status of DQ3 prior to and following each subsequent sector erase command. If DQ3 is high on the second status check, the last command might not have been accepted.

Table 37 shows the status of DQ3 relative to the other status bits.

DQI: Write-to-Buffer Abort

DQ1 indicates whether a Write-to-Buffer operation was aborted. Under these conditions DQ1 produces a “1”. The system must issue the Write-to-Buffer-Abort-Reset command sequence to return the device to reading array data. See Write Buffer section for more details.

Table 37. Write Operation Status

Status			DQ7 (Note 2)	DQ6	DQ5 (Note 1)	DQ3	DQ2 (Note 2)	DQ1	RY/BY#
Standard Mode	Embedded Program Algorithm		DQ7#	Toggle	0	N/A	No toggle	0	0
	Embedded Erase Algorithm		0	Toggle	0	1	Toggle	N/A	0
Program Suspend Mode	Program-Suspend Read	Program-Suspended Sector	Invalid (not allowed)						1
		Non-Program Suspended Sector	Data						1
Erase Suspend Mode	Erase-Suspend Read	Erase-Suspended Sector	1	No toggle	0	N/A	Toggle	N/A	1
		Non-Erase Suspended Sector	Data						1
	Erase-Suspend-Program (Embedded Program)		DQ7#	Toggle	0	N/A	N/A	N/A	0
Write-to-Buffer	Busy (Note 3)		DQ7#	Toggle	0	N/A	N/A	0	0
	Abort (Note 4)		DQ7#	Toggle	0	N/A	N/A	1	0

Notes:

1. *DQ5 switches to ‘1’ when an Embedded Program, Embedded Erase, or Write-to-Buffer operation has exceeded the maximum timing limits. Refer to the section on DQ5 for more information.*
2. *DQ7 and DQ2 require a valid address when reading status information. Refer to the appropriate subsection for further details.*
3. *The Data# Polling algorithm should be used to monitor the last loaded write-buffer address location.*
4. *DQ1 switches to ‘1’ when the device has aborted the write-to-buffer operation*

Absolute Maximum Ratings

Storage Temperature, Plastic Packages . . . . . –65°C to +150°C

Ambient Temperature with Power Applied . . . . . –65°C to +125°C

Voltage with Respect to Ground:

V_{CC} (Note 1) . . . . . –0.5 V to +4.0 V

. . . . . A9, OE#, ACC and RESET# (Note 2) –0.5 V to +12.5 V

All other pins (Note 1) . . . . . –0.5 V to V_{CC}+0.5 V

Output Short Circuit Current (Note 3) . . . . . 200 mA

Notes:

1. *Minimum DC voltage on input or I/Os is –0.5 V. During voltage transitions, inputs or I/Os may overshoot V_{SS} to –2.0 V for periods of up to 20 ns. See Figure 9. Maximum DC voltage on input or I/Os is V_{CC} + 0.5 V. During voltage transitions, input or I/O pins may overshoot to V_{CC} + 2.0 V for periods up to 20 ns. See Figure 10.*
2. *Minimum DC input voltage on pins A9, OE#, ACC, and RESET# is –0.5 V. During voltage transitions, A9, OE#, ACC, and RESET# may overshoot V_{SS} to –2.0 V for periods of up to 20 ns. See Figure 9. Maximum DC input voltage on pin A9, OE#, ACC, and RESET# is +12.5 V which may overshoot to +14.0V for periods up to 20 ns.*
3. *No more than one output may be shorted to ground at a time. Duration of the short circuit should not be greater than one second.*
4. *Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational sections of this data sheet is not implied. Exposure of the device to absolute maximum rating conditions for extended periods may affect device reliability.*

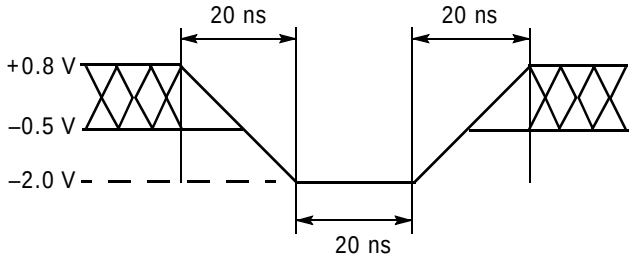


Figure 9. Maximum Negative Overshoot Waveform

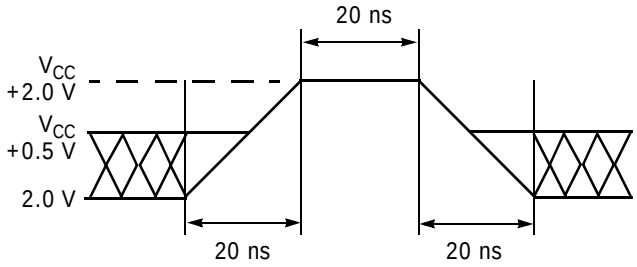


Figure 10. Maximum Positive Overshoot Waveform

Operating Ranges

Industrial (I) Devices

Ambient Temperature (T_A) . . . . . –40°C to +85°C

Supply Voltages

V_{CC} for full voltage range . . . . . +2.7 V to +3.6 V

V_{CC} for regulated voltage range . . . . . +3.0 V to +3.6 V

V_{IO} . . . . . V_{CC}

Notes:

1. *Operating ranges define those limits between which the functionality of the device is guaranteed.*

DC Characteristics

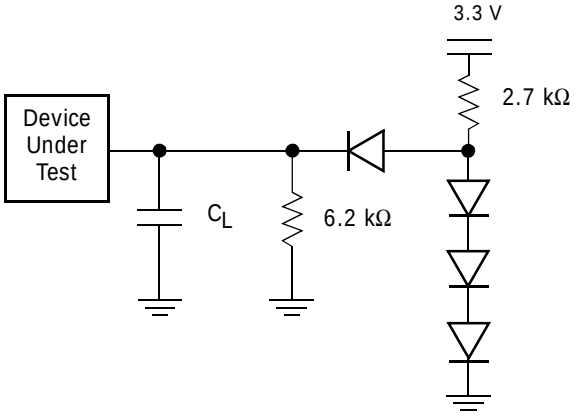
CMOS Compatible

Parameter Symbol	Parameter Description (Notes)	Test Conditions		Min	Typ	Max	Unit
I_{LI}	Input Load Current (1)	V_{IN} = V_{SS} to V_{CC}, V_{CC} = $V_{CC\ max}$				±1.0	µA
I_{LIT}	A9, ACC Input Load Current	V_{CC} = $V_{CC\ max}$; A9 = 12.5 V				35	µA
I_{LR}	Reset Leakage Current	V_{CC} = $V_{CC\ max}$; RESET# = 12.5 V				35	µA
I_{LO}	Output Leakage Current	V_{OUT} = V_{SS} to V_{CC}, V_{CC} = $V_{CC\ max}$				±1.0	µA
I_{CC1}	V_{CC} Initial Read Current (2), (3)	CE# = V_{IL}, OE# = V_{IH},	1 MHz		5	20	mA
			5 MHz (4)		18	25	
			5 MHz (5)		25	35	
			10 MHz (4)		35	50	
			10 MHz (5)		40	60	
I_{CC2}	V_{CC} Intra-Page Read Current (2), (3)	CE# = V_{IL}, OE# = V_{IH}	10 MHz		5	20	mA
			40 MHz		10	40	
I_{CC3}	V_{CC} Active Write Current (3), (4)	CE# = V_{IL}, OE# = V_{IH}			50	60	mA
I_{CC4}	V_{CC} Standby Current (3)	CE#, RESET# = V_{CC} ± 0.3 V, WP# = V_{IH}			1	5	µA
I_{CC5}	V_{CC} Reset Current (3)	RESET# = V_{SS} ± 0.3 V, WP# = V_{IH}			1	5	µA
I_{CC6}	Automatic Sleep Mode (3), (7)	V_{IH} = V_{CC} ± 0.3 V; -0.1< V_{IL} ≤ 0.3 V, WP# = V_{IH}			1	5	µA
V_{IL}	Input Low Voltage 1(8)			–0.5		0.8	V
V_{IH}	Input High Voltage 1 (8)			0.7 V_{CC}		V_{CC} + 0.5	V
V_{HH}	Voltage for ACC Program Acceleration	V_{CC} = 2.7 –3.6 V		11.5	12.0	12.5	V
V_{ID}	Voltage for Autoselect and Temporary Sector Unprotect	V_{CC} = 2.7 –3.6 V		11.5	12.0	12.5	V
V_{OL}	Output Low Voltage (8)	I_{OL} = 4.0 mA, V_{CC} = $V_{CC\ min}$				0.45	V
V_{OH1}	Output High Voltage	I_{OH} = –2.0 mA, V_{CC} = $V_{CC\ min}$		0.85 V_{CC}			V
V_{OH2}		I_{OH} = –100 µA, V_{CC} = $V_{CC\ min}$		V_{CC}–0.4			V
V_{LKO}	Low V_{CC} Lock-Out Voltage (9)			2.3		2.5	V

Notes:

1. *On the WP#/ACC pin only, the maximum input load current when WP# = V_{IL} is ± 2.0 µA.*
2. *The I_{CC} current listed is typically less than 2 mA/MHz, with OE# at V_{IH}.*
3. *Maximum I_{CC} specifications are tested with V_{CC} = V_{CC}max.*
4. *S29GL032M, S29GL064M*
5. *S29GL128M, S29GL256M*
6. *I_{CC} active while Embedded Erase or Embedded Program is in progress.*
7. *Automatic sleep mode enables the low power mode when addresses remain stable for t_{ACC} + 30 ns.*
8. *V_{CC} voltage requirements.*
9. *Not 100% tested.*

Test Conditions



Note: *Diodes are IN3064 or equivalent*

Figure 11. Test Setup

Table 38. Test Specifications

Test Condition	All Speeds	Unit
Output Load	1 TTL gate	
Output Load Capacitance, C_L (including jig capacitance)	30	pF
Input Rise and Fall Times	5	ns
Input Pulse Levels	0.0 or V_{CC}	V
Input timing measurement reference levels (See Note)	0.5 V_{CC}	V
Output timing measurement reference levels	0.5 V_{CC}	V

Key to Switching Waveforms

WAVEFORM	INPUTS	OUTPUTS
	Steady	
	Changing from H to L	
	Changing from L to H	
	Don't Care, Any Change Permitted	Changing, State Unknown
	Does Not Apply	Center Line is High Impedance State (High Z)

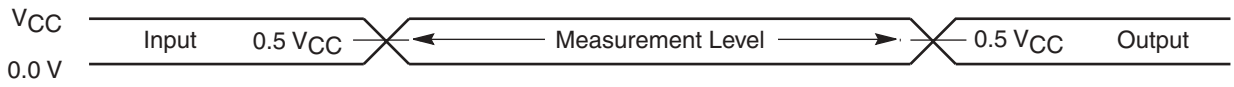


Figure 12. Input Waveforms and Measurement Levels

AC Characteristics

Read-Only Operations-S29GL256M only

Parameter		Description		Test Setup		Speed Options		Unit
JEDEC	Std.					10	11	
t_{AVAV}	t_{RC}	Read Cycle Time (Note 1)			Min	100	100	ns
t_{AVQV}	t_{ACC}	Address to Output Delay		CE#, OE# = V_{IL}	Max	100	100	ns
t_{ELQV}	t_{CE}	Chip Enable to Output Delay		OE# = V_{IL}	Max	100	100	ns
	t_{PACC}	Page Access Time			Max	30	30	ns
t_{GLQV}	t_{OE}	Output Enable to Output Delay			Max	30	30	ns
t_{EHQZ}	t_{DF}	Chip Enable to Output High Z (Note 1)			Max	16		ns
t_{GHQZ}	t_{DF}	Output Enable to Output High Z (Note 1)			Max	16		ns
t_{AXQX}	t_{OH}	Output Hold Time From Addresses, CE# or OE#, Whichever Occurs First			Min	0		ns
	t_{OEH}	Output Enable Hold Time (Note 1)	Read		Min	0		ns
			Toggle and Data# Polling		Min	10		ns

Notes:

1. *Not 100% tested.*
2. *See Figure 11 and Table 38 for test specifications.*

Read-Only Operations-S29GL128M only

Parameter		Description		Test Setup		Speed Options		Unit
JEDEC	Std.					90	10	
t_{AVAV}	t_{RC}	Read Cycle Time (Note 1)			Min	90	100	ns
t_{AVQV}	t_{ACC}	Address to Output Delay		CE#, OE# = V_{IL}	Max	90	100	ns
t_{ELQV}	t_{CE}	Chip Enable to Output Delay		OE# = V_{IL}	Max	90	100	ns
	t_{PACC}	Page Access Time			Max	25	30	ns
t_{GLQV}	t_{OE}	Output Enable to Output Delay			Max	25	30	ns
t_{EHQZ}	t_{DF}	Chip Enable to Output High Z (Note 1)			Max	16		ns
t_{GHQZ}	t_{DF}	Output Enable to Output High Z (Note 1)			Max	16		ns
t_{AXQX}	t_{OH}	Output Hold Time From Addresses, CE# or OE#, Whichever Occurs First			Min	0		ns
	t_{OEH}	Output Enable Hold Time (Note 1)	Read		Min	0		ns
			Toggle and Data# Polling		Min	10		ns

Notes:

1. *Not 100% tested.*
2. *See Figure 11 and Table 38 for test specifications.*

Read-Only Operations-S29GL064M only

Parameter		Description		Test Setup		Speed Options			Unit
JEDEC	Std.					90	10	11	
t_{AVAV}	t_{RC}	Read Cycle Time (Note 1)			Min	90	100	110	ns
t_{AVQV}	t_{ACC}	Address to Output Delay		CE#, OE# = V_{IL}	Max	90	100	110	ns
t_{ELQV}	t_{CE}	Chip Enable to Output Delay		OE# = V_{IL}	Max	90	100	110	ns
	t_{PACC}	Page Access Time			Max	25	30	30	ns
t_{GLQV}	t_{OE}	Output Enable to Output Delay			Max	25	30	30	ns
t_{EHQZ}	t_{DF}	Chip Enable to Output High Z (Note 1)			Max	16			ns
t_{GHQZ}	t_{DF}	Output Enable to Output High Z (Note 1)			Max	16			ns
t_{AXQX}	t_{OH}	Output Hold Time From Addresses, CE# or OE#, Whichever Occurs First			Min	0			ns
	t_{OEH}	Output Enable Hold Time (Note 1)	Read		Min	0			ns
			Toggle and Data# Polling		Min	10			ns

Notes:

1. *Not 100% tested.*
2. *See Figure 11 and Table 38 for test specifications.*

Read-Only Operations-S29GL032M only

Parameter		Description		Test Setup		Speed Options			Unit
JEDEC	Std.					90	10	11	
t_{AVAV}	t_{RC}	Read Cycle Time (Note 1)			Min	90	100	110	ns
t_{AVQV}	t_{ACC}	Address to Output Delay		CE#, OE# = V_{IL}	Max	90	100	110	ns
t_{ELQV}	t_{CE}	Chip Enable to Output Delay		OE# = V_{IL}	Max	90	100	110	ns
	t_{PACC}	Page Access Time			Max	25	30	30	ns
t_{GLQV}	t_{OE}	Output Enable to Output Delay			Max	25	30	30	ns
t_{EHQZ}	t_{DF}	Chip Enable to Output High Z (Note 1)			Max	16			ns
t_{GHQZ}	t_{DF}	Output Enable to Output High Z (Note 1)			Max	16			ns
t_{AXQX}	t_{OH}	Output Hold Time From Addresses, CE# or OE#, Whichever Occurs First			Min	0			ns
	t_{OEH}	Output Enable Hold Time (Note 1)	Read		Min	0			ns
			Toggle and Data# Polling		Min	10			ns

Notes:

1. *Not 100% tested.*
2. *See Figure 11 and Table 38 for test specifications.*

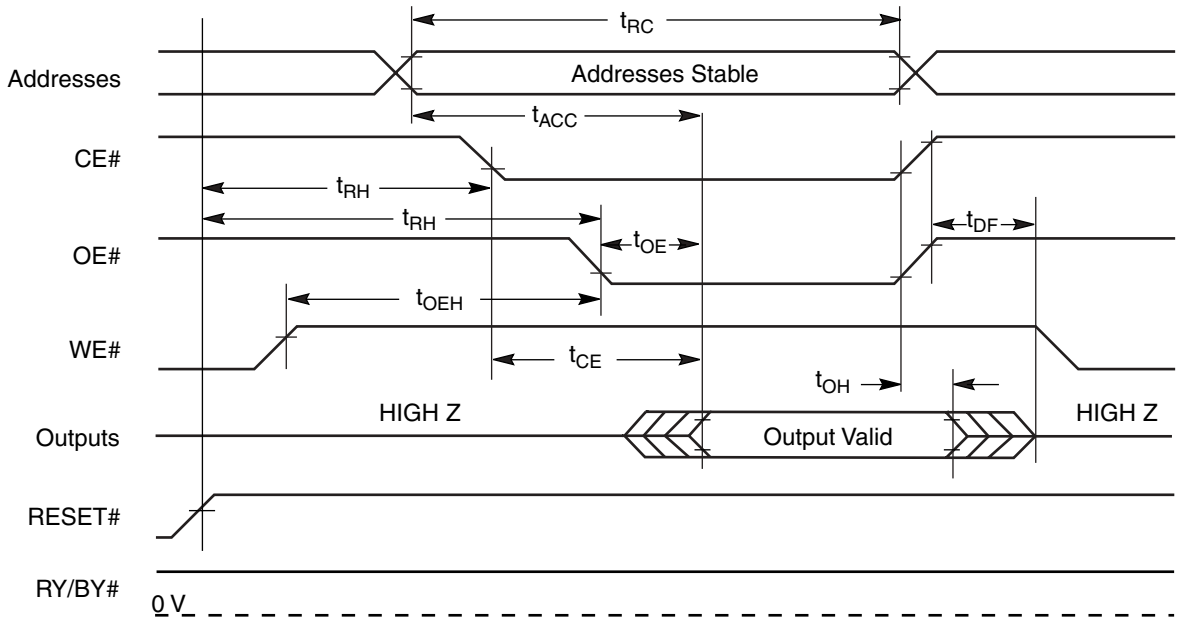
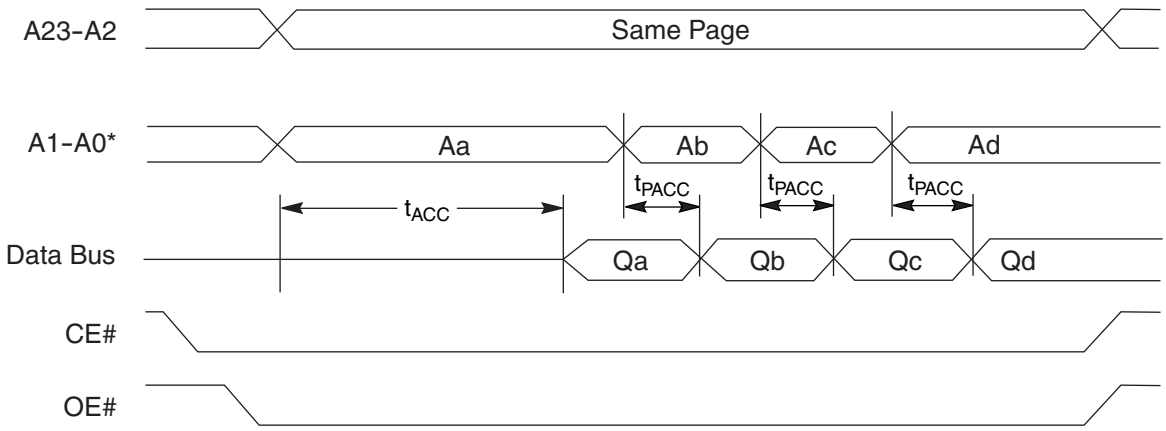


Figure 13. Read Operation Timings



** Figure shows device in word mode. Addresses are A1–A-1 for byte mode.*

Figure 14. Page Read Timings

Hardware Reset (RESET#)

Parameter		Description		All Speed Options	Unit
JEDEC	Std.				
	t_{Ready}	RESET# Pin Low (During Embedded Algorithms) to Read Mode (See Note)	Max	20	µs
	t_{Ready}	RESET# Pin Low (NOT During Embedded Algorithms) to Read Mode (See Note)	Max	500	ns
	t_{RP}	RESET# Pulse Width	Min	500	ns
	t_{RH}	Reset High Time Before Read (See Note)	Min	50	ns
	t_{RPD}	RESET# Input Low to Standby Mode (See Note)	Min	20	µs
	t_{RB}	RY/BY# Output High to CE#, OE# pin Low	Min	0	ns

Notes:
1. Not 100% tested.

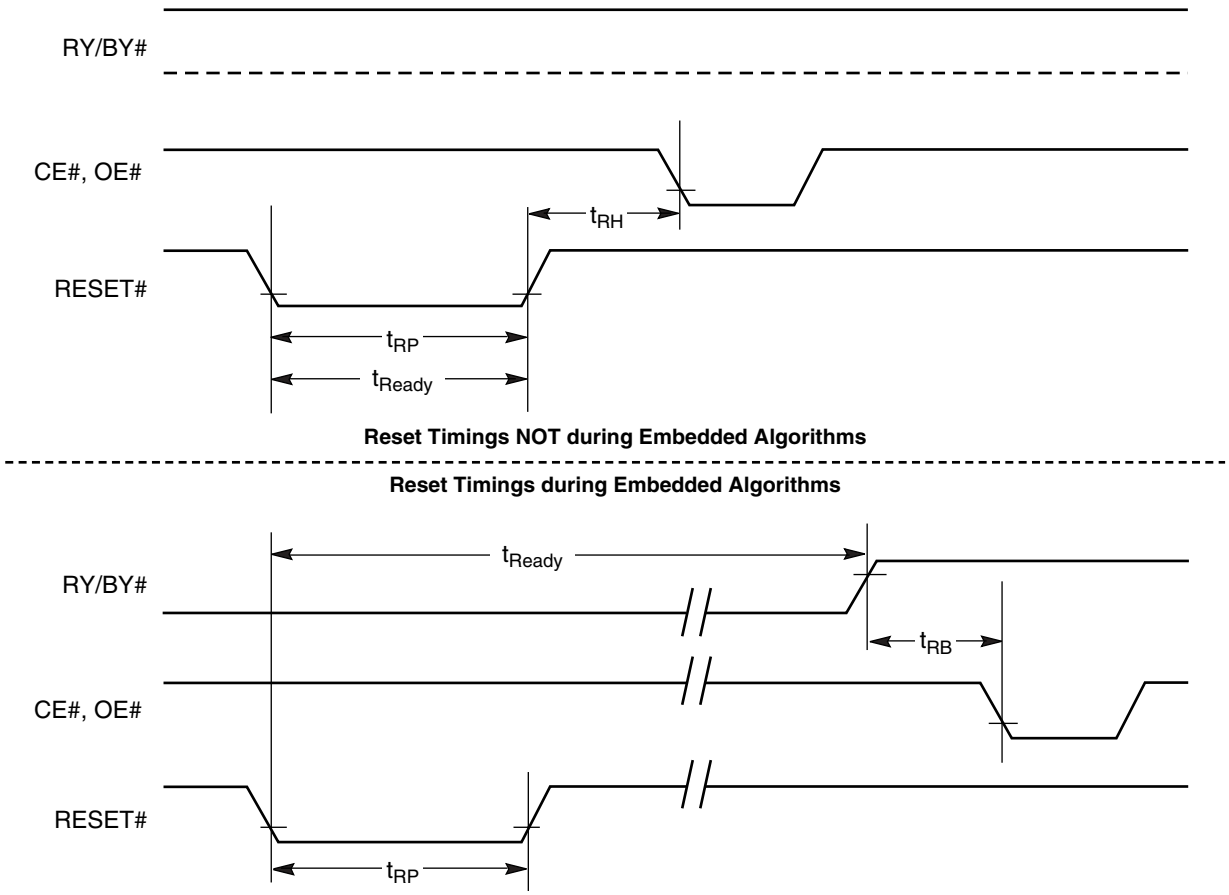


Figure 15. Reset Timings

Erase and Program Operations-S29GL256M only

Parameter		Description		Speed Options		Unit
JEDEC	Std.			10	11	
t_{AVAV}	t_{WC}	Write Cycle Time (Note 1)	Min	100	110	ns
t_{AVWL}	t_{AS}	Address Setup Time	Min	0		ns
	t_{ASO}	Address Setup Time to OE# low during toggle bit polling	Min	15		ns
t_{WLAX}	t_{AH}	Address Hold Time	Min	45		ns
	t_{AHT}	Address Hold Time From CE# or OE# high during toggle bit polling	Min	0		ns
t_{DVWH}	t_{DS}	Data Setup Time	Min	45		ns
t_{WHDX}	t_{DH}	Data Hold Time	Min	0		ns
	t_{CEPH}	CE# High during toggle bit polling	Min	20		ns
	t_{OEPH}	OE# High during toggle bit polling	Min	20		ns
t_{GHWL}	t_{GHWL}	Read Recovery Time Before Write (OE# High to WE# Low)	Min	0		ns
t_{ELWL}	t_{CS}	CE# Setup Time	Min	0		ns
t_{WHEH}	t_{CH}	CE# Hold Time	Min	0		ns
t_{WLWH}	t_{WP}	Write Pulse Width	Min	35		ns
t_{WHDL}	t_{WPH}	Write Pulse Width High	Min	30		ns
t_{WHWH1}	t_{WHWH1}	Write Buffer Program Operation (Notes 2, 3)	Typ	240		µs
		Single Word Program Operation (Note 2)	Typ	60		
		Accelerated Single Word Program Operation (Note 2)	Typ	54		
t_{WHWH2}	t_{WHWH2}	Sector Erase Operation (Note 2)	Typ	0.5		sec
	t_{VHH}	V_{HH} Rise and Fall Time (Note 1)	Min	250		ns
	t_{VCS}	V_{CC} Setup Time (Note 1)	Min	50		µs
	t_{BUSY}	WE# High to RY/BY# Low	Min	100	110	ns
	t_{POLL}	Program Valid before Status Polling	Max	4		µs

Notes:

1. *Not 100% tested.*
2. *See the "Erase and Programming Performance" section for more information.*
3. *For 1–16 words/1–32 bytes programmed.*
4. *If a program suspend command is issued within t_{POLL}, the device requires t_{POLL} before reading status data, once programming has resumed (that is, the program resume command has been written). If the suspend command was issued after t_{POLL}, status data is available immediately after programming has resumed. See 16.*

Erase and Program Operations-S29GL128M Only

Parameter		Description		Speed Options		Unit
JEDEC	Std.			90	10	
t_{AVAV}	t_{WC}	Write Cycle Time (Note 1)	Min	90	100	ns
t_{AVWL}	t_{AS}	Address Setup Time	Min	0		ns
	t_{ASO}	Address Setup Time to OE# low during toggle bit polling	Min	15		ns
t_{WLAX}	t_{AH}	Address Hold Time	Min	45		ns
	t_{AHT}	Address Hold Time From CE# or OE# high during toggle bit polling	Min	0		ns
t_{DVWH}	t_{DS}	Data Setup Time	Min	45		ns
t_{WHDX}	t_{DH}	Data Hold Time	Min	0		ns
	t_{CEPH}	CE# High during toggle bit polling	Min	20		ns
	t_{OEPH}	OE# High during toggle bit polling	Min	20		ns
t_{GHWL}	t_{GHWL}	Read Recovery Time Before Write (OE# High to WE# Low)	Min	0		ns
t_{ELWL}	t_{CS}	CE# Setup Time	Min	0		ns
t_{WHEH}	t_{CH}	CE# Hold Time	Min	0		ns
t_{WLWH}	t_{WP}	Write Pulse Width	Min	35		ns
t_{WHDL}	t_{WPH}	Write Pulse Width High	Min	30		ns
t_{WHWH1}	t_{WHWH1}	Write Buffer Program Operation (Notes 2, 3)	Typ	240		µs
		Single Word Program Operation (Note 2)	Typ	60		
		Accelerated Single Word Program Operation (Note 2)	Typ	54		
t_{WHWH2}	t_{WHWH2}	Sector Erase Operation (Note 2)	Typ	0.5		sec
	t_{VHH}	V_{HH} Rise and Fall Time (Note 1)	Min	250		ns
	t_{VCS}	V_{CC} Setup Time (Note 1)	Min	50		µs
	t_{BUSY}	WE# High to RY/BY# Low	Min	90	100	ns
	t_{POLL}	Program Valid before Status Polling	Max	4		µs

Notes:

1. *Not 100% tested.*
2. *See the "Erase and Programming Performance" section for more information.*
3. *For 1–16 words/1–32 bytes programmed.*
4. *If a program suspend command is issued within t_{POLL}, the device requires t_{POLL} before reading status data, once programming has resumed (that is, the program resume command has been written). If the suspend command was issued after t_{POLL}, status data is available immediately after programming has resumed. See 16.*

Erase and Program Operations-S29GL064M Only

Parameter		Description		Speed Options			Unit
JEDEC	Std.			90	10	11	
t_{AVAV}	t_{WC}	Write Cycle Time (Note 1)	Min	90	100	110	ns
t_{AVWL}	t_{AS}	Address Setup Time	Min	0			ns
	t_{ASO}	Address Setup Time to OE# low during toggle bit polling	Min	15			ns
t_{WLAX}	t_{AH}	Address Hold Time	Min	45			ns
	t_{AHT}	Address Hold Time From CE# or OE# high during toggle bit polling	Min	0			ns
t_{DVWH}	t_{DS}	Data Setup Time	Min	35			ns
t_{WHDX}	t_{DH}	Data Hold Time	Min	0			ns
	t_{CEPH}	CE# High during toggle bit polling	Min	20			ns
	t_{OEPH}	OE# High during toggle bit polling	Min	20			ns
t_{GHWL}	t_{GHWL}	Read Recovery Time Before Write (OE# High to WE# Low)	Min	0			ns
t_{ELWL}	t_{CS}	CE# Setup Time	Min	0			ns
t_{WHEH}	t_{CH}	CE# Hold Time	Min	0			ns
t_{WLWH}	t_{WP}	Write Pulse Width	Min	35			ns
t_{WHDL}	t_{WPH}	Write Pulse Width High	Min	30			ns
t_{WHWH1}	t_{WHWH1}	Write Buffer Program Operation (Notes 2, 3)	Typ	240			µs
		Single Word Program Operation (Note 2)	Typ	60			
		Accelerated Single Word Program Operation (Note 2)	Typ	54			
t_{WHWH2}	t_{WHWH2}	Sector Erase Operation (Note 2)	Typ	0.5			sec
	t_{VHH}	V_{HH} Rise and Fall Time (Note 1)	Min	250			ns
	t_{VCS}	V_{CC} Setup Time (Note 1)	Min	50			µs
	t_{BUSY}	WE# High to RY/BY# Low	Min	90	100	110	ns
	t_{POLL}	Program Valid before Status Polling	Max	4			µs

Notes:

1. *Not 100% tested.*
2. *See the "Erase and Programming Performance" section for more information.*
3. *For 1–16 words/1–32 bytes programmed.*
4. *If a program suspend command is issued within t_{POLL}, the device requires t_{POLL} before reading status data, once programming has resumed (that is, the program resume command has been written). If the suspend command was issued after t_{POLL}, status data is available immediately after programming has resumed. See 16.*

Erase and Program Operations-S29GL032M only

Parameter		Description		Speed Options			Unit
JEDEC	Std.			90	10	11	
t_{AVAV}	t_{WC}	Write Cycle Time (Note 1)	Min	90	100	110	ns
t_{AVWL}	t_{AS}	Address Setup Time	Min	0			ns
	t_{ASO}	Address Setup Time to OE# low during toggle bit polling	Min	15			ns
t_{WLAX}	t_{AH}	Address Hold Time	Min	45			ns
	t_{AHT}	Address Hold Time From CE# or OE# high during toggle bit polling	Min	0			ns
t_{DVWH}	t_{DS}	Data Setup Time	Min	35			ns
t_{WHDX}	t_{DH}	Data Hold Time	Min	0			ns
	t_{CEPH}	CE# High during toggle bit polling	Min	20			ns
	t_{OEPH}	OE# High during toggle bit polling	Min	20			ns
t_{GHWL}	t_{GHWL}	Read Recovery Time Before Write (OE# High to WE# Low)	Min	0			ns
t_{ELWL}	t_{CS}	CE# Setup Time	Min	0			ns
t_{WHEH}	t_{CH}	CE# Hold Time	Min	0			ns
t_{WLWH}	t_{WP}	Write Pulse Width	Min	35			ns
t_{WHDL}	t_{WPH}	Write Pulse Width High	Min	30			ns
t_{WHWH1}	t_{WHWH1}	Write Buffer Program Operation (Notes 2, 3)	Typ	240			µs
		Single Word Program Operation (Note 2)	Typ	60			
		Accelerated Single Word Program Operation (Note 2)	Typ	54			
t_{WHWH2}	t_{WHWH2}	Sector Erase Operation (Note 2)	Typ	0.5			sec
	t_{VHH}	V_{HH} Rise and Fall Time (Note 1)	Min	250			ns
	t_{VCS}	V_{CC} Setup Time (Note 1)	Min	50			µs
	t_{BUSY}	WE# High to RY/BY# Low	Min	90	100	110	ns
	t_{POLL}	Program Valid before Status Polling	Max	4			µs

Notes:

1. *Not 100% tested.*
2. *See the "Erase and Programming Performance" section for more information.*
3. *For 1–16 words/1–32 bytes programmed.*
4. *Effective write buffer specification is based upon a 16-word/32-byte write buffer operation.*
5. *If a program suspend command is issued within t_{POLL}, the device requires t_{POLL} before reading status data, once programming has resumed (that is, the program resume command has been written). If the suspend command was issued after t_{POLL}, status data is available immediately after programming has resumed. See 16.*

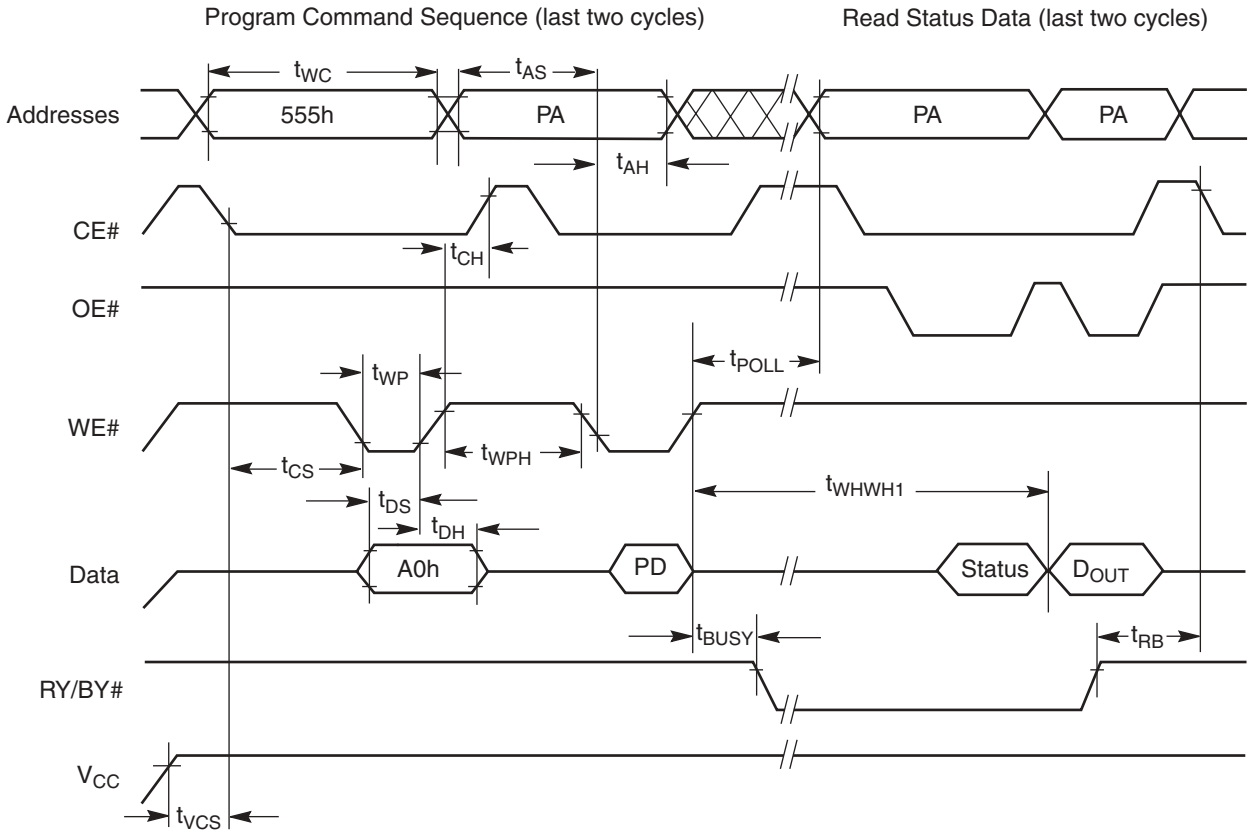


Figure 16. Program Operation Timings

Notes:

1. *PA = program address, PD = program data, D_{OUT} is the true data at the program address.*
2. *Illustration shows device in word mode.*

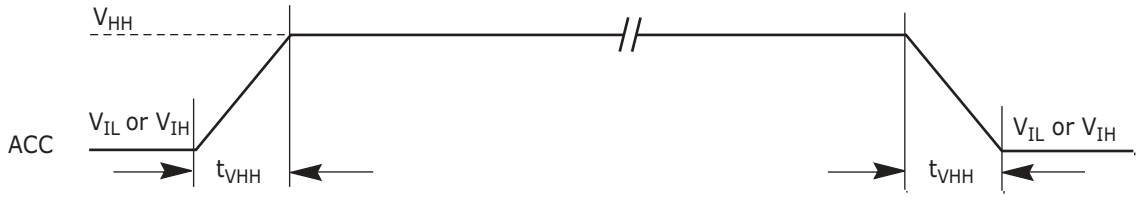
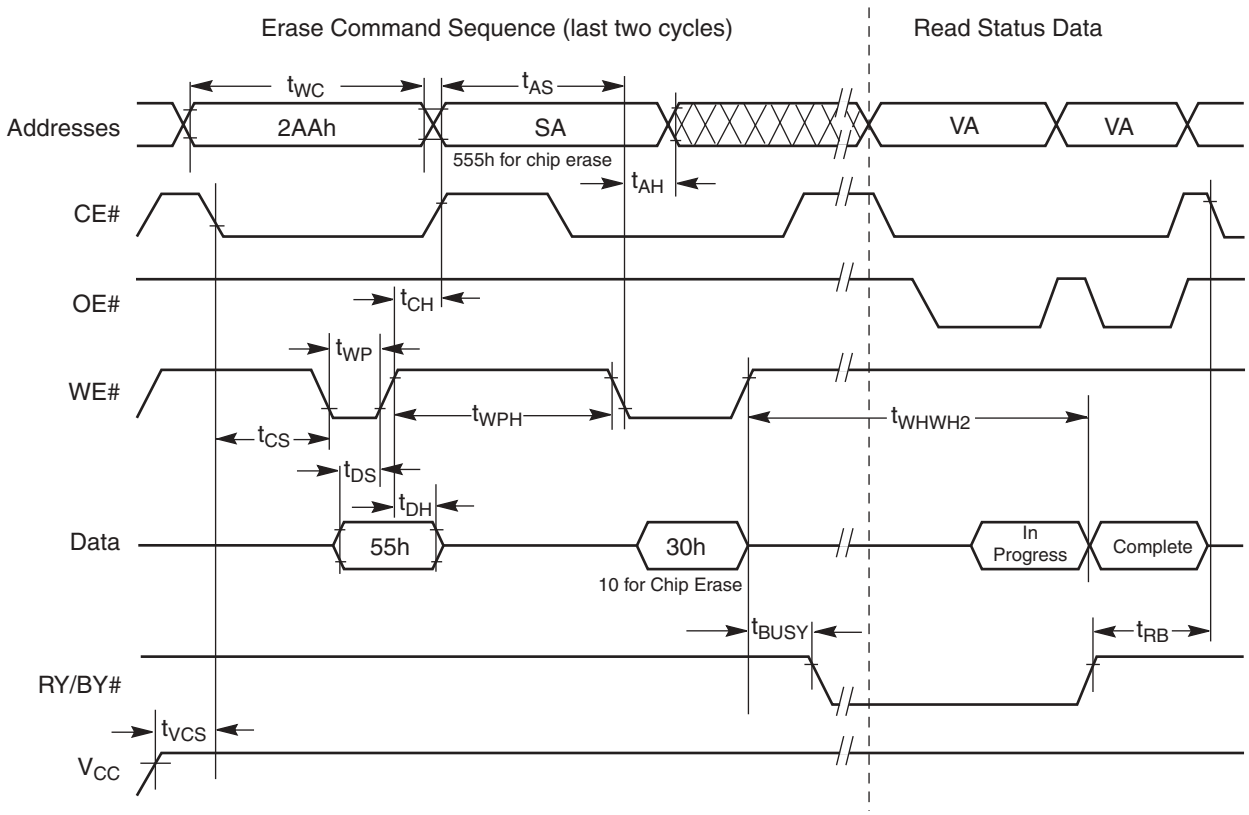


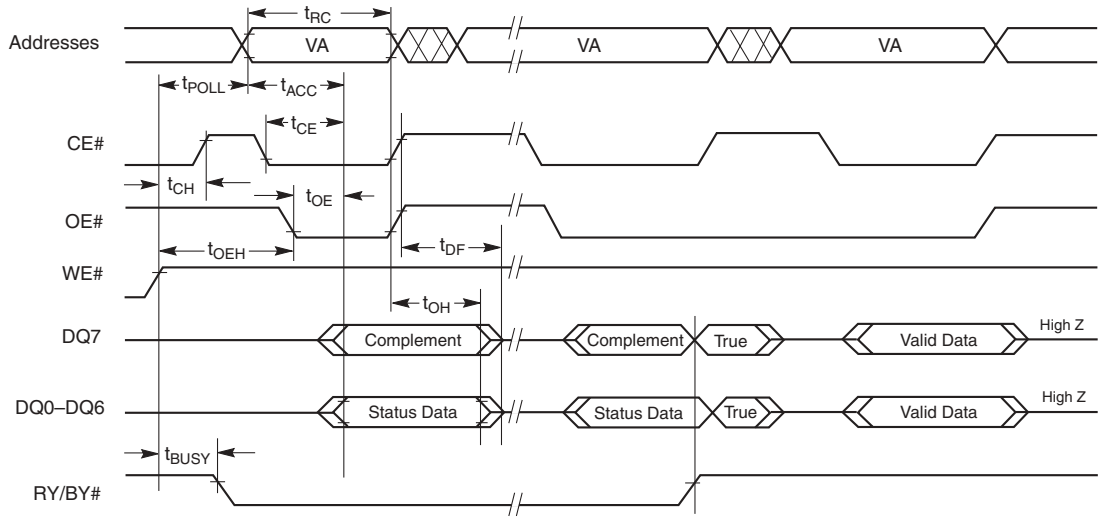
Figure 17. Accelerated Program Timing Diagram



Notes:

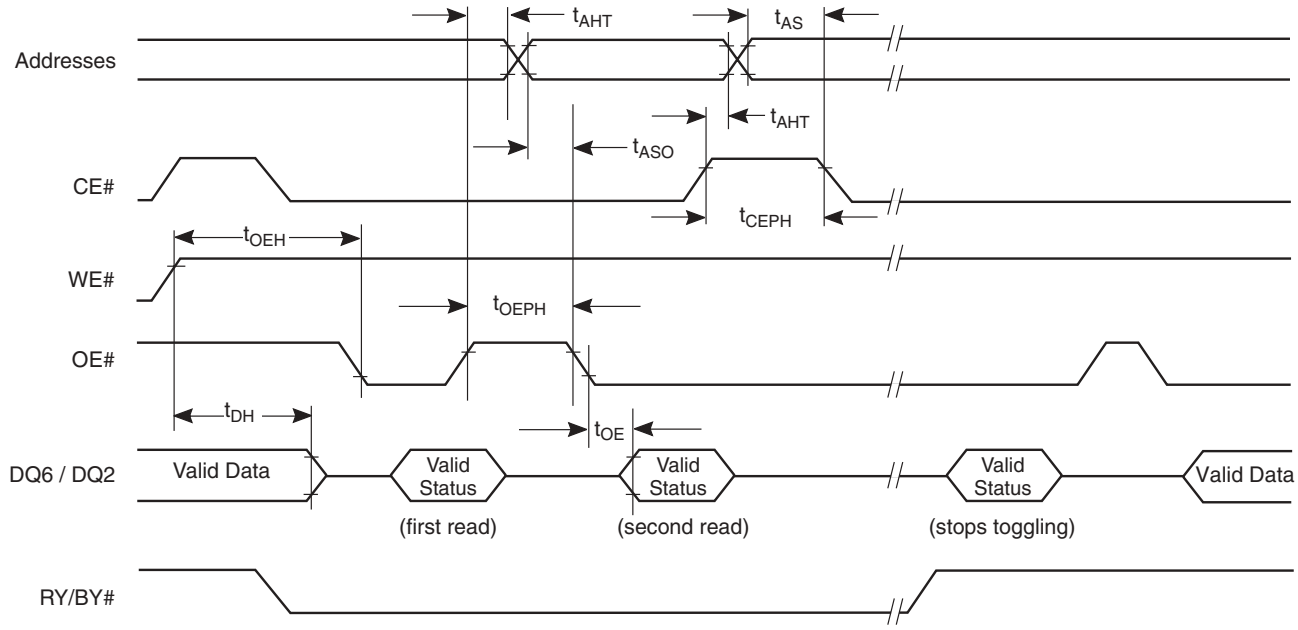
1. *SA = sector address (for Sector Erase), VA = Valid Address for reading status data (see "Write Operation Status".)*
2. *Illustration shows device in word mode.*

Figure 18. Chip/Sector Erase Operation Timings



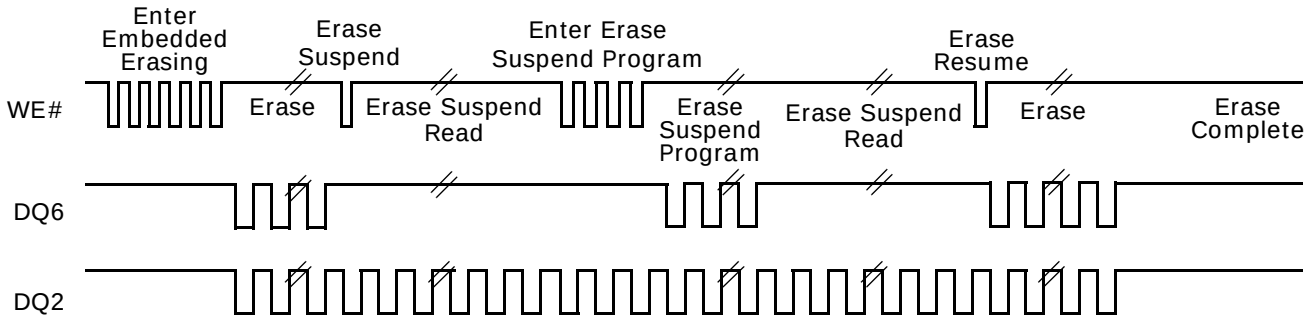
Note: *VA = Valid address. Illustration shows first status cycle after command sequence, last status read cycle, and array data read cycle.*

Figure 19. Data# Polling Timings (During Embedded Algorithms)



Note: *VA = Valid address; not required for DQ6. Illustration shows first two status cycle after command sequence, last status read cycle, and array data read cycle.*

Figure 20. Toggle Bit Timings (During Embedded Algorithms)



Note: *DQ2 toggles only when read at an address within an erase-suspended sector. The system may use OE# or CE# to toggle DQ2 and DQ6.*

Figure 21. DQ2 vs. DQ6

Temporary Sector Unprotect

Parameter		Description		All Speed Options	Unit
JEDEC	Std				
	t_{VIDR}	V_{ID} Rise and Fall Time (See Note)	Min	500	ns
	t_{RSP}	RESET# Setup Time for Temporary Sector Unprotect	Min	4	µs

Note:*Not 100% tested.*

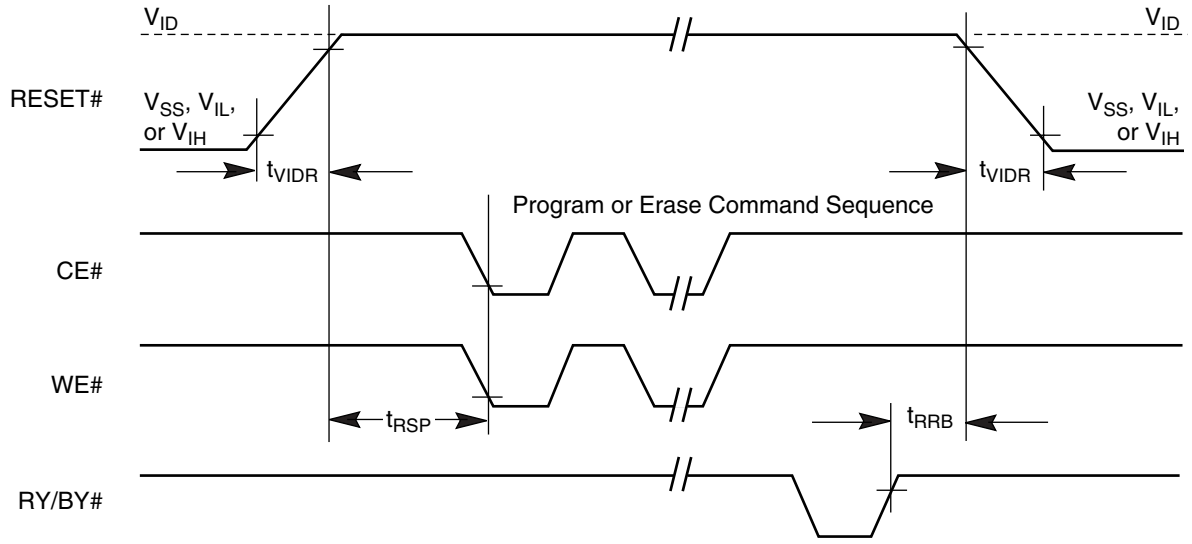
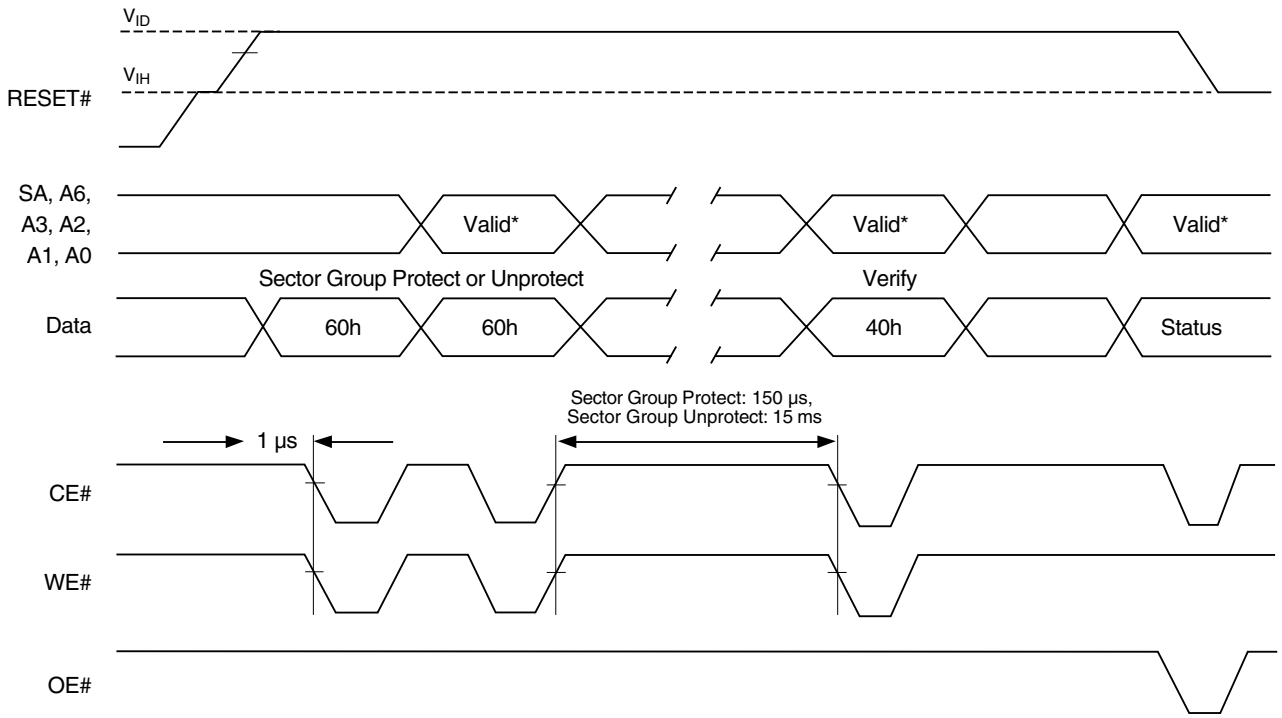


Figure 22. Temporary Sector Group Unprotect Timing Diagram



Note: *For sector group protect, A6:A0 = 0xx0010. For sector group unprotect, A6:A0 = 1xx0010.*

Figure 23. Sector Group Protect and Unprotect Timing Diagram

Alternate CE# Controlled Erase and Program Operations-S29GL256M

Parameter		Description		Speed Options		Unit
JEDEC	Std.			10	11	
t_{AVAV}	t_{WC}	Write Cycle Time (Note 1)	Min	100	110	ns
t_{AVWL}	t_{AS}	Address Setup Time	Min	0		ns
t_{ELAX}	t_{AH}	Address Hold Time	Min	45		ns
t_{DVEH}	t_{DS}	Data Setup Time	Min	45		ns
t_{EHDX}	t_{DH}	Data Hold Time	Min	0		ns
t_{GHEL}	t_{GHEL}	Read Recovery Time Before Write (OE# High to WE# Low)	Min	0		ns
t_{WLEL}	t_{WS}	WE# Setup Time	Min	0		ns
t_{EHWH}	t_{WH}	WE# Hold Time	Min	0		ns
t_{ELEH}	t_{CP}	CE# Pulse Width	Min	35		ns
t_{EHEL}	t_{CPH}	CE# Pulse Width High	Min	25		ns
t_{WHWH1}	t_{WHWH1}	Write Buffer Program Operation (Notes 2, 3)	Typ	240		µs
		Single Word Program Operation (Note 2)	Typ	60		
		Accelerated Single Word Program Operation (Note 2)	Typ	54		
t_{WHWH2}	t_{WHWH2}	Sector Erase Operation (Note 2)	Typ	0.5		sec
	t_{RH}	RESET# High Time Before Write	Min	50		ns
	t_{POLL}	Program Valid before Status Polling	Max	4		µs

Notes:

1. *Not 100% tested.*
2. *See the "Erase and Programming Performance" section for more information.*
3. *For 1–16 words/1–32 bytes programmed.*
4. *If a program suspend command is issued within t_{POLL}, the device requires t_{POLL} before reading status data, once programming has resumed (that is, the program resume command has been written). If the suspend command was issued after t_{POLL}, status data is available immediately after programming has resumed. See 24.*

Alternate CE# Controlled Erase and Program Operations-S29GL128M

Parameter		Description		Speed Options		Unit
JEDEC	Std.			10	11	
t_{AVAV}	t_{WC}	Write Cycle Time (Note 1)	Min	100	110	ns
t_{AVWL}	t_{AS}	Address Setup Time	Min	0		ns
t_{ELAX}	t_{AH}	Address Hold Time	Min	45		ns
t_{DVEH}	t_{DS}	Data Setup Time	Min	45		ns
t_{EHDX}	t_{DH}	Data Hold Time	Min	0		ns
t_{GHEL}	t_{GHEL}	Read Recovery Time Before Write (OE# High to WE# Low)	Min	0		ns
t_{WLEL}	t_{WS}	WE# Setup Time	Min	0		ns
t_{EHWH}	t_{WH}	WE# Hold Time	Min	0		ns
t_{ELEH}	t_{CP}	CE# Pulse Width	Min	35		ns
t_{EHEL}	t_{CPH}	CE# Pulse Width High	Min	25		ns
t_{WHWH1}	t_{WHWH1}	Write Buffer Program Operation (Notes 2, 3)	Typ	240		µs
		Single Word Program Operation (Note 2)	Typ	60		
		Accelerated Single Word Program Operation (Note 2)	Typ	54		
t_{WHWH2}	t_{WHWH2}	Sector Erase Operation (Note 2)	Typ	0.5		sec
	t_{RH}	RESET# High Time Before Write	Min	50		ns
	t_{POLL}	Program Valid before Status Polling (Note 4)	Max	4		µs

Notes:

1. *Not 100% tested.*
2. *See the "Erase and Programming Performance" section for more information.*
3. *For 1–16 words/1–32 bytes programmed.*
4. *If a program suspend command is issued within t_{POLL}, the device requires t_{POLL} before reading status data, once programming has resumed (that is, the program resume command has been written). If the suspend command was issued after t_{POLL}, status data is available immediately after programming has resumed. See 24.*

Alternate CE# Controlled Erase and Program Operations-S29GL064M

Parameter		Description		Speed Options			Unit
JEDEC	Std.			90	10	11	
t_{AVAV}	t_{WC}	Write Cycle Time (Note 1)	Min	90	100	110	ns
t_{AVWL}	t_{AS}	Address Setup Time	Min	0			ns
t_{ELAX}	t_{AH}	Address Hold Time	Min	45			ns
t_{DVEH}	t_{DS}	Data Setup Time	Min	35			ns
t_{EHDX}	t_{DH}	Data Hold Time	Min	0			ns
t_{GHEL}	t_{GHEL}	Read Recovery Time Before Write (OE# High to WE# Low)	Min	0			ns
t_{WLEL}	t_{WS}	WE# Setup Time	Min	0			ns
t_{EHWH}	t_{WH}	WE# Hold Time	Min	0			ns
t_{ELEH}	t_{CP}	CE# Pulse Width	Min	35			ns
t_{EHEL}	t_{CPH}	CE# Pulse Width High	Min	25			ns
t_{WHWH1}	t_{WHWH1}	Write Buffer Program Operation (Notes 2, 3)	Typ	240			µs
		Single Word Program Operation (Note 2)	Typ	60			
		Accelerated Single Word Program Operation (Note 2)	Typ	54			
t_{WHWH2}	t_{WHWH2}	Sector Erase Operation (Note 2)	Typ	0.5			sec
	t_{RH}	RESET# High Time Before Write	Min	50			ns
	t_{POLL}	Program Valid before Status Polling (Note 5)	Max	4			µs

Notes:

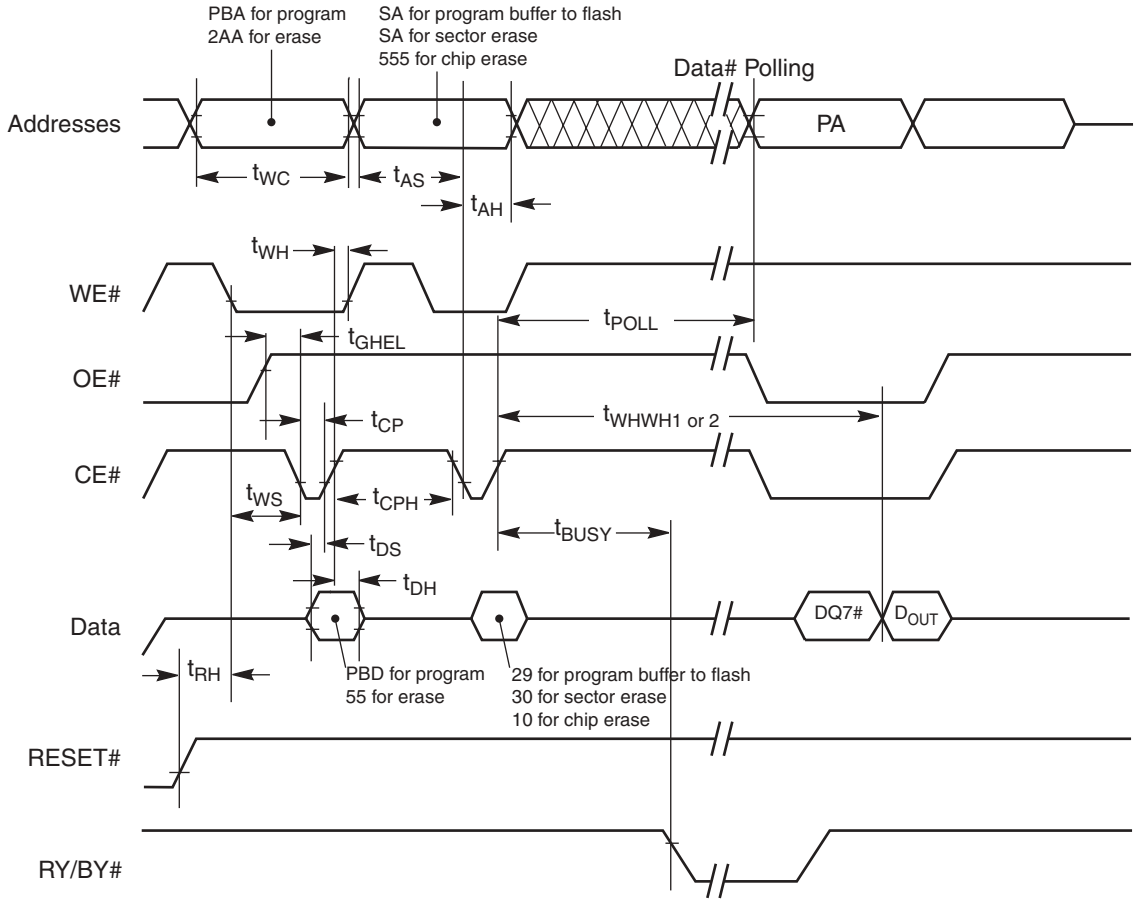
1. *Not 100% tested.*
2. *See the "Erase and Programming Performance" section for more information.*
3. *For 1–16 words/1–32 bytes programmed.*
4. *If a program suspend command is issued within t_{POLL}, the device requires t_{POLL} before reading status data, once programming has resumed (that is, the program resume command has been written). If the suspend command was issued after t_{POLL}, status data is available immediately after programming has resumed. See 24.*

Alternate CE# Controlled Erase and Program Operations-S29GL032M

Parameter		Description		Speed Options			Unit
JEDEC	Std.			90	10	11	
t_{AVAV}	t_{WC}	Write Cycle Time (Note 1)	Min	90	100	110	ns
t_{AVWL}	t_{AS}	Address Setup Time	Min	0			ns
t_{ELAX}	t_{AH}	Address Hold Time	Min	45			ns
t_{DVEH}	t_{DS}	Data Setup Time	Min	35			ns
t_{EHDX}	t_{DH}	Data Hold Time	Min	0			ns
t_{GHEL}	t_{GHEL}	Read Recovery Time Before Write (OE# High to WE# Low)	Min	0			ns
t_{WLEL}	t_{WS}	WE# Setup Time	Min	0			ns
t_{EHWH}	t_{WH}	WE# Hold Time	Min	0			ns
t_{ELEH}	t_{CP}	CE# Pulse Width	Min	35			ns
t_{EHEL}	t_{CPH}	CE# Pulse Width High	Min	25			ns
t_{WHWH1}	t_{WHWH1}	Write Buffer Program Operation (Notes 2, 3)	Typ	240			µs
		Single Word Program Operation (Note 2)	Typ	60			
		Accelerated Single Word Program Operation (Note 2)	Typ	54			
t_{WHWH2}	t_{WHWH2}	Sector Erase Operation (Note 2)	Typ	0.5			sec
	t_{RH}	RESET# High Time Before Write	Min	50			ns
	t_{POLL}	Program Valid before Status Polling (Note 4)	Max	4			µs

Notes:

1. *Not 100% tested.*
2. *See the "Erase and Programming Performance" section for more information.*
3. *For 1–16 words/1–32 bytes programmed.*
4. *If a program suspend command is issued within t_{POLL}, the device requires t_{POLL} before reading status data, once programming has resumed (that is, the program resume command has been written). If the suspend command was issued after t_{POLL}, status data is available immediately after programming has resumed. See 24.*



Notes:

1. *Figure indicates last two bus cycles of a program or erase operation.*
2. *PA = program address, SA = sector address, PD = program data.*
3. *DQ7# is the complement of the data written to the device. D_{OUT} is the data written to the device.*
4. *Illustration shows device in word mode.*

Figure 24. Alternate CE# Controlled Write (Erase/Program) Operation Timings

Erase and Programming Performance

Parameter		Typ (Note 1)	Max (Note 2)	Unit	Comments
Sector Erase Time		0.5	3.5	sec	Excludes 00h programming prior to erasure Note (6)
Chip Erase Time	S29GL032M	32	64	sec	
	S29GL064M	64	128		
	S29GL128M	128	256		
	S29GL256M	256	512		
Total Write Buffer Program Time Notes (3), (5)		240		µs	Excludes system level overhead Note (7)
Total Accelerated Effective Write Buffer Program Time Notes (4), (5)		200		µs	
Chip Program Time	S29GL032M	31.5		sec	
	S29GL064M	63			
	S29GL128M	126			
	S29GL256M	252			

Notes:

1. *Typical program and erase times assume the following conditions: 25°C, V_{CC} = 3.0V, 10,000 cycles; checkerboard data pattern.*
2. *Under worst case conditions of 90°C; Worst case V_{CC}, 100,000 cycles.*
3. *Effective programming time (typ) is 15 µs (per word), 7.5 µs (per byte).*
4. *Effective accelerated programming time (typ) is 12.5 µs (per word), 6.3 µs (per byte).*
5. *Effective write buffer specification is calculated on a per-word/per-byte basis for a 16-word/32-byte write buffer operation.*
6. *In the pre-programming step of the Embedded Erase algorithm, all bits are programmed to 00h before erasure.*
7. *System-level overhead is the time required to execute the command sequence(s) for the program command. See Tables 35 and 36 for further information on command definitions.*

TSOP Pin and BGA Package Capacitance

For package types TA, TF, BA, BF, FA, FF (refer to Ordering Information Pages):

Parameter Symbol	Parameter Description	Test Setup		Typ	Max	Unit
C_{IN}	Input Capacitance	V_{IN} = 0	TSOP	6	7.5	pF
			BGA	4.2	5.0	pF
C_{OUT}	Output Capacitance	V_{OUT} = 0	TSOP	8.5	12	pF
			BGA	5.4	6.5	pF
C_{IN2}	Control Pin Capacitance	V_{IN} = 0	TSOP	7.5	9	pF
			BGA	3.9	4.7	pF

For package types TB, TC, BB, BC, (refer to Ordering Information Pages):

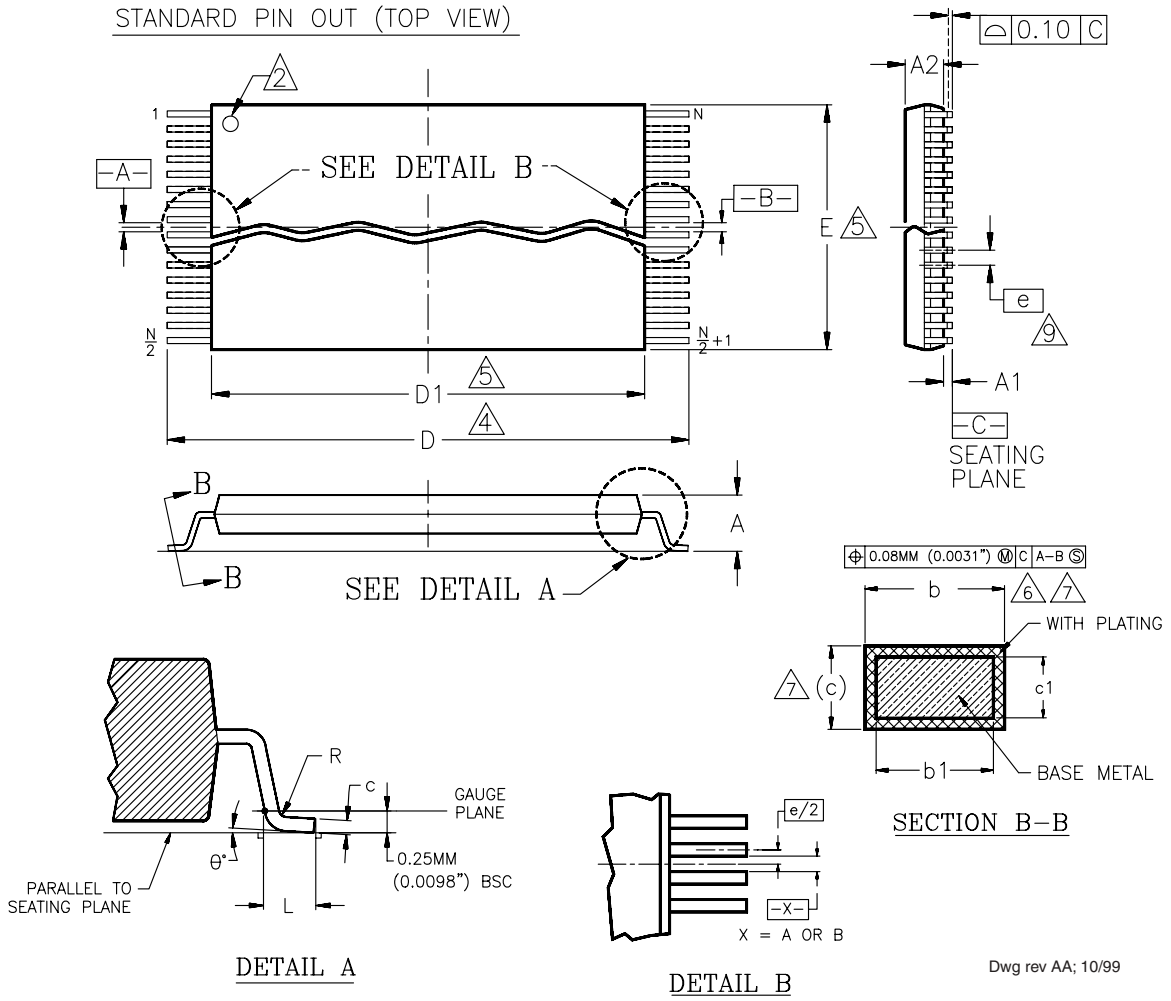
Parameter Symbol	Parameter Description	Test Setup		Typ	Max	Unit
C_{IN}	Input Capacitance	V_{IN} = 0	TSOP	8	10	pF
			BGA	8	10	pF
C_{OUT}	Output Capacitance	V_{OUT} = 0	TSOP	8.5	12	pF
			BGA	8.5	12	pF
C_{IN2}	Control Pin Capacitance	V_{IN} = 0	TSOP	8	10	pF
			BGA	8	10	pF
C_{IN3}	RESET# and WP#/ACC Pin Capacitance	V_{IN} = 0	TSOP	20	25	pF
			BGA	15	20	pF

Notes:

1. *Sampled, not 100% tested.*
2. *Test conditions T_A = 25°C, f = 1.0 MHz.*

Physical Dimensions

TS040—40-Pin Standard Thin Small Outline Package



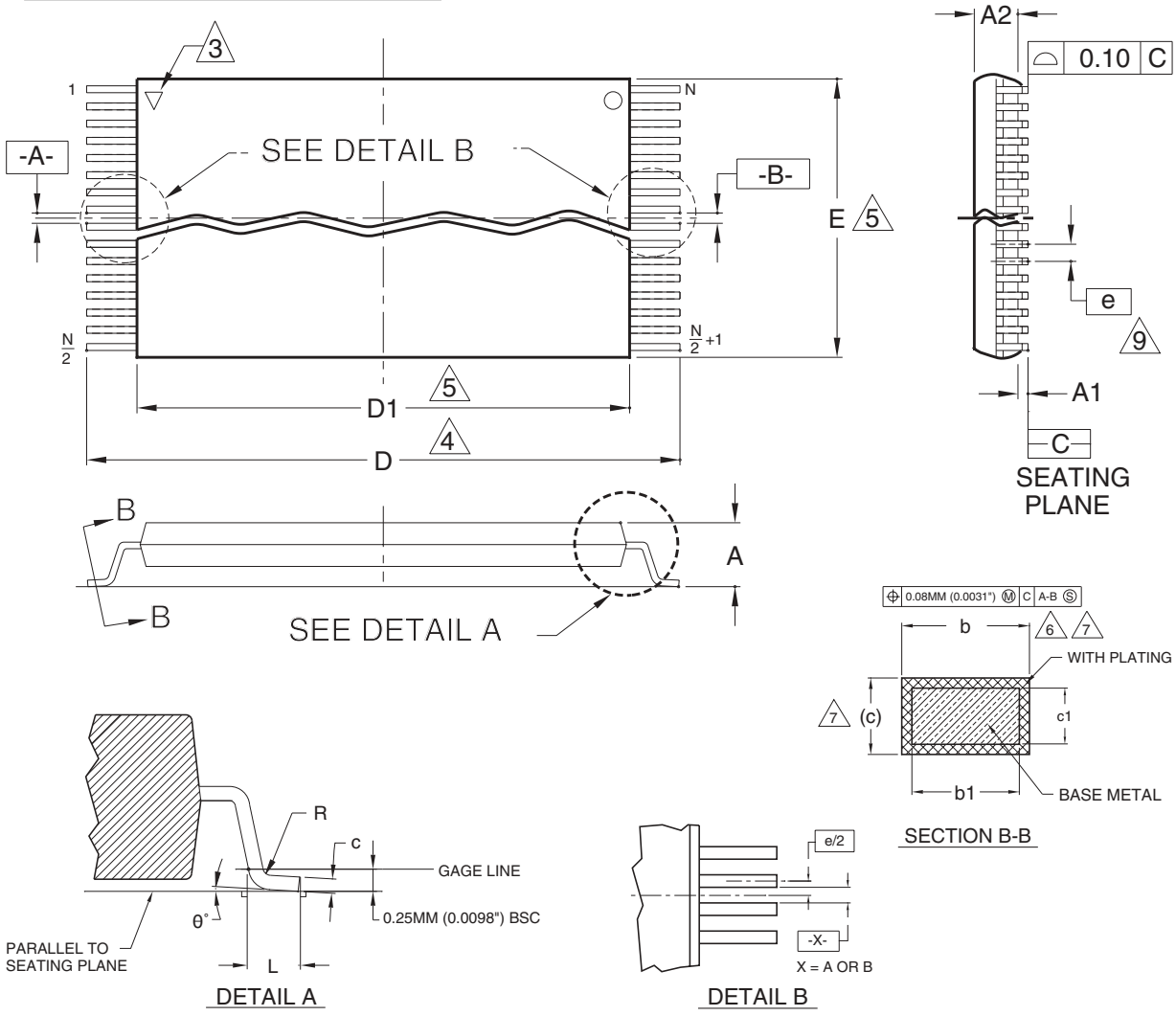
Package	TS 40		
Jedec	MO-142 (B) CD		
Symbol	MIN	NOM	MAX
A	—	—	1.20
A1	0.05	—	0.15
A2	0.95	1.00	1.05
b1	0.17	0.20	0.23
b	0.17	0.22	0.27
c1	0.10	—	0.16
c	0.10	—	0.21
D	19.80	20.00	20.20
D1	18.30	18.40	18.50
E	9.90	10.00	10.10
e	0.50 BASIC		
L	0.50	0.60	0.70
θ	0°	3°	5°
R	0.08	—	0.20
N	40		

NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (mm). (DIMENSIONING AND TOLERANCING CONFORMS TO ANSI Y14.5M-1982)
2. `PIN 1 IDENTIFIER FOR STANDARD PIN OUT (DIE UP).
3. PIN 1 IDENTIFIER FOR REVERSE PIN OUT (DIE DOWN): INK OR LASER MARK.
4. TO BE DETERMINED AT THE SEATING PLANE -C-. THE SEATING PLANE IS DEFINED AS THE PLANE OF CONTACT THAT IS MADE WHEN THE PACKAGE LEADS ARE ALLOWED TO REST FREELY ON A FLAT HORIZONTAL SURFACE.
5. DIMENSIONS D1 AND E DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE MOLD PROTUSION IS 0.15mm (.0059") PER SIDE.
6. DIMENSION b DOES NOT INCLUDE DAMBAR PROTUSION. ALLOWABLE DAMBAR PROTUSION SHALL BE 0.08mm (0.0031") TOTAL IN EXCESS OF b DIMENSION AT MAX. MATERIAL CONDITION. MINIMUM SPACE BETWEEN PROTRUSION AND AN ADJACENT LEAD TO BE 0.07mm (0.0028").
7. THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10mm (.0039") AND 0.25mm (0.0098") FROM THE LEAD TIP.
8. LEAD COPLANARITY SHALL BE WITHIN 0.10mm (0.004") AS MEASURED FROM THE SEATING PLANE.
9. DIMENSION "e" IS MEASURED AT THE CENTERLINE OF THE LEADS.

TSR040—40-Pin Standard / Reverse Thin Small Outline Package (TSOP)

REVERSE PIN OUT (TOP VIEW)



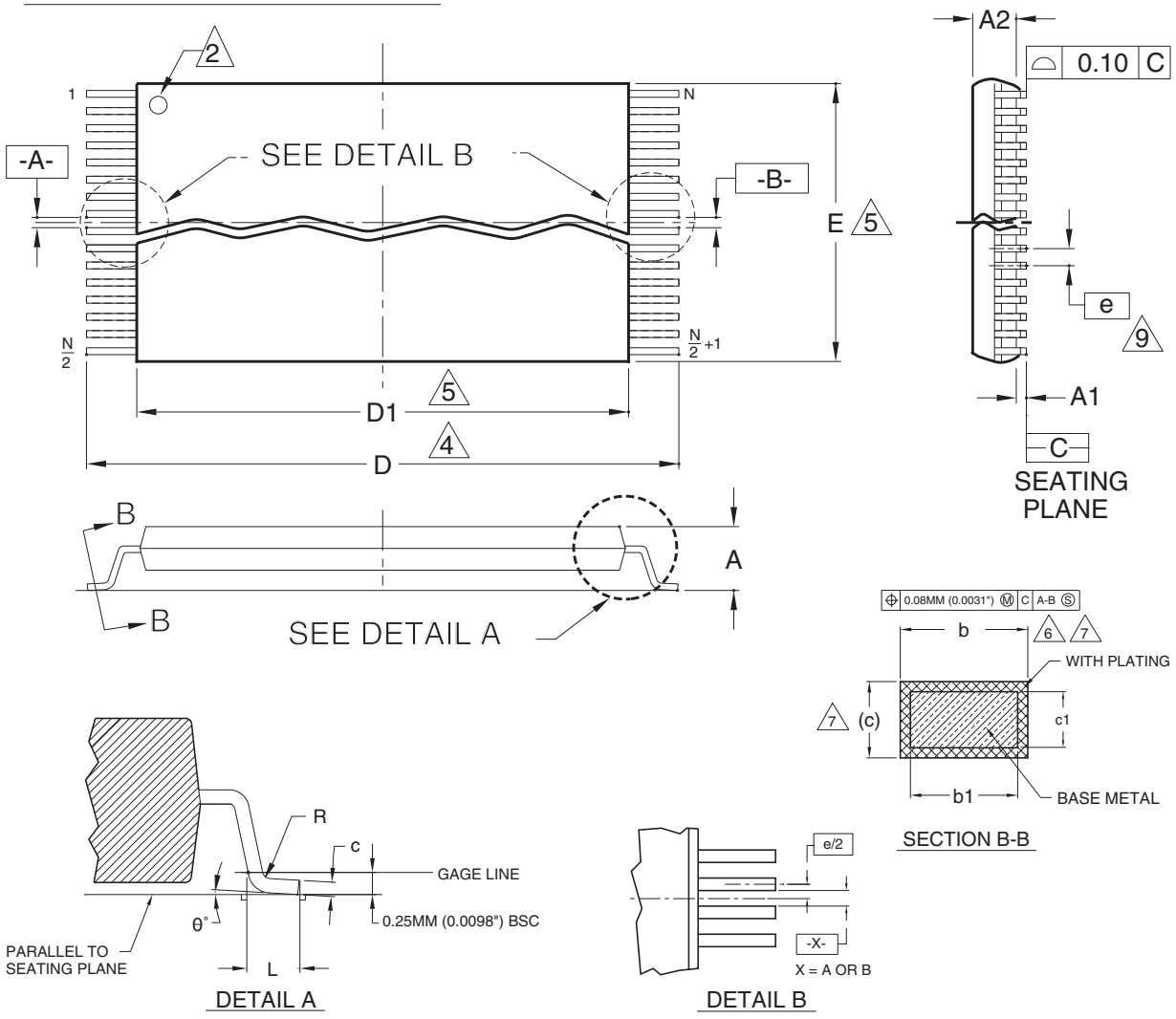
Package	TSR 040		
Jedec	MO-142 (B) EC		
Symbol	MIN	NOM	MAX
A	—	—	1.20
A1	0.05	—	0.15
A2	0.95	1.00	1.05
b1	0.17	0.20	0.23
b	0.17	0.22	0.27
c1	0.10	—	0.16
c	0.10	—	0.21
D	19.80	20.00	20.20
D1	18.30	18.40	18.50
E	9.90	10.00	10.10
e	0.50 BASIC		
L	0.50	0.60	0.70
θ	0°	3°	5°
R	0.08	—	0.20
N	40		

NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (MM). (DIMENSIONING AND TOLERANCING CONFORMS TO ANSI Y14.5M-1982)
2. NOT APPLICABLE.
3. PIN 1 IDENTIFIER FOR REVERSE PIN OUT (DIE DOWN), INK OR LASER MARK.
4. TO BE DETERMINED AT THE SEATING PLANE -C-. THE SEATING PLANE IS DEFINED AS THE PLANE OF CONTACT THAT IS MADE WHEN THE PACKAGE LEADS ARE ALLOWED TO REST FREELY ON A FLAT HORIZONTAL SURFACE.
5. DIMENSIONS D1 AND E DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE MOLD PROTUSION IS 0.15MM (.0059") PER SIDE.
6. DIMENSION b DOES NOT INCLUDE DAMBAR PROTUSION. ALLOWABLE DAMBAR PROTUSION SHALL BE 0.08 (0.0031") TOTAL IN EXCESS OF b DIMENSION AT MAX. MATERIAL CONDITION. MINIMUM SPACE BETWEEN PROTRUSION AND AN ADJACENT LEAD TO BE 0.07 (0.0028").
7. THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10MM (.0039") AND 0.25MM (0.0098") FROM THE LEAD TIP.
8. LEAD COPLANARITY SHALL BE WITHIN 0.10MM (0.004") AS MEASURED FROM THE SEATING PLANE.
9. DIMENSION "e" IS MEASURED AT THE CENTERLINE OF THE LEADS.

3324 \ 16-038.10a

TS048—48-Pin Standard / Reverse Thin Small Outline Package (TSOP)



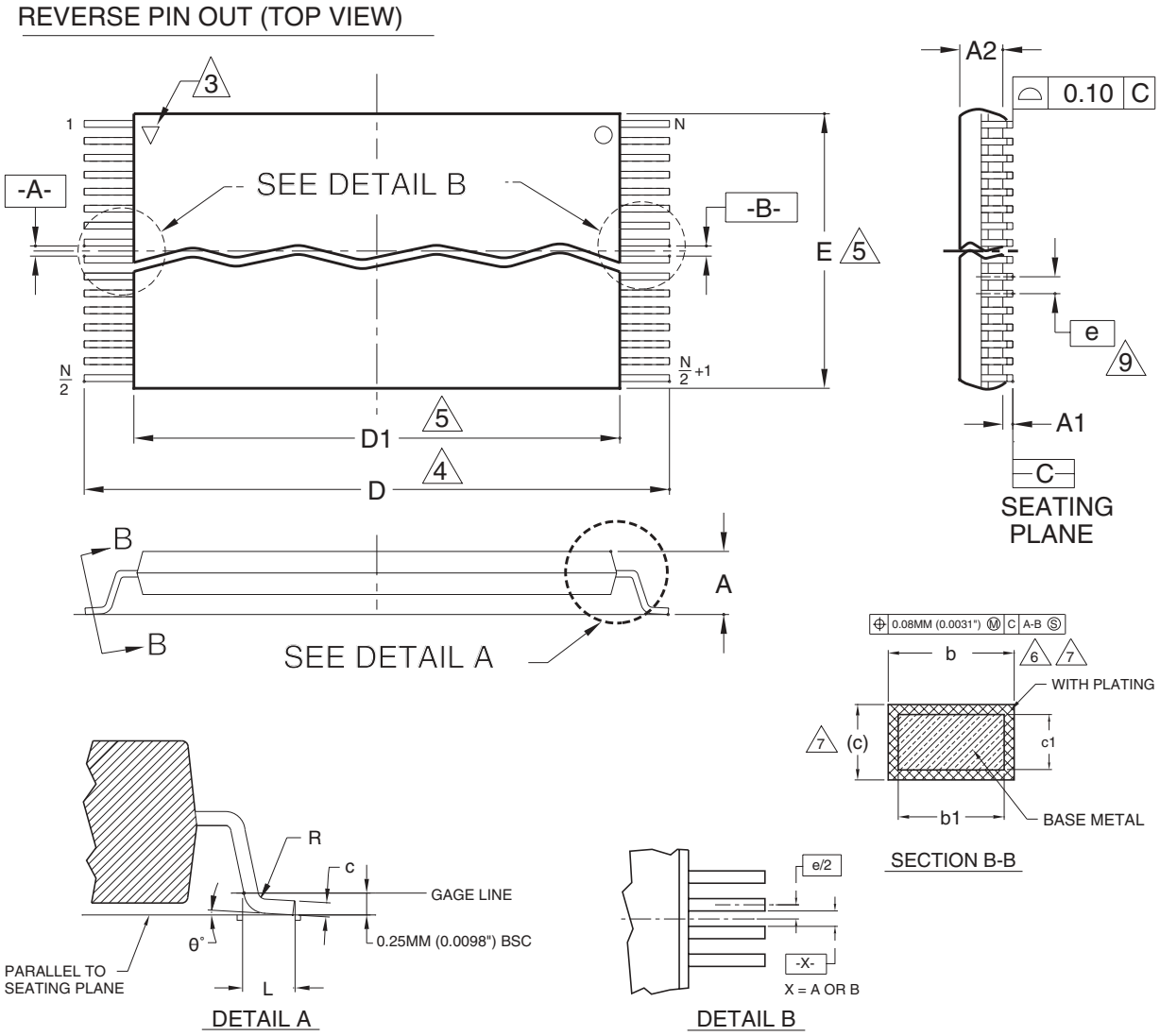
Package	TS 048		
Jedec	MO-142 (B) EC		
Symbol	MIN	NOM	MAX
A	—	—	1.20
A1	0.05	—	0.15
A2	0.95	1.00	1.05
b1	0.17	0.20	0.23
b	0.17	0.22	0.27
c1	0.10	—	0.16
c	0.10	—	0.21
D	19.80	20.00	20.20
D1	18.30	18.40	18.50
E	11.90	12.00	12.10
e	0.50 BASIC		
L	0.50	0.60	0.70
0	0°	3°	5°
R	0.08	—	0.20
N	48		

NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (MM). (DIMENSIONING AND TOLERANCING CONFORMS TO ANSI Y14.5M-1982)
2. PIN 1 IDENTIFIER FOR STANDARD PIN OUT (DIE UP).
3. NOT APPLICABLE.
4. TO BE DETERMINED AT THE SEATING PLANE -C-. THE SEATING PLANE IS DEFINED AS THE PLANE OF CONTACT THAT IS MADE WHEN THE PACKAGE LEADS ARE ALLOWED TO REST FREELY ON A FLAT HORIZONTAL SURFACE.
5. DIMENSIONS D1 AND E DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE MOLD PROTUSION IS 0.15MM (.0059") PER SIDE.
6. DIMENSION b DOES NOT INCLUDE DAMBAR PROTUSION. ALLOWABLE DAMBAR PROTUSION SHALL BE 0.08 (0.0031") TOTAL IN EXCESS OF b DIMENSION AT MAX. MATERIAL CONDITION. MINIMUM SPACE BETWEEN PROTRUSION AND AN ADJACENT LEAD TO BE 0.07 (0.0028").
7. THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10MM (.0039") AND 0.25MM (0.0098") FROM THE LEAD TIP.
8. LEAD COPLANARITY SHALL BE WITHIN 0.10MM (0.004") AS MEASURED FROM THE SEATING PLANE.
9. DIMENSION "e" IS MEASURED AT THE CENTERLINE OF THE LEADS.

3325 \ 16-038.10a

TSR048—48-Pin Standard / Reverse Thin Small Outline Package (TSOP)



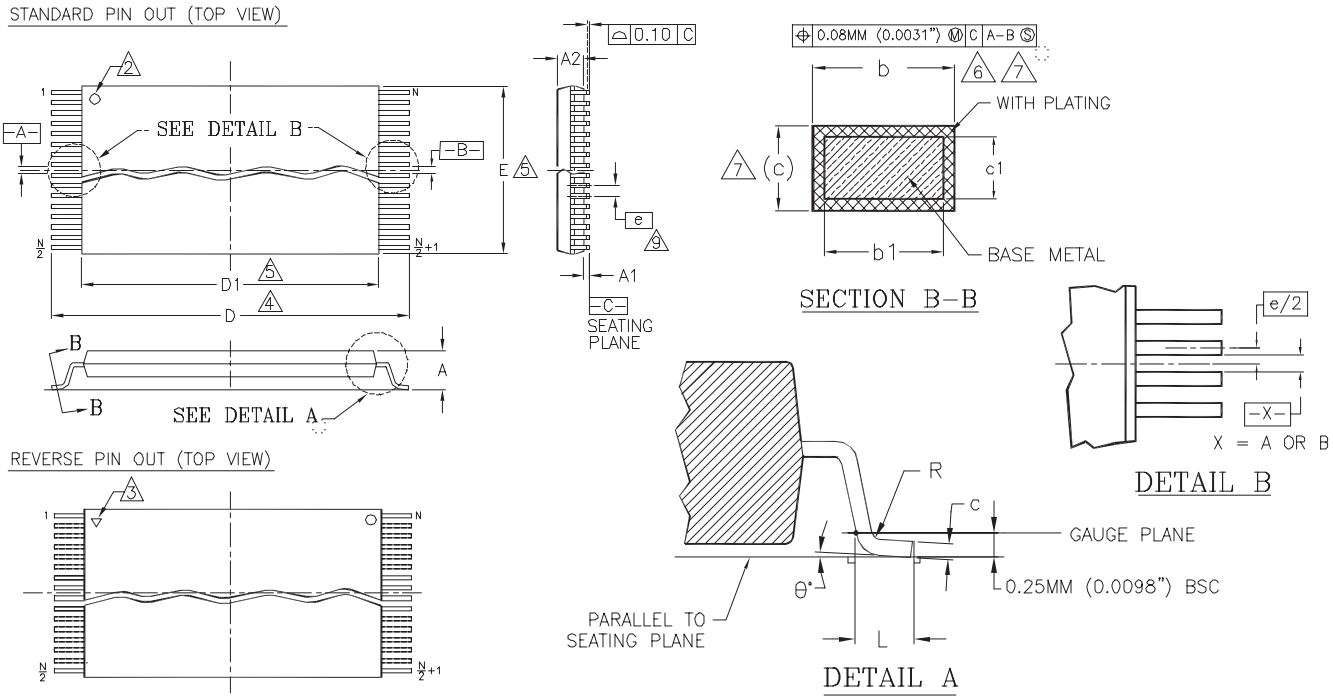
Package	TSR 048		
Jedec	MO-142 (B) EC		
Symbol	MIN	NOM	MAX
A	—	—	1.20
A1	0.05	—	0.15
A2	0.95	1.00	1.05
b1	0.17	0.20	0.23
b	0.17	0.22	0.27
c1	0.10	—	0.16
c	0.10	—	0.21
D	19.80	20.00	20.20
D1	18.30	18.40	18.50
E	11.90	12.00	12.10
e	0.50 BASIC		
L	0.50	0.60	0.70
θ	0°	3°	5°
R	0.08	—	0.20
N	48		

NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (MM). (DIMENSIONING AND TOLERANCING CONFORMS TO ANSI Y14.5M-1982)
2. NOT APPLICABLE.
3. PIN 1 IDENTIFIER FOR REVERSE PIN OUT (DIE DOWN), INK OR LASER MARK.
4. TO BE DETERMINED AT THE SEATING PLANE -C-. THE SEATING PLANE IS DEFINED AS THE PLANE OF CONTACT THAT IS MADE WHEN THE PACKAGE LEADS ARE ALLOWED TO REST FREELY ON A FLAT HORIZONTAL SURFACE.
5. DIMENSIONS D1 AND E DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE MOLD PROTUSION IS 0.15MM (.0059") PER SIDE.
6. DIMENSION b DOES NOT INCLUDE DAMBAR PROTUSION. ALLOWABLE DAMBAR PROTUSION SHALL BE 0.08 (0.0031") TOTAL IN EXCESS OF b DIMENSION AT MAX. MATERIAL CONDITION. MINIMUM SPACE BETWEEN PROTRUSION AND AN ADJACENT LEAD TO BE 0.07 (0.0028").
7. THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10MM (.0039") AND 0.25MM (0.0098") FROM THE LEAD TIP.
8. LEAD COPLANARITY SHALL BE WITHIN 0.10MM (0.004") AS MEASURED FROM THE SEATING PLANE.
9. DIMENSION "e" IS MEASURED AT THE CENTERLINE OF THE LEADS.

3326 \ 16-038.10a

TS056 / TSR056—56-Pin Standard / Reverse Thin Small Outline Package (TSOP)



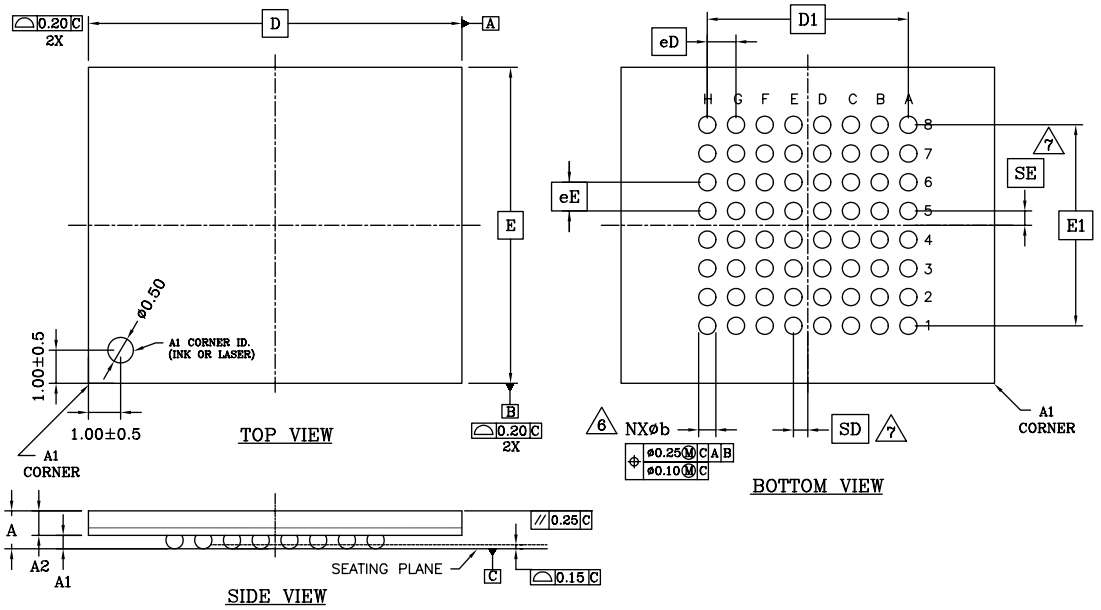
PACKAGE	TS/TSR 56		
JEDEC	MO-142 (B) EC		
SYMBOL	MIN.	NOM.	MAX.
A	---	---	1.20
A1	0.05	---	0.15
A2	0.95	1.00	1.05
b1	0.17	0.20	0.23
b	0.17	0.22	0.27
c1	0.10	---	0.16
c	0.10	---	0.21
D	19.90	20.00	20.20
D1	18.30	18.40	18.50
E	13.90	14.00	14.10
e	0.50 BASIC		
L	0.50	0.60	0.70
ø	0°	3°	5°
R	0.08	---	0.20
N	56		

NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (mm). (DIMENSIONING AND TOLERANCING CONFORMS TO ANSI Y14.5M-1982.)
2. PIN 1 IDENTIFIER FOR STANDARD PIN OUT (DIE UP).
3. PIN 1 IDENTIFIER FOR REVERSE PIN OUT (DIE DOWN), INK OR LASER MARK.
4. TO BE DETERMINED AT THE SEATING PLANE -C-. THE SEATING PLANE IS DEFINED AS THE PLANE OF CONTACT THAT IS MADE WHEN THE PACKAGE LEADS ARE ALLOWED TO REST FREELY ON A FLAT HORIZONTAL SURFACE.
5. DIMENSIONS D1 AND E DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE MOLD PROTUSION IS 0.15 mm PER SIDE.
6. DIMENSION b DOES NOT INCLUDE DAMBAR PROTUSION. ALLOWABLE DAMBAR PROTUSION SHALL BE 0.08 mm TOTAL IN EXCESS OF b DIMENSION AT MAX MATERIAL CONDITION. MINIMUM SPACE BETWEEN PROTRUSION AND AN ADJACENT LEAD TO BE 0.07 mm.
7. THESE DIMESIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.10 mm AND 0.25 mm FROM THE LEAD TIP.
8. LEAD COPLANARITY SHALL BE WITHIN 0.10 mm AS MEASURED FROM THE SEATING PLANE.
9. DIMENSION "e" IS MEASURED AT THE CENTERLINE OF THE LEADS.

3160\38.10A

LAA064—64-Ball Fortified Ball Grid Array (FBGA)

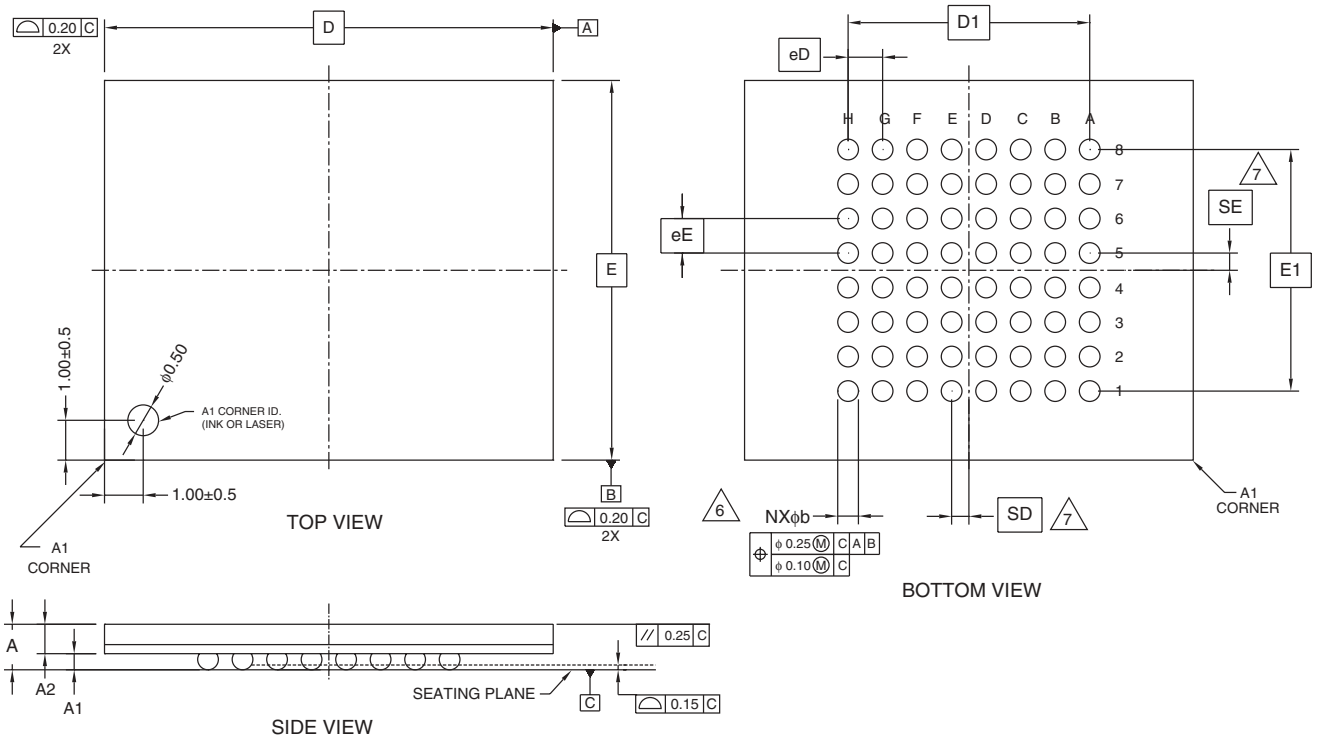


PACKAGE	LAA 064			
JEDEC	N/A			
	13.00x11.00 mm PACKAGE			
SYMBOL	MIN.	NOM.	MAX.	NOTE
A	–	–	1.40	PROFILE HEIGHT
A1	0.40	–	–	STANDOFF
A2	0.60	–	–	BODY THICKNESS
D	13.00 BSC.			BODY SIZE
E	11.00 BSC.			BODY SIZE
D1	7.00 BSC.			MATRIX FOOTPRINT
E1	7.00 BSC.			MATRIX FOOTPRINT
MD	8			MATRIX SIZE D DIRECTION
ME	8			MATRIX SIZE E DIRECTION
N	64			BALL COUNT
øb	0.50	0.60	0.70	BALL DIAMETER
eD	1.00 BSC.			BALL PITCH – D DIRECTION
eE	1.00 BSC.			BALL PITCH – E DIRECTION
SD/SE	0.50 BSC.			SOLDER BALL PLACEMENT
	A1–A8, K1–K8			DEPOPULATED SOLDER BALLS

NOTES:

1. DIMENSIONING AND TOLERANCING METHODS PER ASME Y14.5M–1994 .
2. ALL DIMENSIONS ARE IN MILLIMETERS .
3. BALL POSITION DESIGNATION PER JESD 95–1, SPP–010 (EXCEPT AS NOTED).
4. e REPRESENTS THE SOLDER BALL GRID PITCH .
5. SYMBOL "MD" IS THE BALL MATRIX SIZE IN THE "D" DIRECTION.
   SYMBOL "ME" IS THE BALL COLUMN MATRIX SIZE IN THE "E" DIRECTION.
   N IS THE NUMBER OF POPULATED SOLDER BALL POSITIONS FOR MATRIX SIZE MD X ME.
6. DIMENSION "b" IS MEASURED AT THE MAXIMUM BALL DIAMETER IN A PLANE PARALLEL TO DATUM "C".
7. SD AND SE ARE MEASURED WITH RESPECT TO DATUMS A AND B AND DEFINE THE POSITION OF THE CENTER SOLDER BALL IN THE OUTER ROW.
   WHEN THERE IS AN ODD NUMBER OF SOLDER BALLS IN THE OUTER ROW, SD OR SE = 0.000.
   WHEN THERE IS AN EVEN NUMBER OF SOLDER BALLS IN THE OUTER ROW, SD OR SE = e/2
8. "X" IN THE PACKAGE VARIATIONS DENOTES PART IS UNDER QUALIFICATION.
9. "+" INDICATES THE THEORETICAL CENTER OF DEPOPULATED BALLS.

LAC064—64-Pin 18 x 12 mm package



PACKAGE	LAC 064			
JEDEC	N/A			
	18.00 mm x 12.00 mm PACKAGE			
SYMBOL	MIN	NOM	MAX	NOTE
A	---	---	1.40	PROFILE HEIGHT
A1	0.40	---	---	STANDOFF
A2	0.60	---	---	BODY THICKNESS
D		18.00 BSC.		BODY SIZE
E		12.00 BSC.		BODY SIZE
D1		7.00 BSC.		MATRIX FOOTPRINT
E1		7.00 BSC.		MATRIX FOOTPRINT
MD		8		MATRIX SIZE D DIRECTION
ME		8		MATRIX SIZE E DIRECTION
N		64		BALL COUNT
φb	0.50	0.60	0.70	BALL DIAMETER
eD		1.00 BSC.		BALL PITCH - D DIRECTION
eE		1.00 BSC.		BALL PITCH - E DIRECTION
SD / SE		0.50 BSC.		SOLDER BALL PLACEMENT
		NONE		DEPOPULATED SOLDER BALLS

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
2. ALL DIMENSIONS ARE IN MILLIMETERS.
3. BALL POSITION DESIGNATION PER JESD 95-1, SPP-010 (EXCEPT AS NOTED).
4. e REPRESENTS THE SOLDER BALL GRID PITCH.
5. SYMBOL "MD" IS THE BALL ROW MATRIX SIZE IN THE "D" DIRECTION.

   SYMBOL "ME" IS THE BALL COLUMN MATRIX SIZE IN THE "E" DIRECTION.

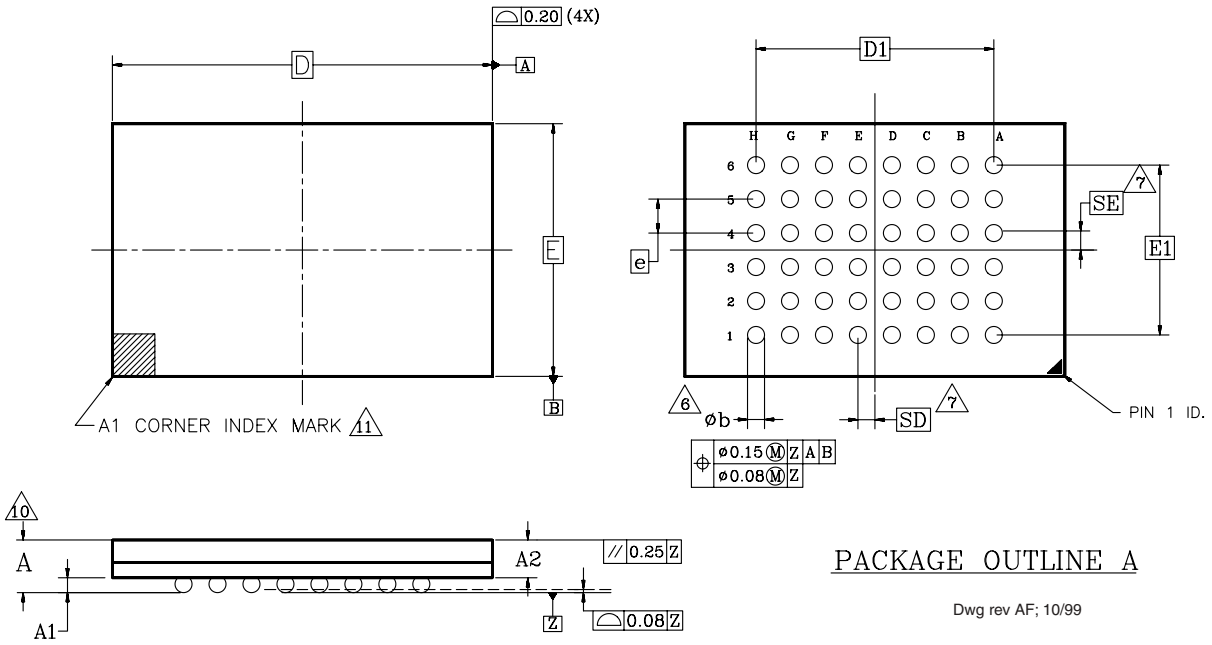
   N IS THE TOTAL NUMBER OF SOLDER BALLS.
6. DIMENSION "b" IS MEASURED AT THE MAXIMUM BALL DIAMETER IN A PLANE PARALLEL TO DATUM C.
7. SD AND SE ARE MEASURED WITH RESPECT TO DATUMS A AND B AND DEFINE THE POSITION OF THE CENTER SOLDER BALL IN THE OUTER ROW.

   WHEN THERE IS AN ODD NUMBER OF SOLDER BALLS IN THE OUTER ROW PARALLEL TO THE D OR E DIMENSION, RESPECTIVELY, SD OR SE = 0.000.

   WHEN THERE IS AN EVEN NUMBER OF SOLDER BALLS IN THE OUTER ROW, SD OR SE = e/2
8. NOT USED.
9. "+" INDICATES THE THEORETICAL CENTER OF DEPOPULATED BALLS.

3243 \ 16-038.12d

FBA048—48-Pin 6.15 x 8.15 mm package



PACKAGE OUTLINE A

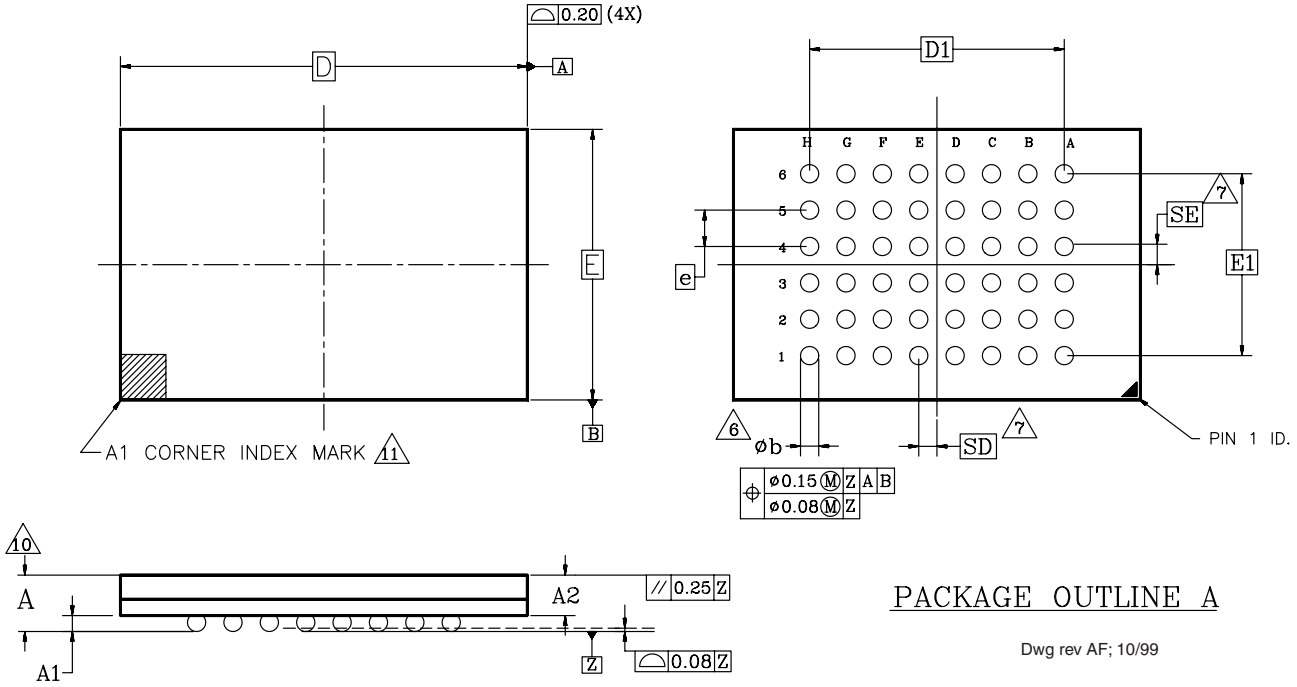
Dwg rev AF; 10/99

PACKAGE	xFBA 048			
JEDEC	N/A			
	6.15mmx8.15mm PACKAGE			
SYMBOL	MIN	NOM	MAX	NOTE
A	–	–	1.20	OVERALL THICKNESS
A1	0.20	–	–	BALL HEIGHT
A2	0.84	–	0.94	BODY THICKNESS
D	8.15 BSC			BODY SIZE
E	6.15 BSC			BODY SIZE
D1	5.60 BSC			BALL FOOTPRINT
E1	4.00 BSC			BALL FOOTPRINT
MD	8			ROW MATRIX SIZE D DIRECTION
ME	6			ROW MATRIX SIZE E DIRECTION
N	48			TOTAL BALL COUNT
b	0.25	0.30	0.35	BALL DIAMETER
e	0.80 BSC			BALL PITCH
SD/SE	0.40 BSC			SOLDER BALL PLACEMENT

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M–1994.
2. ALL DIMENSIONS ARE IN MILLIMETERS.
3. BALL POSITION DESIGNATION PER JESD 95–1, SPP–010.
4. e REPRESENTS THE SOLDER BALL GRID PITCH.
5. SYMBOL "MD" IS THE BALL ROW MATRIX SIZE IN THE "D" DIRECTION. SYMBOL "ME" IS THE BALL COLUMN MATRIX SIZE IN THE "E" DIRECTION. N IS THE MAXIMUM NUMBER OF SOLDER BALLS FOR MATRIX SIZE MD x ME.
6. DIMENSION "b" IS MEASURED AT THE MAXIMUM BALL DIAMETER IN A PLANE PARALLEL TO DATUM Z.
7. SD AND SE ARE MEASURED WITH RESPECT TO DATUMS A AND B AND DEFINE THE POSITION OF THE CENTER SOLDER BALL IN THE OUTER ROW. WHEN THERE IS AN ODD NUMBER OF SOLDER BALLS IN THE OUTER ROW PARALLEL TO THE D OR E DIMENSION, RESPECTIVELY, SD OR SE = 0.000 WHEN THERE IS AN EVEN NUMBER OF SOLDER BALLS IN THE OUTER ROW, SD OR SE = e/2
8. "X" IN THE PACKAGE VARIATIONS DENOTES PART IS UNDER QUALIFICATION.
9. "+" IN THE PACKAGE DRAWING INDICATE THE THEORETICAL CENTER OF DEPOPULATED BALLS.
10. FOR PACKAGE THICKNESS A IS THE CONTROLING DIMENSION.
11. A1 CORNER TO BE IDENTIFIED BY CHAMFER, INK MARK, METALLIZED MARKINGS INDENTION OR OTHER MEANS.

FBC048—48-Pin 8 x 9 mm package



PACKAGE OUTLINE A

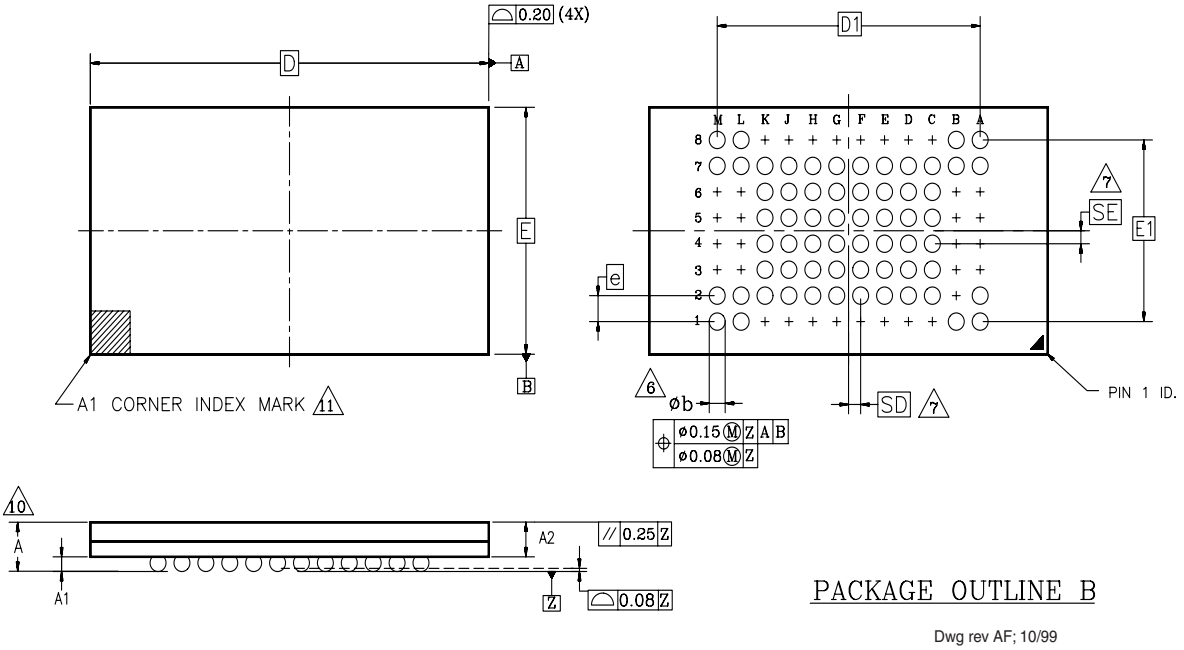
Dwg rev AF; 10/99

PACKAGE	FBC 048			
JEDEC	N/A			
	8.00mmx9.00mm PACKAGE			
SYMBOL	MIN	NOM	MAX	NOTE
A	–	–	1.20	OVERALL THICKNESS
A1	0.20	–	–	BALL HEIGHT
A2	0.84	–	0.94	BODY THICKNESS
D	9.00 BSC			BODY SIZE
E	8.00 BSC			BODY SIZE
D1	5.60 BSC			BALL FOOTPRINT
E1	4.00 BSC			BALL FOOTPRINT
MD	8			ROW MATRIX SIZE D DIRECTION
ME	6			ROW MATRIX SIZE E DIRECTION
N	48			TOTAL BALL COUNT
b	0.25	0.30	0.35	BALL DIAMETER
e	0.80 BSC			BALL PITCH
SD / SE	0.40 BSC			SOLDER BALL PLACEMENT

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M–1994.
2. ALL DIMENSIONS ARE IN MILLIMETERS.
3. BALL POSITION DESIGNATION PER JESD 95–1, SPP–010.
4. e REPRESENTS THE SOLDER BALL GRID PITCH.
5. SYMBOL "MD" IS THE BALL ROW MATRIX SIZE IN THE "D" DIRECTION. SYMBOL "ME" IS THE BALL COLUMN MATRIX SIZE IN THE "E" DIRECTION. N IS THE MAXIMUM NUMBER OF SOLDER BALLS FOR MATRIX SIZE MD x ME.
6. DIMENSION "b" IS MEASURED AT THE MAXIMUM BALL DIAMETER IN A PLANE PARALLEL TO DATUM Z.
7. SD AND SE ARE MEASURED WITH RESPECT TO DATUMS A AND B AND DEFINE THE POSITION OF THE CENTER SOLDER BALL IN THE OUTER ROW. WHEN THERE IS AN ODD NUMBER OF SOLDER BALLS IN THE OUTER ROW PARALLEL TO THE D OR E DIMENSION, RESPECTIVELY, SD OR SE = 0.000 WHEN THERE IS AN EVEN NUMBER OF SOLDER BALLS IN THE OUTER ROW, SD OR SE = e/2
8. "X" IN THE PACKAGE VARIATIONS DENOTES PART IS UNDER QUALIFICATION.
9. "+" IN THE PACKAGE DRAWING INDICATE THE THEORETICAL CENTER OF DEPOPULATED BALLS.
10. FOR PACKAGE THICKNESS A IS THE CONTROLING DIMENSION.
11. A1 CORNER TO BE IDENTIFIED BY CHAMFER, INK MARK, METALLIZED MARKINGS INDENTION OR OTHER MEANS.

FBE063—63-Pin 12 x 11 mm package



PACKAGE OUTLINE B

Dwg rev AF; 10/99

PACKAGE	xFBE 063			
JEDEC	N/A			
	12.00mmx11.00mm PACKAGE			
SYMBOL	MIN	NOM	MAX	NOTE
A	–	–	1.20	OVERALL THICKNESS
A1	0.20	–	–	BALL HEIGHT
A2	0.84	–	0.94	BODY THICKNESS
D	12.00 BSC			BODY SIZE
E	11.00 BSC			BODY SIZE
D1	8.80 BSC			BALL FOOTPRINT
E1	5.60 BSC			BALL FOOTPRINT
MD	12			ROW MATRIX SIZE D DIRECTION
ME	8			ROW MATRIX SIZE E DIRECTION
N	63			TOTAL BALL COUNT
b	0.25	0.30	0.35	BALL DIAMETER
e	0.80 BSC			BALL PITCH
SD/SE	0.40 BSC			SOLDER BALL PLACEMENT
	A3–A6,B2–B6 L3–L6, M3–M6 C1–K1,C8–K8			DEPOPULATED SOLDER BALLS

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M–1994.
2. ALL DIMENSIONS ARE IN MILLIMETERS.
3. BALL POSITION DESIGNATION PER JESD 95–1, SPP–010.
4. e REPRESENTS THE SOLDER BALL GRID PITCH.
5. SYMBOL "MD" IS THE BALL ROW MATRIX SIZE IN THE "D" DIRECTION. SYMBOL "ME" IS THE BALL COLUMN MATRIX SIZE IN THE "E" DIRECTION. N IS THE MAXIMUM NUMBER OF SOLDER BALLS FOR MATRIX SIZE MD x ME.

6 DIMENSION "b" IS MEASURED AT THE MAXIMUM BALL DIAMETER IN A PLANE PARALLEL TO DATUM Z.

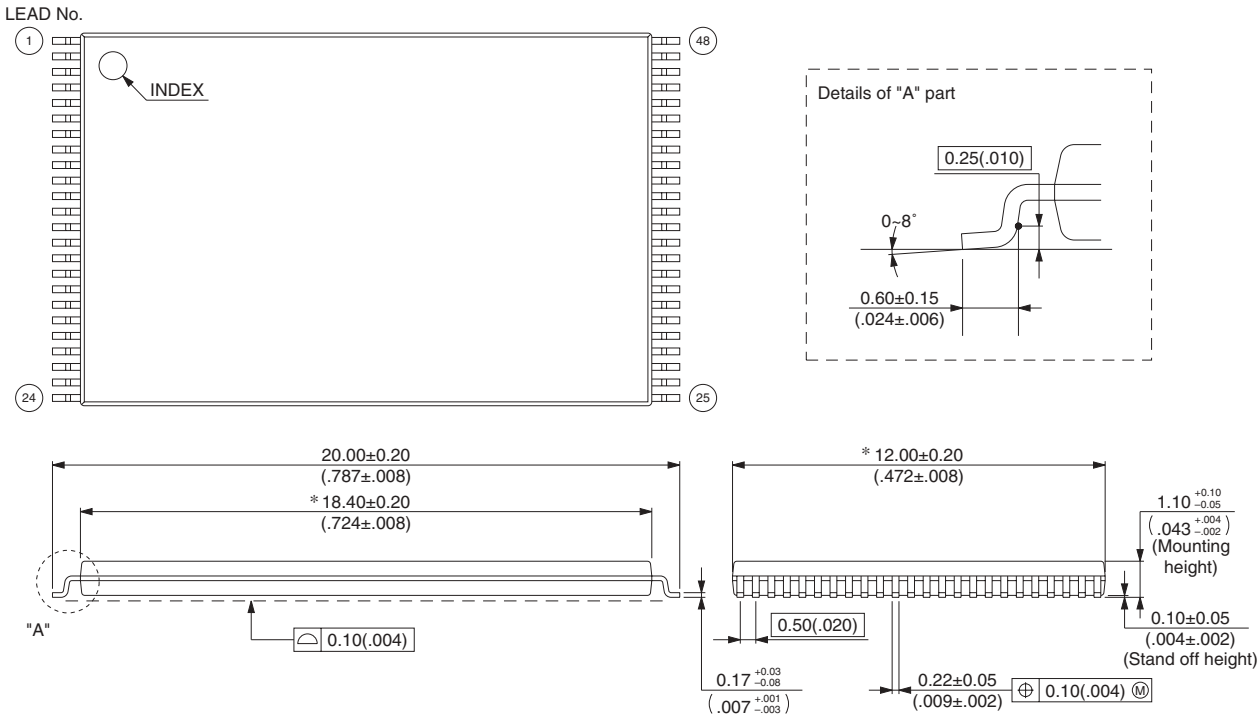
7 SD AND SE ARE MEASURED WITH RESPECT TO DATUMS A AND B AND DEFINE THE POSITION OF THE CENTER SOLDER BALL IN THE OUTER ROW. WHEN THERE IS AN ODD NUMBER OF SOLDER BALLS IN THE OUTER ROW PARALLEL TO THE D OR E DIMENSION, RESPECTIVELY, SD OR SE = 0.000 WHEN THERE IS AN EVEN NUMBER OF SOLDER BALLS IN THE OUTER ROW, SD OR SE = e/2

8. "X" IN THE PACKAGE VARIATIONS DENOTES PART IS UNDER QUALIFICATION.
9. "+" IN THE PACKAGE DRAWING INDICATE THE THEORETICAL CENTER OF DEPOPULATED BALLS.

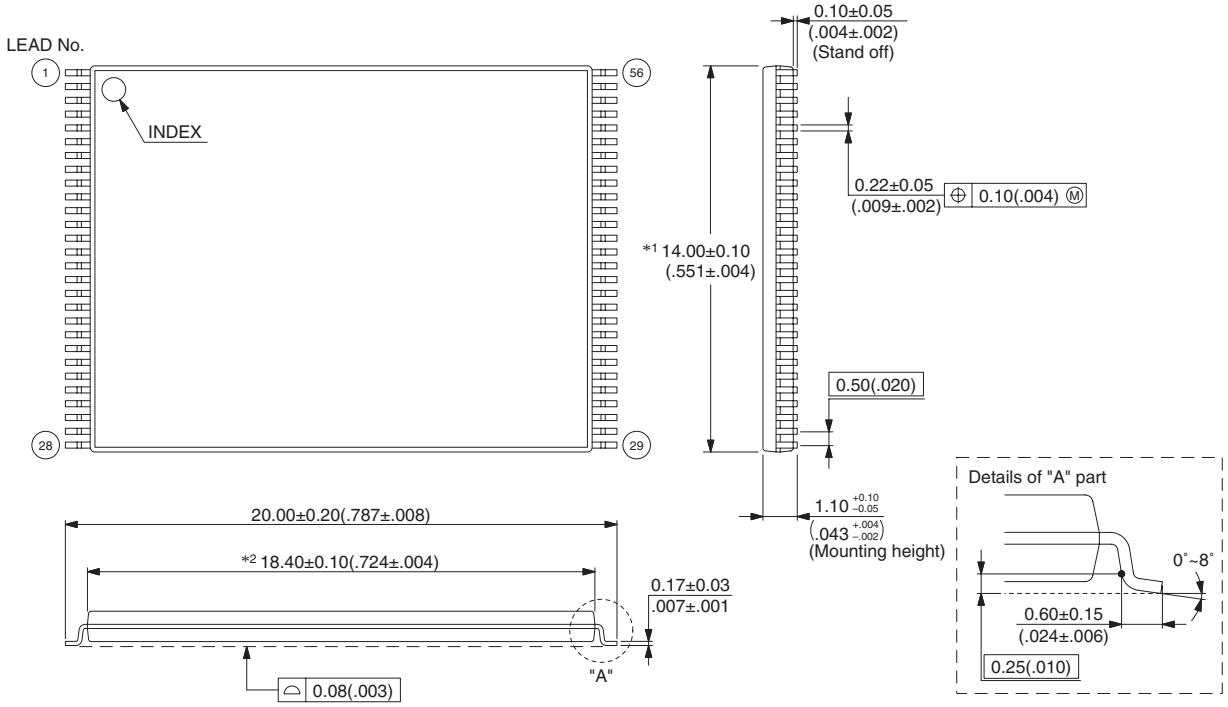
10 FOR PACKAGE THICKNESS A IS THE CONTROLING DIMENSION.

11 A1 CORNER TO BE IDENTIFIED BY CHAMFER, INK MARK, METALLIZED MARKINGS INDENTION OR OTHER MEANS.

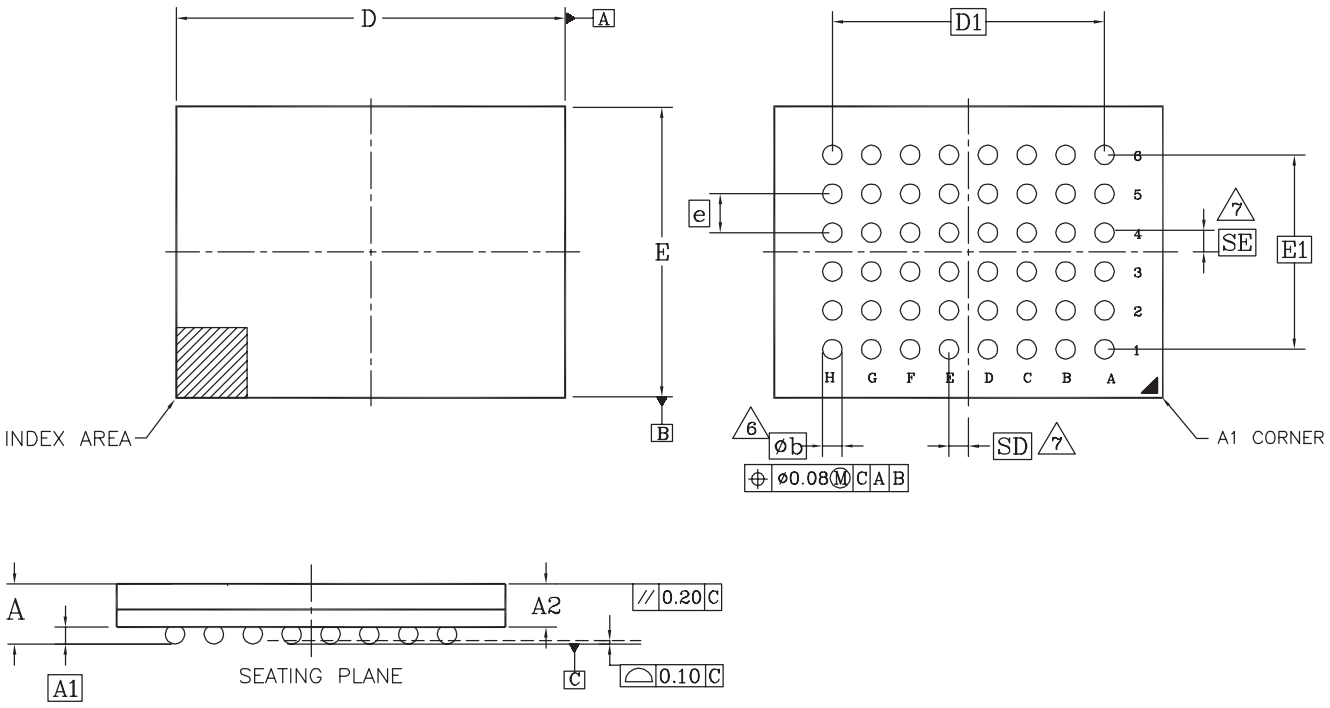
FPT-48P-M19



FPT-56P-M01



FBG048—48-pin 8 x 6 mm package



PACKAGE	FBG 048			
JEDEC	N/A			
	8.00 mm x 6.00 mm NOM PACKAGE			
SYMBOL	MIN	NOM	MAX	NOTE
A	0.95	1.08	1.20	OVERALL THICKNESS
A1	0.28	0.38	0.48	BALL HEIGHT
A2	---	---	---	BODY THICKNESS
D	7.80	8.00	8.20	BODY SIZE
E	5.80	6.00	6.20	BODY SIZE
D1	5.60 BSC.			BALL FOOTPRINT
E1	4.00 BSC.			BALL FOOTPRINT
MD	8			ROW MATRIX SIZE D DIRECTION
ME	6			ROW MATRIX SIZE E DIRECTION
N	48			TOTAL BALL COUNT
ϕb	0.40	0.45	0.50	BALL DIAMETER
e	0.80 BSC.			BALL PITCH
SD / SE	0.40 BSC.			SOLDER BALL PLACEMENT
	NONE			DEPOPULATED SOLDER BALLS

NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
2. ALL DIMENSIONS ARE IN MILLIMETERS.
3. BALL POSITION DESIGNATION PER JESD 95-1, SPP-010 (EXCEPT AS NOTED).
4. e REPRESENTS THE SOLDER BALL GRID PITCH.
5. SYMBOL "MD" IS THE BALL ROW MATRIX SIZE IN THE "D" DIRECTION.

   SYMBOL "ME" IS THE BALL COLUMN MATRIX SIZE IN THE "E" DIRECTION.

   N IS THE TOTAL NUMBER OF SOLDER BALLS.
6. DIMENSION "b" IS MEASURED AT THE MAXIMUM BALL DIAMETER IN A PLANE PARALLEL TO DATUM C.
7. SD AND SE ARE MEASURED WITH RESPECT TO DATUMS A AND B AND DEFINE THE POSITION OF THE CENTER SOLDER BALL IN THE OUTER ROW.

   WHEN THERE IS AN ODD NUMBER OF SOLDER BALLS IN THE OUTER ROW PARALLEL TO THE D OR E DIMENSION, RESPECTIVELY, SD OR SE = 0.000.

   WHEN THERE IS AN EVEN NUMBER OF SOLDER BALLS IN THE OUTER ROW, SD OR SE = e/2
8. NOT USED.
9. "+" INDICATES THE THEORETICAL CENTER OF DEPOPULATED BALLS.
10. A1 CORNER TO BE IDENTIFIED BY CHAMFER, LASER OR INK MARK, METALLIZED MARK INDENTATION OR OTHER MEANS.

3422\ 16-038.9m

Revision Summary

Revision A (January 29, 2004)

Initial Release.

Revision A+1 (February 23, 2004)

Connection Diagrams

Removed 80-ball Fine-pitch BGA pinout.

Ordering Information

Added additional packing type.

Removed frame description from package material set.

Updated valid combinations to reflect the addition of new package type.

Added marking descriptions to all valid combination tables.

Word Program Command Sequence and Unlock Bypass Command Sequence

Added these sections.

Figure 3, "Write Buffer Programming Operation", Figure 4, "Program Operation"

Updated figure.

Table 35, "Command Definitions (x16 Mode, BYTE# = V_{IH}),"

Updated table.

Added note 19.

Table 36, "Command Definitions (x8 Mode, BYTE# = V_{IL}),"

Updated table.

Added note 17.

Figure 7, "Data# Polling Algorithm"

Updated figure.

Erase and Program Operations and Alternate CE# Controlled Erase and Program Operations

Updated T_{WHWHI} description

Added Note 4.

Figure 16, Figure 18, Figure 20, Figure 24

Updated figure.

Physical Dimensions

Removed BGA-63P-M02 and BGA-80P-M01

Added the TS040 package

Revision A+2 (February 25, 2004)

Connection Diagrams

Removed the 40-pin reverse TSOP diagram.

Updated the 48-pin standard TSOP diagram.

Removed the 48-pin reverse TSOP diagram.

Removed the 56-pin reverse TSOP diagram.

Ordering Information

Removed all references to package type R.

Table 18 Autoselect Codes, (High Voltage Method)

Updated the R3, R4 column replacing -04 and -03 designators with -R4 and -R3 respectively.

Word Program Command Sequence

Included statements documenting word programming support for backward compatibility with existing Flash drivers.

Physical Dimensions

Removed the BGA-80P-M02 diagram.

Revision A+3 (February 26, 2004)

Distinctive Characteristics

Corrected typo in the Flexible Sector Architecture section.

Revision A+4 (March 24, 2004)

CMOS Compatible

Removed V_{CC} from Max for V_{OL}.

Erase and Program Operations-S29GL256M only

Corrected unit typos.

Erase and Program Operations-S29GL128M only

Corrected the minimum Data Setup Time.

Alternate CE# Controlled Erase and Program Operations-S29GL128M

Corrected the minimum CE# Pulse width.

TSOP Pin and BGA Package Capacitance: Pkg types TB, TC, BB, BC

Added C_{IN3}.

Connection Diagrams

40-pin standard TSOP: Corrected pin 30 to be V_{IO}.

48-pin standard TSOP: Added superscripts to designators for pin 9, 13, 14, 15 and 47. Changed pin 13 to A21. Added two notes below illustration.

56-pin standard TSOP: Added superscripts to designators for pin 1, 2 and 12. Changed pin 56 to NC. Added three notes below illustration.

64-ball Fortified BGA: Corrected ball D8 to be V_{IO}. Added superscripts to designators for ball D8, F7, and F1. Added two notes below illustration.

63-ball Fine-pitch BGA: Added superscript to designator for Ball H7. Added one note below illustration. Added connection diagrams for S29GL064M (model R0) and S29GL032M (model R0).

Pin Description

Added V_{IO} description.

Logic Symbols

Added V_{IO} on all models except R3 and R4.

Figure 3 Write Buffer Programming Operation

Corrected the DQ locations and added callouts to notes one through three.

DC Characteristics

Corrected test conditions for I_{CC6}.

Revision A+5 (April 30, 2004)

Ordering Information - S29GL032M

Added R5 and R6 model numbers to the breakout table.

Updated the Valid Combinations for BGA packages table to reflect model numbers R5 and R6.

Ordering Information - S29GL064M

Revised R8 and R9 model numbers on the breakout table.

Updated the Valid Combinations for TSOP packages table.

Ordering Information - S29GL0128M

Added R8 and R9 model numbers to the breakout table.

Revised the Package Material Set options on the breakout table.

Updated the Valid Combinations for TSOP packages table.

Ordering Information - S29GL256M

Revised the Package Material Set options on the breakout table.

Connection Diagrams (56-Pin TSOP)

Added a callout to Note 3 for pin 15.

Device Geometry Definition table

Revised the data and description information for addresses: 28h/50h and 29h/52h.

Primary Vendor Specific Extended Query table

Revised the data and description information for addresses: 45h/8Ah (x16/x8)

Revised the data information for addresses: 4Ch/98h (x16/x8)

Erase and Programming Performance table

Revised notes 1 and 2 below the table.

Revision B0 (May 24, 2004)

Global

Converted to full datasheet status.

Figure 18, “Autoselect Codes, (High Voltage Method)“

Corrected typos in description.

Added values for R5, R6, R7 description for cycle 1-3.

Added R8 and R9 to Model Number.

Revision B1 (August 2, 2004)

“Ordering Information-S29GL032M” on page 21

Added the following temperature range: “C = Commercial (0°C to +70°C)'.

Commercial temperature range options added for 90ns speeds.

Global Change

S29GL032M, S29GL064M, S29GL128M, S29GL236M ordering options pages:

Updated note 3 with the following “...TSOPs can be packed in Types 0 and 3; BGAs can be packed in Types 0, 2, or 3.

Revision B2 (September 8, 2004)

Connection Diagram - 64-ball Fortified BGA

Modified note 4.

Logic Symbol-S29GL032M (Models R3, R4)

Added models R5 and R6 to the logic symbol.

Logic Symbol-S29GL064M (Models R1, R2)

Added models R8 & R9 to the logic symbol.

S29GL032M Valid Combinations

Corrected ordering part numbers for LAA064 packages.

Physical Dimensions

Renamed the BGA-48P-M20 package as the FBG048 package.

Ordering Information

Added footnotes to indicate TSOP Pb-free leadframe plating.

Colophon

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